

Arm® Cortex®-A7 up to 1 GHz, 2×ETH, 2×CAN FD, 2×ADC,  
24 timers, audio, crypto and adv. security

Datasheet - production data

## Features

**Includes ST state-of-the-art patented technology**

### Core

- 32-bit Arm® Cortex®-A7
  - L1 32-Kbyte I / 32-Kbyte D
  - 128-Kbyte unified level 2 cache
  - Arm® NEON™ and Arm® TrustZone®

### Memories

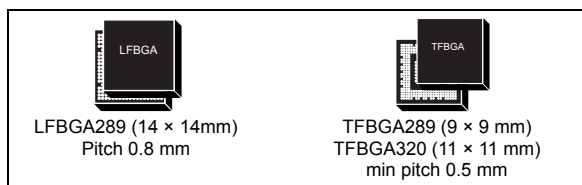
- External DDR memory up to 1 Gbyte
  - up to LPDDR2/LPDDR3-1066 16-bit
  - up to DDR3/DDR3L-1066 16-bit
- 168 Kbytes of internal SRAM: 128 Kbytes of AXI SYSRAM + 32 Kbytes of AHB SRAM and 8 Kbytes of SRAM in Backup domain
- Dual Quad-SPI memory interface
- Flexible external memory controller with up to 16-bit data bus: parallel interface to connect external ICs and SLC NAND memories with up to 8-bit ECC

### Security/safety

- Secure boot, TrustZone® peripherals, 12 x tamper pins including 5 x active tamperers
- Temperature, voltage, frequency and 32 kHz monitoring

### Reset and power management

- 1.71 V to 3.6 V I/Os supply (5 V-tolerant I/Os)
- POR, PDR, PVD and BOR
- On-chip LDOs (USB 1.8 V, 1.1 V)
- Backup regulator (~0.9 V)
- Internal temperature sensors
- Low-power modes: Sleep, Stop, LPLV-Stop, LPLV-Stop2 and Standby



- DDR retention in Standby mode
- Controls for PMIC companion chip

### Clock management

- Internal oscillators: 64 MHz HSI oscillator, 4 MHz CSI oscillator, 32 kHz LSI oscillator
- External oscillators: 8-48 MHz HSE oscillator, 32.768 kHz LSE oscillator
- 4 × PLLs with fractional mode

### General-purpose input/outputs

- Up to 135 secure I/O ports with interrupt capability
- Up to 6 wakeup

### Interconnect matrix

- 2 bus matrices
  - 64-bit Arm® AMBA® AXI interconnect, up to 266 MHz
  - 32-bit Arm® AMBA® AHB interconnect, up to 209 MHz

### 4 DMA controllers to unload the CPU

- 56 physical channels in total
- 1 x high-speed general-purpose master direct memory access controller (MDMA)
- 3 × dual-port DMAs with FIFO and request router capabilities for optimal peripheral management

**Up to 29 communication peripherals**

- 5 × I<sup>2</sup>C FM+ (1 Mbit/s, SMBus/PMBus™)
- 4 × UART + 4 × USART (12.5 Mbit/s, ISO7816 interface, LIN, IrDA, SPI slave)
- 5 × SPI (50 Mbit/s, including 4 with full-duplex I<sup>2</sup>S audio class accuracy via internal audio PLL or external clock)
- 2 × SAI (stereo audio: I<sup>2</sup>S, PDM, SPDIF Tx)
- SPDIF Rx with 4 inputs
- 2 × SDMMC up to 8 bits (SD/eMMC™/SDIO)
- 2 × CAN controllers supporting CAN FD protocol
- 2 × USB 2.0 high-speed Host
  - or 1 × USB 2.0 high-speed Host + 1 × USB 2.0 high-speed OTG simultaneously
- 2 × Ethernet MAC/GMAC
  - IEEE 1588v2 hardware, MII/RMII/RGMII

**6 analog peripherals**

- 2 × ADCs with 12-bit max. resolution up to 5 Msps
- 1 × temperature sensor
- 1 × digital filter for sigma-delta modulator (DFSDM) with 4 channels and 2 filters
- Internal or external ADC reference V<sub>REF+</sub>

**Up to 24 timers and 2 watchdogs**

- 2 × 32-bit timers with up to 4 IC/OC/PWM or pulse counter and quadrature (incremental) encoder input
- 2 × 16-bit advanced timers
- 10 × 16-bit general-purpose timers (including 2 basic timers without PWM)
- 5 × 16-bit low-power timers
- Secure RTC with sub-second accuracy and hardware calendar
- 4 Cortex®-A7 system timers (secure, non-secure, virtual, hypervisor)
- 2 × independent watchdogs

**Hardware acceleration**

- AES 128, 192, 256 DES/TDES
- AES 128, 256 with DPA protection

- PKA ECC/RSA with DPA protection
- AES 128 on-the-fly DRAM encryption and decryption
- HASH (SHA-1, SHA-224, SHA-256, SHA-384, SHA-512, SHA-3), HMAC
- 1 × true random number generator (6 triple oscillators)
- 1 × CRC calculation unit

**Debug mode**

- Arm® CoreSight™ trace and debug: SWD and JTAG interfaces usable as GPIOs
- 4-Kbyte embedded trace buffer

**3072-bit fuses including 96-bit unique ID, up to 1280 bits available for user and 256-bit HUK to protect AES 256 keys**

**All packages are ECOPACK2 compliant**

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# 1 Introduction

This datasheet provides the ordering information and mechanical device characteristics of the STM32MP133C/F microprocessors.

This document should be read in conjunction with the STM32MP133 reference manual (RM0475), available from the STMicroelectronics website [www.st.com](http://www.st.com).

For information on the Arm<sup>®(a)</sup> Cortex<sup>®</sup>-A7, refer to the Cortex<sup>®</sup>-A7 *Technical Reference Manuals*.

For information on the device errata with respect to the datasheet and reference manual, refer to the STM32MP131x/3x/5x device errata (ES0539), available on the STMicroelectronics website [www.st.com](http://www.st.com).



arm

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## 2 Description

The STM32MP133C/F devices are based on the high-performance Arm® Cortex®-A7 32-bit RISC core operating at up to 1 GHz. The Cortex®-A7 processor includes a 32-Kbyte L1 instruction cache, a 32-Kbyte L1 data cache and a 128-Kbyte level2 cache. The Cortex®-A7 processor is a very energy-efficient application processor designed to provide rich performance in high-end wearables, and other low-power embedded and consumer applications. It provides up to 20 % more single thread performance than the Cortex®-A5 and provides similar performance to the Cortex®-A9.

The Cortex®-A7 incorporates all features of the high-performance Cortex®-A15 and Cortex®-A17 processors, including virtualization support in hardware, NEON™, and 128-bit AMBA®4 AXI bus interface.

The STM32MP133C/F devices provide an external SDRAM interface supporting external memories up to 8-Gbit density (1 Gbyte), 16-bit LPDDR2/LPDDR3 or DDR3/DDR3L up to 533 MHz.

The STM32MP133C/F devices incorporate high-speed embedded memories with 168 Kbytes of internal SRAM (including 128 Kbytes of AXI SYSRAM, two banks of 8 Kbytes and one bank of 16 Kbytes securable AHB SRAM, and 8 Kbytes of SRAM in Backup domain), as well as an extensive range of enhanced I/Os and peripherals connected to APB buses, AHB buses, and a 64-bit multi-layer AXI interconnect supporting internal and external memories access.

All the devices offer two ADCs, a low-power secured RTC, ten general-purpose 16-bit timers, two 32-bit timers, two PWM timers for motor control, five low-power timers, a secured true random number generator (RNG), and an advanced secured cryptographic acceleration cell. The devices support two digital filters for external sigma-delta modulators (DFSDM). They also feature standard and advanced communication interfaces.

- Standard peripherals:
  - Five I<sup>2</sup>Cs
  - Four USARTs and four UARTs
  - Five SPIs, four I<sup>2</sup>Ss full-duplex master/slave. To achieve audio class accuracy, the I<sup>2</sup>S peripherals can be clocked via a dedicated internal audio PLL or via an external clock to allow synchronization.
  - Two SAI serial audio interfaces (up to four audio channels each)
  - One SPDIF Rx interface
  - Two SDMMC interfaces
  - A USB OTG high-speed controller
  - A USB high-speed Host controller with two ports and two high-speed phys. The second high-speed phy can be shared between the USB high-speed Host and the USB OTG high-speed.
  - Two FDCAN interfaces
  - Two Gigabit Ethernet interfaces
- Advanced peripherals including:
  - A flexible memory control (FMC) interface
  - A Quad-SPI flash memory interface

Refer to [Table 1: STM32MP133C/F features and peripheral counts](#) for the specificity for each package type.

A comprehensive set of power-saving mode allows the design of low-power applications.

The STM32MP133C/F devices are proposed in three packages ranging from 289 to 320 balls, with pitch 0.5 mm to 0.8 mm.

These features make the STM32MP133C/F suitable for a wide range of consumer, industrial, point of sales, white goods and medical applications.

[Figure 1](#) shows the general block diagram of the device family.

Table 1. STM32MP133C/F features and peripheral counts

| Features         |                 |                | STM32MP133CAE<br>STM32MP133FAE                     | STM32MP133CAG<br>STM32MP133FAG | STM32MP133CAF<br>STM32MP133FAF | Miscellaneous |                                     |
|------------------|-----------------|----------------|----------------------------------------------------|--------------------------------|--------------------------------|---------------|-------------------------------------|
|                  |                 |                | LFBGA289                                           | TFBGA289                       | TFBGA320                       |               |                                     |
| Package          | Body size (mm)  |                | 14x14                                              | 9x9                            | 11x11                          | -             |                                     |
|                  | Pitch (mm)      |                | 0.8                                                | 0.5                            | 0.5                            |               |                                     |
|                  | Ball size (mm)  |                | 0.40                                               | 0.30                           | 0.30                           |               |                                     |
|                  | Thickness (mm)  |                | < 1.4                                              | < 1.2                          | < 1.2                          |               |                                     |
|                  | Ball count      |                | 289                                                | 289                            | 320                            |               |                                     |
| CPU              |                 |                | Cortex-A7 FPU Neon TrustZone                       |                                |                                | -             |                                     |
|                  |                 |                | Caches size                                        |                                |                                |               | 32-Kbyte L1 data cache              |
|                  |                 |                |                                                    |                                |                                |               | 32-Kbyte L1 instruction cache       |
|                  |                 |                |                                                    |                                |                                |               | 128-Kbyte L2 unified coherent cache |
| Frequency        |                 |                | STM32MP133C: 650 MHz<br>STM32MP133F: 1 GHz         |                                |                                | 168 Kbytes    |                                     |
| ROM              |                 |                | 128 Kbytes (secure)                                |                                |                                |               | -                                   |
| Embedded SRAM    | System RAM      |                | 128 Kbytes (securable)                             |                                |                                |               |                                     |
|                  | Backup          |                | 8 Kbytes (securable, tamper protected)             |                                |                                |               |                                     |
|                  | AHB SRAM        |                | 32 Kbytes                                          |                                |                                |               |                                     |
| SDRAM            |                 |                | Securable and on-the-fly data encryption           |                                |                                | -             |                                     |
|                  | LPDDR2/3        | 16-bit 533 MHz | Up to 1 Gbyte, single rank                         |                                |                                |               |                                     |
|                  | DDR3/3L         | 16-bit 533 MHz |                                                    |                                |                                |               |                                     |
| Backup registers |                 |                | 128 bytes (32x32-bit, securable, tamper protected) |                                |                                | -             |                                     |
| Timers           | Advanced        | 16 bits        | 2                                                  |                                |                                | 24 timers     |                                     |
|                  | General purpose | 16 bits        | 8 (6 securable)                                    |                                |                                |               |                                     |
|                  |                 | 32 bits        | 2                                                  |                                |                                |               |                                     |
|                  | Basic           | 16 bits        | 2                                                  |                                |                                |               |                                     |
|                  | Low power       | 16 bits        | 5 (2 securable)                                    |                                |                                |               |                                     |
|                  | A7 timers       | 64 bits        | 4 (secure, non-secure, virtual, hypervisor)        |                                |                                |               |                                     |
|                  | RTC/AWU         |                | 1 (securable)                                      |                                |                                |               |                                     |

Table 1. STM32MP133C/F features and peripheral counts (continued)

| Features                      |                                                      |                                                          | STM32MP133CAE<br>STM32MP133FAE                                                                                              | STM32MP133CAG<br>STM32MP133FAG | STM32MP133CAF<br>STM32MP133FAF | Miscellaneous |
|-------------------------------|------------------------------------------------------|----------------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------|--------------------------------|--------------------------------|---------------|
|                               |                                                      |                                                          | LFBGA289                                                                                                                    | TFBGA289                       | TFBGA320                       |               |
| Watchdogs                     |                                                      |                                                          | 2 (independent, independent secure)                                                                                         |                                |                                | -             |
| Communication peripherals     | SPI                                                  |                                                          | 5 (2 securable)                                                                                                             |                                |                                | -             |
|                               |                                                      | Having I2S                                               | 4                                                                                                                           |                                |                                |               |
|                               | I2C (with SMB/PMB support)                           |                                                          | 5 (3 securable)                                                                                                             |                                |                                |               |
|                               | USART (smartcard, SPI, IrDA, LIN) + UART (IrDA, LIN) |                                                          | 4 + 4 (including 2 securable USART), some can be a boot source                                                              |                                |                                | Boot          |
|                               | SAI                                                  |                                                          | 2 (up to 4 audio channels), with I2S master/slave, PCM input, SPDIF-TX                                                      |                                |                                | -             |
|                               | USB                                                  | EHCI/OHCI Host                                           | 2 ports                                                                                                                     |                                |                                | -             |
|                               |                                                      |                                                          | Embedded HSPHY with BCD                                                                                                     |                                |                                |               |
|                               |                                                      | OTG HS                                                   | Embedded HS PHY with BCD (securable), can be a boot source                                                                  |                                |                                | Boot          |
|                               |                                                      | Embedded PHYs                                            | 2 × HS shared between Host and OTG                                                                                          |                                |                                | -             |
|                               | SPDIFRX                                              |                                                          | 4 inputs                                                                                                                    |                                |                                | -             |
| FDCAN                         |                                                      | 2 (1 × TTCAN), clock calibration, 10 Kbyte shared buffer |                                                                                                                             |                                | -                              |               |
| SDMMC (SD, SDIO, eMMC)        |                                                      |                                                          | 2 (8 + 8 bits) (securable), eMMC or SD can be a boot source<br>2 optional independant power supplies for SD card interfaces |                                |                                | Boot          |
| QUADSPI                       |                                                      |                                                          | 1 (dual-quad) (securable), can be a boot source                                                                             |                                |                                | Boot (1)      |
| FMC                           | Parallel address/data 8/16-bit                       |                                                          | 4 × CS, up to 4 × 64 Mbyte                                                                                                  |                                |                                | -             |
|                               | Parallel AD-mux 8/16-bit                             |                                                          |                                                                                                                             |                                |                                |               |
|                               | NAND 8/16-bit                                        |                                                          | Yes, 2× CS, SLC, BCH4/8, can be a boot source                                                                               |                                |                                | Boot          |
| 10/100M/Gigabit Ethernet      |                                                      |                                                          | 2 x (MII, RMI, RGMII) with PTP and EEE (securable)                                                                          |                                |                                | -             |
| DMA                           |                                                      |                                                          | 3 instances (1 secure), 33-channel MDMA                                                                                     |                                |                                | -             |
| Cryptography                  |                                                      |                                                          | PKA (with DPA protection), DES, TDES, AES (with DPA protection) (all securable)                                             |                                |                                | -             |
| Hash                          |                                                      |                                                          | SHA-1, SHA-224, SHA-256, SHA-384, SHA-512, SHA-3, HMAC (securable)                                                          |                                |                                | -             |
| True random number generator  |                                                      |                                                          | True-RNG (securable)                                                                                                        |                                |                                | -             |
| Fuses (one-time programmable) |                                                      |                                                          | 3072 effective bits (secure, 1280 bits available for the user)                                                              |                                |                                | -             |



Table 1. STM32MP133C/F features and peripheral counts (continued)

| Features                                    | STM32MP133CAE<br>STM32MP133FAE                                                                                                                                                                         | STM32MP133CAG<br>STM32MP133FAG | STM32MP133CAF<br>STM32MP133FAF | Miscellaneous |
|---------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------------------|--------------------------------|---------------|
|                                             | LFBGA289                                                                                                                                                                                               | TFBGA289                       | TFBGA320                       |               |
| GPIOs with interrupt (total count)          | 135 <sup>(2)</sup>                                                                                                                                                                                     |                                |                                | -             |
| Securable GPIOs                             | All                                                                                                                                                                                                    |                                |                                |               |
| Wakeup pins                                 | 6                                                                                                                                                                                                      |                                |                                |               |
| Tamper pins (active tamper)                 | 12 (5)                                                                                                                                                                                                 |                                |                                |               |
| DFSDM                                       | 4 input channels with 2 filters                                                                                                                                                                        |                                |                                | -             |
| Up to 12-bit synchronized ADC               | 2 <sup>(3)</sup> (up to 5 Msps on 12-bit each) (securable)                                                                                                                                             |                                |                                | -             |
| 12-bit ADC channels in total <sup>(4)</sup> | ADC1: 19 channels including 1x internal, 18 channels available for user including 8x differential<br>ADC2: 18 channels including 6x internal, 12 channels available for user including 6x differential |                                |                                |               |
| Internal ADC VREF                           | 1.65 V, 1.8 V, 2.048 V, 2.5 V or VREF+ input                                                                                                                                                           |                                |                                | -             |
| VREF+ input pin                             | Yes                                                                                                                                                                                                    |                                |                                |               |

- QUADSPI may boot either from dedicated GPIOs or using some FMC Nand8 boot GPIOs (PD4, PD1, PD5, PE9, PD11, PD15 (see [Table 7: STM32MP133C/F ball definitions](#)).
- This total GPIO count includes four JTAG GPIOs and three BOOT GPIOs with limited usage (may conflict with external device connection during boundary scan or boot).
- When both ADCs are used, the kernel clock should be the same for both ADCs and the embedded ADC prescalers cannot be used.
- In addition, there are also internal channels:
  - ADC1 internal channel:  $V_{REFINT}$
  - ADC2 internal channels: temperature, internal voltage reference,  $V_{DDCORE}$ ,  $V_{DDCPU}$ ,  $V_{DDQ\_DDR}$ ,  $V_{BAT} / 4$ .

**Figure 1. STM32MP133C/F block diagram**



## 3 Functional overview

### 3.1 Arm Cortex-A7 subsystem

#### 3.1.1 Features

- ARMv7-A architecture
- 32-Kbyte L1 instruction cache
- 32-Kbyte L1 data cache
- 128-Kbyte level2 cache
- Arm + Thumb®-2 instruction set
- Arm TrustZone security technology
- Arm NEON advanced SIMD
- DSP and SIMD extensions
- VFPv4 floating-point
- Hardware virtualization support
- Embedded trace module (ETM)
- Integrated generic interrupt controller (GIC) with 160 shared peripheral interrupts
- Integrated generic timer (CNT)

#### 3.1.2 Overview

The Cortex-A7 processor is a very energy-efficient applications processor designed to provide rich performance in high-end wearables, and other low-power embedded and consumer applications. It provides up to 20 % more single thread performance than the Cortex-A5 and provides similar performance than the Cortex-A9.

The Cortex-A7 incorporates all features of the high-performance Cortex-A15 and Cortex-A17 processors, including virtualization support in hardware, NEON, and 128-bit AMBA 4 AXI bus interface.

The Cortex-A7 processor builds on the energy-efficient 8-stage pipeline of the Cortex-A5 processor. It also benefits from an integrated L2 cache designed for low-power, with lower transaction latencies and improved OS support for cache maintenance. On top of this, there is improved branch prediction and improved memory system performance, with 64-bit load-store path, 128-bit AMBA 4 AXI buses and increased TLB size (256 entry, up from 128 entry for Cortex-A9 and Cortex-A5), increasing performance for large workloads such as web browsing.

#### Thumb-2 technology

Delivers the peak performance of traditional Arm code while also providing up to a 30 % reduction in memory requirement for instructions storage.

#### TrustZone technology

Ensures reliable implementation of security applications ranging from digital rights management to electronic payment. Broad support from technology and industry partners.

## NEON

NEON technology can accelerate multimedia and signal processing algorithms such as video encode/decode, 2D/3D graphics, gaming, audio and speech processing, image processing, telephony, and sound synthesis. The Cortex-A7 provides an engine that offers both the performance and functionality of the Cortex-A7 floating-point unit (FPU) and an implementation of the NEON advanced SIMD instruction set for further acceleration of media and signal processing functions. The NEON extends the Cortex-A7 processor FPU to provide a quad-MAC and additional 64-bit and 128-bit register set supporting a rich set of SIMD operations over 8-, 16- and 32-bit integer and 32-bit floating-point data quantities.

## Hardware virtualization

Highly efficient hardware support for data management and arbitration, whereby multiple software environments and their applications are able to simultaneously access the system capabilities. This enables the realization of devices that are robust, with virtual environments that are well isolated from each other.

## Optimized L1 caches

Performance and power optimized L1 caches combine minimal access latency techniques to maximize performance and minimize power consumption.

## Integrated L2 cache controller

Provides low-latency and high-bandwidth access to cached memory in high-frequency, or to reduce the power consumption associated with off-chip memory access.

## Cortex-A7 floating-point unit (FPU)

The FPU provides high-performance single and double precision floating-point instructions compatible with the Arm VFPv4 architecture that is software compatible with previous generations of Arm floating-point coprocessor.

## Snoop control unit (SCU)

The SCU is responsible for managing the interconnect, arbitration, communication, cache to cache and system memory transfers, cache coherence and other capabilities for the processor.

This system coherence also reduces software complexity involved in maintaining software coherence within each OS driver.

## Generic interrupt controller (GIC)

Implementing the standardized and architected interrupt controller, the GIC provides a rich and flexible approach to inter-processor communication and the routing and prioritization of system interrupts.

Supporting up to 192 independent interrupts, under software control, hardware prioritized, and routed between the operating system and TrustZone software management layer.

This routing flexibility and the support for virtualization of interrupts into the operating system, provides one of the key features required to enhance the capabilities of a solution utilizing a hypervisor.

## 3.2 Memories

### 3.2.1 External SDRAM

The STM32MP133C/F devices embed a controller for external SDRAM that supports the following:

- LPDDR2 or LPDDR3, 16-bit data, up to 1 Gbyte, up to 533 MHz clock
- DDR3 or DDR3L, 16-bit data, up to 1 Gbyte, up to 533 MHz clock

### 3.2.2 Embedded SRAM

All devices feature:

- SYSRAM: 128 Kbytes (with programmable size secure zone)
- AHB SRAM: 32 Kbytes (securable)
- BKPSRAM (backup SRAM): 8 Kbytes

The content of this area is protected against possible unwanted write accesses, and can be retained in Standby or  $V_{BAT}$  mode.

BKPSRAM can be defined (in ETZPC) as accessible by secure software only.

## 3.3 DDR3/DDR3L/LPDDR2/LPDDR3 controller (DDRCTRL)

DDRCTRL combined with DDRPHYC provides a complete memory interface solution for DDR memory subsystem.

- One 64-bit AMBA 4 AXI ports interface (XPI)
- AXI clock asynchronous to the controller
- DDR memory cypher engine (DDRMCE) featuring AES-128 DDR on-the-fly write encryption/read decryption.
- Supported standards:
  - JEDEC DDR3 SDRAM specification, JESD79-3E for DDR3/3L with 16-bit interface
  - JEDEC LPDDR2 SDRAM specification, JESD209-2E for LPDDR2 with 16-bit interface
  - JEDEC LPDDR3 SDRAM specification, JESD209-3B for LPDDR3 with 16-bit interface
- Advanced scheduler and SDRAM command generator
- Programmable full data width (16-bit) or half data width (8-bit)
- Advanced QoS support with three traffic class on read and two traffic classes on write
- Options to avoid starvation of lower priority traffic
- Guaranteed coherency for write-after-read (WAR) and read-after-write (RAW) on AXI ports
- Programmable support for burst length options (4, 8, 16)
- Write combine to allow multiple writes to the same address to be combined into a single write
- Single rank configuration

- Support of automatic SDRAM power-down entry and exit caused by lack of transaction arrival for programmable time
- Support of automatic clock stop (LPDDR2/3) entry and exit caused by lack of transaction arrival
- Support of automatic low-power mode operation caused by lack of transaction arrival for programmable time via hardware low-power interface
- Programmable paging policy
- Support of automatic or under software control self-refresh entry and exit
- Support of deep power-down entry and exit under software control (LPDDR2 and LPDDR3)
- Support of explicit SDRAM mode register updates under software control
- Flexible address mapper logic to allow application specific mapping of row, column, bank bits
- User-selectable refresh control options
- DDRPERFM associated block to help for performance monitoring and tuning

DDRCTRL and DDRPHYC can be defined (in ETZPC) as accessible by secure software only.

The DDRMCE (DDR memory cypher engine) main features are listed below:

- AXI system bus master/slave interfaces (64-bit)
- In-line encryption (for writes) and decryption (for reads), based on embedded firewall programming
- Two encryption mode per region (maximum one region): no encryption (bypass mode), block cipher mode
- Start and end of regions defined with 64-Kbyte granularity
- Default filtering (region 0): any access granted
- Region access filtering: none
  - Supported block cipher: AES
  - Supported chaining mode
- Block mode with AES cipher is compatible with ECB mode specified in NIST FIPS publication 197 advanced encryption standard (AES), with an associated key derivation function based on Keccak-400 algorithm published on <https://keccak.team> website.
- Minimal read/write 16-byte access granularity
- One set of write-only and lockable master key registers
- AHB configuration port, privileged aware

### 3.4 TrustZone address space controller for DDR (TZC)

TZC is used to filter read/write accesses to DDR controller according to TrustZone rights and according to non-secure master (NSAID) on up to nine programmable regions:

- Configuration supported by trusted software only
- One filter unit
- Nine regions:
  - Region 0 is always enabled and covers the whole address range.
  - Regions 1 to 8 have programmable base-/end-address and can be assigned to any one or both filters.
- Secure and non-secure access permissions programmed per region
- Non-secure accesses filtered according to NSAID
- Regions controlled by same filter must not overlap
- Fail modes with error and/or interrupt
- Acceptance capability = 256
- Gate keeper logic to enable and disable of each filter
- Speculative accesses

### 3.5 Boot modes

At startup, the boot source used by the internal boot ROM is selected by the BOOT pin and OTP bytes.

**Table 2. Boot modes**

| BOOT2 | BOOT1 | BOOT0 | Initial boot mode                       | Comments                                                                                                                                  |
|-------|-------|-------|-----------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------|
| 0     | 0     | 0     | UART and USB <sup>(1)</sup>             | Wait incoming connection on:<br>– USART3/6 and UART4/5/7/8 on default pins<br>– USB high-speed device on OTG_HS_DP/DM pins <sup>(2)</sup> |
| 0     | 0     | 1     | Serial NOR flash <sup>(3)</sup>         | Serial NOR flash on QUADSPI <sup>(5)</sup>                                                                                                |
| 0     | 1     | 0     | eMMC <sup>(3)</sup>                     | eMMC on SDMMC2 (default) <sup>(5)(6)</sup>                                                                                                |
| 0     | 1     | 1     | NAND flash <sup>(3)</sup>               | SLC NAND flash on FMC                                                                                                                     |
| 1     | 0     | 0     | Development boot (no flash memory boot) | Used to get debug access without boot from flash memory <sup>(4)</sup>                                                                    |
| 1     | 0     | 1     | SD card <sup>(3)</sup>                  | SD card on SDMMC1 (default) <sup>(5)(6)</sup>                                                                                             |
| 1     | 1     | 0     | UART and USB <sup>(1)(3)</sup>          | Wait incoming connection on:<br>– USART3/6 and UART4/5/7/8 on default pins<br>– USB high-speed device on OTG_HS_DP/DM pins <sup>(2)</sup> |
| 1     | 1     | 1     | Serial NAND flash <sup>(3)</sup>        | Serial NAND flash on QUADSPI <sup>(5)</sup>                                                                                               |

1. Can be disabled by OTP settings.
2. USB requires HSE clock/crystal (see AN5474 for supported frequencies with and without OTP settings).
3. Boot source can be changed by OTP settings (for example initial boot on SD card, then eMMC with OTP settings).
4. Cortex®-A7 core in infinite loop toggling PA13.
5. Default pins can be altered by OTP.
6. Alternatively, another SDMMC interface than this default can be selected by OTP.

Although low level boot is done using internal clocks, ST supplied software packages as well as major external interfaces such as DDR, USB (but not limited to) require a crystal or an external oscillator to be connected on HSE pins.

See RM0475 “STM32MP13xx advanced Arm®-based 32-bit MPUs” or AN5474 “Getting started with STM32MP13xx lines hardware development” for constraints and recommendations regarding HSE pins connection and supported frequencies.



## 3.6 Power supply management

### 3.6.1 Power supply scheme

- $V_{DD}$  is the main supply for I/Os and internal part kept powered during Standby mode. Useful voltage range is 1.71 V to 3.6 V (1.8 V, 2.5 V, 3.0 V or 3.3 V typ.)
  - $V_{DD\_PLL}$  and  $V_{DD\_ANA}$  must be star-connected to  $V_{DD}$ .
- $V_{DDCPU}$  is the Cortex-A7 CPU dedicated voltage supply, whose value depends on the desired CPU frequency. 1.22 V to 1.38 V in run mode.  $V_{DD}$  must be present before  $V_{DDCPU}$ .
- $V_{DDCORE}$  is the main digital voltage and is usually shutdown during Standby mode. Voltage range is 1.22 V to 1.38 V in run mode.  $V_{DD}$  must be present before  $V_{DDCORE}$ .
- The VBAT pin can be connected to the external battery (1.6 V <  $V_{BAT}$  < 3.6 V). If no external battery is used, this pin must be connected to  $V_{DD}$ .
- $V_{DDA}$  is the analog (ADC/VREF), supply voltage (1.62 V to 3.6 V). Using the internal  $V_{REF+}$  requires  $V_{DDA}$  equal to or higher than  $V_{REF+} + 0.3$  V.
- The  $V_{DDA1V8\_REG}$  pin is the output of the internal regulator, connected internally to USB PHY and USB PLL. The internal  $V_{DDA1V8\_REG}$  regulator is enabled by default and can be controlled by software. It is always shut down during Standby mode.  
The specific  $BYPASS\_REG1V8$  pin must never be left floating. It must be connected either to  $V_{SS}$  or to  $V_{DD}$  to activate or deactivate the voltage regulator. When  $V_{DD} = 1.8$  V,  $BYPASS\_REG1V8$  should be set.
- $V_{DDA1V1\_REG}$  pin is the output of the internal regulator, connected internally to USB PHY. The internal  $V_{DDA1V1\_REG}$  regulator is enabled by default and can be controlled by software. It is always shut down during Standby mode.
- $V_{DD3V3\_USBHS}$  is the USB high-speed supply. Voltage range is 3.07 V to 3.6 V.

**Caution:**  $V_{DD3V3\_USBHS}$  must not be present unless  $V_{DDA1V8\_REG}$  is present, otherwise permanent damage may occur on the STM32MP133C/F. This must be ensured by PMIC ranking order or with external component in case of discrete component power supply implementation.

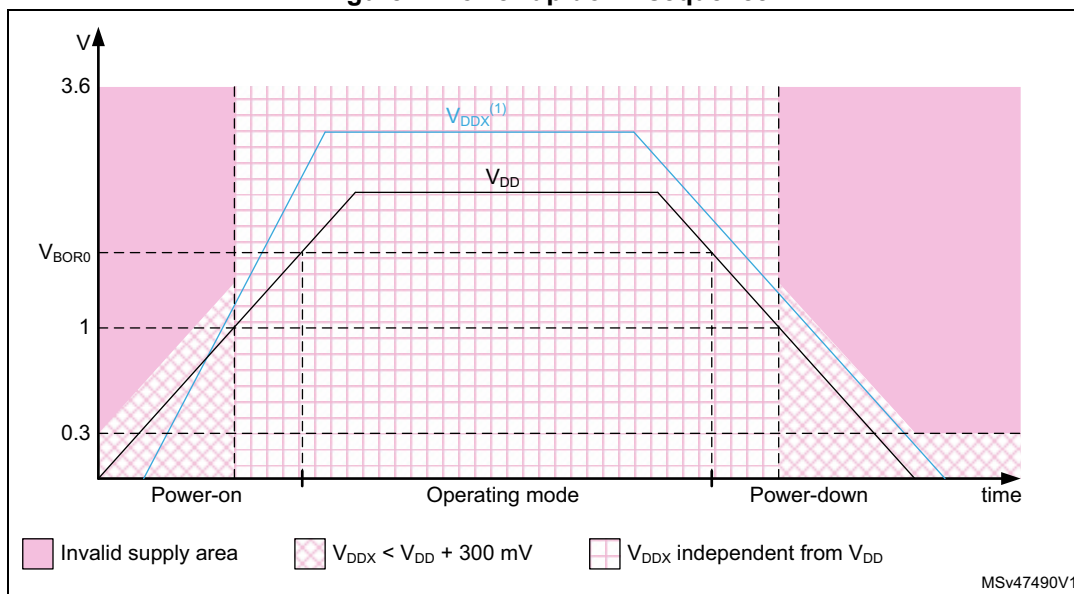
- $V_{DDSD1}$  and  $V_{DDSD2}$  are respectively SDMMC1 and SDMMC2 SD card power supplies to support ultra-high-speed mode.
- $V_{DDQ\_DDR}$  is the DDR IO supply.
  - 1.425 V to 1.575 V for interfacing DDR3 memories (1.5 V typ.)
  - 1.283 V to 1.45 V for interfacing DDR3L memories (1.35 V typ.)
  - 1.14 V to 1.3 V for interfacing LPDDR2 or LPDDR3 memories (1.2 V typ.)

During power-up and power-down phases, the following power sequence requirements must be respected:

- When  $V_{DD}$  is below 1 V, other power supplies ( $V_{DDCORE}$ ,  $V_{DDCPU}$ ,  $V_{DDSD1}$ ,  $V_{DDSD2}$ ,  $V_{DDA}$ ,  $V_{DDA1V8\_REG}$ ,  $V_{DDA1V1\_REG}$ ,  $V_{DD3V3\_USBHS}$ ,  $V_{DDQ\_DDR}$ ) must remain below  $V_{DD} + 300$  mV.
- When  $V_{DD}$  is above 1 V, all power supplies are independent.

During the power-down phase,  $V_{DD}$  can temporarily become lower than other supplies only if the energy provided to the STM32MP133C/F remains below 1 mJ. This allows external decoupling capacitors to be discharged with different time constants during the power-down transient phase.

Figure 2. Power-up/down sequence



1.  $V_{DDX}$  refers to any power supply among  $V_{DDCORE}$ ,  $V_{DDCPU}$ ,  $V_{DDSD1}$ ,  $V_{DDSD2}$ ,  $V_{DDA}$ ,  $V_{DDA1V8\_REG}$ ,  $V_{DDA1V1\_REG}$ ,  $V_{DD3V3\_USBHS}$ ,  $V_{DDQ\_DDR}$ .

### 3.6.2 Power supply supervisor

The devices have an integrated power-on reset (POR)/ power-down reset (PDR) circuitry coupled with a Brownout reset (BOR) circuitry:

- **Power-on reset (POR)**  
The POR supervisor monitors  $V_{DD}$  power supply and compares it to a fixed threshold. The devices remain in reset mode when  $V_{DD}$  is below this threshold,
- **Power-down reset (PDR)**  
The PDR supervisor monitors  $V_{DD}$  power supply. A reset is generated when  $V_{DD}$  drops below a fixed threshold.  
The PDR supervisor can be enabled/disabled through PDR\_ON pin. PDR\_ON must be connected to either  $V_{DD}$  or  $V_{SS}$  and never be left floating.
- **Brownout reset (BOR)**  
The BOR supervisor monitors  $V_{DD}$  power supply. Three BOR thresholds (from 2.1 to 2.7 V) can be configured through option bytes. A reset is generated when  $V_{DD}$  drops below this threshold.
- **Power-on reset  $V_{DDCORE}$  (POR\_VDDCORE)**  
The POR\_VDDCORE supervisor monitors  $V_{DDCORE}$  power supply and compares it to a fixed threshold. The  $V_{DDCORE}$  domain remains in reset mode when  $V_{DDCORE}$  is below this threshold.

- Power-down reset  $V_{DDCORE}$  (PDR\_VDDCORE)  
The PDR\_VDDCORE supervisor monitors  $V_{DDCORE}$  power supply. A  $V_{DDCORE}$  domain reset is generated when  $V_{DDCORE}$  drops below a fixed threshold.  
The PDR\_VDDCORE supervisor can be enabled/disabled through PDR\_ON pin. PDR\_ON must be connected to either  $V_{DD}$  or  $V_{SS}$  and never be left floating.
- Power-on-reset  $V_{DDCPU}$  (POR\_VDDCPU)  
The POR\_VDDCPU supervisor monitors  $V_{DDCPU}$  power supply and compares it to a fixed threshold. The  $V_{DDCPU}$  domain remains in reset mode when  $V_{DDCORE}$  is below this threshold.

### 3.7 Low-power strategy

There are several ways to reduce power consumption on STM32MP133C/F:

- Decrease dynamic power consumption by slowing down the CPU clocks and/or the bus matrix clocks and/or controlling individual peripheral clocks.
- Save power consumption when the CPU is IDLE, by selecting among the available low-power modes according to the user application needs. This allows the best compromise between short startup time, low-power consumption, as well as available wakeup sources, to be achieved.
- Use the DVFS (dynamic voltage and frequency scaling) operating points that directly controls the CPU clock frequency as well as the  $V_{DDCPU}$  output supply.

The operating modes allow the control of the clock distribution to the different system parts and the power of the system. The system operation mode is driven by the MPU sub-system.

The MPU sub-system low-power modes are listed below:

- CSleep: The CPU clocks are stopped and the peripheral(s) clock operates as previously set in the RCC (reset and clock controller).
- CStop: The CPU peripheral(s) clocks are stopped.
- CStandby:  $V_{DDCPU}$  OFF

CSleep and CStop low-power modes are entered by the CPU when executing the WFI (wait for interrupt) or WFE (wait for event) instructions.

The system operating modes available are the followings:

- Run (system at its full performance,  $V_{DDCORE}$ ,  $V_{DDCPU}$  and clocks ON)
- Stop (clocks OFF)
- LP-Stop (clocks OFF)
- LPLV-Stop (clocks OFF,  $V_{DDCORE}$  and  $V_{DDCPU}$  supply level may be lowered)
- LPLV-Stop2 ( $V_{DDCPU}$  OFF,  $V_{DDCORE}$  lowered, and clocks OFF)
- Standby ( $V_{DDCPU}$ ,  $V_{DDCORE}$ , and clocks OFF)

**Table 3. System versus CPU power mode**

| System power mode                                              | CPU               |
|----------------------------------------------------------------|-------------------|
| Run mode                                                       | CRun or CSleep    |
| Stop mode<br>LP-Stop mode<br>LPLV-Stop mode<br>LPLV-Stop2 mode | CStop or CStandby |
| Standby mode                                                   | CStandby          |

## 3.8 Reset and clock controller (RCC)

The clock and reset controller manages the generation of all the clocks, as well as the clock gating, and the control of the system and peripheral resets. RCC provides a high flexibility in the choice of clock sources and allows application of clock ratios to improve the power consumption. In addition, on some communication peripherals that are capable to work with two different clock domains (either a bus interface clock or a kernel peripheral clock), the system frequency can be changed without modifying the baudrate.

### 3.8.1 Clock management

The devices embed four internal oscillators, two oscillators with external crystal or resonator, three internal oscillators with fast startup time and four PLLs.

The RCC receives the following clock source inputs:

- Internal oscillators:
  - 64 MHz HSI clock (1 % accuracy)
  - 4 MHz CSI clock
  - 32 kHz LSI clock
- External oscillators:
  - 8-48 MHz HSE clock
  - 32.768 kHz LSE clock

The RCC provides four PLLs:

- PLL1 dedicated to the CPU clocking
- PLL2 providing:
  - clocks for the AXI-SS (including APB4, APB5, AHB5 and AHB6 bridges)
  - clocks for the DDR interface
- PLL3 providing:
  - clocks for the multi-Layer AHB and peripheral bus matrix (including the APB1, APB2, APB3, APB6, AHB1, AHB2, and AHB4)
  - kernel clocks for peripherals
- PLL4 dedicated to the generation of the kernel clocks for various peripherals

The system starts on the HSI clock. The user application can then select the clock configuration.

### 3.8.2 System reset sources

The power-on reset initializes all registers except for the debug, a part of the RCC, a part of the RTC and power controller status registers, as well as the Backup power domain.

An application reset is generated from one of the following sources:

- a reset from NRST pad
- a reset from POR and PDR signal (generally called power-on reset)
- a reset from BOR (generally called brownout)
- a reset from the independent watchdog 1
- a reset from the independent watchdog 2
- a software system reset from the Cortex-A7 (CPU)
- a failure on HSE, when the clock security system feature is activated

A system reset is generated from one of the following sources:

- an application reset
- a reset from POR\_VDDCORE signal
- an exit from Standby mode to Run mode

A MPU processor reset is generated from one of the following sources:

- a system reset
- every time the MPU exits CStandby
- a software MPU reset from the Cortex-A7 (CPU)

## 3.9 General-purpose input/outputs (GPIOs)

Each of the GPIO pins can be configured by software as output (push-pull or open-drain, with or without pull-up or pull-down), as input (with or without pull-up or pull-down) or as peripheral alternate function. Most of the GPIO pins are shared with digital or analog alternate functions. All GPIOs are high-current-capable and have speed selection to better manage internal noise, power consumption and electromagnetic emission.

After reset, all GPIOs are in analog mode to reduce power consumption.

The I/O configuration can be locked if needed by following a specific sequence in order to avoid spurious writing to the I/Os registers.

All GPIO pins can be individually set as secure, which means that software accesses to these GPIOs and associated peripherals defined as secure are restricted to secure software running on the CPU.

## 3.10 TrustZone protection controller (ETZPC)

ETZPC is used to configure TrustZone security of bus masters and slaves with programmable-security attributes (securable resources). For instance:

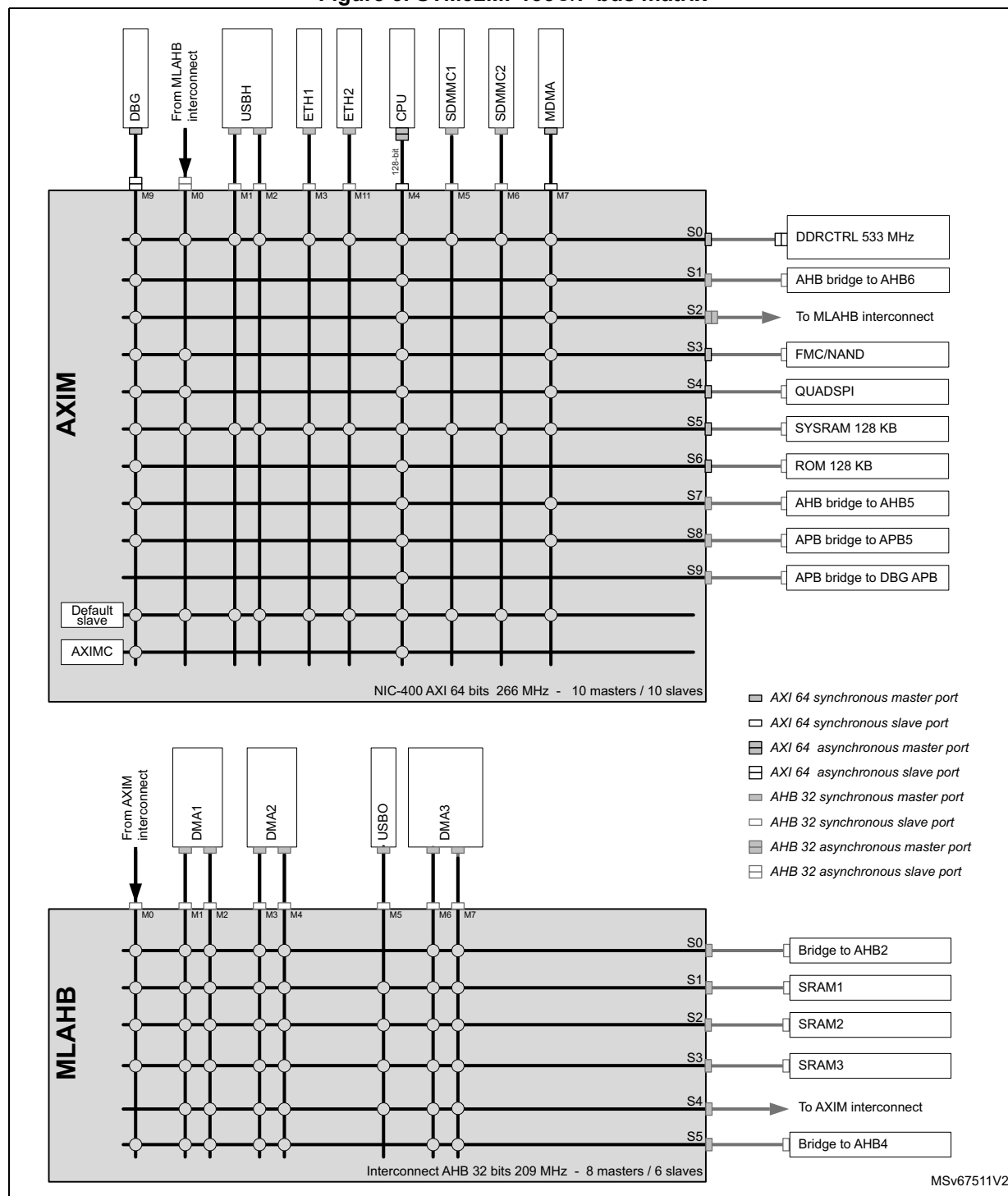
- On-chip SYSRAM secure region size can be programmed.
- AHB and APB peripherals can be made secure or non-secure.
- AHB SRAM can be made secure or non-secure.

*Note: By default, SYSRAM, AHB SRAMs and securable peripherals are set to secure access only, so, not accessible by non-secure masters such as DMA1/DMA2.*

### 3.11 Bus-interconnect matrix

The devices feature an AXI bus matrix, one main AHB bus matrix and bus bridges that allow bus masters to be interconnected with bus slaves (see the figure below, the dots represent the enabled master/slave connections).

Figure 3. STM32MP133C/F bus matrix



### 3.12 DMA controllers

The devices feature the following DMA modules to unload CPU activity:

- a master direct memory access (MDMA)  
The MDMA is a high-speed DMA controller, that is in charge of all types of memory transfers (peripheral-to-memory, memory-to-memory, memory-to-peripheral), without any CPU action. It features a master AXI interface.  
The MDMA is able to interface with the other DMA controllers to extend the standard DMA capabilities, or can manage peripheral DMA requests directly.  
Each of the 32 channels can perform block transfers, repeated block transfers and linked list transfers.  
The MDMA can be set to make secure transfers to secured memories.
- three DMA controllers (not secure DMA1 and DMA2, plus secure DMA3)  
Each controller has a dual-port AHB, for a total of 16 non-secure and eight secure DMA channels to perform FIFO-based block transfers.

Two DMAMUX units multiplex and route the DMA peripheral requests to the three DMA controllers, with high flexibility, maximizing the number of DMA requests that run concurrently, as well as generating DMA requests from peripheral output triggers or DMA events.

DMAMUX1 maps DMA requests from non-secure peripherals to DMA1 and DMA2 channels. DMAMUX2 maps DMA requests from secure peripherals to DMA3 channels.

### 3.13 Extended interrupt and event controller (EXTI)

The extended interrupt and event controller (EXTI) manages the CPU and system wakeup through configurable and direct event inputs. EXTI provides wakeup requests to the power control, and generates an interrupt request to the GIC, and events to the CPU event input.

The EXTI wakeup requests allow the system to be woken up from Stop mode, and the CPU to be woken up from CStop and CStandby modes.

The interrupt request and event request generation can also be used in Run mode.

The EXTI also includes the EXTI I/O port selection.

Each interrupt or event can be set as secure in order to restrict access to secure software only.

### 3.14 Cyclic redundancy check calculation unit (CRC)

The CRC (cyclic redundancy check) calculation unit is used to get a CRC code using a programmable polynomial.

Among other applications, CRC-based techniques are used to verify data transmission or storage integrity. In the scope of the EN/IEC 60335-1 standard, they offer a means of verifying the flash memory integrity. The CRC calculation unit helps computing a signature of the software during runtime, to be compared with a reference signature generated at link-time and stored at a given memory location.



### 3.15 Flexible memory controller (FMC)

The FMC controller main features are the following:

- Interface with static-memory mapped devices including:
  - NOR flash memory
  - Static or pseudo-static random access memory (SRAM, PSRAM)
  - NAND flash memory with 4-bit/8-bit BCH hardware ECC
- 8-,16-bit data bus width
- Independent chip-select control for each memory bank
- Independent configuration for each memory bank
- Write FIFO

The FMC configuration registers can be made secure.

### 3.16 Dual Quad-SPI memory interface (QUADSPI)

The QUADSPI is a specialized communication interface targeting single, dual or quad SPI flash memories. It can operate in any of the three following modes:

- Indirect mode: all the operations are performed using the QUADSPI registers.
- Status-polling mode: the external flash memory status register is periodically read and an interrupt can be generated in case of flag setting.
- Memory-mapped mode: the external flash memory is mapped to the address space and is seen by the system as if it was an internal memory.

Both throughput and capacity can be increased two-fold using dual-flash mode, where two Quad-SPI flash memories are accessed simultaneously.

QUADSPI is coupled with a delay block (DLYBQS) allowing the support of external data frequency above 100 MHz.

The QUADSPI configuration registers can be secure, as well as its delay block.

### 3.17 Analog-to-digital converters (ADC1, ADC2)

The devices embed two analog-to-digital converters, whose resolution can be configured to 12-, 10-, 8- or 6-bit. Each ADC shares up to 18 external channels, performing conversions in the single-shot or scan mode. In scan mode, the automatic conversion is performed on a selected group of analog inputs.

Both ADCs have securable bus interfaces.

Each ADC can be served by a DMA controller, thus allowing the automatic transfer of ADC converted values to a destination location without any software action.

In addition, an analog watchdog feature can accurately monitor the converted voltage of one, some or all selected channels. An interrupt is generated when the converted voltage is outside the programmed thresholds.

In order to synchronize A/D conversion and timers, the ADCs can be triggered by any of TIM1, TIM2, TIM3, TIM4, TIM6, TIM8, TIM15, LPTIM1, LPTIM2 and LPTIM3 timers.

### 3.18 Temperature sensor

The devices embed a temperature sensor that generates a voltage ( $V_{TS}$ ) that varies linearly with the temperature. This temperature sensor is internally connected to ADC2\_INP12 and can measure the device ambient temperature ranging from  $-40$  to  $+125$  °C with a precision of  $\pm 2$  %.

The temperature sensor has a good linearity, but it has to be calibrated to obtain a good overall accuracy of the temperature measurement. As the temperature sensor offset varies from chip to chip due to process variation, the uncalibrated internal temperature sensor is suitable for applications that detect temperature changes only. To improve the accuracy of the temperature sensor measurement, each device is individually factory-calibrated by ST. The temperature sensor factory calibration data are stored by ST in the OTP area, that is accessible in read-only mode.

### 3.19 Digital temperature sensor (DTS)

The devices embed a frequency output temperature sensor. DTS counts the frequency based on the LSE or PCLK to provide the temperature information.

Following functions are supported:

- interrupt generation by temperature threshold
- wakeup signal generation by temperature threshold

### 3.20 $V_{BAT}$ operation

The  $V_{BAT}$  power domain contains the RTC, the backup registers and the backup SRAM.

In order to optimize battery duration, this power domain is supplied by  $V_{DD}$  when available or by the voltage applied on VBAT pin (when  $V_{DD}$  supply is not present).  $V_{BAT}$  power is switched when the PDR detects that  $V_{DD}$  has dropped below the PDR level.

The voltage on the VBAT pin can be provided by an external battery, a supercapacitor or directly by  $V_{DD}$ . In the later case, VBAT mode is not functional.

$V_{BAT}$  operation is activated when  $V_{DD}$  is not present.

**Note:** *None of these events (external interrupts, TAMP event, or RTC alarm/events) are able to directly restore the  $V_{DD}$  supply and force the device out of the  $V_{BAT}$  operation. Nevertheless, TAMP events and RTC alarm/events can be used to generate a signal to an external circuitry (typically a PMIC) that can restore the  $V_{DD}$  supply. When the PDR\_ON pin is connected to  $V_{SS}$  (internal reset OFF), the  $V_{BAT}$  functionality is no more available and the VBAT pin must be connected to  $V_{DD}$ .*

### 3.21 Voltage reference buffer (VREFBUF)

The devices embed a voltage reference buffer that can be used as voltage reference for the ADCs, and also as voltage reference for external components through the VREF+ pin.

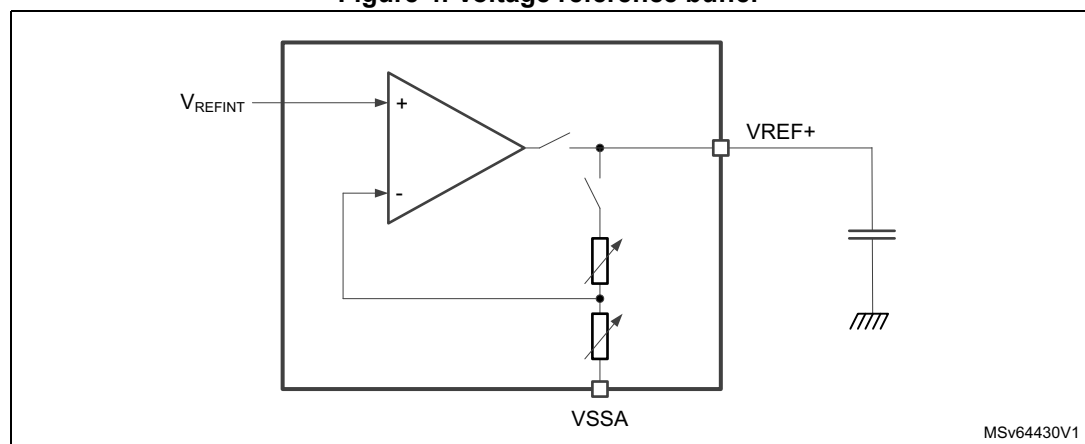
VREFBUF can be secure.

The internal VREFBUF supports four voltages:

- 1.65 V
- 1.8 V
- 2.048 V
- 2.5 V

An external voltage reference can be provided through the VREF+ pin when the internal VREFBUF is off.

**Figure 4. Voltage reference buffer**



### 3.22 Digital filter for sigma-delta modulator (DFSDM)

The devices embed one DFSDM with support for two digital filters modules and four external input serial channels (transceivers) or alternately four internal parallel inputs.

The DFSDM interfaces external  $\Sigma\Delta$  modulators to the device and performs digital filtering of the received data streams.  $\Sigma\Delta$  modulators are used to convert analog signals into digital-serial streams that constitute the inputs of the DFSDM.

The DFSDM can also interface PDM (pulse-density modulation) microphones and perform the PDM to PCM conversion and filtering (hardware accelerated). The DFSDM features optional parallel data stream inputs from the ADCs or from the device memory (through DMA/CPU transfers into DFSDM).

The DFSDM transceivers support several serial-interface formats (to support various  $\Sigma\Delta$  modulators). DFSDM digital filter modules perform digital processing according user-defined filter parameters with up to 24-bit final ADC resolution.

The DFSDM peripheral supports:

- Four multiplexed input digital serial channels:
  - configurable SPI interface to connect various  $\Sigma\Delta$  modulators
  - configurable Manchester coded 1-wire interface
  - PDM (pulse-density modulation) microphone input
  - maximum input clock frequency up to 20 MHz (10 MHz for Manchester coding)
  - clock output for  $\Sigma\Delta$  modulators (0 to 20 MHz)
- Alternative inputs from four internal digital parallel channels (up to 16-bit input resolution):
  - internal sources: ADC data or memory data streams (DMA)
- Two digital filter modules with adjustable digital signal processing:
  - Sinc<sup>x</sup> filter: filter order/type (1 to 5), oversampling ratio (1 to 1024)
  - integrator: oversampling ratio (1 to 256)
- Up to 24-bit output data resolution, signed output data format
- Automatic data offset correction (offset stored in register by user)
- Continuous or single conversion
- Start-of-conversion triggered by:
  - software trigger
  - internal timers
  - external events
  - start-of-conversion synchronously with first digital filter module (DFSDM)
- Analog watchdog featuring:
  - low-value and high-value data threshold registers
  - dedicated configurable Sinc<sup>x</sup> digital filter (order = 1 to 3, oversampling ratio = 1 to 32)
  - input from final output data or from selected input digital serial channels
  - continuous monitoring independently from standard conversion
- Short-circuit detector to detect saturated analog input values (bottom and top range):
  - up to 8-bit counter to detect 1 to 256 consecutive 0's or 1's on serial data stream
  - monitoring continuously each input serial channel
- Break signal generation on analog watchdog event or on short-circuit detector event
- Extremes detector:
  - storage of minimum and maximum values of final conversion data
  - refreshed by software
- DMA capability to read the final conversion data
- Interrupts: end of conversion, overrun, analog watchdog, short circuit, input serial channel clock absence
- “Regular” or “injected” conversions:
  - “regular” conversions can be requested at any time or even in continuous mode without having any impact on the timing of “injected” conversions
  - “injected” conversions for precise timing and with high conversion priority

### 3.23 True random number generator (RNG)

The devices embed one RNG that delivers 32-bit random numbers generated by an integrated analog circuit.

The RNG can be defined (in ETZPC) as accessible by secure software only.

The true RNG connects to the secured AES and PKA peripherals via a dedicated bus (not readable by the CPU).

### 3.24 Cryptographic and hash processors (CRYP, SAES, PKA and HASH)

The devices embed one cryptographic processor that supports the advanced cryptographic algorithms usually required to ensure confidentiality, authentication, data integrity and non-repudiation when exchanging messages with a peer.

The devices also embed a dedicated DPA resistant secure AES 128- and 256-bit key (SAES) and PKA hardware encryption/decryption accelerator, with dedicated hardware bus not accessible by the CPU.

CRYP main features:

- DES/TDES (data encryption standard/triple data encryption standard): ECB (electronic codebook) and CBC (cipher block chaining) chaining algorithms, 64-, 128- or 192-bit key
- AES (advanced encryption standard): ECB, CBC, GCM, CCM, and CTR (counter mode) chaining algorithms, 128-, 192- or 256-bit key

Universal HASH main features:

- SHA-1, SHA-224, SHA-256, SHA-384, SHA-512, SHA-3 (secure HASH algorithms)
- HMAC

The cryptographic accelerator supports DMA request generation.

CRYP, SAES, PKA and HASH can be defined (in ETZPC) as accessible by secure software only.

### 3.25 Boot and security and OTP control (BSEC)

The BSEC (boot and security and OTP control) is intended to control an OTP (one-time programmable) fuse box, used for embedded non-volatile storage for device configuration and security parameters. Some part of BSEC must be configured as accessible by secure software only.

The BSEC can use OTP words for storage of HWKEY 256-bit for SAES (secure AES).

## 3.26 Timers and watchdogs

The devices include two advanced-control timers, ten general-purpose timers (out of which seven are secured), two basic timers, five low-power timers, two watchdogs, and four system timers in each Cortex-A7.

All timer counters can be frozen in debug mode.

The table below compares the features of the advanced-control, general-purpose, basic and low-power timers.

**Table 4. Timer feature comparison**

| Timer type       | Timer                                                                  | Counter resolution | Counter type      | Prescaler factor                | DMA request generation | Capture/compare channels | Complementary output | Max interface clock (MHz) | Max timer clock (MHz) <sup>(1)</sup> |
|------------------|------------------------------------------------------------------------|--------------------|-------------------|---------------------------------|------------------------|--------------------------|----------------------|---------------------------|--------------------------------------|
| Advanced-control | TIM1, TIM8                                                             | 16-bit             | Up, down, up/down | Any integer between 1 and 65536 | Yes                    | 6                        | 4                    | 104.5                     | 209                                  |
| General purpose  | TIM2<br>TIM5                                                           | 32-bit             | Up, down, up/down | Any integer between 1 and 65536 | Yes                    | 4                        | No                   | 104.5                     | 209                                  |
|                  | TIM3<br>TIM4                                                           | 16-bit             | Up, down, up/down | Any integer between 1 and 65536 | Yes                    | 4                        | No                   | 104.5                     | 209                                  |
|                  | TIM12 <sup>(2)</sup>                                                   | 16-bit             | Up                | Any integer between 1 and 65536 | No                     | 2                        | No                   | 104.5                     | 209                                  |
|                  | TIM13 <sup>(2)</sup><br>TIM14 <sup>(2)</sup>                           | 16-bit             | Up                | Any integer between 1 and 65536 | No                     | 1                        | No                   | 104.5                     | 209                                  |
|                  | TIM15 <sup>(2)</sup>                                                   | 16-bit             | Up                | Any integer between 1 and 65536 | Yes                    | 2                        | 1                    | 104.5                     | 209                                  |
|                  | TIM16 <sup>(2)</sup><br>TIM17 <sup>(2)</sup>                           | 16-bit             | Up                | Any integer between 1 and 65536 | Yes                    | 1                        | 1                    | 104.5                     | 209                                  |
| Basic            | TIM6, TIM7                                                             | 16-bit             | Up                | Any integer between 1 and 65536 | Yes                    | 0                        | No                   | 104.5                     | 209                                  |
| Low-power        | LPTIM1, LPTIM2 <sup>(2)</sup> , LPTIM3 <sup>(2)</sup> , LPTIM4, LPTIM5 | 16-bit             | Up                | 1, 2, 4, 8, 16, 32, 64, 128     | No                     | 1 <sup>(3)</sup>         | No                   | 104.5                     | 104.5                                |

1. The maximum timer clock is up to 209 MHz depending on TIMxPRE bit in the RCC.

2. Securable timer.

3. No capture channel on LPTIM.

### 3.26.1 Advanced-control timers (TIM1, TIM8)

The advanced-control timers (TIM1, TIM8) can be seen as three-phase PWM generators multiplexed on 6 channels. They have complementary PWM outputs with programmable inserted dead times. They can also be considered as complete general-purpose timers. Their four independent channels can be used for:

- input capture
- output compare
- PWM generation (edge- or center-aligned modes)
- one-pulse mode output

If configured as standard 16-bit timers, they have the same features as the general-purpose timers. If configured as 16-bit PWM generators, they have full modulation capability (0-100 %).

The advanced-control timer can work together with the general-purpose timers via the timer link feature for synchronization or event chaining.

TIM1 and TIM8 support independent DMA request generation.

### 3.26.2 General-purpose timers (TIM2, TIM3, TIM4, TIM5, TIM12, TIM13, TIM14, TIM15, TIM16, TIM17)

There are ten synchronizable general-purpose timers embedded in the STM32MP133C/F devices (see [Table 4](#) for differences).

- **TIM2, TIM3, TIM4, TIM5**

TIM 2 and TIM5 are based on a 32-bit auto-reload up/down counter and a 16-bit prescaler, while TIM3 and TIM4 are based on a 16-bit auto-reload up/downcounter and a 16-bit prescaler. All timers feature four independent channels for input capture/output compare, PWM or one-pulse mode output. This gives up to 16 input capture/output compare/PWMs on the largest packages.

These general-purpose timers can work together, or with the other general-purpose timers and the advanced-control timers TIM1 and TIM8, via the timer link feature for synchronization or event chaining.

Any of these general-purpose timers can be used to generate PWM outputs.

TIM2, TIM3, TIM4, TIM5 all have independent DMA request generation. They are capable of handling quadrature (incremental) encoder signals and the digital outputs from one to four hall-effect sensors.

- **TIM12, TIM13, TIM14, TIM15, TIM16, TIM17**

These timers are based on a 16-bit auto-reload upcounter and a 16-bit prescaler. TIM13, TIM14, TIM16 and TIM17 feature one independent channel, whereas TIM12 and TIM15 have two independent channels for input capture/output compare, PWM or one-pulse mode output. They can be synchronized with the TIM2, TIM3, TIM4, TIM5 full-featured general-purpose timers or used as simple timebases.

Each of these timers can be defined (in ETZPC) as accessible by secure software only.

### 3.26.3 Basic timers (TIM6 and TIM7)

These timers are mainly used as a generic 16-bit time base.

TIM6 and TIM7 support independent DMA request generation.

### 3.26.4 Low-power timers (LPTIM1, LPTIM2, LPTIM3, LPTIM4, LPTIM5)

Each low-power timer has an independent clock and runs also in Stop mode if it is clocked by LSE, LSI or an external clock. An LPTIMx is able to wake up the device from Stop mode.

These low-power timers support the following features:

- 16-bit up counter with 16-bit autoreload register
- 16-bit compare register
- Configurable output: pulse, PWM
- Continuous/one-shot mode
- Selectable software/hardware input trigger
- Selectable clock source:
  - internal clock source: LSE, LSI, HSI or APB clock
  - external clock source over LPTIM input (working even with no internal clock source running, used by the pulse counter application)
- Programmable digital glitch filter
- Encoder mode

LPTIM2 and LPTIM3 can be defined (in ETZPC) as accessible by secure software only.

### 3.26.5 Independent watchdogs (IWDG1, IWDG2)

An independent watchdog is based on a 12-bit downcounter and a 8-bit prescaler. It is clocked from an independent 32 kHz internal RC (LSI) and, as it operates independently from the main clock, it can operate in Stop and Standby modes. IWDG can be used either as a watchdog to reset the device when a problem occurs, or as a free-running timer for application timeout management. It is hardware- or software-configurable through the option bytes.

IWDG1 can be defined (in ETZPC) as accessible by secure software only.

### 3.26.6 Generic timers (Cortex-A7 CNT)

Cortex-A7 generic timers embedded inside Cortex-A7 are fed by value from system timing generation (STGEN).

The Cortex-A7 processor provides the following timers:

- physical timer for use in secure and non-secure modes  
The registers for the physical timer are banked to provide secure and non-secure copies.
- virtual timer for use in non-secure modes
- physical timer for use in hypervisor mode

Generic timers are not memory mapped peripherals and are then accessible only by specific Cortex-A7 coprocessor instructions (cp15).

## 3.27 System timer generation (STGEN)

The system timing generation (STGEN) generates a time-count value that provides a consistent view of time for all Cortex-A7 generic timers.



The system timing generation has the following key features:

- 64-bit wide to avoid roll-over issues
- Start from zero or a programmable value
- Control APB interface (STGENC) that enables the timer to be saved and restored across powerdown events
- Read-only APB interface (STGENR) that enables the timer value to be read by non-secure software and debug tools
- Timer value incrementing that can be stopped during system debug

STGENC can be defined (in ETZPC) as accessible by secure software only.

### 3.28 Real-time clock (RTC)

The RTC provides an automatic wakeup to manage all low-power modes. RTC is an independent BCD timer/counter and provides a time-of-day clock/calendar with programmable alarm interrupts.

The RTC includes also a periodic programmable wakeup flag with interrupt capability.

Two 32-bit registers contain the seconds, minutes, hours (12- or 24-hour format), day (day of week), date (day of month), month, and year, expressed in binary coded decimal format (BCD). The sub-seconds value is also available in binary format.

Binary mode is supported to ease software driver management.

Compensations for 28-, 29- (leap year), 30-, and 31-day months are performed automatically. Daylight saving time compensation can also be performed.

Additional 32-bit registers contain the programmable alarm subseconds, seconds, minutes, hours, day, and date.

A digital calibration feature is available to compensate for any deviation in crystal oscillator accuracy.

After Backup domain reset, all RTC registers are protected against possible parasitic write accesses and protected by secured access.

As long as the supply voltage remains in the operating range, the RTC never stops, regardless of the device status (Run mode, low-power mode or under reset).

The RTC main features are the following:

- Calendar with subseconds, seconds, minutes, hours (12 or 24 format), day (day of week), date (day of month), month, and year
- Daylight saving compensation programmable by software
- Programmable alarm with interrupt function. The alarm can be triggered by any combination of the calendar fields.
- Automatic wakeup unit generating a periodic flag that triggers an automatic wakeup interrupt
- Reference clock detection: a more precise second source clock (50 or 60 Hz) can be used to enhance the calendar precision.
- Accurate synchronization with an external clock using the sub-second shift feature
- Digital calibration circuit (periodic counter correction): 0.95 ppm accuracy, obtained in a calibration window of several seconds

- Timestamp function for event saving
- Storage of SWKEY in RTC backup registers with direct bus access to SAE (not readable by the CPU)
- Maskable interrupts/events:
  - Alarm A
  - Alarm B
  - Wakeup interrupt
  - Timestamp
- TrustZone support:
  - RTC fully securable
  - Alarm A, alarm B, wakeup timer and timestamp individual secure or non-secure configuration
  - RTC calibration done in secure on non-secure configuration

### 3.29 Tamper and backup registers (TAMP)

32 x 32-bit backup registers are retained in all low-power modes and also in VBAT mode. They can be used to store sensitive data as their content is protected by a tamper detection circuit.

Seven tamper input pins and five tamper output pins are available for anti-tamper detection. The external tamper pins can be configured for edge detection, edge and level, level detection with filtering, or active tamper that increases the security level by auto checking that the tamper pins are not externally opened or shorted.

TAMP main features

- 32 backup registers (TAMP\_BKPxR) implemented in the RTC domain that remains powered-on by  $V_{BAT}$  when the  $V_{DD}$  power is switched off
- 12 tamper pins available (seven inputs and five outputs)
- Any tamper detection can generate a RTC timestamp event.
- Any tamper detection erases the backup registers.
- TrustZone support:
  - Tamper secure or non-secure configuration
  - Backup registers configuration in three configurable-size areas:
    - . one read/write secure area
    - . one write secure/read non-secure area
    - . one read/write non-secure area
- Monotonic counter

### 3.30 Inter-integrated circuit interfaces (I2C1, I2C2, I2C3, I2C4, I2C5)

The devices embed five I<sup>2</sup>C interfaces.

The I<sup>2</sup>C bus interface handles communications between the STM32MP133C/F and the serial I<sup>2</sup>C bus. It controls all I<sup>2</sup>C bus-specific sequencing, protocol, arbitration and timing.

The I2C peripheral supports:

- I<sup>2</sup>C-bus specification and user manual rev. 5 compatibility:
  - Slave and master modes, multimaster capability
  - Standard-mode (Sm), with a bitrate up to 100 kbit/s
  - Fast-mode (Fm), with a bitrate up to 400 kbit/s
  - Fast-mode Plus (Fm+), with a bitrate up to 1 Mbit/s and 20 mA output drive I/Os
  - 7-bit and 10-bit addressing mode, multiple 7-bit slave addresses
  - Programmable setup and hold times
  - Optional clock stretching
- System management bus (SMBus) specification rev 2.0 compatibility:
  - Hardware PEC (packet error checking) generation and verification with ACK control
  - Address resolution protocol (ARP) support
  - SMBus alert
- Power system management protocol (PMBus™) specification rev 1.1 compatibility
- Independent clock: a choice of independent clock sources allowing the I<sup>2</sup>C communication speed to be independent from the PCLK reprogramming
- Wakeup from Stop mode on address match
- Programmable analog and digital noise filters
- 1-byte buffer with DMA capability

I2C3, I2C4 and I2C5 can be defined (in ETZPC) as accessible by secure software only.

### 3.31 Universal synchronous asynchronous receiver transmitter (USART1, USART2, USART3, USART6 and UART4, UART5, UART7, UART8)

The devices have four embedded universal synchronous receiver transmitters (USART1, USART2, USART3 and USART6) and four universal asynchronous receiver transmitters (UART4, UART5, UART7 and UART8). Refer to the table below for a summary of USARTx and UARTx features.

These interfaces provide asynchronous communication, IrDA SIR ENDEC support, multiprocessor communication mode, single-wire half-duplex communication mode and have LIN master/slave capability. They provide hardware management of the CTS and RTS signals, and RS485 Driver Enable. They are able to communicate at speeds of up to 10 Mbit/s.

USART1, USART2, USART3 and USART6 also provide Smartcard mode (ISO 7816 compliant) and SPI-like communication capability.

All USART have a clock domain independent from the CPU clock, allowing the USARTx to wake up the STM32MP133C/F from Stop mode using baudrates up to 200 Kbaud. The wakeup events from Stop mode are programmable and can be:

- start bit detection
- any received data frame
- a specific programmed data frame

All USART interfaces can be served by the DMA controller.

**Table 5. USART features**

| USART modes/features <sup>(1)</sup>              | USART1/2/3/6    | UART4/5/7/8 |
|--------------------------------------------------|-----------------|-------------|
| Hardware flow control for modem                  | X               | X           |
| Continuous communication using DMA               | X               | X           |
| Multiprocessor communication                     | X               | X           |
| Synchronous mode (master/slave)                  | X               | -           |
| Smartcard mode                                   | X               | -           |
| Single-wire half-duplex communication            | X               | X           |
| IrDA SIR ENDEC block                             | X               | X           |
| LIN mode                                         | X               | X           |
| Dual clock domain and wakeup from low power mode | X               | X           |
| Receiver timeout interrupt                       | X               | X           |
| Modbus communication                             | X               | X           |
| Auto baud rate detection                         | X               | X           |
| Driver Enable                                    | X               | X           |
| USART data length                                | 7, 8 and 9 bits |             |

1. X = supported.

USART1 and USART2 can be defined (in ETZPC) as accessible by secure software only.

### 3.32 Serial peripheral interfaces (SPI1, SPI2, SPI3, SPI4, SPI5) – inter- integrated sound interfaces (I2S1, I2S2, I2S3, I2S4)

The devices feature up to five SPIs (SPI2S1, SPI2S2, SPI2S3, SPI2S4, and SPI5) that allow communication at up to 50 Mbit/s in master and slave modes, in half-duplex, full-duplex and simplex modes. The 3-bit prescaler gives eight master mode frequencies and the frame is configurable from 4 to 16 bits. All SPI interfaces support NSS pulse mode, TI mode, hardware CRC calculation and multiply of 8-bit embedded Rx and Tx FIFOs with DMA capability.

I2S1, I2S2, I2S3, and I2S4 are multiplexed with SPI1, SPI2, SPI3 and SPI4. They can be operated in master or slave mode, in full-duplex and half-duplex communication modes, and can be configured to operate with a 16- or 32-bit resolution as an input or output channel. Audio sampling frequencies from 8 kHz up to 192 kHz are supported. All I<sup>2</sup>S interfaces support multiply of 8-bit embedded Rx and Tx FIFOs with DMA capability.

SPI4 and SPI5 can be defined (in ETZPC) as accessible by secure software only.

### 3.33 Serial audio interfaces (SAI1, SAI2)

The devices embed two SAIs that allow the design of many stereo or mono audio protocols

such as I<sup>2</sup>S, LSB or MSB-justified, PCM/DSP, TDM or AC'97. An SPDIF output is available when the audio block is configured as a transmitter. To bring this level of flexibility and reconfigurability, each SAI contains two independent audio sub-blocks. Each block has its own clock generator and I/O line controller.

Audio sampling frequencies up to 192 kHz are supported.

In addition, up to eight microphones can be supported thanks to an embedded PDM interface.

The SAI can work in master or slave configuration. The audio sub-blocks can be either receiver or transmitter and can work synchronously or asynchronously (with respect to the other one). The SAI can be connected with other SAIs to work synchronously.

### 3.34 SPDIF receiver interface (SPDIFRX)

The SPDIFRX is designed to receive an S/PDIF flow compliant with IEC-60958 and IEC-61937. These standards support simple stereo streams up to high sample rate, and compressed multi-channel surround sound, such as those defined by Dolby or DTS (up to 5.1).

The SPDIFRX main features are the following:

- Up to four inputs available
- Automatic symbol rate detection
- Maximum symbol rate: 12.288 MHz
- Stereo stream from 32 to 192 kHz supported
- Support of audio IEC-60958 and IEC-61937, consumer applications
- Parity bit management
- Communication using DMA for audio samples
- Communication using DMA for control and user channel information
- Interrupt capabilities

The SPDIFRX receiver provides all the necessary features to detect the symbol rate, and decode the incoming data stream. The user can select the wanted SPDIF input, and when a valid signal is available, the SPDIFRX re-samples the incoming signal, decodes the Manchester stream, and recognizes frames, sub-frames and blocks elements. The SPDIFRX delivers to the CPU decoded data, and associated status flags.

The SPDIFRX also offers a signal named `spdif_frame_sync`, that toggles at the S/PDIF sub-frame rate that is used to compute the exact sample rate for clock drift algorithms.

### 3.35 Secure digital input/output MultiMediaCard interfaces (SDMMC1, SDMMC2)

Two secure digital input/output MultiMediaCard interfaces (SDMMC) provide an interface between the AHB bus and SD memory cards, SDIO cards and MMC devices.

The SDMMC features include the following:

- Full compliance with *MultiMediaCard System Specification Version 4.51*  
Card support for three different databus modes: 1-bit (default), 4-bit and 8-bit
- Full compatibility with previous versions of MultiMediaCards (backward compatibility)
- Full compliance with *SD memory card specifications version 4.1*  
(SDR104 SDMMC\_CLK speed limited to maximum allowed I/O speed, SPI mode and UHS-II mode not supported)
- Full compliance with SDIO card specification version 4.0  
Card support for two different databus modes: 1-bit (default) and 4-bit  
(SDR104 SDMMC\_CLK speed limited to maximum allowed I/O speed, SPI mode and UHS-II mode not supported)
- Data transfer up to 208 Mbyte/s for the 8-bit mode  
(depending maximum allowed I/O speed)
- Data and command output enable signals to control external bidirectional drivers
- Dedicated DMA controller embedded in the SDMMC host interface, allowing high-speed transfers between the interface and the SRAM
- IDMA linked list support
- Dedicated power supplies,  $V_{DDSD1}$  and  $V_{DDSD2}$  for SDMMC1 and SDMMC2 respectively, removing the need for level-shifter insertion on the SD card interface in UHS-I mode

Only some GPIOs for SDMMC1 and SDMMC2 are available on a dedicated  $V_{DDSD1}$  or  $V_{DDSD2}$  supply pin. Those are part of the default boot GPIOs for SDMMC1 and SDMMC2 (SDMMC1: PC[12:8], PD[2], SDMMC2: PB[15,14,4,3], PE3, PG6). They can be identified in the alternate function table by signals with a "\_VSD1" or "\_VSD2" suffix.

Each SDMMC is coupled with a delay block (DLYBSD) allowing support of an external data frequency above 100 MHz.

Both SDMMC interfaces have securable configuration ports.

### 3.36 Controller area network (FDCAN1, FDCAN2)

The controller area network (CAN) subsystem consists of two CAN modules, a shared message RAM memory and a clock calibration unit.

Both CAN modules (FDCAN1 and FDCAN2) are compliant with ISO 11898-1 (CAN protocol specification version 2.0 part A, B) and CAN FD protocol specification version 1.0.

A 10-Kbyte message RAM memory implements filters, receive FIFOs, receive buffers, transmit event FIFOs and transmit buffers (plus triggers for TTCAN). This message RAM is shared between the two FDCAN1 and FDCAN2 modules.

The common clock calibration unit is optional. It can be used to generate a calibrated clock for both FDCAN1 and FDCAN2 from the HSI internal RC oscillator and the PLL, by evaluating CAN messages received by the FDCAN1.

### 3.37 Universal serial bus high-speed host (USBH)

The devices embed one USB high-speed host (up to 480 Mbit/s) with two physical ports. USBH supports both low, full-speed (OHCI) as well as high-speed (EHCI) operations independently on each port. It integrates two transceivers that can be used for either low-speed (1.2 Mbit/s), full-speed (12 Mbit/s) or high-speed operation (480 Mbit/s). The second high-speed transceiver is shared with OTG high-speed.

The USBH is compliant with the USB 2.0 specification. The USBH controllers require dedicated clocks that are generated by a PLL inside the USB high-speed PHY.

### 3.38 USB on-the-go high-speed (OTG)

The devices embed one USB OTG high-speed (up to 480 Mbit/s) device/host/OTG peripheral. OTG supports both full-speed and high-speed operations. The transceiver for high-speed operation (480 Mbit/s) is shared with the USB Host second port.

The USB OTG HS is compliant with the USB 2.0 specification and with the OTG 2.0 specification. It has software-configurable endpoint setting and supports suspend/resume. The USB OTG controllers require a dedicated 48 MHz clock that is generated by a PLL inside RCC or inside the USB high-speed PHY.

The USB OTG HS main features are listed below:

- Combined Rx and Tx FIFO size of 4 Kbyte with dynamic FIFO sizing
- SRP (session request protocol) and HNP (host negotiation protocol) support
- Eight bidirectional endpoints
- 16 host channels with periodic OUT support
- Software configurable to OTG1.3 and OTG2.0 modes of operation
- USB 2.0 LPM (link power management) support
- Battery charging specification revision 1.2 support
- HS OTG PHY support
- Internal USB DMA
- HNP/SNP/IP inside (no need for any external resistor)
- For OTG/Host modes, a power switch is needed in case bus-powered devices are connected.

The USB OTG configuration port can be secure.

### 3.39 Gigabit Ethernet MAC interfaces (ETH1, ETH2)

The devices provide two IEEE-802.3-2002-compliant gigabit media access controllers (GMAC) for Ethernet LAN communications through an industry-standard medium-independent interface (MII), a reduced medium-independent interface (RMII), or a reduced gigabit medium-independent interface (RGMII).

The devices require an external physical interface device (PHY) to connect to the physical LAN bus (twisted-pair, fiber, etc.). The PHY is connected to the device port using 17 signals for MII, 7 signals for RMII, or 13 signals for RGMII, and can be clocked using the 25 MHz (MII, RMII, RGMII) or 125 MHz (RGMII) from the STM32MP133C/F or from the PHY.

The devices include the following features:

- Operation modes and PHY interfaces
  - 10-, 100-, and 1000-Mbit/s data transfer rates
  - Support of both full-duplex and half-duplex operations
  - MII, RMII and RGMII PHY interfaces
- Processing control
  - Multi-layer Packet filtering: MAC filtering on source (SA) and destination (DA) address with perfect and hash filter, VLAN tag-based filtering with perfect and hash filter, Layer 3 filtering on IP source (SA) or destination (DA) address, Layer 4 filtering on source (SP) or destination (DP) port
  - Double VLAN processing: insertion of up to two VLAN tags in transmit path, tag filtering in receive path
  - IEEE 1588-2008/PTPv2 support
  - Supports network statistics with RMON/MIB counters (RFC2819/RFC2665)
- Hardware offload processing
  - Preamble and start-of-frame data (SFD) insertion or deletion
  - Integrity checksum offload engine for IP header and TCP/UDP/ICMP payload: transmit checksum calculation and insertion, receive checksum calculation and comparison
  - Automatic ARP request response with the device MAC address
  - TCP segmentation: automatic split of large transmit TCP packet into multiple small packets
- Low-power mode
  - Energy efficient Ethernet (standard IEEE 802.3az-2010)
  - Remote wakeup packet and AMD Magic Packet™ detection

Both ETH1 and ETH2 can be programmed as secure. When secure, transactions over the AXI interface are secure, and the configuration registers can only be modified by secure accesses.



### 3.40 Debug infrastructure

The devices offer the following debug and trace features to support software development and system integration:

- Breakpoint debugging
- Code execution tracing
- Software instrumentation
- JTAG debug port
- Serial-wire debug port
- Trigger input and output
- Trace port
- Arm CoreSight debug and trace components

The debug can be controlled via a JTAG/serial-wire debug access port, using industry standard debugging tools.

A trace port allows data to be captured for logging and analysis.

A debug access to secure areas is enabled by the authentication signals in the BSEC.

## 4 Pinout, pin description and alternate functions

Figure 5. STM32MP133C/F LFBGA289 ballout

|   | 1             | 2              | 3          | 4       | 5       | 6      | 7    | 8       | 9       | 10           | 11          | 12        | 13       | 14            | 15       | 16        | 17         |
|---|---------------|----------------|------------|---------|---------|--------|------|---------|---------|--------------|-------------|-----------|----------|---------------|----------|-----------|------------|
| A | VSS           | PA9            | PD10       | PB7     | PE7     | PD5    | PE8  | PG4     | PH9     | PH13         | PC7         | PB9       | PB14     | PG6           | PD2      | PC9       | VSS        |
| B | PD3           | PF5            | PD14       | PE12    | PE1     | PE9    | PH14 | PE10    | PF1     | PF3          | PC6         | PB15      | PB4      | PC10          | PC12     | DDR_DQ4   | DDR_DQ0    |
| C | PB6           | PH12           | PE14       | PE13    | PD8     | PD12   | PD15 | VSS     | PG7     | PB5          | PB3         | VDDSD1    | PF0      | PC11          | DDR_DQ1  | DDR_DQS0N | DDR_DQS0P  |
| D | PB8           | PD6            | VSS        | PE11    | PD1     | PE0    | PG0  | PE15    | PB12    | PB10         | VDDSD2      | VSS       | PE3      | PC8           | DDR_DQM0 | DDR_DQ5   | DDR_DQ3    |
| E | PG9           | PD11           | PA12       | PD0     | VSS     | PA15   | PD4  | PD9     | PF2     | PB13         | PH10        | VDDQ_DDR  | DDR_DQ2  | DDR_DQ6       | DDR_DQ7  | DDR_A5    | DDR_RESETN |
| F | PG10          | PG5            | PG8        | PH2     | PH8     | VDDCPU | VDD  | VDDCPU  | VDDCPU  | VDD          | VDD         | VDDQ_DDR  | VSS      | DDR_A13       | VSS      | DDR_A9    | DDR_A2     |
| G | PF9           | PF6            | PF10       | PG15    | PF8     | VDD    | VSS  | VSS     | VSS     | VSS          | VSS         | VDDQ_DDR  | DDR_BA2  | DDR_A7        | DDR_A3   | DDR_A0    | DDR_BA0    |
| H | PH11          | PI3            | PH7        | PB2     | PE4     | VDDCPU | VSS  | VDDCORE | VDDCORE | VDDCORE      | VSS         | VDDQ_DDR  | DDR_WEN  | VSS           | DDR_ODT  | DDR_CSN   | DDR_RASN   |
| J | PD13          | VBAT           | PI2        | VSS_PLL | VDD_PLL | VDDCPU | VSS  | VDDCORE | VSS     | VDDCORE      | VSS         | VDDQ_DDR  | VDDCORE  | DDR_A10       | DDR_CASN | DDR_CLKP  | DDR_CLKN   |
| K | PC14-OSC32_IN | PC15-OSC32_OUT | VSS        | PC13    | PI1     | VDD    | VSS  | VDDCORE | VDDCORE | VDDCORE      | VSS         | VDDQ_DDR  | DDR_A11  | DDR_CKE       | DDR_A1   | DDR_A15   | DDR_A12    |
| L | PE2           | PF4            | PH6        | PI0     | PG3     | VDD    | VSS  | VSS     | VSS     | VSS          | VSS         | VDDQ_DDR  | DDR_ATO  | DDR_DTO0      | DDR_A8   | DDR_BA1   | DDR_A14    |
| M | PF7           | PA8            | PG11       | VDD_ANA | VSS_ANA | VDD    | VDD  | VDD     | VDD     | VDD          | VDD         | VDDQ_DDR  | DDR_VREF | DDR_A4        | VSS      | DDR_DTO1  | DDR_A6     |
| N | PE6           | PG1            | PD7        | VSS     | PB11    | PF13   | VSSA | PA3     | NJTRST  | VSS_USB_HS   | VDDA1V1_REG | VDDQ_DDR  | PWR_LP   | DDR_DQM1      | DDR_DQ10 | DDR_DQ8   | DDR_ZQ     |
| P | PH0-OSC_IN    | PH1-OSC_OUT    | PA13       | PF14    | PA2     | VREF-  | VDDA | PG13    | PG14    | VDD3V3_USBHS | VSS         | PI5-BOOT1 | VSS_PLL2 | PWR_ON        | DDR_DQ11 | DDR_DQ13  | DDR_DQ9    |
| R | PG2           | PH3            | PWR_CPU_ON | PA1     | VSS     | VREF+  | PC5  | VSS     | VDD     | PF15         | VDDA1V8_REG | PI6-BOOT2 | VDD_PLL2 | PH5           | DDR_DQ12 | DDR_DQS1N | DDR_DQS1P  |
| T | PG12          | PA11           | PC0        | PF12    | PC3     | PF11   | PB1  | PA6     | PE5     | PDR_ON       | USB_DP2     | PA14      | USB_DP1  | BYPASS_REG1V8 | PH4      | DDR_DQ15  | DDR_DQ14   |
| U | VSS           | PA7            | PA0        | PA5     | PA4     | PC4    | PB0  | PC1     | PC2     | NRST         | USB_DM2     | USB_RREF  | USB_DM1  | PI4-BOOT0     | PA10     | PI7       | VSS        |

MSv65067V5

The above figure shows the package top view.

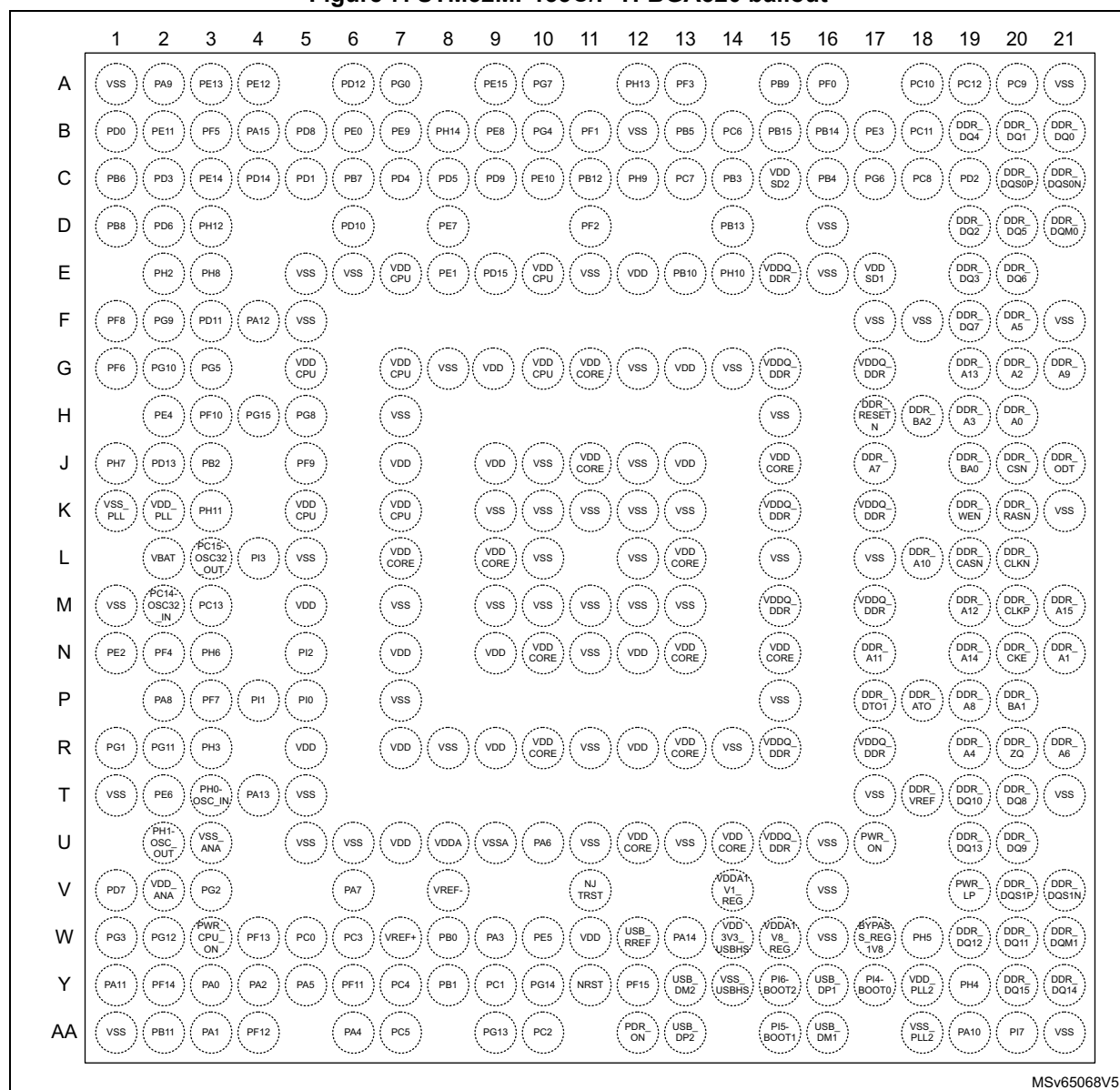
Figure 6. STM32MP133C/F TFBGA289 ballout

|   | 1             | 2              | 3    | 4          | 5       | 6       | 7      | 8      | 9       | 10          | 11            | 12      | 13       | 14       | 15         | 16        | 17        |
|---|---------------|----------------|------|------------|---------|---------|--------|--------|---------|-------------|---------------|---------|----------|----------|------------|-----------|-----------|
| A | VSS           | PD4            | PE9  | PG0        | PD15    | PE15    | PB12   | PF1    | PC7     | PC6         | PF0           | PB14    | VDDSD2   | VDDSD1   | DDR_DQ4    | DDR_DQ0   | VSS       |
| B | PE12          | PD8            | PE0  | PD5        | PD9     | PH14    | PF2    | VSS    | PF3     | PB13        | PB3           | PE3     | PC12     | VSS      | DDR_DQ1    | DDR_DQS0N | DDR_DQS0P |
| C | PE13          | PD1            | PE1  | PE7        | VSS     | VDD     | PE10   | PG7    | PG4     | PB9         | PH10          | PC11    | PC8      | DDR_DQ2  | DDR_DQM0   | DDR_DQ3   | DDR_DQ5   |
| D | PF5           | PA9            | PD10 | VDDCPU     | PB7     | VDDCPU  | PD12   | VDDCPU | PH8     | VDD         | PB15          | VDD     | VSS      | VDDQ_DDR | DDR_RESETN | DDR_DQ7   | DDR_DQ6   |
| E | PD0           | PE14           | VSS  | PE11       | VDDCPU  | VSS     | PA15   | VSS    | PH13    | VSS         | PB4           | VSS     | VDDQ_DDR | VSS      | VDDQ_DDR   | VSS       | DDR_A13   |
| F | PH8           | PA12           | VDD  | VDDCPU     | VSS     | VDDCORE | PD14   | PE8    | PB5     | VDDCORE     | PC10          | VDDCORE | VSS      | VDDQ_DDR | DDR_A7     | DDR_A5    | DDR_A9    |
| G | PD11          | PH2            | PB6  | PB8        | PG9     | PD3     | PH12   | PG15   | PD6     | PB10        | PD2           | PC9     | DDR_A2   | DDR_BA2  | DDR_A3     | DDR_A0    | DDR_ODT   |
| H | PG5           | PG10           | PF8  | VDDCPU     | VSS     | VDDCORE | PH11   | PI3    | PF9     | PG6         | BYPASS_REG1V8 | VDDCORE | VSS      | VDDQ_DDR | DDR_BA0    | DDR_CSN   | DDR_WEN   |
| J | VDD_PLL       | VSS_PLL        | PG8  | PI2        | VBAT    | PH6     | PF7    | PA8    | PF12    | VDD         | VDDA1V8_REG   | PA10    | DDR_VREF | DDR_RASN | DDR_A10    | VSS       | DDR_CASN  |
| K | PE4           | PF10           | PB2  | VDD        | VSS     | VDDCORE | PA13   | PA1    | PC4     | NRST        | VSS_PLL2      | VDDCORE | VSS      | VDDQ_DDR | DDR_A15    | DDR_CLKP  | DDR_CLKN  |
| L | PF6           | VSS            | PH7  | VDD_ANA    | VSS_ANA | PG12    | PA0    | PF11   | PE5     | PF15        | VDD_PLL2      | PH5     | DDR_CKE  | DDR_A12  | DDR_A1     | DDR_A11   | DDR_A14   |
| M | PC14-OSC32_IN | PC15-OSC32_OUT | PC13 | VDD        | VSS     | PB11    | PA5    | PB0    | VDDCORE | USB_RREF    | PI6-BOOT2     | VDDCORE | VSS      | VDDQ_DDR | DDR_A6     | DDR_A8    | DDR_BA1   |
| N | PD13          | VSS            | PI0  | PI1        | PA11    | VSS     | PA4    | PB1    | VSS     | VSS         | PI5-BOOT1     | VSS     | VDDQ_DDR | VSS      | VDDQ_DDR   | VSS       | DDR_A10   |
| P | PH0-OSC_IN    | PH1-OSC_OUT    | PF4  | PG1        | VSS     | VDD     | PC3    | PC5    | VDD     | VDD         | PI4-BOOT0     | VDD     | VSS      | VDDQ_DDR | DDR_A4     | DDR_ZQ    | DDR_DQ8   |
| R | PG11          | PE6            | PD7  | PWR_CPU_ON | PA2     | PA7     | PC1    | PA6    | PG13    | NJTRST      | PA14          | VSS     | PWR_ON   | DDR_DQM1 | DDR_DQ12   | DDR_DQ11  | DDR_DQ9   |
| T | PE2           | PH3            | PF13 | PC0        | VSSA    | VREF-   | PA3    | PG14   | USB_DP2 | VSS         | VSS_USBHS     | USB_DP1 | PH4      | DDR_DQ13 | DDR_DQ14   | DDR_DQS1P | DDR_DQS1N |
| U | VSS           | PG3            | PG2  | PF14       | VDDA    | VREF+   | PDR_ON | PC2    | USB_DM2 | VDDA1V1_REG | VDD3V3_USBHS  | USB_DM1 | PI7      | PWR_LP   | DDR_DQ15   | DDR_DQ10  | VSS       |

MSv67512V3

The above figure shows the package top view.

Figure 7. STM32MP133C/F TFBGA320 ballout



MSv65068V5

The above figure shows the package top view.

Table 6. Legend/abbreviations used in the pinout table

| Name                 | Abbreviation                                                                                           | Definition                                                                     |
|----------------------|--------------------------------------------------------------------------------------------------------|--------------------------------------------------------------------------------|
| Pin name             | Unless otherwise specified, the pin function during and after reset is the same as the actual pin name |                                                                                |
| Pin type             | S                                                                                                      | Supply pin                                                                     |
|                      | I                                                                                                      | Input only pin                                                                 |
|                      | O                                                                                                      | Output only pin                                                                |
|                      | I/O                                                                                                    | Input/output pin                                                               |
|                      | A                                                                                                      | Analog or special level pin                                                    |
| I/O structure        | FT(U/D/PD)                                                                                             | 5 V tolerant I/O (with fixed pull-up / pull-down / programmable pull-down)     |
|                      | DDR                                                                                                    | 1.5 V, 1.35 V or 1.2 V I/O for DDR3, DDR3L, LPDDR2/LPDDR3 interface            |
|                      | A                                                                                                      | Analog signal                                                                  |
|                      | RST                                                                                                    | Reset pin with weak pull-up resistor                                           |
|                      | Option for FT I/Os                                                                                     |                                                                                |
|                      | _f <sup>(1)</sup>                                                                                      | I2C FM+ option                                                                 |
|                      | _a <sup>(2)</sup>                                                                                      | Analog option (supplied by VDDA for the analog part of the I/O)                |
|                      | _u <sup>(3)</sup>                                                                                      | USB option (supplied by VDD3V3_USBxx for the USB part of the I/O)              |
|                      | _h <sup>(4)</sup>                                                                                      | High-speed output for 1.8V typ. VDD (for SPI, SDMMC, QUADSPI, TRACE)           |
|                      | _vh <sup>(5)</sup>                                                                                     | Very-high-speed option for 1.8V typ. VDD (for ETH, SPI, SDMMC, QUADSPI, TRACE) |
| Notes                | Unless otherwise specified by a note, all I/Os are set as floating inputs during and after reset       |                                                                                |
| Alternate functions  | Functions selected through GPIOx_AFR registers                                                         |                                                                                |
| Additional functions | Functions directly selected/enabled through peripheral registers                                       |                                                                                |

1. The related I/O structures in [Table 7](#) are: FT\_f, FT\_fh, FT\_fvh
2. The related I/O structures in [Table 7](#) are: FT\_a, FT\_ha, FT\_vha
3. The related I/O structures in [Table 7](#) are: FT\_u
4. The related I/O structures in [Table 7](#) are: FT\_h, FT\_fh, FT\_fvh, FT\_vh, FT\_ha, FT\_vha
5. The related I/O structures in [Table 7](#) are: FT\_vh, FT\_vha, FT\_fvh

Table 7. STM32MP133C/F ball definitions

| Pin Number |          |          | Pin name<br>(function after<br>reset) | Pin type | I/O structure | Notes | Ball functions                                                                                                                                                |                      |
|------------|----------|----------|---------------------------------------|----------|---------------|-------|---------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------|
| LFBGA289   | TFBGA289 | TFBGA320 |                                       |          |               |       | Alternate functions                                                                                                                                           | Additional functions |
| K10        | F6       | U14      | VDDCORE                               | S        | -             | -     | -                                                                                                                                                             | -                    |
| A2         | D2       | A2       | PA9                                   | I/O      | FT_h          | -     | TIM1_CH2, I2C3_SMBA,<br>DFSDM1_DATIN0,<br>USART1_TX, UART4_TX,<br>FMC_NWAIT(boot)                                                                             | -                    |
| A1         | A1       | T5       | VSS                                   | S        | -             | -     | -                                                                                                                                                             | -                    |
| M6         | F3       | U7       | VDD                                   | S        | -             | -     | -                                                                                                                                                             | -                    |
| D4         | E4       | B2       | PE11                                  | I/O      | FT_vh         | -     | TIM1_CH2,<br>USART2_CTS/USART2_NSS,<br>SAI1_D2,<br>SPI4_MOSI/I2S4_SDO,<br>SAI1_FS_A, USART6_CK,<br>ETH2_MII_TX_ER,<br>ETH1_MII_TX_ER,<br>FMC_D8(boot)/FMC_AD8 | -                    |
| B2         | D1       | B3       | PF5                                   | I/O      | FT_h          | -     | TRACED12, DFSDM1_CKIN0,<br>I2C1_SMBA, FMC_A5                                                                                                                  | -                    |
| B1         | G6       | C2       | PD3                                   | I/O      | FT_f          | -     | TIM2_CH1/TIM2_ETR,<br>USART2_CTS/USART2_NSS,<br>DFSDM1_CKOUT, I2C1_SDA,<br>SAI1_D3, FMC_CLK                                                                   | -                    |
| C3         | E2       | C3       | PE14                                  | I/O      | FT_h          | -     | TIM1_BKIN, SAI1_D4,<br>UART8_RTS/UART8_DE,<br>QUADSPI_BK1_NCS,<br>QUADSPI_BK2_IO2,<br>FMC_D11(boot)/FMC_AD11                                                  | TAMP_IN6             |
| F6         | D4       | E7       | VDDCPU                                | S        | -             | -     | -                                                                                                                                                             | -                    |
| E4         | E1       | B1       | PD0                                   | I/O      | FT            | -     | SAI1_MCLK_A, SAI1_CK1,<br>FDCAN1_RX,<br>FMC_D2(boot)/FMC_AD2                                                                                                  | -                    |
| C2         | G7       | D3       | PH12                                  | I/O      | FT_fh         | -     | USART2_TX, TIM5_CH3,<br>DFSDM1_CKIN1, I2C3_SCL,<br>SPI5_MOSI, SAI1_SCK_A,<br>QUADSPI_BK2_IO2,<br>SAI1_CK2, ETH1_MII_CRS,<br>FMC_A6                            | -                    |
| C1         | G3       | C1       | PB6                                   | I/O      | FT_h          | -     | TRACED6, TIM16_CH1N,<br>TIM4_CH1, TIM8_CH1,<br>USART1_TX, SAI1_CK2,<br>QUADSPI_BK1_NCS,<br>ETH2_MDIO, FMC_NE3,<br>HDP6                                        | -                    |

Table 7. STM32MP133C/F ball definitions (continued)

| Pin Number |          |          | Pin name<br>(function after<br>reset) | Pin type | I/O structure | Notes | Ball functions                                                                                                                                   |                      |
|------------|----------|----------|---------------------------------------|----------|---------------|-------|--------------------------------------------------------------------------------------------------------------------------------------------------|----------------------|
| LFBGA289   | TFBGA289 | TFBGA320 |                                       |          |               |       | Alternate functions                                                                                                                              | Additional functions |
| A17        | A17      | T17      | VSS                                   | S        | -             | -     | -                                                                                                                                                | -                    |
| M7         | -        | J13      | VDD                                   | S        | -             | -     | -                                                                                                                                                | -                    |
| D2         | G9       | D2       | PD6                                   | I/O      | FT            | -     | TIM16_CH1N, SAI1_D1,<br>SAI1_SD_A, UART4_TX(boot)                                                                                                | -                    |
| F5         | F1       | E3       | PH8                                   | I/O      | FT_fh         | -     | TRACED9, TIM5_ETR,<br>USART2_RX, I2C3_SDA,<br>FMC_A8, HDP2                                                                                       | -                    |
| D1         | G4       | D1       | PB8                                   | I/O      | FT_f          | -     | TIM16_CH1, TIM4_CH3,<br>I2C1_SCL, I2C3_SCL,<br>DFSDM1_DATIN1,<br>UART4_RX, SAI1_D1,<br>FMC_D13(boot)/FMC_AD13                                    | -                    |
| E3         | F2       | F4       | PA12                                  | I/O      | FT_h          | -     | TIM1_ETR, SAI2_MCLK_A,<br>USART1_RTS/USART1_DE,<br>ETH2_MII_RX_DV/ETH2_<br>RGMII_RX_CTL/ETH2_RMII_<br>CRS_DV, FMC_A7                             | -                    |
| F8         | D6       | E10      | VDDCPU                                | S        | -             | -     | -                                                                                                                                                | -                    |
| F4         | G2       | E2       | PH2                                   | I/O      | FT_h          | -     | LPTIM1_IN2, UART7_TX,<br>QUADSPI_BK2_IO0(boot),<br>ETH2_MII_CRS,<br>ETH1_MII_CRS, FMC_NE4,<br>ETH2_RGMII_CLK125                                  | -                    |
| C8         | B8       | T21      | VSS                                   | S        | -             | -     | -                                                                                                                                                | -                    |
| E2         | G1       | F3       | PD11                                  | I/O      | FT_h          | -     | LPTIM2_IN2, I2C4_SMBA,<br>USART3_CTS/USART3_NSS,<br>SPDIFRX_IN0,<br>QUADSPI_BK1_IO2,<br>ETH2_RGMII_CLK125,<br>FMC_CLE(boot)/FMC_A16,<br>UART7_RX | -                    |
| E1         | G5       | F2       | PG9                                   | I/O      | FT_f          | -     | DBTRGO, I2C2_SDA,<br>USART6_RX, SPDIFRX_IN3,<br>FDCAN1_RX, FMC_NE2,<br>FMC_NCE(boot)                                                             | -                    |
| G5         | H3       | F1       | PF8                                   | I/O      | FT_h          | -     | TIM16_CH1N, TIM4_CH3,<br>TIM8_CH3, SAI1_SCK_B,<br>USART6_TX, TIM13_CH1,<br>QUADSPI_BK1_IO0(boot)                                                 | WKUP1                |
| M8         | -        | M5       | VDD                                   | S        | -             | -     | -                                                                                                                                                | -                    |

Table 7. STM32MP133C/F ball definitions (continued)

| Pin Number |          |          | Pin name<br>(function after<br>reset) | Pin type | I/O structure | Notes | Ball functions                                                                                                                                                   |                      |
|------------|----------|----------|---------------------------------------|----------|---------------|-------|------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------|
| LFBGA289   | TFBGA289 | TFBGA320 |                                       |          |               |       | Alternate functions                                                                                                                                              | Additional functions |
| F3         | J3       | H5       | PG8                                   | I/O      | FT_h          | -     | TIM2_CH1/TIM2_ETR,<br>TIM8_ETR, SPI5_MISO,<br>SAI1_MCLK_B,<br>USART3_RTS/USART3_DE,<br>SPDIFRX_IN2,<br>QUADSPI_BK2_IO2,<br>QUADSPI_BK1_IO3,<br>FMC_NE2, ETH2_CLK | TAMP_IN4             |
| F9         | D8       | G5       | VDDCPU                                | S        | -             | -     | -                                                                                                                                                                | -                    |
| F2         | H1       | G3       | PG5                                   | I/O      | FT_h          | -     | TIM17_CH1, ETH2_MDC,<br>FMC_A15                                                                                                                                  | -                    |
| G4         | G8       | H4       | PG15                                  | I/O      | FT_h          | -     | USART6_CTS/USART6_NSS,<br>UART7_CTS,<br>QUADSPI_BK1_IO1,<br>ETH2_PHY_INTN                                                                                        | -                    |
| F1         | H2       | G2       | PG10                                  | I/O      | FT_h          | -     | SPI5_SCK, SAI1_SD_B,<br>UART8_CTS, FDCAN1_TX,<br>QUADSPI_BK2_IO1(boot),<br>FMC_NE3                                                                               | -                    |
| D3         | B14      | U5       | VSS                                   | S        | -             | -     | -                                                                                                                                                                | -                    |
| G3         | K2       | H3       | PF10                                  | I/O      | FT_h          | -     | TIM16_BKIN, SAI1_D3,<br>TIM8_BKIN, SPI5_NSS,<br>USART6_RTS/USART6_DE,<br>UART7_RTS/UART7_DE,<br>QUADSPI_CLK(boot)                                                | TAMP_IN1             |
| H8         | F10      | -        | VDDCORE                               | S        | -             | -     | -                                                                                                                                                                | -                    |
| G2         | L1       | G1       | PF6                                   | I/O      | FT_vh         | -     | TIM16_CH1, SPI5_NSS,<br>UART7_RX(boot),<br>QUADSPI_BK1_IO2,<br>ETH2_MII_TX_EN/ETH2_<br>RGMII_TX_CTL/ETH2_RMII_<br>TX_EN                                          | -                    |
| D12        | C5       | U6       | VSS                                   | S        | -             | -     | -                                                                                                                                                                | -                    |
| M9         | K4       | N7       | VDD                                   | S        | -             | -     | -                                                                                                                                                                | -                    |
| G1         | H9       | J5       | PF9                                   | I/O      | FT_h          | -     | TIM17_CH1N, TIM1_CH1,<br>DFSDM1_CKIN3, SAI1_D4,<br>UART7_CTS, UART8_RX,<br>TIM14_CH1,<br>QUADSPI_BK1_IO1(boot),<br>QUADSPI_BK2_IO3, FMC_A9                       | -                    |



Table 7. STM32MP133C/F ball definitions (continued)

| Pin Number |          |          | Pin name<br>(function after<br>reset) | Pin type | I/O structure | Notes | Ball functions                                                                                                                                                             |                                                                |
|------------|----------|----------|---------------------------------------|----------|---------------|-------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------------------------------------|
| LFBGA289   | TFBGA289 | TFBGA320 |                                       |          |               |       | Alternate functions                                                                                                                                                        | Additional functions                                           |
| H5         | K1       | H2       | PE4                                   | I/O      | FT_h          | -     | SPI5_MISO, SAI1_D2,<br>DFSDM1_DATIN3,<br>TIM15_CH1N, I2S_CKIN,<br>SAI1_FS_A,<br>UART7_RTS/UART7_DE,<br>UART8_TX,<br>QUADSPI_BK2_NCS,<br>FMC_NCE2, FMC_A25                  | -                                                              |
| H6         | E5       | G7       | VDDCPU                                | S        | -             | -     | -                                                                                                                                                                          | -                                                              |
| H4         | K3       | J3       | PB2                                   | I/O      | FT_h          | -     | RTC_OUT2, SAI1_D1,<br>I2S_CKIN, SAI1_SD_A,<br>UART4_RX,<br>QUADSPI_BK1_NCS(boot),<br>ETH2_MDIO, FMC_A6                                                                     | TAMP_IN7                                                       |
| E5         | D13      | U11      | VSS                                   | S        | -             | -     | -                                                                                                                                                                          | -                                                              |
| H3         | L3       | J1       | PH7                                   | I/O      | FT_fh         | -     | SAI2_FS_B, I2C3_SDA,<br>SPI5_SCK,<br>QUADSPI_BK2_IO3,<br>ETH2_MII_TX_CLK,<br>ETH1_MII_TX_CLK,<br>QUADSPI_BK1_IO3                                                           | -                                                              |
| H1         | H7       | K3       | PH11                                  | I/O      | FT_fh         | -     | SPI5_NSS, TIM5_CH2,<br>SAI2_SD_A,<br>SPI2_NSS/I2S2_WS,<br>I2C4_SCL, USART6_RX,<br>QUADSPI_BK2_IO0,<br>ETH2_MII_RX_CLK/ETH2_<br>RGMII_RX_CLK/ETH2_RMII_<br>REF_CLK, FMC_A12 | -                                                              |
| J1         | N1       | J2       | PD13                                  | I/O      | FT_h          | -     | LPTIM2_ETR, TIM4_CH2,<br>TIM8_CH2, SAI1_CK1,<br>SAI1_MCLK_A, USART1_RX,<br>QUADSPI_BK1_IO3,<br>QUADSPI_BK2_IO2,<br>FMC_A18                                                 | -                                                              |
| J5         | J1       | K2       | VDD_PLL                               | S        | -             | -     | -                                                                                                                                                                          | -                                                              |
| J4         | J2       | K1       | VSS_PLL                               | S        | -             | -     | -                                                                                                                                                                          | -                                                              |
| H2         | H8       | L4       | PI3                                   | I/O      | FT            | (1)   | SPDIFRX_IN3,<br>ETH1_MII_RX_ER                                                                                                                                             | TAMP_IN4/TAMP_<br>OUT5, WKUP2                                  |
| K4         | M3       | M3       | PC13                                  | I/O      | FT            | (1)   | -                                                                                                                                                                          | RTC_OUT1/RTC_TS/<br>RTC_LSCO,<br>TAMP_IN1/TAMP_<br>OUT2, WKUP3 |

Table 7. STM32MP133C/F ball definitions (continued)

| Pin Number |          |          | Pin name<br>(function after<br>reset) | Pin type | I/O structure | Notes | Ball functions                                                                                                                                                          |                                                 |
|------------|----------|----------|---------------------------------------|----------|---------------|-------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------------------------------------------------|
| LFBGA289   | TFBGA289 | TFBGA320 |                                       |          |               |       | Alternate functions                                                                                                                                                     | Additional functions                            |
| J3         | J4       | N5       | PI2                                   | I/O      | FT            | (1)   | SPDIFRX_IN2                                                                                                                                                             | TAMP_IN3/TAMP_OUT4, WKUP5                       |
| K5         | N4       | P4       | PI1                                   | I/O      | FT            | (1)   | SPDIFRX_IN1                                                                                                                                                             | RTC_OUT2/RTC_LSCO,<br>TAMP_IN2/TAMP_OUT3, WKUP4 |
| F13        | L2       | U13      | VSS                                   | S        | -             | -     | -                                                                                                                                                                       | -                                               |
| J2         | J5       | L2       | VBAT                                  | S        | -             | -     | -                                                                                                                                                                       | -                                               |
| L4         | N3       | P5       | PI0                                   | I/O      | FT            | (1)   | SPDIFRX_IN0                                                                                                                                                             | TAMP_IN8/TAMP_OUT1                              |
| K2         | M2       | L3       | PC15-<br>OSC32_OUT                    | I/O      | FT            | (1)   | -                                                                                                                                                                       | OSC32_OUT                                       |
| F15        | N2       | U16      | VSS                                   | S        | -             | -     | -                                                                                                                                                                       | -                                               |
| K1         | M1       | M2       | PC14-<br>OSC32_IN                     | I/O      | FT            | (1)   | -                                                                                                                                                                       | OSC32_IN                                        |
| G7         | E3       | V16      | VSS                                   | S        | -             | -     | -                                                                                                                                                                       | -                                               |
| H9         | K6       | N15      | VDDCORE                               | S        | -             | -     | -                                                                                                                                                                       | -                                               |
| M10        | M4       | N9       | VDD                                   | S        | -             | -     | -                                                                                                                                                                       | -                                               |
| G8         | E6       | W16      | VSS                                   | S        | -             | -     | -                                                                                                                                                                       | -                                               |
| L2         | P3       | N2       | PF4                                   | I/O      | FT_h          | -     | USART2_RX,<br>ETH2_MII_RXD0/ETH2_RGMII_RXD0/ETH2_RMII_RXD0, FMC_A4                                                                                                      | -                                               |
| M2         | J8       | P2       | PA8                                   | I/O      | FT_fh         | -     | MCO1, SAI2_MCLK_A,<br>TIM8_BKIN2, I2C4_SDA,<br>SPI5_MISO, SAI2_CK1,<br>USART1_CK,<br>SPI2_MOSI/I2S2_SDO,<br>OTG_HS_SOF,<br>ETH2_MII_RXD3/ETH2_RGMII_RXD3, FMC_A21       | -                                               |
| L1         | T1       | N1       | PE2                                   | I/O      | FT_fh         | -     | TRACECLK,<br>TIM2_CH1/TIM2_ETR,<br>I2C4_SCL, SPI5_MOSI,<br>SAI1_FS_B,<br>USART6_RTS/USART6_DE,<br>SPDIFRX_IN1,<br>ETH2_MII_RXD1/ETH2_RGMII_RXD1/ETH2_RMII_RXD1, FMC_A23 | -                                               |

Table 7. STM32MP133C/F ball definitions (continued)

| Pin Number |          |          | Pin name<br>(function after<br>reset) | Pin type | I/O structure | Notes | Ball functions                                                                                                                                                            |                      |
|------------|----------|----------|---------------------------------------|----------|---------------|-------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------|
| LFBGA289   | TFBGA289 | TFBGA320 |                                       |          |               |       | Alternate functions                                                                                                                                                       | Additional functions |
| M1         | J7       | P3       | PF7                                   | I/O      | FT_vh         | -     | TIM17_CH1,<br>UART7_TX(boot),<br>UART4_CTS,<br>ETH1_RGMII_CLK125,<br>ETH2_MII_TXD0/ETH2_<br>RGMII_TXD0/ETH2_RMII_<br>TXD0, FMC_A18                                        | -                    |
| M3         | R1       | R2       | PG11                                  | I/O      | FT_vh         | -     | SAI2_D3, I2S2_MCK,<br>USART3_TX, UART4_TX,<br>ETH2_MII_TXD1/ETH2_<br>RGMII_TXD1/ETH2_RMII_<br>TXD1, FMC_A24                                                               | -                    |
| L3         | J6       | N3       | PH6                                   | I/O      | FT_fh         | -     | TIM12_CH1, USART2_CK,<br>I2C5_SDA,<br>SPI2_SCK/I2S2_CK,<br>QUADSPI_BK1_IO2,<br>ETH1_PHY_INTN,<br>ETH1_MII_RX_ER,<br>ETH2_MII_RXD2/ETH2_<br>RGMII_RXD2,<br>QUADSPI_BK1_NCS | -                    |
| N2         | P4       | R1       | PG1                                   | I/O      | FT_vh         | -     | LPTIM1_ETR, TIM4_ETR,<br>SAI2_FS_A, I2C2_SMBA,<br>SPI2_MISO/I2S2_SDI,<br>SAI2_D2, FDCAN2_TX,<br>ETH2_MII_TXD2/ETH2_<br>RGMII_TXD2, FMC_NBL0                               | -                    |
| M11        | -        | N12      | VDD                                   | S        | -             | -     | -                                                                                                                                                                         | -                    |
| N1         | R2       | T2       | PE6                                   | I/O      | FT_vh         | -     | MCO2, TIM1_BKIN2,<br>SAI2_SCK_B, TIM15_CH2,<br>I2C3_SMBA, SAI1_SCK_B,<br>UART4_RTS/UART4_DE,<br>ETH2_MII_TXD3/ETH2_<br>RGMII_TXD3, FMC_A22                                | -                    |
| P1         | P1       | T3       | PH0-OSC_IN                            | I/O      | FT            | -     | -                                                                                                                                                                         | OSC_IN               |
| G9         | U1       | N11      | VSS                                   | S        | -             | -     | -                                                                                                                                                                         | -                    |
| P2         | P2       | U2       | PH1-OSC_OUT                           | I/O      | FT            | -     | -                                                                                                                                                                         | OSC_OUT              |
| R2         | T2       | R3       | PH3                                   | I/O      | FT_fh         | -     | I2C3_SCL, SPI5_MOSI,<br>QUADSPI_BK2_IO1,<br>ETH1_MII_COL,<br>ETH2_MII_COL,<br>QUADSPI_BK1_IO0                                                                             | -                    |
| M5         | L5       | U3       | VSS_ANA                               | S        | -             | -     | -                                                                                                                                                                         | -                    |

Table 7. STM32MP133C/F ball definitions (continued)

| Pin Number |          |          | Pin name<br>(function after<br>reset) | Pin type | I/O structure | Notes | Ball functions                                                                                                                                                                |                      |
|------------|----------|----------|---------------------------------------|----------|---------------|-------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------|
| LFBGA289   | TFBGA289 | TFBGA320 |                                       |          |               |       | Alternate functions                                                                                                                                                           | Additional functions |
| L5         | U2       | W1       | PG3                                   | I/O      | FT_fvh        | -     | TIM8_BKIN2, I2C2_SDA,<br>SAI2_SD_B, FDCAN2_RX,<br>ETH2_RGMII_GTX_CLK,<br>ETH1_MDIO, FMC_A13                                                                                   | -                    |
| M4         | L4       | V2       | VDD_ANA                               | S        | -             | -     | -                                                                                                                                                                             | -                    |
| R1         | U3       | V3       | PG2                                   | I/O      | FT            | -     | MCO2, TIM8_BKIN,<br>SAI2_MCLK_B, ETH1_MDC                                                                                                                                     | -                    |
| T1         | L6       | W2       | PG12                                  | I/O      | FT            | -     | LPTIM1_IN1, SAI2_SCK_A,<br>SAI2_CK2,<br>USART6_RTS/USART6_DE,<br>USART3_CTS,<br>ETH2_PHY_INTN,<br>ETH1_PHY_INTN,<br>ETH2_MII_RX_DV/ETH2_<br>RGMII_RX_CTL/ETH2_RMII_<br>CRS_DV | -                    |
| F7         | P6       | R5       | VDD                                   | S        | -             | -     | -                                                                                                                                                                             | -                    |
| G10        | E8       | T1       | VSS                                   | S        | -             | -     | -                                                                                                                                                                             | -                    |
| N3         | R3       | V1       | PD7                                   | I/O      | FT_fh         | -     | MCO1, USART2_CK,<br>I2C2_SCL, I2C3_SDA,<br>SPDIFRX_IN0,<br>ETH1_MII_RX_CLK/ETH1_<br>RGMII_RX_CLK/ETH1_RMII_<br>REF_CLK,<br>QUADSPI_BK1_IO2,<br>FMC_NE1                        | -                    |
| P3         | K7       | T4       | PA13                                  | I/O      | FT            | -     | DBTRGO, DBTRGI, MCO1,<br>UART4_TX                                                                                                                                             | BOOTFAILN            |
| R3         | R4       | W3       | PWR_CPU_ON                            | O        | FT            | -     | -                                                                                                                                                                             | -                    |
| T2         | N5       | Y1       | PA11                                  | I/O      | FT_f          | -     | TIM1_CH4, I2C5_SCL,<br>SPI2_NSS/I2S2_WS,<br>USART1_CTS/USART1_NSS,<br>ETH2_MII_RXD1/ETH2_<br>RGMII_RXD1/ETH2_RMII_<br>RXD1, ETH1_CLK,<br>ETH2_CLK                             | -                    |
| N5         | M6       | AA2      | PB11                                  | I/O      | FT_vh         | -     | TIM2_CH4, LPTIM1_OUT,<br>I2C5_SMBA, USART3_RX,<br>ETH1_MII_TX_EN/ETH1_<br>RGMII_TX_CTL/ETH1_RMII_<br>TX_EN                                                                    | -                    |

Table 7. STM32MP133C/F ball definitions (continued)

| Pin Number |          |          | Pin name<br>(function after<br>reset) | Pin type | I/O structure | Notes | Ball functions                                                                                                                                          |                                                                  |
|------------|----------|----------|---------------------------------------|----------|---------------|-------|---------------------------------------------------------------------------------------------------------------------------------------------------------|------------------------------------------------------------------|
| LFBGA289   | TFBGA289 | TFBGA320 |                                       |          |               |       | Alternate functions                                                                                                                                     | Additional functions                                             |
| P4         | U4       | Y2       | PF14(JTCK/SW<br>CLK)                  | I/O      | FT            | (2)   | JTCK/SWCLK                                                                                                                                              | -                                                                |
| U3         | L7       | Y3       | PA0                                   | I/O      | FT_a          | -     | TIM2_CH1/TIM2_ETR,<br>TIM5_CH1, TIM8_ETR,<br>TIM15_BKIN, SAI1_SD_B,<br>UART5_TX, ETH1_MII_CRS,<br>ETH2_MII_CRS                                          | ADC1_INP7,<br>ADC1_INN3,<br>ADC2_INP7,<br>ADC2_INN3              |
| N6         | T3       | W4       | PF13                                  | I/O      | FT_a          | -     | TIM2_CH1/TIM2_ETR,<br>SAI1_MCLK_B,<br>DFSDM1_DATIN3,<br>USART2_TX, UART5_RX                                                                             | ADC1_INP11,<br>ADC1_INN10,<br>ADC2_INP11,<br>ADC2_INN10          |
| G11        | E10      | P7       | VSS                                   | S        | -             | -     | -                                                                                                                                                       | -                                                                |
| F10        | -        | -        | VDD                                   | S        | -             | -     | -                                                                                                                                                       | -                                                                |
| R4         | K8       | AA3      | PA1                                   | I/O      | FT_a          | -     | TIM2_CH2, TIM5_CH2,<br>LPTIM3_OUT, TIM15_CH1N,<br>DFSDM1_CKIN0,<br>USART2_RTS/USART2_DE,<br>ETH1_MII_RX_CLK/ETH1_<br>RGMII_RX_CLK/ETH1_RMII_<br>REF_CLK | ADC1_INP3,<br>ADC2_INP3                                          |
| P5         | R5       | Y4       | PA2                                   | I/O      | FT_a          | -     | TIM2_CH3, TIM5_CH3,<br>LPTIM4_OUT, TIM15_CH1,<br>USART2_TX, ETH1_MDIO                                                                                   | ADC1_INP1,<br>ADC2_INP1                                          |
| U4         | M7       | Y5       | PA5                                   | I/O      | FT_a          | -     | TIM2_CH1/TIM2_ETR,<br>USART2_CK, TIM8_CH1N,<br>SAI1_D1,<br>SPI1_NSS/I2S1_WS,<br>SAI1_SD_A, ETH1_PPS_OUT,<br>ETH2_PPS_OUT                                | ADC1_INP2                                                        |
| T3         | T4       | W5       | PC0                                   | I/O      | FT_ha         | -     | SAI1_SCK_A, SAI1_CK2,<br>I2S1_MCK,<br>SPI1_MOSI/I2S1_SDO,<br>USART1_TX                                                                                  | ADC1_INP0,<br>ADC1_INN1,<br>ADC2_INP0,<br>ADC2_INN1,<br>TAMP_IN3 |
| T4         | J9       | AA4      | PF12                                  | I/O      | FT_vha        | -     | SPI1_NSS/I2S1_WS,<br>SAI1_SD_A, UART4_TX,<br>ETH1_MII_TX_ER,<br>ETH1_RGMII_CLK125                                                                       | ADC1_INP6,<br>ADC1_INN2                                          |
| R6         | U6       | W7       | VREF+                                 | S        | -             | -     | -                                                                                                                                                       | -                                                                |
| P7         | U5       | U8       | VDDA                                  | S        | -             | -     | -                                                                                                                                                       | -                                                                |
| P6         | T6       | V8       | VREF-                                 | S        | -             | -     | -                                                                                                                                                       | -                                                                |

Table 7. STM32MP133C/F ball definitions (continued)

| Pin Number |          |          | Pin name<br>(function after<br>reset) | Pin type | I/O structure | Notes | Ball functions                                                                                                                                                                   |                                                     |
|------------|----------|----------|---------------------------------------|----------|---------------|-------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------------------------------------|
| LFBGA289   | TFBGA289 | TFBGA320 |                                       |          |               |       | Alternate functions                                                                                                                                                              | Additional functions                                |
| N7         | T5       | U9       | VSSA                                  | S        | -             | -     | -                                                                                                                                                                                | -                                                   |
| U2         | R6       | V6       | PA7                                   | I/O      | FT_ha         | -     | TIM1_CH1N, TIM3_CH2,<br>TIM8_CH1N, SAI2_D1,<br>SPI1_SCK/I2S1_CK,<br>USART1_CTS/USART1_NSS,<br>TIM14_CH1,<br>ETH1_MII_RX_DV/ETH1_<br>RGMII_RX_CTL/ETH1_RMII_<br>CRS_DV, SAI2_SD_A | ADC1_INP16                                          |
| T6         | L8       | Y6       | PF11                                  | I/O      | FT_a          | -     | USART2_TX, SAI1_D2,<br>DFSDM1_CKIN3, SAI1_FS_A,<br>ETH2_MII_RX_ER                                                                                                                | ADC1_INP8,<br>ADC1_INN4,<br>ADC2_INP8,<br>ADC2_INN4 |
| U5         | N7       | AA6      | PA4                                   | I/O      | FT_a          | -     | TIM5_ETR, USART2_CK,<br>SAI1_SCK_B,<br>SPI1_NSS/I2S1_WS,<br>DFSDM1_CKIN1,<br>ETH1_PPS_OUT,<br>ETH2_PPS_OUT,<br>SAI1_SCK_A                                                        | ADC1_INP14                                          |
| U6         | K9       | Y7       | PC4                                   | I/O      | FT_a          | -     | TIM3_ETR, DFSDM1_CKIN2,<br>SAI1_D3, I2S1_MCK,<br>UART5_RTS/UART5_DE,<br>SPDIFRX_IN2,<br>ETH1_MII_RXD0/ETH1_<br>RGMII_RXD0/ETH1_RMII_<br>RXD0, SAI2_D3                            | ADC1_INP4,<br>ADC2_INP4                             |
| F11        | P9       | -        | VDD                                   | S        | -             | -     | -                                                                                                                                                                                | -                                                   |
| H7         | E12      | P15      | VSS                                   | S        | -             | -     | -                                                                                                                                                                                | -                                                   |
| T5         | P7       | W6       | PC3                                   | I/O      | FT_ha         | -     | SAI1_CK1, DFSDM1_CKOUT,<br>SPI1_MISO/I2S1_SDI,<br>SPI1_SCK/I2S1_CK,<br>UART5_CTS, SAI1_MCLK_A,<br>ETH1_MII_TX_CLK,<br>ETH2_MII_TX_CLK                                            | ADC1_INP13,<br>ADC1_INN12,<br>TAMP_IN5              |
| J8         | M9       | -        | VDDCORE                               | S        | -             | -     | -                                                                                                                                                                                | -                                                   |
| R7         | P8       | AA7      | PC5                                   | I/O      | FT_a          | -     | DFSDM1_DATIN2, SAI2_D4,<br>I2S_CKIN, SAI1_D4,<br>USART2_CTS/USART2_NSS,<br>SPDIFRX_IN3,<br>ETH1_MII_RXD1/ETH1_<br>RGMII_RXD1/ETH1_RMII_<br>RXD1                                  | ADC1_INP10,<br>ADC2_INP10                           |

Table 7. STM32MP133C/F ball definitions (continued)

| Pin Number |          |          | Pin name<br>(function after<br>reset) | Pin type | I/O structure | Notes | Ball functions                                                                                                                                          |                                                     |
|------------|----------|----------|---------------------------------------|----------|---------------|-------|---------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------------------------------------|
| LFBGA289   | TFBGA289 | TFBGA320 |                                       |          |               |       | Alternate functions                                                                                                                                     | Additional functions                                |
| U7         | M8       | W8       | PB0                                   | I/O      | FT_a          | -     | DBTRGI, TIM1_CH2N,<br>TIM3_CH3, TIM8_CH2N,<br>USART1_RX, I2S1_MCK,<br>SAI2_FS_A, USART1_CK,<br>UART4_CTS, SAI2_D2,<br>ETH1_MII_RXD2/ETH1_<br>RGMII_RXD2 | ADC1_INP9,<br>ADC1_INN5,<br>ADC2_INP9,<br>ADC2_INN5 |
| N8         | T7       | W9       | PA3                                   | I/O      | FT_ha         | -     | TIM2_CH4, TIM5_CH4,<br>LPTIM5_OUT, TIM15_CH2,<br>SPI1_MOSI/I2S1_SDO,<br>SAI1_FS_B, USART2_RX,<br>ETH1_MII_COL,<br>ETH2_MII_COL                          | ADC1_INP12,<br>ADC1_INN11,<br>PVD_IN, WKUP6         |
| T7         | N8       | Y8       | PB1                                   | I/O      | FT_ha         | -     | TIM1_CH3N, TIM3_CH4,<br>TIM8_CH3N,<br>SPI1_SCK/I2S1_CK,<br>DFSDM1_DATIN1,<br>UART4_RX,<br>ETH1_MII_RXD3/ETH1_<br>RGMII_RXD3                             | ADC1_INP5,<br>ADC2_INP5                             |
| U8         | R7       | Y9       | PC1                                   | I/O      | FT_vha        | -     | DFSDM1_DATIN0, SAI1_D3,<br>ETH1_MII_RX_DV/ETH1_<br>RMII_CRS_DV,<br>ETH1_RGMII_GTX_CLK                                                                   | ADC2_INP2                                           |
| H10        | -        | R10      | VDDCORE                               | S        | -             | -     | -                                                                                                                                                       | -                                                   |
| T8         | R8       | U10      | PA6                                   | I/O      | FT_ha         | -     | TIM1_BKIN, TIM3_CH1,<br>TIM8_BKIN, SAI2_CK2,<br>SPI1_MISO/I2S1_SDI,<br>USART1_CK,<br>UART4_RTS/UART4_DE,<br>TIM13_CH1, SAI2_SCK_A                       | ADC1_INP17,<br>ADC1_INN16,<br>TAMP_IN2              |
| H11        | E14      | R8       | VSS                                   | S        | -             | -     | -                                                                                                                                                       | -                                                   |
| G6         | P10      | -        | VDD                                   | S        | -             | -     | -                                                                                                                                                       | -                                                   |
| J10        | -        | R13      | VDDCORE                               | S        | -             | -     | -                                                                                                                                                       | -                                                   |
| P8         | R9       | AA9      | PG13                                  | I/O      | FT_vha        | -     | LPTIM1_OUT,<br>USART6_CTS/USART6_NSS,<br>ETH1_MII_TXD0/ETH1_<br>RGMII_TXD0/ETH1_RMII_<br>TXD0                                                           | ADC2_INP6,<br>ADC2_INN2                             |
| T9         | L9       | W10      | PE5                                   | I/O      | FT_vh         | -     | SAI2_SCK_B, TIM8_CH3,<br>TIM15_CH1, UART4_RX,<br>ETH1_MII_TXD3/ETH1_<br>RGMII_TXD3, FMC_NE1                                                             | -                                                   |

Table 7. STM32MP133C/F ball definitions (continued)

| Pin Number |          |          | Pin name<br>(function after<br>reset) | Pin type | I/O structure | Notes | Ball functions                                                                                                            |                                  |
|------------|----------|----------|---------------------------------------|----------|---------------|-------|---------------------------------------------------------------------------------------------------------------------------|----------------------------------|
| LFBGA289   | TFBGA289 | TFBGA320 |                                       |          |               |       | Alternate functions                                                                                                       | Additional functions             |
| P9         | T8       | Y10      | PG14                                  | I/O      | FT_vh         | -     | LPTIM1_ETR, SAI2_D1,<br>USART6_TX, SAI2_SD_A,<br>ETH1_MII_TXD1/ETH1_<br>RGMII_TXD1/ETH1_RMII_TX<br>D1                     | -                                |
| J13        | -        | U12      | VDDCORE                               | S        | -             | -     | -                                                                                                                         | -                                |
| U9         | U8       | AA10     | PC2                                   | I/O      | FT_vha        | -     | SPI5_NSS,<br>SPI1_NSS/I2S1_WS,<br>SAI2_MCLK_A,<br>USART1_RTS/USART1_DE,<br>SAI2_CK1,<br>ETH1_MII_TXD2/ETH1_<br>RGMII_TXD2 | ADC1_INP15                       |
| H14        | E16      | R11      | VSS                                   | S        | -             | -     | -                                                                                                                         | -                                |
| R9         | J10      | W11      | VDD                                   | S        | -             | -     | -                                                                                                                         | -                                |
| K8         | -        | G11      | VDDCORE                               | S        | -             | -     | -                                                                                                                         | -                                |
| N9         | R10      | V11      | NJTRST                                | I        | FTU           | -     | -                                                                                                                         | -                                |
| U10        | K10      | Y11      | NRST                                  | I/O      | RST           | -     | -                                                                                                                         | -                                |
| T10        | U7       | AA12     | PDR_ON                                | I        | FT            | -     | -                                                                                                                         | -                                |
| U12        | M10      | W12      | USB_RREF                              | A        | A             | -     | -                                                                                                                         | -                                |
| P10        | U11      | W14      | VDD3V3_<br>USBHS                      | S        | -             | -     | -                                                                                                                         | -                                |
| T11        | T9       | AA13     | USB_DP2                               | A        | FT_u          | -     | -                                                                                                                         | USBH_HS_DP2<br>(boot), OTG_HS_DP |
| U11        | U9       | Y13      | USB_DM2                               | A        | FT_u          | -     | -                                                                                                                         | USBH_HS_DM2<br>(boot), OTG_HS_DM |
| N10        | T11      | Y14      | VSS_USBHS                             | S        | -             | -     | -                                                                                                                         | -                                |
| R10        | L10      | Y12      | PF15<br>(JTMS/SWDIO)                  | I/O      | FT            | (3)   | JTMS/SWDIO                                                                                                                | -                                |
| T12        | R11      | W13      | PA14                                  | I/O      | FT            | -     | DBTRGO, DBTRGI, MCO2,<br>OTG_HS_SOF                                                                                       | -                                |
| R12        | M11      | Y15      | PI6-BOOT2<br>(BOOT2)                  | I/O      | FT            | (4)   | BOOT2                                                                                                                     | -                                |
| K6         | -        | -        | VDD                                   | S        | -             | -     | -                                                                                                                         | -                                |
| L6         | -        | -        | VDD                                   | S        | -             | -     | -                                                                                                                         | -                                |
| -          | -        | R7       | VDD                                   | S        | -             | -     | -                                                                                                                         | -                                |



Table 7. STM32MP133C/F ball definitions (continued)

| Pin Number |          |          | Pin name<br>(function after<br>reset) | Pin type | I/O structure | Notes | Ball functions      |                      |
|------------|----------|----------|---------------------------------------|----------|---------------|-------|---------------------|----------------------|
| LFBGA289   | TFBGA289 | TFBGA320 |                                       |          |               |       | Alternate functions | Additional functions |
| R11        | J11      | W15      | VDDA1V8_<br>REG                       | S        | -             | -     | -                   | -                    |
| J7         | R12      | R14      | VSS                                   | S        | -             | -     | -                   | -                    |
| N11        | U10      | V14      | VDDA1V1_<br>REG                       | S        | -             | -     | -                   | -                    |
| J9         | T10      | -        | VSS                                   | S        | -             | -     | -                   | -                    |
| -          | -        | R9       | VDD                                   | S        | -             | -     | -                   | -                    |
| -          | -        | R12      | VDD                                   | S        | -             | -     | -                   | -                    |
| P12        | N11      | AA15     | PI5-BOOT1<br>(BOOT1)                  | I/O      | FT            | (4)   | BOOT1               | -                    |
| U14        | P11      | Y17      | PI4-BOOT0<br>(BOOT0)                  | I/O      | FT            | (4)   | BOOT0               | -                    |
| U13        | U12      | AA16     | USB_DM1                               | A        | FT_u          | -     | -                   | USBH_HS_DM1          |
| T13        | T12      | Y16      | USB_DP1                               | A        | FT_u          | -     | -                   | USBH_HS_DP1          |
| U15        | J12      | AA19     | PA10                                  | I/O      | FT_u          | -     | TIM1_CH3            | OTG_HS_ID            |
| U16        | U13      | AA20     | PI7                                   | I/O      | FT_u          | -     | -                   | OTG_HS_VBUS          |
| R13        | L11      | Y18      | VDD_PLL2                              | S        | -             | -     | -                   | -                    |
| P13        | K11      | AA18     | VSS_PLL2                              | S        | -             | -     | -                   | -                    |
| K9         | F12      | J11      | VDDCORE                               | S        | -             | -     | -                   | -                    |
| T14        | H11      | W17      | BYPASS_REG<br>1V8                     | I        | FT            | -     | -                   | -                    |
| -          | F5       | B12      | VSS                                   | S        | -             | -     | -                   | -                    |
| T15        | T13      | Y19      | PH4(JTDI)                             | I/O      | FT            | (3)   | JTDI                | -                    |
| R14        | L12      | W18      | PH5(JTDO)                             | I/O      | FT            | (3)   | JTDO                | -                    |
| N13        | U14      | V19      | PWR_LP                                | O        | FT            | -     | -                   | -                    |
| P14        | R13      | U17      | PWR_ON                                | O        | FT            | -     | -                   | PWR_ONL_P            |
| -          | F13      | F17      | VSS                                   | S        | -             | -     | -                   | -                    |
| -          | P12      | E12      | VDD                                   | S        | -             | -     | -                   | -                    |
| E12        | K14      | E15      | VDDQ_DDR                              | S        | -             | -     | -                   | -                    |
| R15        | R15      | W19      | DDR_DQ12                              | I/O      | DDR           | -     | -                   | -                    |
| F12        | M14      | G15      | VDDQ_DDR                              | S        | -             | -     | -                   | -                    |
| T16        | U15      | Y20      | DDR_DQ15                              | I/O      | DDR           | -     | -                   | -                    |
| -          | H5       | A1       | VSS                                   | S        | -             | -     | -                   | -                    |

Table 7. STM32MP133C/F ball definitions (continued)

| Pin Number |          |          | Pin name<br>(function after<br>reset) | Pin type | I/O structure | Notes | Ball functions      |                      |
|------------|----------|----------|---------------------------------------|----------|---------------|-------|---------------------|----------------------|
| LFBGA289   | TFBGA289 | TFBGA320 |                                       |          |               |       | Alternate functions | Additional functions |
| T17        | T15      | Y21      | DDR_DQ14                              | I/O      | DDR           | -     | -                   | -                    |
| -          | H13      | A21      | VSS                                   | S        | -             | -     | -                   | -                    |
| P15        | R16      | W20      | DDR_DQ11                              | I/O      | DDR           | -     | -                   | -                    |
| G12        | N13      | G17      | VDDQ_DDR                              | S        | -             | -     | -                   | -                    |
| N14        | R14      | W21      | DDR_DQM1                              | O        | DDR           | -     | -                   | -                    |
| H12        | N15      | K15      | VDDQ_DDR                              | S        | -             | -     | -                   | -                    |
| R17        | T16      | V20      | DDR_DQS1P                             | I/O      | DDR           | -     | -                   | -                    |
| -          | J16      | AA1      | VSS                                   | S        | -             | -     | -                   | -                    |
| R16        | T17      | V21      | DDR_DQS1N                             | I/O      | DDR           | -     | -                   | -                    |
| -          | K5       | AA21     | VSS                                   | S        | -             | -     | -                   | -                    |
| -          | K13      | G14      | VSS                                   | S        | -             | -     | -                   | -                    |
| M13        | J13      | T18      | DDR_VREF                              | A        | A             | -     | -                   | -                    |
| -          | H6       | J15      | VDDCORE                               | S        | -             | -     | -                   | -                    |
| J12        | P14      | K17      | VDDQ_DDR                              | S        | -             | -     | -                   | -                    |
| P16        | T14      | U19      | DDR_DQ13                              | I/O      | DDR           | -     | -                   | -                    |
| K12        | -        | M15      | VDDQ_DDR                              | S        | -             | -     | -                   | -                    |
| P17        | R17      | U20      | DDR_DQ9                               | I/O      | DDR           | -     | -                   | -                    |
| -          | M5       | D16      | VSS                                   | S        | -             | -     | -                   | -                    |
| N15        | U16      | T19      | DDR_DQ10                              | I/O      | DDR           | -     | -                   | -                    |
| -          | M13      | E5       | VSS                                   | S        | -             | -     | -                   | -                    |
| N16        | P17      | T20      | DDR_DQ8                               | I/O      | DDR           | -     | -                   | -                    |
| L12        | -        | M17      | VDDQ_DDR                              | S        | -             | -     | -                   | -                    |
| N17        | P16      | R20      | DDR_ZQ                                | A        | A             | -     | -                   | -                    |
| M16        | -        | P17      | DDR_DTO1                              | O        | DDR           | -     | -                   | -                    |
| M12        | -        | R15      | VDDQ_DDR                              | S        | -             | -     | -                   | -                    |
| M14        | P15      | R19      | DDR_A4                                | O        | DDR           | -     | -                   | -                    |
| L15        | M16      | P19      | DDR_A8                                | O        | DDR           | -     | -                   | -                    |
| M17        | M15      | R21      | DDR_A6                                | O        | DDR           | -     | -                   | -                    |
| -          | N6       | E6       | VSS                                   | S        | -             | -     | -                   | -                    |
| L13        | N17      | P18      | DDR_ATO                               | A        | A             | -     | -                   | -                    |
| -          | N9       | E11      | VSS                                   | S        | -             | -     | -                   | -                    |

Table 7. STM32MP133C/F ball definitions (continued)

| Pin Number |          |          | Pin name<br>(function after<br>reset) | Pin type | I/O structure | Notes | Ball functions      |                      |
|------------|----------|----------|---------------------------------------|----------|---------------|-------|---------------------|----------------------|
| LFBGA289   | TFBGA289 | TFBGA320 |                                       |          |               |       | Alternate functions | Additional functions |
| L14        | -        | -        | DDR_DTO0                              | O        | DDR           | -     | -                   | -                    |
| N12        | -        | R17      | VDDQ_DDR                              | S        | -             | -     | -                   | -                    |
| L16        | M17      | P20      | DDR_BA1                               | O        | DDR           | -     | -                   | -                    |
| -          | -        | U15      | VDDQ_DDR                              | S        | -             | -     | -                   | -                    |
| L17        | L17      | N19      | DDR_A14                               | O        | DDR           | -     | -                   | -                    |
| -          | N10      | E16      | VSS                                   | S        | -             | -     | -                   | -                    |
| K13        | L16      | N17      | DDR_A11                               | O        | DDR           | -     | -                   | -                    |
| -          | N12      | F5       | VSS                                   | S        | -             | -     | -                   | -                    |
| L8         | N14      | K11      | VSS                                   | S        | -             | -     | -                   | -                    |
| K14        | L13      | N20      | DDR_CKE                               | O        | DDR           | -     | -                   | -                    |
| -          | H12      | L7       | VDDCORE                               | S        | -             | -     | -                   | -                    |
| K15        | L15      | N21      | DDR_A1                                | O        | DDR           | -     | -                   | -                    |
| K17        | L14      | M19      | DDR_A12                               | O        | DDR           | -     | -                   | -                    |
| K16        | K15      | M21      | DDR_A15                               | O        | DDR           | -     | -                   | -                    |
| -          | N16      | F18      | VSS                                   | S        | -             | -     | -                   | -                    |
| J16        | K16      | M20      | DDR_CLKP                              | O        | DDR           | -     | -                   | -                    |
| -          | P5       | F21      | VSS                                   | S        | -             | -     | -                   | -                    |
| J17        | K17      | L20      | DDR_CLKN                              | O        | DDR           | -     | -                   | -                    |
| -          | H14      | -        | VDDQ_DDR                              | S        | -             | -     | -                   | -                    |
| J14        | J15      | L18      | DDR_A10                               | O        | DDR           | -     | -                   | -                    |
| -          | P13      | G8       | VSS                                   | S        | -             | -     | -                   | -                    |
| H17        | J14      | K20      | DDR_RASN                              | O        | DDR           | -     | -                   | -                    |
| J15        | J17      | L19      | DDR_CASN                              | O        | DDR           | -     | -                   | -                    |
| H13        | H17      | K19      | DDR_WEN                               | O        | DDR           | -     | -                   | -                    |
| -          | U17      | G12      | VSS                                   | S        | -             | -     | -                   | -                    |
| P11        | -        | L12      | VSS                                   | S        | -             | -     | -                   | -                    |
| -          | -        | H7       | VSS                                   | S        | -             | -     | -                   | -                    |
| -          | K12      | L9       | VDDCORE                               | S        | -             | -     | -                   | -                    |
| H16        | H16      | J20      | DDR_CSN                               | O        | DDR           | -     | -                   | -                    |
| G17        | H15      | J19      | DDR_BA0                               | O        | DDR           | -     | -                   | -                    |
| J11        | -        | H15      | VSS                                   | S        | -             | -     | -                   | -                    |

Table 7. STM32MP133C/F ball definitions (continued)

| Pin Number |          |          | Pin name<br>(function after<br>reset) | Pin type | I/O structure | Notes | Ball functions      |                      |
|------------|----------|----------|---------------------------------------|----------|---------------|-------|---------------------|----------------------|
| LFBGA289   | TFBGA289 | TFBGA320 |                                       |          |               |       | Alternate functions | Additional functions |
| H15        | G17      | J21      | DDR_ODT                               | O        | DDR           | -     | -                   | -                    |
| K3         | -        | J10      | VSS                                   | S        | -             | -     | -                   | -                    |
| G16        | G16      | H20      | DDR_A0                                | O        | DDR           | -     | -                   | -                    |
| G15        | G15      | H19      | DDR_A3                                | O        | DDR           | -     | -                   | -                    |
| G14        | F15      | J17      | DDR_A7                                | O        | DDR           | -     | -                   | -                    |
| -          | D14      | -        | VDDQ_DDR                              | S        | -             | -     | -                   | -                    |
| F17        | G13      | G20      | DDR_A2                                | O        | DDR           | -     | -                   | -                    |
| -          | E13      | -        | VDDQ_DDR                              | S        | -             | -     | -                   | -                    |
| E16        | F16      | F20      | DDR_A5                                | O        | DDR           | -     | -                   | -                    |
| G13        | G14      | H18      | DDR_BA2                               | O        | DDR           | -     | -                   | -                    |
| F16        | F17      | G21      | DDR_A9                                | O        | DDR           | -     | -                   | -                    |
| K7         | -        | J12      | VSS                                   | S        | -             | -     | -                   | -                    |
| F14        | E17      | G19      | DDR_A13                               | O        | DDR           | -     | -                   | -                    |
| K11        | -        | K9       | VSS                                   | S        | -             | -     | -                   | -                    |
| E17        | D15      | H17      | DDR_RESETN                            | O        | DDR           | -     | -                   | -                    |
| -          | E15      | -        | VDDQ_DDR                              | S        | -             | -     | -                   | -                    |
| E15        | D16      | F19      | DDR_DQ7                               | I/O      | DDR           | -     | -                   | -                    |
| -          | F14      | -        | VDDQ_DDR                              | S        | -             | -     | -                   | -                    |
| E14        | D17      | E20      | DDR_DQ6                               | I/O      | DDR           | -     | -                   | -                    |
| L7         | -        | K10      | VSS                                   | S        | -             | -     | -                   | -                    |
| R5         | -        | L15      | VSS                                   | S        | -             | -     | -                   | -                    |
| L9         | -        | K12      | VSS                                   | S        | -             | -     | -                   | -                    |
| -          | M12      | L13      | VDDCORE                               | S        | -             | -     | -                   | -                    |
| D17        | C16      | E19      | DDR_DQ3                               | I/O      | DDR           | -     | -                   | -                    |
| D16        | C17      | D20      | DDR_DQ5                               | I/O      | DDR           | -     | -                   | -                    |
| C17        | B17      | C20      | DDR_DQS0P                             | I/O      | DDR           | -     | -                   | -                    |
| L10        | -        | K13      | VSS                                   | S        | -             | -     | -                   | -                    |
| C16        | B16      | C21      | DDR_DQS0N                             | I/O      | DDR           | -     | -                   | -                    |
| L11        | -        | K21      | VSS                                   | S        | -             | -     | -                   | -                    |
| D15        | C15      | D21      | DDR_DQM0                              | O        | DDR           | -     | -                   | -                    |
| E13        | C14      | D19      | DDR_DQ2                               | I/O      | DDR           | -     | -                   | -                    |

Table 7. STM32MP133C/F ball definitions (continued)

| Pin Number |          |          | Pin name<br>(function after<br>reset) | Pin type | I/O structure | Notes | Ball functions                                                                                                                           |                      |
|------------|----------|----------|---------------------------------------|----------|---------------|-------|------------------------------------------------------------------------------------------------------------------------------------------|----------------------|
| LFBGA289   | TFBGA289 | TFBGA320 |                                       |          |               |       | Alternate functions                                                                                                                      | Additional functions |
| C15        | B15      | B20      | DDR_DQ1                               | I/O      | DDR           | -     | -                                                                                                                                        | -                    |
| M15        | -        | L5       | VSS                                   | S        | -             | -     | -                                                                                                                                        | -                    |
| B17        | A16      | B21      | DDR_DQ0                               | I/O      | DDR           | -     | -                                                                                                                                        | -                    |
| N4         | -        | L10      | VSS                                   | S        | -             | -     | -                                                                                                                                        | -                    |
| B16        | A15      | B19      | DDR_DQ4                               | I/O      | DDR           | -     | -                                                                                                                                        | -                    |
| A16        | G12      | A20      | PC9                                   | I/O      | FT_h          | (5)   | TRACED1, TIM3_CH4,<br>TIM8_CH4, USART3_RTS,<br>UART5_CTS, FDCAN1_TX,<br>SDMMC1_D1                                                        | -                    |
| C12        | A14      | E17      | VDDSD1                                | S        | -             | -     | -                                                                                                                                        | -                    |
| R8         | -        | L17      | VSS                                   | S        | -             | -     | -                                                                                                                                        | -                    |
| D14        | C13      | C18      | PC8                                   | I/O      | FT_h          | (5)   | TRACED0, TIM3_CH3,<br>TIM8_CH3,<br>SPI3_MISO/I2S3_SDI,<br>USART6_CK, USART3_CTS,<br>SAI2_FS_B,<br>UART5_RTS/UART5_DE,<br>SDMMC1_D0(boot) | -                    |
| A15        | G11      | C19      | PD2                                   | I/O      | FT_h          | (5)   | TRACED4, TIM3_ETR,<br>I2C1_SMBA,<br>SPI3_NSS/I2S3_WS,<br>SAI2_D1, USART3_RX,<br>SDMMC1_CMD(boot)                                         | -                    |
| B15        | B13      | A19      | PC12                                  | I/O      | FT_h          | (5)   | TRACECLK, UART7_TX,<br>SAI2_SD_B,<br>SDMMC1_CK(boot)                                                                                     | -                    |
| B14        | F11      | A18      | PC10                                  | I/O      | FT_fh         | (5)   | TRACED2, I2C1_SCL,<br>SPI3_SCK/I2S3_CK,<br>USART3_TX, SAI2_MCLK_B,<br>SDMMC1_D2                                                          | -                    |
| C14        | C12      | B18      | PC11                                  | I/O      | FT_fh         | (5)   | TRACED3, I2C1_SDA,<br>SPI3_MOSI/I2S3_SDO,<br>USART3_CK, UART5_RX,<br>SAI2_SCK_B, SDMMC1_D3                                               | -                    |
| -          | -        | N10      | VDDCORE                               | S        | -             | -     | -                                                                                                                                        | -                    |
| A14        | H10      | C17      | PG6                                   | I/O      | FT_h          | (6)   | TRACED3, TIM17_BKIN,<br>TIM5_CH4, SAI2_D1,<br>USART1_RX, SAI2_SD_A,<br>SDMMC2_CMD(boot), HDP3                                            | -                    |

Table 7. STM32MP133C/F ball definitions (continued)

| Pin Number |          |          | Pin name<br>(function after<br>reset) | Pin type | I/O structure | Notes | Ball functions                                                                                                                                           |                      |
|------------|----------|----------|---------------------------------------|----------|---------------|-------|----------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------|
| LFBGA289   | TFBGA289 | TFBGA320 |                                       |          |               |       | Alternate functions                                                                                                                                      | Additional functions |
| D13        | B12      | B17      | PE3                                   | I/O      | FT_h          | (6)   | TRACED11, SAI2_D4,<br>TIM15_BKIN,<br>SPI4_MISO/I2S4_SDI,<br>USART3_RTS/USART3_DE,<br>FDCAN1_RX,<br>SDMMC2_CK(boot)                                       | -                    |
| B13        | E11      | C16      | PB4                                   | I/O      | FT_h          | (6)   | TRACED14, TIM16_BKIN,<br>TIM3_CH1, SAI2_CK2,<br>SPI4_SCK/I2S4_CK,<br>USART3_CK, SDMMC2_D3,<br>SAI2_SCK_A                                                 | -                    |
| A13        | A12      | B16      | PB14                                  | I/O      | FT_h          | (6)   | TRACED0, TIM1_CH2N,<br>TIM12_CH1, TIM8_CH2N,<br>USART1_TX,<br>SDMMC2_D0(boot),<br>SDMMC1_D4                                                              | -                    |
| -          | -        | N13      | VDDCORE                               | S        | -             | -     | -                                                                                                                                                        | -                    |
| D11        | A13      | C15      | VDDSD2                                | S        | -             | -     | -                                                                                                                                                        | -                    |
| U1         | -        | M1       | VSS                                   | S        | -             | -     | -                                                                                                                                                        | -                    |
| C11        | B11      | C14      | PB3                                   | I/O      | FT_h          | (6)   | TRACED2, TIM2_CH2,<br>SAI2_CK1,<br>SPI4_NSS/I2S4_WS,<br>SDMMC1_D123DIR,<br>SDMMC2_D2, SAI2_MCLK_A,<br>UART7_RX                                           | -                    |
| B12        | D11      | B15      | PB15                                  | I/O      | FT_h          | (6)   | RTC_REFIN, TIM1_CH3N,<br>TIM12_CH2, TIM8_CH3N,<br>SAI2_D2,<br>SPI4_MOSI/I2S4_SDO,<br>DFSDM1_CKIN2,<br>UART7_CTS,<br>SDMMC1_CKIN,<br>SDMMC2_D1, SAI2_FS_A | -                    |
| U17        | -        | M7       | VSS                                   | S        | -             | -     | -                                                                                                                                                        | -                    |
| C13        | A11      | A16      | PF0                                   | I/O      | FT_h          | -     | TRACED13,<br>DFSDM1_CKOUT,<br>USART3_CK, SDMMC2_D4,<br>FMC_A0                                                                                            | -                    |

Table 7. STM32MP133C/F ball definitions (continued)

| Pin Number |          |          | Pin name<br>(function after<br>reset) | Pin type | I/O structure | Notes | Ball functions                                                                                                                                |                      |
|------------|----------|----------|---------------------------------------|----------|---------------|-------|-----------------------------------------------------------------------------------------------------------------------------------------------|----------------------|
| LFBGA289   | TFBGA289 | TFBGA320 |                                       |          |               |       | Alternate functions                                                                                                                           | Additional functions |
| E11        | C11      | E14      | PH10                                  | I/O      | FT_h          | -     | TRACED0, TIM5_CH1,<br>SAI2_D3, DFSDM1_DATIN2,<br>I2S3_MCK,<br>SPI2_MOSI/I2S2_SDO,<br>USART3_CTS/USART3_NSS,<br>SDMMC1_D4, HDP0                | -                    |
| A12        | C10      | A15      | PB9                                   | I/O      | FT_fh         | -     | TRACED3, TIM4_CH4,<br>I2C4_SDA, FDCAN1_TX,<br>SDMMC2_D5, UART5_TX,<br>SDMMC1_CD1R(boot)                                                       | -                    |
| -          | D10      | G9       | VDD                                   | S        | -             | -     | -                                                                                                                                             | -                    |
| -          | -        | M9       | VSS                                   | S        | -             | -     | -                                                                                                                                             | -                    |
| E10        | B10      | D14      | PB13                                  | I/O      | FT_fh         | -     | TRACECLK, TIM1_CH1N,<br>LPTIM2_OUT,<br>SPI2_NSS/I2S2_WS,<br>I2C4_SCL,<br>SDMMC1_D123DIR,<br>FDCAN2_TX,<br>UART5_TX(boot)                      | -                    |
| D10        | G10      | E13      | PB10                                  | I/O      | FT_h          | -     | TIM2_CH3, LPTIM2_IN1,<br>I2C5_SMBA,<br>SPI4_NSS/I2S4_WS,<br>SPI2_SCK/I2S2_CK,<br>USART3_TX(boot)                                              | -                    |
| B11        | A10      | B14      | PC6                                   | I/O      | FT_h          | -     | TRACED2, TIM3_CH1,<br>TIM8_CH1, DFSDM1_DATIN0,<br>I2S3_MCK,<br>USART6_TX(boot),<br>SDMMC1_D6,<br>SDMMC2_D0DIR,<br>SDMMC2_D6, FMC_A19,<br>HDP2 | -                    |
| C10        | F9       | B13      | PB5                                   | I/O      | FT_h          | -     | TRACED4, TIM17_BKIN,<br>TIM3_CH2,<br>SPI2_MISO/I2S2_SDI,<br>I2C4_SMBA, SDMMC1_CKIN,<br>FDCAN2_RX,<br>UART5_RX(boot)                           | -                    |

Table 7. STM32MP133C/F ball definitions (continued)

| Pin Number |          |          | Pin name<br>(function after<br>reset) | Pin type | I/O structure | Notes | Ball functions                                                                                                                |                      |
|------------|----------|----------|---------------------------------------|----------|---------------|-------|-------------------------------------------------------------------------------------------------------------------------------|----------------------|
| LFBGA289   | TFBGA289 | TFBGA320 |                                       |          |               |       | Alternate functions                                                                                                           | Additional functions |
| A11        | A9       | C13      | PC7                                   | I/O      | FT_h          | -     | TRACED4, TIM3_CH2,<br>TIM8_CH2, I2S2_MCK,<br>USART6_RX(boot),<br>USART3_CTS,<br>SDMMC2_CD1R,<br>SDMMC2_D7, SDMMC1_D7,<br>HDP4 | -                    |
| B10        | B9       | A13      | PF3                                   | I/O      | FT_fh         | -     | LPTIM2_IN2, I2C5_SDA,<br>SPI4_MISO/I2S4_SDI,<br>SPI3_NSS/I2S3_WS, FMC_A3                                                      | -                    |
| A9         | D9       | C12      | PH9                                   | I/O      | FT_h          | -     | TIM1_CH4, TIM12_CH2,<br>SPI4_SCK/I2S4_CK,<br>FMC_A20                                                                          | -                    |
| -          | C6       | G13      | VDD                                   | S        | -             | -     | -                                                                                                                             | -                    |
| -          | -        | M10      | VSS                                   | S        | -             | -     | -                                                                                                                             | -                    |
| B9         | A8       | B11      | PF1                                   | I/O      | FT_fh         | -     | TRACED7, I2C2_SDA,<br>SPI3_MOSI/I2S3_SDO,<br>FMC_A1, HDP7                                                                     | -                    |
| A10        | E9       | A12      | PH13                                  | I/O      | FT_fh         | -     | TRACED15, USART2_CK,<br>TIM8_CH1N, I2C5_SCL,<br>SPI3_SCK/I2S3_CK,<br>UART4_TX                                                 | -                    |
| C9         | C8       | A10      | PG7                                   | I/O      | FT_h          | -     | TRACED8, TIM1_ETR,<br>SPI3_MISO/I2S3_SDI,<br>UART7_CTS, SDMMC2_CKIN                                                           | -                    |
| A8         | C9       | B10      | PG4                                   | I/O      | FT_h          | -     | TRACED1, TIM1_BKIN2,<br>DFSDM1_CKIN3,<br>USART3_RX,<br>SDMMC2_D123DIR,<br>FMC_A14, HDP1                                       | -                    |
| D9         | A7       | C11      | PB12                                  | I/O      | FT_h          | -     | TRACED10, I2C2_SMBA,<br>DFSDM1_DATIN1,<br>UART7_RTS/UART7_DE,<br>USART3_RX(boot),<br>UART5_RX, SDMMC1_D5                      | -                    |
| E9         | B7       | D11      | PF2                                   | I/O      | FT_fh         | -     | TRACED1, I2C2_SCL,<br>DFSDM1_CKIN1,<br>USART6_CK,<br>SDMMC2_D0DIR,<br>SDMMC1_D0DIR, FMC_A2                                    | -                    |
| -          | -        | M11      | VSS                                   | S        | -             | -     | -                                                                                                                             | -                    |
| -          | -        | J7       | VDD                                   | S        | -             | -     | -                                                                                                                             | -                    |



Table 7. STM32MP133C/F ball definitions (continued)

| Pin Number |          |          | Pin name<br>(function after<br>reset) | Pin type | I/O structure | Notes | Ball functions                                                                                             |                      |
|------------|----------|----------|---------------------------------------|----------|---------------|-------|------------------------------------------------------------------------------------------------------------|----------------------|
| LFBGA289   | TFBGA289 | TFBGA320 |                                       |          |               |       | Alternate functions                                                                                        | Additional functions |
| J6         | F4       | G10      | VDDCPU                                | S        | -             | -     | -                                                                                                          | -                    |
| B8         | C7       | C10      | PE10                                  | I/O      | FT            | -     | TIM1_CH2N, UART7_RX,<br>FDCAN1_TX,<br>FMC_D7(boot)/FMC_AD7                                                 | -                    |
| -          | -        | M12      | VSS                                   | S        | -             | -     | -                                                                                                          | -                    |
| D8         | A6       | A9       | PE15                                  | I/O      | FT_fh         | -     | TIM2_CH1/TIM2_ETR,<br>TIM1_BKIN,<br>USART2_CTS/USART2_NSS,<br>I2C4_SCL,<br>FMC_D12(boot)/FMC_AD12,<br>HDP7 | -                    |
| -          | H4       | -        | VDDCPU                                | S        | -             | -     | -                                                                                                          | -                    |
| B7         | B6       | B8       | PH14                                  | I/O      | FT_fh         | -     | DFSDM1_DATIN2, I2C3_SDA,<br>UART4_RX                                                                       | -                    |
| A7         | F8       | B9       | PE8                                   | I/O      | FT_f          | -     | TIM1_CH1N,<br>DFSDM1_CKIN2, I2C1_SDA,<br>UART7_TX,<br>FMC_D5(boot)/FMC_AD5                                 | -                    |
| C7         | A5       | E9       | PD15                                  | I/O      | FT_h          | -     | USART2_RX, TIM4_CH4,<br>DFSDM1_DATIN2,<br>QUADSPI_BK1_IO3,<br>FMC_D1(boot)/FMC_AD1                         | -                    |
| E8         | B5       | C9       | PD9                                   | I/O      | FT_h          | -     | TRACECLK,<br>DFSDM1_DATIN3,<br>SDMMC2_CDIR,<br>FMC_D14(boot)/FMC_AD14                                      | -                    |
| -          | -        | M13      | VSS                                   | S        | -             | -     | -                                                                                                          | -                    |
| D7         | A4       | A7       | PG0                                   | I/O      | FT_h          | -     | FDCAN2_TX, FMC_A10                                                                                         | -                    |
| A6         | B4       | C8       | PD5                                   | I/O      | FT_h          | -     | QUADSPI_BK1_IO0,<br>FMC_NWE(boot)                                                                          | -                    |
| -          | -        | J9       | VDD                                   | S        | -             | -     | -                                                                                                          | -                    |
| B6         | A3       | B7       | PE9                                   | I/O      | FT_h          | -     | TIM1_CH1,<br>QUADSPI_BK1_IO1,<br>FMC_D6(boot)/FMC_AD6,<br>HDP3                                             | -                    |
| A5         | C4       | D8       | PE7                                   | I/O      | FT_h          | -     | TIM1_ETR, LPTIM2_IN1,<br>UART5_TX,<br>FMC_D4(boot)/FMC_AD4                                                 | -                    |
| D6         | B3       | B6       | PE0                                   | I/O      | FT_h          | -     | UART8_RX(boot),<br>FDCAN2_RX, FMC_A11                                                                      | -                    |

Table 7. STM32MP133C/F ball definitions (continued)

| Pin Number |          |          | Pin name<br>(function after<br>reset) | Pin type | I/O structure | Notes | Ball functions                                                                                 |                      |
|------------|----------|----------|---------------------------------------|----------|---------------|-------|------------------------------------------------------------------------------------------------|----------------------|
| LFBGA289   | TFBGA289 | TFBGA320 |                                       |          |               |       | Alternate functions                                                                            | Additional functions |
| C6         | D7       | A6       | PD12                                  | I/O      | FT_f          | -     | LPTIM1_IN1, TIM4_CH1,<br>I2C1_SCL,<br>USART3_RTS/USART3_DE,<br>FMC_ALE(boot)/FMC_A17           | -                    |
| E7         | A2       | C7       | PD4                                   | I/O      | FT_h          | -     | USART2_RTS/USART2_DE,<br>SPI3_MISO/I2S3_SDI,<br>DFSDM1_CKIN0,<br>QUADSPI_CLK,<br>FMC_NOE(boot) | -                    |
| C5         | B2       | B5       | PD8                                   | I/O      | FT            | -     | USART2_TX, I2S4_WS,<br>USART3_TX,<br>UART4_RX(boot)                                            | -                    |
| B5         | C3       | E8       | PE1                                   | I/O      | FT_h          | -     | LPTIM1_IN2,<br>UART8_TX(boot), FMC_NBL1                                                        | -                    |
| A4         | D5       | C6       | PB7                                   | I/O      | FT_f          | -     | TIM17_CH1N, TIM4_CH2,<br>I2S4_CK, I2C4_SDA,<br>FMC_NCE2, FMC_NL                                | -                    |
| B4         | B1       | A4       | PE12                                  | I/O      | FT_h          | -     | TIM1_CH3N,<br>SPI4_SCK/I2S4_CK,<br>UART8_RTS/UART8_DE,<br>FMC_D9(boot)/FMC_AD9,<br>HDP4        | -                    |
| -          | -        | K7       | VDDCPU                                | S        | -             | -     | -                                                                                              | -                    |
| D5         | C2       | C5       | PD1                                   | I/O      | FT_fh         | -     | I2C5_SCL,<br>SPI4_MOSI/I2S4_SDO,<br>UART4_TX,<br>QUADSPI_BK1_NCS,<br>FMC_D3(boot)/FMC_AD3      | -                    |
| -          | -        | K5       | VDDCPU                                | S        | -             | -     | -                                                                                              | -                    |
| A3         | D3       | D6       | PD10                                  | I/O      | FT_h          | -     | RTC_REFIN, I2C5_SMBA,<br>SPI4_NSS/I2S4_WS,<br>USART3_CK,<br>FMC_D15(boot)/FMC_AD15             | -                    |
| E6         | E7       | B4       | PA15                                  | I/O      | FT_h          | -     | TRACED5,<br>TIM2_CH1/TIM2_ETR,<br>I2S4_MCK,<br>UART4_RTS/UART4_DE,<br>UART4_RX, FMC_A9, HDP5   | -                    |
| C4         | C1       | A3       | PE13                                  | I/O      | FT_fh         | -     | TIM1_CH3, I2C5_SDA,<br>SPI4_MISO/I2S4_SDI,<br>FMC_D10(boot)/FMC_AD10                           | -                    |

Table 7. STM32MP133C/F ball definitions (continued)

| Pin Number |          |          | Pin name<br>(function after<br>reset) | Pin type | I/O structure | Notes | Ball functions                                                       |                      |
|------------|----------|----------|---------------------------------------|----------|---------------|-------|----------------------------------------------------------------------|----------------------|
| LFBGA289   | TFBGA289 | TFBGA320 |                                       |          |               |       | Alternate functions                                                  | Additional functions |
| B3         | F7       | C4       | PD14                                  | I/O      | FT_fh         | -     | TIM4_CH3, I2C3_SDA,<br>USART1_RX, UART8_CTS,<br>FMC_D0(boot)/FMC_AD0 | -                    |
| -          | D12      | -        | VDD                                   | S        | -             | -     | -                                                                    | -                    |

1. Power supply is  $V_{BAT}$ .
2. During reset and when configured as alternate function for JTAG/SWD an internal pull-down is present.
3. During reset and when configured as alternate function for JTAG/SWD an internal pull-up is present.
4. During reset an internal pull-down is present.
5. Power supply is  $V_{DDSD1}$ .
6. Power supply is  $V_{DDSD2}$ .



Table 8. Alternate function AF0 to AF7

| Port   |      | AF0     | AF1                                                 | AF2                                     | AF3                                              | AF4                                                        | AF5                                                             | AF6                                                               | AF7                       |
|--------|------|---------|-----------------------------------------------------|-----------------------------------------|--------------------------------------------------|------------------------------------------------------------|-----------------------------------------------------------------|-------------------------------------------------------------------|---------------------------|
|        |      | RTC/SYS | LPTIM1/RTC/<br>SPI5/SYS/<br>TIM1/2/16/17/<br>USART2 | SAI1/2/SYS/<br>TIM1/3/4/5/12/<br>USART2 | DFSDM1/<br>LPTIM2/3/4/5/<br>SAI2/TIM8/<br>USART2 | DFSDM1/<br>I2C1/2/3/4/5/<br>LPTIM2/SAI1/2/<br>TIM15/USART1 | I2C1/3/SPI1/<br>I2S1/SPI2/I2S2/<br>SPI3/I2S3/SPI4/<br>I2S4/SPI5 | DFSDM1/I2C4/<br>SAI1/2/SPI1/I2<br>S1/SPI2/I2S2/S<br>PI3/I2S3/SPI5 | UART4/7/<br>USART1/2/3/6  |
| Port A | PA0  | -       | TIM2_CH1/<br>TIM2_ETR                               | TIM5_CH1                                | TIM8_ETR                                         | TIM15_BKIN                                                 | -                                                               | SAI1_SD_B                                                         | -                         |
|        | PA1  | -       | TIM2_CH2                                            | TIM5_CH2                                | LPTIM3_OUT                                       | TIM15_CH1N                                                 | -                                                               | DFSDM1_<br>CKIN0                                                  | USART2_RTS/<br>USART2_DE  |
|        | PA2  | -       | TIM2_CH3                                            | TIM5_CH3                                | LPTIM4_OUT                                       | TIM15_CH1                                                  | -                                                               | -                                                                 | USART2_TX                 |
|        | PA3  | -       | TIM2_CH4                                            | TIM5_CH4                                | LPTIM5_OUT                                       | TIM15_CH2                                                  | SPI1_MOSI/<br>I2S1_SDO                                          | SAI1_FS_B                                                         | USART2_RX                 |
|        | PA4  | -       | -                                                   | TIM5_ETR                                | USART2_CK                                        | SAI1_SCK_B                                                 | SPI1_NSS/<br>I2S1_WS                                            | DFSDM1_<br>CKIN1                                                  | -                         |
|        | PA5  | -       | TIM2_CH1/<br>TIM2_ETR                               | USART2_CK                               | TIM8_CH1N                                        | SAI1_D1                                                    | SPI1_NSS/<br>I2S1_WS                                            | SAI1_SD_A                                                         | -                         |
|        | PA6  | -       | TIM1_BKIN                                           | TIM3_CH1                                | TIM8_BKIN                                        | SAI2_CK2                                                   | SPI1_MISO/<br>I2S1_SDI                                          | -                                                                 | USART1_CK                 |
|        | PA7  | -       | TIM1_CH1N                                           | TIM3_CH2                                | TIM8_CH1N                                        | SAI2_D1                                                    | SPI1_SCK/<br>I2S1_CK                                            | -                                                                 | USART1_CTS/<br>USART1_NSS |
|        | PA8  | MCO1    | -                                                   | SAI2_MCLK_A                             | TIM8_BKIN2                                       | I2C4_SDA                                                   | SPI5_MISO                                                       | SAI2_CK1                                                          | USART1_CK                 |
|        | PA9  | -       | TIM1_CH2                                            | -                                       | -                                                | I2C3_SMBA                                                  | -                                                               | DFSDM1_<br>DATIN0                                                 | USART1_TX                 |
|        | PA10 | -       | TIM1_CH3                                            | -                                       | -                                                | -                                                          | -                                                               | -                                                                 | -                         |
|        | PA11 | -       | TIM1_CH4                                            | -                                       | -                                                | I2C5_SCL                                                   | SPI2_NSS/<br>I2S2_WS                                            | -                                                                 | USART1_CTS/<br>USART1_NSS |
|        | PA12 | -       | TIM1_ETR                                            | SAI2_MCLK_A                             | -                                                | -                                                          | -                                                               | -                                                                 | USART1_RTS/<br>USART1_DE  |
|        | PA13 | DBTRGO  | DBTRGI                                              | MCO1                                    | -                                                | -                                                          | -                                                               | -                                                                 | -                         |

Table 8. Alternate function AF0 to AF7 (continued)

| Port   |      | AF0      | AF1                                                 | AF2                                     | AF3                                              | AF4                                                        | AF5                                                             | AF6                                                               | AF7                      |
|--------|------|----------|-----------------------------------------------------|-----------------------------------------|--------------------------------------------------|------------------------------------------------------------|-----------------------------------------------------------------|-------------------------------------------------------------------|--------------------------|
|        |      | RTC/SYS  | LPTIM1/RTC/<br>SPI5/SYS/<br>TIM1/2/16/17/<br>USART2 | SAI1/2/SYS/<br>TIM1/3/4/5/12/<br>USART2 | DFSDM1/<br>LPTIM2/3/4/5/<br>SAI2/TIM8/<br>USART2 | DFSDM1/<br>I2C1/2/3/4/5/<br>LPTIM2/SAI1/2/<br>TIM15/USART1 | I2C1/3/SPI1/<br>I2S1/SPI2/I2S2/<br>SPI3/I2S3/SPI4/<br>I2S4/SPI5 | DFSDM1/I2C4/<br>SAI1/2/SPI1/I2<br>S1/SPI2/I2S2/S<br>PI3/I2S3/SPI5 | UART4/7/<br>USART1/2/3/6 |
| Port A | PA14 | DBTRGO   | DBTRGI                                              | MCO2                                    | -                                                | -                                                          | -                                                               | -                                                                 | -                        |
|        | PA15 | TRACED5  | TIM2_CH1/<br>TIM2_ETR                               | -                                       | -                                                | -                                                          | I2S4_MCK                                                        | -                                                                 | UART4_RTS/<br>UART4_DE   |
| Port B | PB0  | DBTRGI   | TIM1_CH2N                                           | TIM3_CH3                                | TIM8_CH2N                                        | USART1_RX                                                  | I2S1_MCK                                                        | SAI2_FS_A                                                         | USART1_CK                |
|        | PB1  | -        | TIM1_CH3N                                           | TIM3_CH4                                | TIM8_CH3N                                        | -                                                          | SPI1_SCK/<br>I2S1_CK                                            | DFSDM1_<br>DATIN1                                                 | UART4_RX                 |
|        | PB2  | -        | RTC_OUT2                                            | SAI1_D1                                 | -                                                | -                                                          | I2S_CKIN                                                        | SAI1_SD_A                                                         | -                        |
|        | PB3  | TRACED2  | TIM2_CH2                                            | -                                       | -                                                | SAI2_CK1                                                   | SPI4_NSS/<br>I2S4_WS                                            | -                                                                 | -                        |
|        | PB4  | TRACED14 | TIM16_BKIN                                          | TIM3_CH1                                | -                                                | SAI2_CK2                                                   | SPI4_SCK/<br>I2S4_CK                                            | -                                                                 | USART3_CK                |
|        | PB5  | TRACED4  | TIM17_BKIN                                          | TIM3_CH2                                | -                                                | -                                                          | SPI2_MISO/<br>I2S2_SDI                                          | I2C4_SMBA                                                         | -                        |
|        | PB6  | TRACED6  | TIM16_CH1N                                          | TIM4_CH1                                | TIM8_CH1                                         | USART1_TX                                                  | -                                                               | SAI1_CK2                                                          | -                        |
|        | PB7  | -        | TIM17_CH1N                                          | TIM4_CH2                                | -                                                | -                                                          | I2S4_CK                                                         | I2C4_SDA                                                          | -                        |
|        | PB8  | -        | TIM16_CH1                                           | TIM4_CH3                                | -                                                | I2C1_SCL                                                   | I2C3_SCL                                                        | DFSDM1_<br>DATIN1                                                 | -                        |
|        | PB9  | TRACED3  | -                                                   | TIM4_CH4                                | -                                                | -                                                          | -                                                               | I2C4_SDA                                                          | -                        |
|        | PB10 | -        | TIM2_CH3                                            | -                                       | LPTIM2_IN1                                       | I2C5_SMBA                                                  | SPI4_NSS/<br>I2S4_WS                                            | SPI2_SCK/<br>I2S2_CK                                              | USART3_TX                |
|        | PB11 | -        | TIM2_CH4                                            | -                                       | LPTIM1_OUT                                       | I2C5_SMBA                                                  | -                                                               | -                                                                 | USART3_RX                |
|        | PB12 | TRACED10 | -                                                   | -                                       | -                                                | I2C2_SMBA                                                  | -                                                               | DFSDM1_<br>DATIN1                                                 | UART7_RTS/<br>UART7_DE   |



Table 8. Alternate function AF0 to AF7 (continued)

| Port   |      | AF0       | AF1                                                 | AF2                                     | AF3                                              | AF4                                                        | AF5                                                             | AF6                                                               | AF7                       |
|--------|------|-----------|-----------------------------------------------------|-----------------------------------------|--------------------------------------------------|------------------------------------------------------------|-----------------------------------------------------------------|-------------------------------------------------------------------|---------------------------|
|        |      | RTC/SYS   | LPTIM1/RTC/<br>SPI5/SYS/<br>TIM1/2/16/17/<br>USART2 | SAI1/2/SYS/<br>TIM1/3/4/5/12/<br>USART2 | DFSDM1/<br>LPTIM2/3/4/5/<br>SAI2/TIM8/<br>USART2 | DFSDM1/<br>I2C1/2/3/4/5/<br>LPTIM2/SAI1/2/<br>TIM15/USART1 | I2C1/3/SPI1/<br>I2S1/SPI2/I2S2/<br>SPI3/I2S3/SPI4/<br>I2S4/SPI5 | DFSDM1/I2C4/<br>SAI1/2/SPI1/I2<br>S1/SPI2/I2S2/S<br>PI3/I2S3/SPI5 | UART4/7/<br>USART1/2/3/6  |
| Port B | PB13 | TRACECLK  | TIM1_CH1N                                           | -                                       | -                                                | LPTIM2_OUT                                                 | SPI2_NSS/<br>I2S2_WS                                            | I2C4_SCL                                                          | -                         |
|        | PB14 | TRACED0   | TIM1_CH2N                                           | TIM12_CH1                               | TIM8_CH2N                                        | USART1_TX                                                  | -                                                               | -                                                                 | -                         |
|        | PB15 | RTC_REFIN | TIM1_CH3N                                           | TIM12_CH2                               | TIM8_CH3N                                        | SAI2_D2                                                    | SPI4_MOSI/<br>I2S4_SDO                                          | DFSDM1_<br>CKIN2                                                  | UART7_CTS                 |
| Port C | PC0  | -         | -                                                   | SAI1_SCK_A                              | -                                                | SAI1_CK2                                                   | I2S1_MCK                                                        | SPI1_MOSI/<br>I2S1_SDO                                            | USART1_TX                 |
|        | PC1  | -         | -                                                   | -                                       | DFSDM1_<br>DATIN0                                | -                                                          | -                                                               | SAI1_D3                                                           | -                         |
|        | PC2  | -         | SPI5_NSS                                            | -                                       | -                                                | -                                                          | SPI1_NSS/<br>I2S1_WS                                            | SAI2_MCLK_A                                                       | USART1_RTS/<br>USART1_DE  |
|        | PC3  | -         | -                                                   | SAI1_CK1                                | DFSDM1_<br>CKOUT                                 | -                                                          | SPI1_MISO/<br>I2S1_SDI                                          | SPI1_SCK/<br>I2S1_CK                                              | -                         |
|        | PC4  | -         | -                                                   | TIM3_ETR                                | DFSDM1_<br>CKIN2                                 | SAI1_D3                                                    | I2S1_MCK                                                        | -                                                                 | -                         |
|        | PC5  | -         | -                                                   | -                                       | DFSDM1_<br>DATIN2                                | SAI2_D4                                                    | I2S_CKIN                                                        | SAI1_D4                                                           | USART2_CTS/<br>USART2_NSS |
|        | PC6  | TRACED2   | -                                                   | TIM3_CH1                                | TIM8_CH1                                         | DFSDM1_<br>DATIN0                                          | I2S3_MCK                                                        | -                                                                 | USART6_TX                 |
|        | PC7  | TRACED4   | -                                                   | TIM3_CH2                                | TIM8_CH2                                         | -                                                          | -                                                               | I2S2_MCK                                                          | USART6_RX                 |
|        | PC8  | TRACED0   | -                                                   | TIM3_CH3                                | TIM8_CH3                                         | -                                                          | SPI3_MISO/<br>I2S3_SDI                                          | -                                                                 | USART6_CK                 |
|        | PC9  | TRACED1   | -                                                   | TIM3_CH4                                | TIM8_CH4                                         | -                                                          | -                                                               | -                                                                 | USART3_RTS                |

Table 8. Alternate function AF0 to AF7 (continued)

| Port   |      | AF0      | AF1                                                 | AF2                                     | AF3                                              | AF4                                                        | AF5                                                             | AF6                                                               | AF7                      |
|--------|------|----------|-----------------------------------------------------|-----------------------------------------|--------------------------------------------------|------------------------------------------------------------|-----------------------------------------------------------------|-------------------------------------------------------------------|--------------------------|
|        |      | RTC/SYS  | LPTIM1/RTC/<br>SPI5/SYS/<br>TIM1/2/16/17/<br>USART2 | SAI1/2/SYS/<br>TIM1/3/4/5/12/<br>USART2 | DFSDM1/<br>LPTIM2/3/4/5/<br>SAI2/TIM8/<br>USART2 | DFSDM1/<br>I2C1/2/3/4/5/<br>LPTIM2/SAI1/2/<br>TIM15/USART1 | I2C1/3/SPI1/<br>I2S1/SPI2/I2S2/<br>SPI3/I2S3/SPI4/<br>I2S4/SPI5 | DFSDM1/I2C4/<br>SAI1/2/SPI1/I2<br>S1/SPI2/I2S2/S<br>PI3/I2S3/SPI5 | UART4/7/<br>USART1/2/3/6 |
| Port C | PC10 | TRACED2  | -                                                   | -                                       | -                                                | -                                                          | I2C1_SCL                                                        | SPI3_SCK/<br>I2S3_CK                                              | USART3_TX                |
|        | PC11 | TRACED3  | -                                                   | -                                       | -                                                | I2C1_SDA                                                   | -                                                               | SPI3_MOSI/<br>I2S3_SDO                                            | USART3_CK                |
|        | PC12 | TRACECLK | -                                                   | -                                       | -                                                | -                                                          | -                                                               | -                                                                 | -                        |
|        | PC13 | -        | -                                                   | -                                       | -                                                | -                                                          | -                                                               | -                                                                 | -                        |
|        | PC14 | -        | -                                                   | -                                       | -                                                | -                                                          | -                                                               | -                                                                 | -                        |
|        | PC15 | -        | -                                                   | -                                       | -                                                | -                                                          | -                                                               | -                                                                 | -                        |
| Port D | PD0  | -        | -                                                   | SAI1_MCLK_A                             | -                                                | -                                                          | -                                                               | SAI1_CK1                                                          | -                        |
|        | PD1  | -        | -                                                   | -                                       | -                                                | I2C5_SCL                                                   | SPI4_MOSI/<br>I2S4_SDO                                          | -                                                                 | -                        |
|        | PD2  | TRACED4  | -                                                   | TIM3_ETR                                | -                                                | I2C1_SMBA                                                  | SPI3_NSS/<br>I2S3_WS                                            | SAI2_D1                                                           | USART3_RX                |
|        | PD3  | -        | -                                                   | TIM2_CH1/<br>TIM2_ETR                   | USART2_CTS/<br>USART2_NSS                        | DFSDM1_<br>CKOUT                                           | I2C1_SDA                                                        | SAI1_D3                                                           | -                        |
|        | PD4  | -        | -                                                   | -                                       | USART2_RTS/<br>USART2_DE                         | -                                                          | SPI3_MISO/<br>I2S3_SDI                                          | DFSDM1_<br>CKIN0                                                  | -                        |
|        | PD5  | -        | -                                                   | -                                       | -                                                | -                                                          | -                                                               | -                                                                 | -                        |
|        | PD6  | -        | TIM16_CH1N                                          | SAI1_D1                                 | -                                                | -                                                          | -                                                               | SAI1_SD_A                                                         | -                        |
|        | PD7  | MCO1     | -                                                   | -                                       | USART2_CK                                        | I2C2_SCL                                                   | I2C3_SDA                                                        | -                                                                 | -                        |
|        | PD8  | -        | -                                                   | -                                       | USART2_TX                                        | -                                                          | I2S4_WS                                                         | -                                                                 | USART3_TX                |
|        | PD9  | TRACECLK | -                                                   | -                                       | DFSDM1_<br>DATIN3                                | -                                                          | -                                                               | -                                                                 | -                        |



Table 8. Alternate function AF0 to AF7 (continued)

| Port   |      | AF0       | AF1                                                 | AF2                                     | AF3                                              | AF4                                                        | AF5                                                             | AF6                                                               | AF7                       |
|--------|------|-----------|-----------------------------------------------------|-----------------------------------------|--------------------------------------------------|------------------------------------------------------------|-----------------------------------------------------------------|-------------------------------------------------------------------|---------------------------|
|        |      | RTC/SYS   | LPTIM1/RTC/<br>SPI5/SYS/<br>TIM1/2/16/17/<br>USART2 | SAI1/2/SYS/<br>TIM1/3/4/5/12/<br>USART2 | DFSDM1/<br>LPTIM2/3/4/5/<br>SAI2/TIM8/<br>USART2 | DFSDM1/<br>I2C1/2/3/4/5/<br>LPTIM2/SAI1/2/<br>TIM15/USART1 | I2C1/3/SPI1/<br>I2S1/SPI2/I2S2/<br>SPI3/I2S3/SPI4/<br>I2S4/SPI5 | DFSDM1/I2C4/<br>SAI1/2/SPI1/I2<br>S1/SPI2/I2S2/S<br>PI3/I2S3/SPI5 | UART4/7/<br>USART1/2/3/6  |
| Port D | PD10 | RTC_REFIN | -                                                   | -                                       | -                                                | I2C5_SMBA                                                  | SPI4_NSS/<br>I2S4_WS                                            | -                                                                 | USART3_CK                 |
|        | PD11 | -         | -                                                   | -                                       | LPTIM2_IN2                                       | I2C4_SMBA                                                  | -                                                               | -                                                                 | USART3_CTS/<br>USART3_NSS |
|        | PD12 | -         | LPTIM1_IN1                                          | TIM4_CH1                                | -                                                | -                                                          | I2C1_SCL                                                        | -                                                                 | USART3_RTS/<br>USART3_DE  |
|        | PD13 | -         | LPTIM2_ETR                                          | TIM4_CH2                                | TIM8_CH2                                         | SAI1_CK1                                                   | -                                                               | SAI1_MCLK_A                                                       | USART1_RX                 |
|        | PD14 | -         | -                                                   | TIM4_CH3                                | -                                                | I2C3_SDA                                                   | -                                                               | -                                                                 | USART1_RX                 |
|        | PD15 | -         | USART2_RX                                           | TIM4_CH4                                | DFSDM1_<br>DATIN2                                | -                                                          | -                                                               | -                                                                 | -                         |
| Port E | PE0  | -         | -                                                   | -                                       | -                                                | -                                                          | -                                                               | -                                                                 | -                         |
|        | PE1  | -         | LPTIM1_IN2                                          | -                                       | -                                                | -                                                          | -                                                               | -                                                                 | -                         |
|        | PE2  | TRACECLK  | TIM2_CH1/<br>TIM2_ETR                               | -                                       | -                                                | I2C4_SCL                                                   | SPI5_MOSI                                                       | SAI1_FS_B                                                         | USART6_RTS/<br>USART6_DE  |
|        | PE3  | TRACED11  | -                                                   | SAI2_D4                                 | -                                                | TIM15_BKIN                                                 | SPI4_MISO/<br>I2S4_SDI                                          | -                                                                 | -                         |
|        | PE4  | -         | SPI5_MISO                                           | SAI1_D2                                 | DFSDM1_<br>DATIN3                                | TIM15_CH1N                                                 | I2S_CKIN                                                        | SAI1_FS_A                                                         | UART7_RTS/U<br>ART7_DE    |
|        | PE5  | -         | -                                                   | SAI2_SCK_B                              | TIM8_CH3                                         | TIM15_CH1                                                  | -                                                               | -                                                                 | -                         |
|        | PE6  | MCO2      | TIM1_BKIN2                                          | SAI2_SCK_B                              | -                                                | TIM15_CH2                                                  | I2C3_SMBA                                                       | SAI1_SCK_B                                                        | -                         |
|        | PE7  | -         | TIM1_ETR                                            | -                                       | -                                                | LPTIM2_IN1                                                 | -                                                               | -                                                                 | -                         |
|        | PE8  | -         | TIM1_CH1N                                           | -                                       | DFSDM1_<br>CKIN2                                 | -                                                          | I2C1_SDA                                                        | -                                                                 | UART7_TX                  |



Table 8. Alternate function AF0 to AF7 (continued)

| Port   |      | AF0      | AF1                                                 | AF2                                     | AF3                                              | AF4                                                        | AF5                                                             | AF6                                                               | AF7                      |
|--------|------|----------|-----------------------------------------------------|-----------------------------------------|--------------------------------------------------|------------------------------------------------------------|-----------------------------------------------------------------|-------------------------------------------------------------------|--------------------------|
|        |      | RTC/SYS  | LPTIM1/RTC/<br>SPI5/SYS/<br>TIM1/2/16/17/<br>USART2 | SAI1/2/SYS/<br>TIM1/3/4/5/12/<br>USART2 | DFSDM1/<br>LPTIM2/3/4/5/<br>SAI2/TIM8/<br>USART2 | DFSDM1/<br>I2C1/2/3/4/5/<br>LPTIM2/SAI1/2/<br>TIM15/USART1 | I2C1/3/SPI1/<br>I2S1/SPI2/I2S2/<br>SPI3/I2S3/SPI4/<br>I2S4/SPI5 | DFSDM1/I2C4/<br>SAI1/2/SPI1/I2<br>S1/SPI2/I2S2/S<br>PI3/I2S3/SPI5 | UART4/7/<br>USART1/2/3/6 |
| Port E | PE9  | -        | TIM1_CH1                                            | -                                       | -                                                | -                                                          | -                                                               | -                                                                 | -                        |
|        | PE10 | -        | TIM1_CH2N                                           | -                                       | -                                                | -                                                          | -                                                               | -                                                                 | UART7_RX                 |
|        | PE11 | -        | TIM1_CH2                                            | USART2_CTS/<br>USART2_NSS               | -                                                | SAI1_D2                                                    | SPI4_MOSI/<br>I2S4_SDO                                          | SAI1_FS_A                                                         | USART6_CK                |
|        | PE12 | -        | TIM1_CH3N                                           | -                                       | -                                                | -                                                          | SPI4_SCK/<br>I2S4_CK                                            | -                                                                 | -                        |
|        | PE13 | -        | TIM1_CH3                                            | -                                       | -                                                | I2C5_SDA                                                   | SPI4_MISO/<br>I2S4_SDI                                          | -                                                                 | -                        |
|        | PE14 | -        | TIM1_BKIN                                           | -                                       | -                                                | SAI1_D4                                                    | -                                                               | -                                                                 | -                        |
|        | PE15 | -        | TIM2_CH1/<br>TIM2_ETR                               | TIM1_BKIN                               | USART2_CTS/<br>USART2_NSS                        | -                                                          | -                                                               | I2C4_SCL                                                          | -                        |
| Port F | PF0  | TRACED13 | -                                                   | -                                       | DFSDM1_<br>CKOUT                                 | -                                                          | -                                                               | -                                                                 | USART3_CK                |
|        | PF1  | TRACED7  | -                                                   | -                                       | -                                                | I2C2_SDA                                                   | SPI3_MOSI/<br>I2S3_SDO                                          | -                                                                 | -                        |
|        | PF2  | TRACED1  | -                                                   | -                                       | -                                                | I2C2_SCL                                                   | -                                                               | DFSDM1_<br>CKIN1                                                  | USART6_CK                |
|        | PF3  | -        | -                                                   | -                                       | LPTIM2_IN2                                       | I2C5_SDA                                                   | SPI4_MISO/<br>I2S4_SDI                                          | SPI3_NSS/<br>I2S3_WS                                              | -                        |
|        | PF4  | -        | -                                                   | -                                       | USART2_RX                                        | -                                                          | -                                                               | -                                                                 | -                        |
|        | PF5  | TRACED12 | -                                                   | -                                       | -                                                | DFSDM1_<br>CKIN0                                           | I2C1_SMBA                                                       | -                                                                 | -                        |
|        | PF6  | -        | TIM16_CH1                                           | -                                       | -                                                | -                                                          | SPI5_NSS                                                        | -                                                                 | UART7_RX                 |



Table 8. Alternate function AF0 to AF7 (continued)

| Port   |      | AF0        | AF1                                                 | AF2                                     | AF3                                              | AF4                                                        | AF5                                                             | AF6                                                               | AF7                      |
|--------|------|------------|-----------------------------------------------------|-----------------------------------------|--------------------------------------------------|------------------------------------------------------------|-----------------------------------------------------------------|-------------------------------------------------------------------|--------------------------|
|        |      | RTC/SYS    | LPTIM1/RTC/<br>SPI5/SYS/<br>TIM1/2/16/17/<br>USART2 | SAI1/2/SYS/<br>TIM1/3/4/5/12/<br>USART2 | DFSDM1/<br>LPTIM2/3/4/5/<br>SAI2/TIM8/<br>USART2 | DFSDM1/<br>I2C1/2/3/4/5/<br>LPTIM2/SAI1/2/<br>TIM15/USART1 | I2C1/3/SPI1/<br>I2S1/SPI2/I2S2/<br>SPI3/I2S3/SPI4/<br>I2S4/SPI5 | DFSDM1/I2C4/<br>SAI1/2/SPI1/I2<br>S1/SPI2/I2S2/S<br>PI3/I2S3/SPI5 | UART4/7/<br>USART1/2/3/6 |
| Port F | PF7  | -          | TIM17_CH1                                           | -                                       | -                                                | -                                                          | -                                                               | -                                                                 | UART7_TX                 |
|        | PF8  | -          | TIM16_CH1N                                          | TIM4_CH3                                | TIM8_CH3                                         | -                                                          | -                                                               | SAI1_SCK_B                                                        | USART6_TX                |
|        | PF9  | -          | TIM17_CH1N                                          | TIM1_CH1                                | DFSDM1_CKIN<br>3                                 | -                                                          | -                                                               | SAI1_D4                                                           | UART7_CTS                |
|        | PF10 | -          | TIM16_BKIN                                          | SAI1_D3                                 | TIM8_BKIN                                        | -                                                          | SPI5_NSS                                                        | -                                                                 | USART6_RTS/<br>USART6_DE |
|        | PF11 | -          | USART2_TX                                           | SAI1_D2                                 | DFSDM1_<br>CKIN3                                 | -                                                          | -                                                               | SAI1_FS_A                                                         | -                        |
|        | PF12 | -          | -                                                   | -                                       | -                                                | -                                                          | SPI1_NSS/<br>I2S1_WS                                            | SAI1_SD_A                                                         | -                        |
|        | PF13 | -          | TIM2_CH1/<br>TIM2_ETR                               | SAI1_MCLK_B                             | -                                                | -                                                          | -                                                               | DFSDM1_<br>DATIN3                                                 | USART2_TX                |
|        | PF14 | JTCK/SWCLK | -                                                   | -                                       | -                                                | -                                                          | -                                                               | -                                                                 | -                        |
|        | PF15 | JTMS/SWDIO | -                                                   | -                                       | -                                                | -                                                          | -                                                               | -                                                                 | -                        |
| Port G | PG0  | -          | -                                                   | -                                       | -                                                | -                                                          | -                                                               | -                                                                 | -                        |
|        | PG1  | -          | LPTIM1_ETR                                          | TIM4_ETR                                | SAI2_FS_A                                        | I2C2_SMBA                                                  | SPI2_MISO/<br>I2S2_SDI                                          | SAI2_D2                                                           | -                        |
|        | PG2  | -          | MCO2                                                | -                                       | TIM8_BKIN                                        | -                                                          | -                                                               | -                                                                 | -                        |
|        | PG3  | -          | -                                                   | -                                       | TIM8_BKIN2                                       | I2C2_SDA                                                   | -                                                               | SAI2_SD_B                                                         | -                        |
|        | PG4  | TRACED1    | TIM1_BKIN2                                          | -                                       | -                                                | DFSDM1_<br>CKIN3                                           | -                                                               | -                                                                 | -                        |
|        | PG5  | -          | TIM17_CH1                                           | -                                       | -                                                | -                                                          | -                                                               | -                                                                 | -                        |
|        | PG6  | TRACED3    | TIM17_BKIN                                          | TIM5_CH4                                | SAI2_D1                                          | USART1_RX                                                  | -                                                               | SAI2_SD_A                                                         | -                        |

Table 8. Alternate function AF0 to AF7 (continued)

| Port   |      | AF0     | AF1                                                 | AF2                                     | AF3                                              | AF4                                                        | AF5                                                             | AF6                                                               | AF7                       |
|--------|------|---------|-----------------------------------------------------|-----------------------------------------|--------------------------------------------------|------------------------------------------------------------|-----------------------------------------------------------------|-------------------------------------------------------------------|---------------------------|
|        |      | RTC/SYS | LPTIM1/RTC/<br>SPI5/SYS/<br>TIM1/2/16/17/<br>USART2 | SAI1/2/SYS/<br>TIM1/3/4/5/12/<br>USART2 | DFSDM1/<br>LPTIM2/3/4/5/<br>SAI2/TIM8/<br>USART2 | DFSDM1/<br>I2C1/2/3/4/5/<br>LPTIM2/SAI1/2/<br>TIM15/USART1 | I2C1/3/SPI1/<br>I2S1/SPI2/I2S2/<br>SPI3/I2S3/SPI4/<br>I2S4/SPI5 | DFSDM1/I2C4/<br>SAI1/2/SPI1/I2<br>S1/SPI2/I2S2/S<br>PI3/I2S3/SPI5 | UART4/7/<br>USART1/2/3/6  |
| Port G | PG7  | TRACED8 | TIM1_ETR                                            | -                                       | -                                                | -                                                          | SPI3_MISO/<br>I2S3_SDI                                          | -                                                                 | -                         |
|        | PG8  | -       | TIM2_CH1/<br>TIM2_ETR                               | -                                       | TIM8_ETR                                         | -                                                          | SPI5_MISO                                                       | SAI1_MCLK_B                                                       | -                         |
|        | PG9  | DBTRGO  | -                                                   | -                                       | -                                                | I2C2_SDA                                                   | -                                                               | -                                                                 | USART6_RX                 |
|        | PG10 | -       | -                                                   | -                                       | -                                                | -                                                          | SPI5_SCK                                                        | SAI1_SD_B                                                         | -                         |
|        | PG11 | -       | -                                                   | -                                       | -                                                | SAI2_D3                                                    | I2S2_MCK                                                        | -                                                                 | USART3_TX                 |
|        | PG12 | -       | LPTIM1_IN1                                          | -                                       | -                                                | SAI2_SCK_A                                                 | -                                                               | SAI2_CK2                                                          | USART6_RTS/<br>USART6_DE  |
|        | PG13 | -       | LPTIM1_OUT                                          | -                                       | -                                                | -                                                          | -                                                               | -                                                                 | USART6_CTS/<br>USART6_NSS |
|        | PG14 | -       | LPTIM1_ETR                                          | -                                       | -                                                | -                                                          | -                                                               | SAI2_D1                                                           | USART6_TX                 |
|        | PG15 | -       | -                                                   | -                                       | -                                                | -                                                          | -                                                               | -                                                                 | USART6_CTS/<br>USART6_NSS |
| Port H | PH0  | -       | -                                                   | -                                       | -                                                | -                                                          | -                                                               | -                                                                 | -                         |
|        | PH1  | -       | -                                                   | -                                       | -                                                | -                                                          | -                                                               | -                                                                 | -                         |
|        | PH2  | -       | LPTIM1_IN2                                          | -                                       | -                                                | -                                                          | -                                                               | -                                                                 | -                         |
|        | PH3  | -       | -                                                   | -                                       | -                                                | I2C3_SCL                                                   | SPI5_MOSI                                                       | -                                                                 | -                         |
|        | PH4  | JTDI    | -                                                   | -                                       | -                                                | -                                                          | -                                                               | -                                                                 | -                         |
|        | PH5  | JTDO    | -                                                   | -                                       | -                                                | -                                                          | -                                                               | -                                                                 | -                         |
|        | PH6  | -       | -                                                   | TIM12_CH1                               | USART2_CK                                        | I2C5_SDA                                                   | SPI2_SCK/<br>I2S2_CK                                            | -                                                                 | -                         |
|        | PH7  | -       | -                                                   | SAI2_FS_B                               | -                                                | -                                                          | I2C3_SDA                                                        | SPI5_SCK                                                          | -                         |



Table 8. Alternate function AF0 to AF7 (continued)

| Port   |      | AF0      | AF1                                                 | AF2                                     | AF3                                              | AF4                                                        | AF5                                                             | AF6                                                               | AF7                       |
|--------|------|----------|-----------------------------------------------------|-----------------------------------------|--------------------------------------------------|------------------------------------------------------------|-----------------------------------------------------------------|-------------------------------------------------------------------|---------------------------|
|        |      | RTC/SYS  | LPTIM1/RTC/<br>SPI5/SYS/<br>TIM1/2/16/17/<br>USART2 | SAI1/2/SYS/<br>TIM1/3/4/5/12/<br>USART2 | DFSDM1/<br>LPTIM2/3/4/5/<br>SAI2/TIM8/<br>USART2 | DFSDM1/<br>I2C1/2/3/4/5/<br>LPTIM2/SAI1/2/<br>TIM15/USART1 | I2C1/3/SPI1/<br>I2S1/SPI2/I2S2/<br>SPI3/I2S3/SPI4/<br>I2S4/SPI5 | DFSDM1/I2C4/<br>SAI1/2/SPI1/I2<br>S1/SPI2/I2S2/S<br>PI3/I2S3/SPI5 | UART4/7/<br>USART1/2/3/6  |
| Port H | PH8  | TRACED9  | -                                                   | TIM5_ETR                                | USART2_RX                                        | I2C3_SDA                                                   | -                                                               | -                                                                 | -                         |
|        | PH9  | -        | TIM1_CH4                                            | TIM12_CH2                               | -                                                | -                                                          | SPI4_SCK/<br>I2S4_CK                                            | -                                                                 | -                         |
|        | PH10 | TRACED0  | -                                                   | TIM5_CH1                                | SAI2_D3                                          | DFSDM1_<br>DATIN2                                          | I2S3_MCK                                                        | SPI2_MOSI/<br>I2S2_SDO                                            | USART3_CTS/<br>USART3_NSS |
|        | PH11 | -        | SPI5_NSS                                            | TIM5_CH2                                | SAI2_SD_A                                        | -                                                          | SPI2_NSS/<br>I2S2_WS                                            | I2C4_SCL                                                          | USART6_RX                 |
|        | PH12 | -        | USART2_TX                                           | TIM5_CH3                                | DFSDM1_<br>CKIN1                                 | I2C3_SCL                                                   | SPI5_MOSI                                                       | SAI1_SCK_A                                                        | -                         |
|        | PH13 | TRACED15 | -                                                   | USART2_CK                               | TIM8_CH1N                                        | I2C5_SCL                                                   | -                                                               | SPI3_SCK/<br>I2S3_CK                                              | -                         |
|        | PH14 | -        | -                                                   | -                                       | DFSDM1_<br>DATIN2                                | I2C3_SDA                                                   | -                                                               | -                                                                 | -                         |
| Port I | PI0  | -        | -                                                   | -                                       | -                                                | -                                                          | -                                                               | -                                                                 | -                         |
|        | PI1  | -        | -                                                   | -                                       | -                                                | -                                                          | -                                                               | -                                                                 | -                         |
|        | PI2  | -        | -                                                   | -                                       | -                                                | -                                                          | -                                                               | -                                                                 | -                         |
|        | PI3  | -        | -                                                   | -                                       | -                                                | -                                                          | -                                                               | -                                                                 | -                         |
|        | PI4  | BOOT0    | -                                                   | -                                       | -                                                | -                                                          | -                                                               | -                                                                 | -                         |
|        | PI5  | BOOT1    | -                                                   | -                                       | -                                                | -                                                          | -                                                               | -                                                                 | -                         |
|        | PI6  | BOOT2    | -                                                   | -                                       | -                                                | -                                                          | -                                                               | -                                                                 | -                         |
|        | PI7  | -        | -                                                   | -                                       | -                                                | -                                                          | -                                                               | -                                                                 | -                         |

Table 9. Alternate function AF8 to AF15

| Port   |      | AF8                                                         | AF9                                                      | AF10                                                    | AF11                                                                    | AF12                           | AF13                       | AF14 | AF15    |
|--------|------|-------------------------------------------------------------|----------------------------------------------------------|---------------------------------------------------------|-------------------------------------------------------------------------|--------------------------------|----------------------------|------|---------|
|        |      | SDMMC1/<br>SPDIFRX/SPI2/<br>I2S2/<br>UART4/5/7/8/<br>USART3 | FDCAN1/2/QU<br>ADSPI/<br>SDMMC2/<br>SPDIFRX/<br>TIM13/14 | ETH1/2/FMC/<br>OTG_HS/<br>QUADSPI/<br>SAI1/2/<br>SDMMC2 | ETH1/2/<br>QUADSPI/<br>SDMMC1/<br>UART5                                 | ETH2/FMC/<br>SAI1/2/<br>SDMMC1 | ETH2/<br>QUADSPI/<br>UART7 |      | HDP/SYS |
| Port A | PA0  | UART5_TX                                                    | -                                                        | -                                                       | ETH1_MII_CRD                                                            | ETH2_MII_CRD                   | -                          | -    | -       |
|        | PA1  | -                                                           | -                                                        | -                                                       | ETH1_MII_RX_<br>CLK/<br>ETH1_RGMII_<br>RX_CLK/<br>ETH1_RMII_<br>REF_CLK | -                              | -                          | -    | -       |
|        | PA2  | -                                                           | -                                                        | -                                                       | ETH1_MDIO                                                               | -                              | -                          | -    | -       |
|        | PA3  | -                                                           | -                                                        | -                                                       | ETH1_MII_COL                                                            | ETH2_MII_COL                   | -                          | -    | -       |
|        | PA4  | -                                                           | -                                                        | ETH1_PPS_<br>OUT                                        | ETH2_PPS_<br>OUT                                                        | SAI1_SCK_A                     | -                          | -    | -       |
|        | PA5  | -                                                           | -                                                        | ETH1_PPS_<br>OUT                                        | ETH2_PPS_<br>OUT                                                        | -                              | -                          | -    | -       |
|        | PA6  | UART4_RTS/<br>UART4_DE                                      | TIM13_CH1                                                | -                                                       | -                                                                       | SAI2_SCK_A                     | -                          | -    | -       |
|        | PA7  | -                                                           | TIM14_CH1                                                | -                                                       | ETH1_MII_RX_<br>DV/<br>ETH1_RGMII_<br>RX_CTL/<br>ETH1_RMII_<br>CRD_DV   | SAI2_SD_A                      | -                          | -    | -       |
|        | PA8  | SPI2_MOSI/<br>I2S2_SDO                                      | -                                                        | OTG_HS_SOF                                              | ETH2_MII_<br>RXD3/<br>ETH2_RGMII_<br>RXD3                               | FMC_A21                        | -                          | -    | -       |
|        | PA9  | UART4_TX                                                    | -                                                        | FMC_NWAIT                                               | -                                                                       | -                              | -                          | -    | -       |
|        | PA10 | -                                                           | -                                                        | -                                                       | -                                                                       | -                              | -                          | -    | -       |



Table 9. Alternate function AF8 to AF15 (continued)

| Port   |      | AF8                                                         | AF9                                                      | AF10                                                             | AF11                                                                  | AF12                           | AF13                       | AF14 | AF15    |
|--------|------|-------------------------------------------------------------|----------------------------------------------------------|------------------------------------------------------------------|-----------------------------------------------------------------------|--------------------------------|----------------------------|------|---------|
|        |      | SDMMC1/<br>SPDIFRX/SPI2/<br>I2S2/<br>UART4/5/7/8/<br>USART3 | FDCAN1/2/QU<br>ADSPI/<br>SDMMC2/<br>SPDIFRX/<br>TIM13/14 | ETH1/2/FMC/<br>OTG_HS/<br>QUADSPI/<br>SAI1/2/<br>SDMMC2          | ETH1/2/<br>QUADSPI/<br>SDMMC1/<br>UART5                               | ETH2/FMC/<br>SAI1/2/<br>SDMMC1 | ETH2/<br>QUADSPI/<br>UART7 |      | HDP/SYS |
| Port A | PA11 | -                                                           | -                                                        | ETH2_MII_<br>RXD1/<br>ETH2_RGMII_<br>RXD1/<br>ETH2_RMII_<br>RXD1 | ETH1_CLK                                                              | -                              | ETH2_CLK                   | -    | -       |
|        | PA12 | -                                                           | -                                                        | -                                                                | ETH2_MII_RX_<br>DV/<br>ETH2_RGMII_<br>RX_CTL/<br>ETH2_RMII_<br>CRS_DV | FMC_A7                         | -                          | -    | -       |
|        | PA13 | UART4_TX                                                    | -                                                        | -                                                                | -                                                                     | -                              | -                          | -    | -       |
|        | PA14 | -                                                           | -                                                        | OTG_HS_SOF                                                       | -                                                                     | -                              | -                          | -    | -       |
|        | PA15 | UART4_RX                                                    | -                                                        | -                                                                | -                                                                     | FMC_A9                         | -                          | -    | HDP5    |
| Port B | PB0  | UART4_CTS                                                   | -                                                        | SAI2_D2                                                          | ETH1_MII_<br>RXD2/<br>ETH1_RGMII_<br>RXD2                             | -                              | -                          | -    | -       |
|        | PB1  | -                                                           | -                                                        | -                                                                | ETH1_MII_<br>RXD3/<br>ETH1_RGMII_<br>RXD3                             | -                              | -                          | -    | -       |
|        | PB2  | UART4_RX                                                    | QUADSPI_<br>BK1_NCS                                      | -                                                                | ETH2_MDIO                                                             | FMC_A6                         | -                          | -    | -       |
|        | PB3  | SDMMC1_<br>D123DIR                                          | -                                                        | SDMMC2_D2                                                        | -                                                                     | SAI2_MCLK_A                    | UART7_RX                   | -    | -       |

Table 9. Alternate function AF8 to AF15 (continued)

| Port   |      | AF8                                                         | AF9                                                      | AF10                                                    | AF11                                                                 | AF12                           | AF13                       | AF14 | AF15    |
|--------|------|-------------------------------------------------------------|----------------------------------------------------------|---------------------------------------------------------|----------------------------------------------------------------------|--------------------------------|----------------------------|------|---------|
|        |      | SDMMC1/<br>SPDIFRX/SPI2/<br>I2S2/<br>UART4/5/7/8/<br>USART3 | FDCAN1/2/QU<br>ADSPI/<br>SDMMC2/<br>SPDIFRX/<br>TIM13/14 | ETH1/2/FMC/<br>OTG_HS/<br>QUADSPI/<br>SAI1/2/<br>SDMMC2 | ETH1/2/<br>QUADSPI/<br>SDMMC1/<br>UART5                              | ETH2/FMC/<br>SAI1/2/<br>SDMMC1 | ETH2/<br>QUADSPI/<br>UART7 |      | HDP/SYS |
| Port B | PB4  | -                                                           | -                                                        | SDMMC2_D3                                               | -                                                                    | SAI2_SCK_A                     | -                          | -    | -       |
|        | PB5  | SDMMC1_<br>CKIN                                             | FDCAN2_RX                                                | -                                                       | UART5_RX                                                             | -                              | -                          | -    | -       |
|        | PB6  | -                                                           | QUADSPI_<br>BK1_NCS                                      | -                                                       | ETH2_MDIO                                                            | FMC_NE3                        | -                          | -    | HDP6    |
|        | PB7  | -                                                           | -                                                        | FMC_NCE2                                                | -                                                                    | FMC_NL                         | -                          | -    | -       |
|        | PB8  | UART4_RX                                                    | -                                                        | SAI1_D1                                                 | -                                                                    | FMC_D13/FMC<br>_AD13           | -                          | -    | -       |
|        | PB9  | -                                                           | FDCAN1_TX                                                | SDMMC2_D5                                               | UART5_TX                                                             | SDMMC1_<br>CDIR                | -                          | -    | -       |
|        | PB10 | -                                                           | -                                                        | -                                                       | -                                                                    | -                              | -                          | -    | -       |
|        | PB11 | -                                                           | -                                                        | -                                                       | ETH1_MII_TX_<br>EN/<br>ETH1_RGMII_<br>TX_CTL/<br>ETH1_RMII_TX<br>_EN | -                              | -                          | -    | -       |
|        | PB12 | USART3_RX                                                   | -                                                        | -                                                       | UART5_RX                                                             | SDMMC1_D5                      | -                          | -    | -       |
|        | PB13 | SDMMC1_<br>D123DIR                                          | FDCAN2_TX                                                | -                                                       | UART5_TX                                                             | -                              | -                          | -    | -       |
| Port B | PB14 | -                                                           | -                                                        | SDMMC2_D0                                               | SDMMC1_D4                                                            | -                              | -                          | -    | -       |
|        | PB15 | SDMMC1_<br>CKIN                                             | -                                                        | SDMMC2_D1                                               | -                                                                    | SAI2_FS_A                      | -                          | -    | -       |



Table 9. Alternate function AF8 to AF15 (continued)

| Port   |     | AF8                                                         | AF9                                                      | AF10                                                    | AF11                                                             | AF12                           | AF13                       | AF14 | AF15    |
|--------|-----|-------------------------------------------------------------|----------------------------------------------------------|---------------------------------------------------------|------------------------------------------------------------------|--------------------------------|----------------------------|------|---------|
|        |     | SDMMC1/<br>SPDIFRX/SPI2/<br>I2S2/<br>UART4/5/7/8/<br>USART3 | FDCAN1/2/QU<br>ADSPI/<br>SDMMC2/<br>SPDIFRX/<br>TIM13/14 | ETH1/2/FMC/<br>OTG_HS/<br>QUADSPI/<br>SAI1/2/<br>SDMMC2 | ETH1/2/<br>QUADSPI/<br>SDMMC1/<br>UART5                          | ETH2/FMC/<br>SAI1/2/<br>SDMMC1 | ETH2/<br>QUADSPI/<br>UART7 |      | HDP/SYS |
| Port C | PC0 | -                                                           | -                                                        | -                                                       | -                                                                | -                              | -                          | -    | -       |
|        | PC1 | -                                                           | -                                                        | ETH1_MII_RX_<br>DV/<br>ETH1_RMII_<br>CRS_DV             | ETH1_RGMII_<br>GTX_CLK                                           | -                              | -                          | -    | -       |
|        | PC2 | -                                                           | -                                                        | SAI2_CK1                                                | ETH1_MII_<br>TXD2/<br>ETH1_RGMII_<br>TXD2                        | -                              | -                          | -    | -       |
|        | PC3 | UART5_CTS                                                   | -                                                        | SAI1_MCLK_A                                             | ETH1_MII_TX_<br>CLK                                              | ETH2_MII_TX_<br>CLK            | -                          | -    | -       |
|        | PC4 | UART5_RTS/<br>UART5_DE                                      | SPDIFRX_IN2                                              | -                                                       | ETH1_MII_<br>RXD0/<br>ETH1_RGMII_<br>RXD0/<br>ETH1_RMII_<br>RXD0 | SAI2_D3                        | -                          | -    | -       |
|        | PC5 | -                                                           | SPDIFRX_IN3                                              | -                                                       | ETH1_MII_<br>RXD1/<br>ETH1_RGMII_<br>RXD1/<br>ETH1_RMII_<br>RXD1 | -                              | -                          | -    | -       |
|        | PC6 | SDMMC1_D6                                                   | SDMMC2_<br>D0DIR                                         | SDMMC2_D6                                               | -                                                                | FMC_A19                        | -                          | -    | HDP2    |



Table 9. Alternate function AF8 to AF15 (continued)

| Port   |      | AF8                                                         | AF9                                                      | AF10                                                    | AF11                                    | AF12                           | AF13                       | AF14 | AF15    |
|--------|------|-------------------------------------------------------------|----------------------------------------------------------|---------------------------------------------------------|-----------------------------------------|--------------------------------|----------------------------|------|---------|
|        |      | SDMMC1/<br>SPDIFRX/SPI2/<br>I2S2/<br>UART4/5/7/8/<br>USART3 | FDCAN1/2/QU<br>ADSPI/<br>SDMMC2/<br>SPDIFRX/<br>TIM13/14 | ETH1/2/FMC/<br>OTG_HS/<br>QUADSPI/<br>SAI1/2/<br>SDMMC2 | ETH1/2/<br>QUADSPI/<br>SDMMC1/<br>UART5 | ETH2/FMC/<br>SAI1/2/<br>SDMMC1 | ETH2/<br>QUADSPI/<br>UART7 |      | HDP/SYS |
| Port C | PC7  | USART3_CTS                                                  | SDMMC2_<br>CDIR                                          | SDMMC2_D7                                               | -                                       | SDMMC1_D7                      | -                          | -    | HDP4    |
|        | PC8  | USART3_CTS                                                  | -                                                        | SAI2_FS_B                                               | UART5_RTS/<br>UART5_DE                  | SDMMC1_D0                      | -                          | -    | -       |
|        | PC9  | UART5_CTS                                                   | FDCAN1_TX                                                | -                                                       | -                                       | SDMMC1_D1                      | -                          | -    | -       |
|        | PC10 | -                                                           | -                                                        | SAI2_MCLK_B                                             | -                                       | SDMMC1_D2                      | -                          | -    | -       |
|        | PC11 | UART5_RX                                                    | -                                                        | SAI2_SCK_B                                              | -                                       | SDMMC1_D3                      | -                          | -    | -       |
|        | PC12 | UART7_TX                                                    | -                                                        | SAI2_SD_B                                               | -                                       | SDMMC1_CK                      | -                          | -    | -       |
|        | PC13 | -                                                           | -                                                        | -                                                       | -                                       | -                              | -                          | -    | -       |
|        | PC14 | -                                                           | -                                                        | -                                                       | -                                       | -                              | -                          | -    | -       |
| Port D | PD0  | -                                                           | FDCAN1_RX                                                | -                                                       | -                                       | FMC_D2/<br>FMC_AD2             | -                          | -    | -       |
|        | PD1  | UART4_TX                                                    | QUADSPI_BK1<br>_NCS                                      | -                                                       | -                                       | FMC_D3/<br>FMC_AD3             | -                          | -    | -       |



Table 9. Alternate function AF8 to AF15 (continued)

| Port   |      | AF8                                                         | AF9                                                      | AF10                                                                    | AF11                                    | AF12                           | AF13                       | AF14 | AF15    |
|--------|------|-------------------------------------------------------------|----------------------------------------------------------|-------------------------------------------------------------------------|-----------------------------------------|--------------------------------|----------------------------|------|---------|
|        |      | SDMMC1/<br>SPDIFRX/SPI2/<br>I2S2/<br>UART4/5/7/8/<br>USART3 | FDCAN1/2/QU<br>ADSPI/<br>SDMMC2/<br>SPDIFRX/<br>TIM13/14 | ETH1/2/FMC/<br>OTG_HS/<br>QUADSPI/<br>SAI1/2/<br>SDMMC2                 | ETH1/2/<br>QUADSPI/<br>SDMMC1/<br>UART5 | ETH2/FMC/<br>SAI1/2/<br>SDMMC1 | ETH2/<br>QUADSPI/<br>UART7 |      | HDP/SYS |
| Port D | PD2  | -                                                           | -                                                        | -                                                                       | -                                       | SDMMC1_CMD                     | -                          | -    | -       |
|        | PD3  | -                                                           | -                                                        | -                                                                       | -                                       | FMC_CLK                        | -                          | -    | -       |
|        | PD4  | -                                                           | QUADSPI_CLK                                              | -                                                                       | -                                       | FMC_NOE                        | -                          | -    | -       |
|        | PD5  | -                                                           | QUADSPI_BK1<br>_IO0                                      | -                                                                       | -                                       | FMC_NWE                        | -                          | -    | -       |
|        | PD6  | UART4_TX                                                    | -                                                        | -                                                                       | -                                       | -                              | -                          | -    | -       |
|        | PD7  | -                                                           | SPDIFRX_IN0                                              | ETH1_MII_RX_<br>CLK/<br>ETH1_RGMII_<br>RX_CLK/<br>ETH1_RMII_<br>REF_CLK | QUADSPI_BK1<br>_IO2                     | FMC_NE1                        | -                          | -    | -       |
|        | PD8  | UART4_RX                                                    | -                                                        | -                                                                       | -                                       | -                              | -                          | -    | -       |
|        | PD9  | -                                                           | -                                                        | SDMMC2_<br>CDIR                                                         | -                                       | FMC_D14/<br>FMC_AD14           | -                          | -    | -       |
|        | PD10 | -                                                           | -                                                        | -                                                                       | -                                       | FMC_D15/<br>FMC_AD15           | -                          | -    | -       |
|        | PD11 | SPDIFRX_IN0                                                 | QUADSPI_BK1<br>_IO2                                      | ETH2_RGMII_<br>CLK125                                                   | -                                       | FMC_CLE/FMC<br>_A16            | UART7_RX                   | -    | -       |
|        | PD12 | -                                                           | -                                                        | -                                                                       | -                                       | FMC_ALE/FMC<br>_A17            | -                          | -    | -       |
|        | PD13 | -                                                           | QUADSPI_BK1<br>_IO3                                      | -                                                                       | QUADSPI_BK2<br>_IO2                     | FMC_A18                        | -                          | -    | -       |

Table 9. Alternate function AF8 to AF15 (continued)

| Port   |      | AF8                                                         | AF9                                                      | AF10                                                             | AF11                                      | AF12                           | AF13                       | AF14 | AF15    |
|--------|------|-------------------------------------------------------------|----------------------------------------------------------|------------------------------------------------------------------|-------------------------------------------|--------------------------------|----------------------------|------|---------|
|        |      | SDMMC1/<br>SPDIFRX/SPI2/<br>I2S2/<br>UART4/5/7/8/<br>USART3 | FDCAN1/2/QU<br>ADSPI/<br>SDMMC2/<br>SPDIFRX/<br>TIM13/14 | ETH1/2/FMC/<br>OTG_HS/<br>QUADSPI/<br>SAI1/2/<br>SDMMC2          | ETH1/2/<br>QUADSPI/<br>SDMMC1/<br>UART5   | ETH2/FMC/<br>SAI1/2/<br>SDMMC1 | ETH2/<br>QUADSPI/<br>UART7 |      | HDP/SYS |
| Port D | PD14 | UART8_CTS                                                   | -                                                        | -                                                                | -                                         | FMC_D0/FMC_<br>AD0             | -                          | -    | -       |
|        | PD15 | -                                                           | QUADSPI_BK1<br>_IO3                                      | -                                                                | -                                         | FMC_D1/FMC_<br>AD1             | -                          | -    | -       |
| Port E | PE0  | UART8_RX                                                    | FDCAN2_RX                                                | -                                                                | -                                         | FMC_A11                        | -                          | -    | -       |
|        | PE1  | UART8_TX                                                    | -                                                        | -                                                                | -                                         | FMC_NBL1                       | -                          | -    | -       |
|        | PE2  | -                                                           | SPDIFRX_IN1                                              | ETH2_MII_<br>RXD1/<br>ETH2_RGMII_<br>RXD1/<br>ETH2_RMII_<br>RXD1 | -                                         | FMC_A23                        | -                          | -    | -       |
|        | PE3  | USART3_RTS/<br>USART3_DE                                    | FDCAN1_RX                                                | SDMMC2_CK                                                        | -                                         | -                              | -                          | -    | -       |
|        | PE4  | UART8_TX                                                    | QUADSPI_BK2<br>_NCS                                      | FMC_NCE2                                                         | -                                         | FMC_A25                        | -                          | -    | -       |
|        | PE5  | UART4_RX                                                    | -                                                        | ETH1_MII_<br>TXD3/<br>ETH1_RGMII_<br>TXD3                        | -                                         | FMC_NE1                        | -                          | -    | -       |
|        | PE6  | UART4_RTS/<br>UART4_DE                                      | -                                                        | -                                                                | ETH2_MII_<br>TXD3/<br>ETH2_RGMII_<br>TXD3 | FMC_A22                        | -                          | -    | -       |
|        | PE7  | UART5_TX                                                    | -                                                        | -                                                                | -                                         | FMC_D4/<br>FMC_AD4             | -                          | -    | -       |



Table 9. Alternate function AF8 to AF15 (continued)

| Port   |      | AF8                                                         | AF9                                                      | AF10                                                    | AF11                                    | AF12                           | AF13                       | AF14 | AF15    |
|--------|------|-------------------------------------------------------------|----------------------------------------------------------|---------------------------------------------------------|-----------------------------------------|--------------------------------|----------------------------|------|---------|
|        |      | SDMMC1/<br>SPDIFRX/SPI2/<br>I2S2/<br>UART4/5/7/8/<br>USART3 | FDCAN1/2/QU<br>ADSPI/<br>SDMMC2/<br>SPDIFRX/<br>TIM13/14 | ETH1/2/FMC/<br>OTG_HS/<br>QUADSPI/<br>SAI1/2/<br>SDMMC2 | ETH1/2/<br>QUADSPI/<br>SDMMC1/<br>UART5 | ETH2/FMC/<br>SAI1/2/<br>SDMMC1 | ETH2/<br>QUADSPI/<br>UART7 |      | HDP/SYS |
| Port E | PE8  | -                                                           | -                                                        | -                                                       | -                                       | FMC_D5/<br>FMC_AD5             | -                          | -    | -       |
|        | PE9  | -                                                           | QUADSPI_BK1<br>_IO1                                      | -                                                       | -                                       | FMC_D6/<br>FMC_AD6             | -                          | -    | HDP3    |
|        | PE10 | -                                                           | FDCAN1_TX                                                | -                                                       | -                                       | FMC_D7/<br>FMC_AD7             | -                          | -    | -       |
|        | PE11 | -                                                           | -                                                        | ETH2_MII_TX_<br>ER                                      | ETH1_MII_TX_<br>ER                      | FMC_D8/<br>FMC_AD8             | -                          | -    | -       |
|        | PE12 | UART8_RTS/<br>UART8_DE                                      | -                                                        | -                                                       | -                                       | FMC_D9/<br>FMC_AD9             | -                          | -    | HDP4    |
|        | PE13 | -                                                           | -                                                        | -                                                       | -                                       | FMC_D10/<br>FMC_AD10           | -                          | -    | -       |
|        | PE14 | UART8_RTS/<br>UART8_DE                                      | QUADSPI_BK1<br>_NCS                                      | QUADSPI_BK2<br>_IO2                                     | -                                       | FMC_D11/<br>FMC_AD11           | -                          | -    | -       |
|        | PE15 | -                                                           | -                                                        | -                                                       | -                                       | FMC_D12/<br>FMC_AD12           | -                          | -    | HDP7    |
| Port F | PF0  | -                                                           | -                                                        | SDMMC2_D4                                               | -                                       | FMC_A0                         | -                          | -    | -       |
|        | PF1  | -                                                           | -                                                        | -                                                       | -                                       | FMC_A1                         | -                          | -    | HDP7    |
|        | PF2  | -                                                           | SDMMC2_<br>D0DIR                                         | -                                                       | SDMMC1_<br>D0DIR                        | FMC_A2                         | -                          | -    | -       |
|        | PF3  | -                                                           | -                                                        | -                                                       | -                                       | FMC_A3                         | -                          | -    | -       |

Table 9. Alternate function AF8 to AF15 (continued)

| Port   |      | AF8                                                         | AF9                                                      | AF10                                                    | AF11                                                                 | AF12                           | AF13                       | AF14 | AF15    |
|--------|------|-------------------------------------------------------------|----------------------------------------------------------|---------------------------------------------------------|----------------------------------------------------------------------|--------------------------------|----------------------------|------|---------|
|        |      | SDMMC1/<br>SPDIFRX/SPI2/<br>I2S2/<br>UART4/5/7/8/<br>USART3 | FDCAN1/2/QU<br>ADSPI/<br>SDMMC2/<br>SPDIFRX/<br>TIM13/14 | ETH1/2/FMC/<br>OTG_HS/<br>QUADSPI/<br>SAI1/2/<br>SDMMC2 | ETH1/2/<br>QUADSPI/<br>SDMMC1/<br>UART5                              | ETH2/FMC/<br>SAI1/2/<br>SDMMC1 | ETH2/<br>QUADSPI/<br>UART7 |      | HDP/SYS |
| Port F | PF4  | -                                                           | -                                                        | -                                                       | ETH2_MII_<br>RXD0/<br>ETH2_RGMII_<br>RXD0/<br>ETH2_RMII_<br>RXD0     | FMC_A4                         | -                          | -    | -       |
|        | PF5  | -                                                           | -                                                        | -                                                       | -                                                                    | FMC_A5                         | -                          | -    | -       |
|        | PF6  | -                                                           | QUADSPI_BK1<br>_IO2                                      | -                                                       | ETH2_MII_TX_<br>EN/<br>ETH2_RGMII_<br>TX_CTL/<br>ETH2_RMII_TX<br>_EN | -                              | -                          | -    | -       |
|        | PF7  | UART4_CTS                                                   | -                                                        | ETH1_RGMII_<br>CLK125                                   | ETH2_MII_<br>TXD0/<br>ETH2_RGMII_<br>TXD0/<br>ETH2_RMII_<br>TXD0     | FMC_A18                        | -                          | -    | -       |
|        | PF8  | -                                                           | TIM13_CH1                                                | QUADSPI_BK1<br>_IO0                                     | -                                                                    | -                              | -                          | -    | -       |
|        | PF9  | UART8_RX                                                    | TIM14_CH1                                                | QUADSPI_BK1<br>_IO1                                     | QUADSPI_BK2<br>_IO3                                                  | FMC_A9                         | -                          | -    | -       |
|        | PF10 | UART7_RTS/<br>UART7_DE                                      | QUADSPI_CLK                                              | -                                                       | -                                                                    | -                              | -                          | -    | -       |
|        | PF11 | -                                                           | -                                                        | -                                                       | -                                                                    | ETH2_MII_RX_<br>ER             | -                          | -    | -       |



Table 9. Alternate function AF8 to AF15 (continued)

| Port   |      | AF8                                                         | AF9                                                      | AF10                                                    | AF11                                    | AF12                           | AF13                       | AF14 | AF15    |
|--------|------|-------------------------------------------------------------|----------------------------------------------------------|---------------------------------------------------------|-----------------------------------------|--------------------------------|----------------------------|------|---------|
|        |      | SDMMC1/<br>SPDIFRX/SPI2/<br>I2S2/<br>UART4/5/7/8/<br>USART3 | FDCAN1/2/QU<br>ADSPI/<br>SDMMC2/<br>SPDIFRX/<br>TIM13/14 | ETH1/2/FMC/<br>OTG_HS/<br>QUADSPI/<br>SAI1/2/<br>SDMMC2 | ETH1/2/<br>QUADSPI/<br>SDMMC1/<br>UART5 | ETH2/FMC/<br>SAI1/2/<br>SDMMC1 | ETH2/<br>QUADSPI/<br>UART7 |      | HDP/SYS |
| Port F | PF12 | UART4_TX                                                    | -                                                        | ETH1_MII_TX_<br>ER                                      | ETH1_RGMII_<br>CLK125                   | -                              | -                          | -    | -       |
|        | PF13 | UART5_RX                                                    | -                                                        | -                                                       | -                                       | -                              | -                          | -    | -       |
|        | PF14 | -                                                           | -                                                        | -                                                       | -                                       | -                              | -                          | -    | -       |
|        | PF15 | -                                                           | -                                                        | -                                                       | -                                       | -                              | -                          | -    | -       |
| Port G | PG0  | -                                                           | FDCAN2_TX                                                | -                                                       | -                                       | FMC_A10                        | -                          | -    | -       |
|        | PG1  | -                                                           | FDCAN2_TX                                                | ETH2_MII_TXD<br>2/ETH2_RGMII_<br>_TXD2                  | -                                       | FMC_NBL0                       | -                          | -    | -       |
|        | PG2  | -                                                           | -                                                        | SAI2_MCLK_B                                             | ETH1_MDC                                | -                              | -                          | -    | -       |
|        | PG3  | -                                                           | FDCAN2_RX                                                | ETH2_RGMII_<br>GTX_CLK                                  | ETH1_MDIO                               | FMC_A13                        | -                          | -    | -       |
|        | PG4  | USART3_RX                                                   | -                                                        | SDMMC2_<br>D123DIR                                      | -                                       | FMC_A14                        | -                          | -    | HDP1    |
|        | PG5  | -                                                           | -                                                        | ETH2_MDC                                                | -                                       | FMC_A15                        | -                          | -    | -       |
|        | PG6  | -                                                           | -                                                        | SDMMC2_CMD                                              | -                                       | -                              | -                          | -    | HDP3    |
|        | PG7  | UART7_CTS                                                   | -                                                        | SDMMC2_<br>CKIN                                         | -                                       | -                              | -                          | -    | -       |
|        | PG8  | USART3_RTS/<br>USART3_DE                                    | SPDIFRX_IN2                                              | QUADSPI_BK2<br>_IO2                                     | QUADSPI_BK1<br>_IO3                     | FMC_NE2                        | ETH2_CLK                   | -    | -       |

Table 9. Alternate function AF8 to AF15 (continued)

| Port   |      | AF8                                                         | AF9                                                      | AF10                                                             | AF11                                                             | AF12                                                                  | AF13                       | AF14 | AF15    |
|--------|------|-------------------------------------------------------------|----------------------------------------------------------|------------------------------------------------------------------|------------------------------------------------------------------|-----------------------------------------------------------------------|----------------------------|------|---------|
|        |      | SDMMC1/<br>SPDIFRX/SPI2/<br>I2S2/<br>UART4/5/7/8/<br>USART3 | FDCAN1/2/QU<br>ADSPI/<br>SDMMC2/<br>SPDIFRX/<br>TIM13/14 | ETH1/2/FMC/<br>OTG_HS/<br>QUADSPI/<br>SAI1/2/<br>SDMMC2          | ETH1/2/<br>QUADSPI/<br>SDMMC1/<br>UART5                          | ETH2/FMC/<br>SAI1/2/<br>SDMMC1                                        | ETH2/<br>QUADSPI/<br>UART7 |      | HDP/SYS |
| Port G | PG9  | SPDIFRX_IN3                                                 | FDCAN1_RX                                                | FMC_NE2                                                          | -                                                                | FMC_NCE                                                               | -                          | -    | -       |
|        | PG10 | UART8_CTS                                                   | FDCAN1_TX                                                | QUADSPI_BK2<br>_IO1                                              | -                                                                | FMC_NE3                                                               | -                          | -    | -       |
|        | PG11 | UART4_TX                                                    | -                                                        | ETH2_MII_<br>TXD1/<br>ETH2_RGMII_<br>TXD1/<br>ETH2_RMII_<br>TXD1 | -                                                                | FMC_A24                                                               | -                          | -    | -       |
|        | PG12 | USART3_CTS                                                  | -                                                        | ETH2_PHY_<br>INTN                                                | ETH1_PHY_<br>INTN                                                | ETH2_MII_RX_<br>DV/<br>ETH2_RGMII_<br>RX_CTL/<br>ETH2_RMII_<br>CRS_DV | -                          | -    | -       |
|        | PG13 | -                                                           | -                                                        | -                                                                | ETH1_MII_<br>TXD0/<br>ETH1_RGMII_<br>TXD0/<br>ETH1_RMII_<br>TXD0 | -                                                                     | -                          | -    | -       |
|        | PG14 | -                                                           | -                                                        | SAI2_SD_A                                                        | ETH1_MII_<br>TXD1/<br>ETH1_RGMII_<br>TXD1/<br>ETH1_RMII_<br>TXD1 | -                                                                     | -                          | -    | -       |
| Port G | PG15 | UART7_CTS                                                   | QUADSPI_BK1<br>_IO1                                      | ETH2_PHY_<br>INTN                                                | -                                                                | -                                                                     | -                          | -    | -       |



Table 9. Alternate function AF8 to AF15 (continued)

| Port   |      | AF8                                                         | AF9                                                      | AF10                                                    | AF11                                    | AF12                                      | AF13                       | AF14 | AF15    |
|--------|------|-------------------------------------------------------------|----------------------------------------------------------|---------------------------------------------------------|-----------------------------------------|-------------------------------------------|----------------------------|------|---------|
|        |      | SDMMC1/<br>SPDIFRX/SPI2/<br>I2S2/<br>UART4/5/7/8/<br>USART3 | FDCAN1/2/QU<br>ADSPI/<br>SDMMC2/<br>SPDIFRX/<br>TIM13/14 | ETH1/2/FMC/<br>OTG_HS/<br>QUADSPI/<br>SAI1/2/<br>SDMMC2 | ETH1/2/<br>QUADSPI/<br>SDMMC1/<br>UART5 | ETH2/FMC/<br>SAI1/2/<br>SDMMC1            | ETH2/<br>QUADSPI/<br>UART7 |      | HDP/SYS |
| Port H | PH0  | -                                                           | -                                                        | -                                                       | -                                       | -                                         | -                          | -    | -       |
|        | PH1  | -                                                           | -                                                        | -                                                       | -                                       | -                                         | -                          | -    | -       |
|        | PH2  | UART7_TX                                                    | QUADSPI_BK2<br>_IO0                                      | ETH2_MII_CRS                                            | ETH1_MII_CRS                            | FMC_NE4                                   | ETH2_RGMII_<br>CLK125      | -    | -       |
|        | PH3  | -                                                           | QUADSPI_BK2<br>_IO1                                      | ETH1_MII_COL                                            | -                                       | ETH2_MII_COL                              | QUADSPI_BK1<br>_IO0        | -    | -       |
|        | PH4  | -                                                           | -                                                        | -                                                       | -                                       | -                                         | -                          | -    | -       |
|        | PH5  | -                                                           | -                                                        | -                                                       | -                                       | -                                         | -                          | -    | -       |
|        | PH6  | -                                                           | QUADSPI_BK1<br>_IO2                                      | ETH1_PHY_IN<br>TN                                       | ETH1_MII_RX_<br>ER                      | ETH2_MII_<br>RXD2/<br>ETH2_RGMII_<br>RXD2 | QUADSPI_BK1<br>_NCS        | -    | -       |
|        | PH7  | -                                                           | QUADSPI_BK2<br>_IO3                                      | ETH2_MII_TX_<br>CLK                                     | ETH1_MII_TX_<br>CLK                     | -                                         | QUADSPI_BK1<br>_IO3        | -    | -       |
|        | PH8  | -                                                           | -                                                        | -                                                       | -                                       | FMC_A8                                    | -                          | -    | HDP2    |
|        | PH9  | -                                                           | -                                                        | -                                                       | -                                       | FMC_A20                                   | -                          | -    | -       |
|        | PH10 | SDMMC1_D4                                                   | -                                                        | -                                                       | -                                       | -                                         | -                          | -    | HDP0    |



Table 9. Alternate function AF8 to AF15 (continued)

| Port   |      | AF8                                                         | AF9                                                      | AF10                                                    | AF11                                                                    | AF12                           | AF13                       | AF14 | AF15    |
|--------|------|-------------------------------------------------------------|----------------------------------------------------------|---------------------------------------------------------|-------------------------------------------------------------------------|--------------------------------|----------------------------|------|---------|
|        |      | SDMMC1/<br>SPDIFRX/SPI2/<br>I2S2/<br>UART4/5/7/8/<br>USART3 | FDCAN1/2/QU<br>ADSPI/<br>SDMMC2/<br>SPDIFRX/<br>TIM13/14 | ETH1/2/FMC/<br>OTG_HS/<br>QUADSPI/<br>SAI1/2/<br>SDMMC2 | ETH1/2/<br>QUADSPI/<br>SDMMC1/<br>UART5                                 | ETH2/FMC/<br>SAI1/2/<br>SDMMC1 | ETH2/<br>QUADSPI/<br>UART7 |      | HDP/SYS |
| Port H | PH11 | -                                                           | QUADSPI_BK2<br>_IO0                                      | -                                                       | ETH2_MII_RX_<br>CLK/<br>ETH2_RGMII_<br>RX_CLK/<br>ETH2_RMII_<br>REF_CLK | FMC_A12                        | -                          | -    | -       |
|        | PH12 | -                                                           | QUADSPI_BK2<br>_IO2                                      | SAI1_CK2                                                | ETH1_MII_CRS                                                            | FMC_A6                         | -                          | -    | -       |
|        | PH13 | UART4_TX                                                    | -                                                        | -                                                       | -                                                                       | -                              | -                          | -    | -       |
|        | PH14 | UART4_RX                                                    | -                                                        | -                                                       | -                                                                       | -                              | -                          | -    | -       |
| Port I | PI0  | SPDIFRX_IN0                                                 | -                                                        | -                                                       | -                                                                       | -                              | -                          | -    | -       |
|        | PI1  | SPDIFRX_IN1                                                 | -                                                        | -                                                       | -                                                                       | -                              | -                          | -    | -       |
|        | PI2  | SPDIFRX_IN2                                                 | -                                                        | -                                                       | -                                                                       | -                              | -                          | -    | -       |
|        | PI3  | SPDIFRX_IN3                                                 | -                                                        | -                                                       | ETH1_MII_RX_<br>ER                                                      | -                              | -                          | -    | -       |
|        | PI4  | -                                                           | -                                                        | -                                                       | -                                                                       | -                              | -                          | -    | -       |
|        | PI5  | -                                                           | -                                                        | -                                                       | -                                                                       | -                              | -                          | -    | -       |
|        | PI6  | -                                                           | -                                                        | -                                                       | -                                                                       | -                              | -                          | -    | -       |
|        | PI7  | -                                                           | -                                                        | -                                                       | -                                                                       | -                              | -                          | -    | -       |

## 5 Memory mapping

Refer to the product line reference manual for details on the memory mapping as well as the boundary addresses for all peripherals.

## 6 Electrical characteristics

### 6.1 Parameter conditions

Unless otherwise specified, all voltages are referenced to  $V_{SS}$ .

#### 6.1.1 Minimum and maximum values

Unless otherwise specified the minimum and maximum values are guaranteed in the worst conditions of junction temperature, supply voltage and frequencies by tests in production on 100% of the devices with an junction temperature at  $T_J = 25\text{ }^{\circ}\text{C}$  and  $T_J = T_{J\text{max}}$  (given by the selected temperature range).

Data based on characterization results, design simulation and/or technology characteristics are indicated in the table footnotes and are not tested in production. Based on characterization, the minimum and maximum values refer to sample tests and represent the mean value plus or minus three times the standard deviation ( $\text{mean} \pm 3\sigma$ ).

#### 6.1.2 Typical values

Unless otherwise specified, typical data are based on  $T_J = 25\text{ }^{\circ}\text{C}$ ,  $V_{DD} = 3.3\text{ V}$ ,  $V_{DD\text{CORE}} = 1.25\text{ V}$ ,  $V_{DD\text{CPU}} = 1.25\text{ V}$ . They are given only as design guidelines and are not tested.

Typical ADC accuracy values are determined by characterization of a batch of samples from a standard diffusion lot over the full temperature range, where 95% of the devices have an error less than or equal to the value indicated ( $\text{mean} \pm 2\sigma$ ).

#### 6.1.3 Typical curves

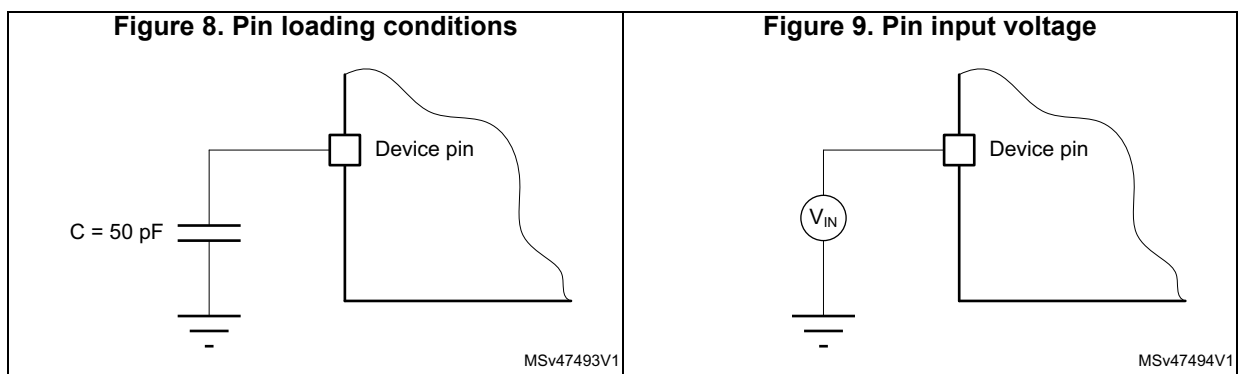
Unless otherwise specified, all typical curves are given only as design guidelines and are not tested.

#### 6.1.4 Loading capacitor

The loading conditions used for pin parameter measurement are shown in [Figure 8](#).

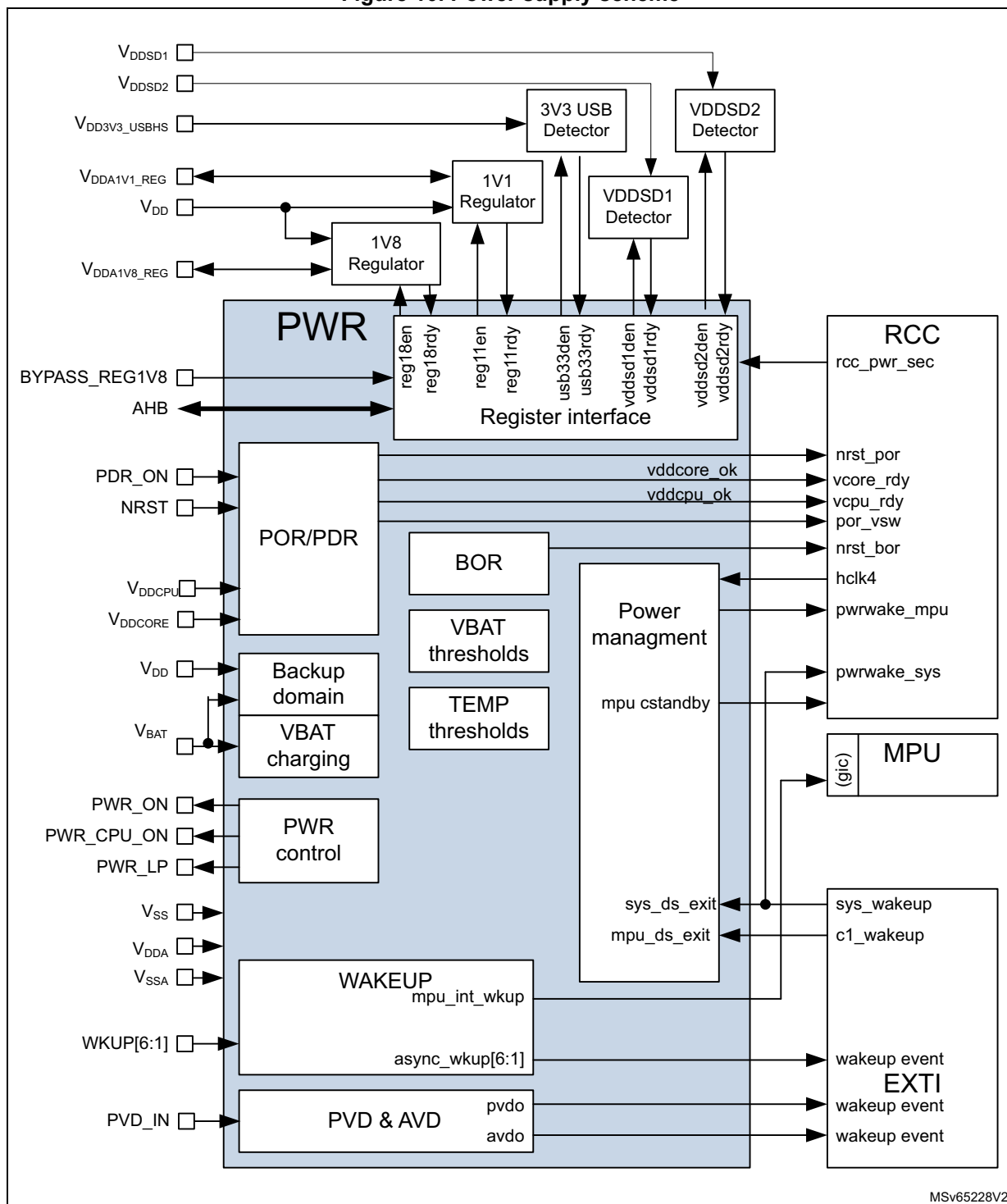
#### 6.1.5 Pin input voltage

The input voltage measurement on a pin of the device is described in [Figure 9](#).



### 6.1.6 Power supply scheme

Figure 10. Power supply scheme

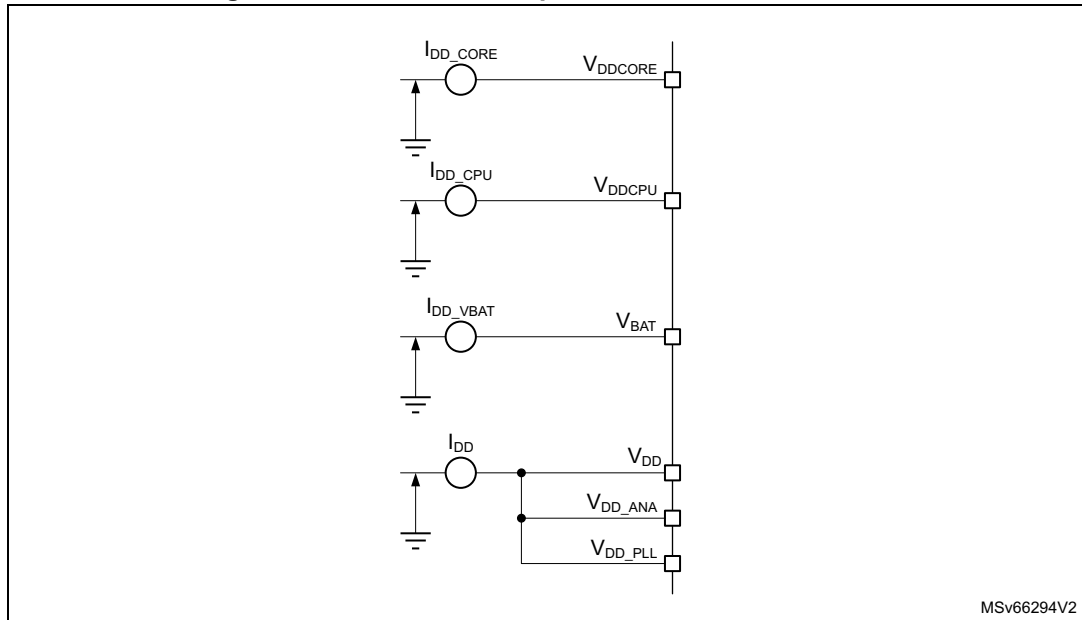


**Caution:** Each power supply pair ( $V_{DD}/V_{SS}$ ,  $V_{DDSDx}/V_{SS}$ ,  $V_{DDCORE}/V_{SS}$ ,  $V_{DDCPU}/V_{SS}$ ,  $V_{DDA}/V_{SSA}$  ...) must be decoupled with filtering ceramic capacitors. These capacitors must be placed as close as possible to, or below, the appropriate pins on the underside of the PCB to ensure

good operation of the device. It is not recommended to remove filtering capacitors to reduce PCB size or cost. This might cause incorrect operation of the device.

### 6.1.7 Current consumption measurement

Figure 11. Current consumption measurement scheme



MSv66294V2

## 6.2 Absolute maximum ratings

Stresses above the absolute maximum ratings listed in [Table 10: Voltage characteristics](#), [Table 11: Current characteristics](#), and [Table 12: Thermal characteristics](#) may cause permanent damage to the device. These are stress ratings only and the functional operation of the device at these conditions is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability. Device mission profile (application conditions) is compliant with JEDEC JESD47 qualification standard, extended mission profiles are available on demand.

Table 10. Voltage characteristics <sup>(1)</sup>

| Symbols                                | Ratings                                                                                                                                                                                                                              | Min  | Max  | Unit |
|----------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------|------|------|
| V <sub>DDX</sub> - V <sub>SSX</sub>    | External main supply voltage (including V <sub>DD</sub> , V <sub>DDSD1</sub> , V <sub>DDSD2</sub> , V <sub>DD_ANA</sub> , V <sub>DD_PLL</sub> , V <sub>DDA</sub> , V <sub>DD3V3_USBHS</sub> , V <sub>BAT</sub> , V <sub>REF+</sub> ) | -0.3 | 3.9  | V    |
| V <sub>DDCORE</sub> - V <sub>SS</sub>  | External core supply voltage                                                                                                                                                                                                         | -0.3 | 1.5  | V    |
| V <sub>DDCPU</sub> - V <sub>SS</sub>   | External Cortex®-A7 CPU supply voltage                                                                                                                                                                                               | -0.3 | 1.5  | V    |
| V <sub>DDA_DDR</sub> - V <sub>SS</sub> | DDR IO supply voltage                                                                                                                                                                                                                | -0.3 | 1.98 | V    |

Table 10. Voltage characteristics (continued)<sup>(1)</sup>

| Symbols               | Ratings                                                              | Min            | Max | Unit |
|-----------------------|----------------------------------------------------------------------|----------------|-----|------|
| $V_{DDA1V8} - V_{SS}$ | 1.8 V supply ( $V_{DDA1V8\_REG}$ )                                   | -0.3           | 3.9 | V    |
| $V_{IN}^{(2)}$        | Input voltage on FT_XXX pins                                         | $V_{SS} - 0.3$ | (3) | V    |
|                       | Input voltage on TT_XX pins                                          |                | 3.9 | V    |
|                       | Input voltage on OTG_VBUS pin                                        |                | (4) | V    |
|                       | Input voltage on USB/OTG_HS_DP/DM pins                               |                | (5) | V    |
|                       | Input voltage on any other pins                                      |                | 3.9 | V    |
| $ \Delta V_{DDX} $    | Variations between different $V_{DDX}$ power pins of the same domain | -              | 50  | mV   |
| $ V_{SSx} - V_{SS} $  | Variations between all the different ground pins                     | -              | 50  | mV   |
| $V_{REF+} - V_{DDA}$  | Allowed voltage difference for $V_{REF+} > V_{DDA}$                  | -              | 0.4 | V    |

1. All power ( $V_{DD}$ ,  $V_{DDSD1}$ ,  $V_{DDSD2}$ ,  $V_{DDA}$ ,  $V_{DD3V3\_USBHS}$ ,  $V_{DDCORE}$ ,  $V_{DDCPU}$ ,  $V_{BAT}$ ) and ground ( $V_{SS}$ ,  $V_{SSA}$ ,  $V_{SSX}$ ) pins must always be connected to the external/internal power supply, in the permitted range.
2.  $V_{IN}$  maximum must always be respected. Refer to [Table 53](#) for the maximum allowed injected current values.
3. Min(6.0,  $V_{DD}+3.9$ ,  $V_{DDA}+3.9$ ,  $V_{DD3V3\_USBHS}+3.9$ ,  $V_{BAT}+3.9$ ).  
This formula has to be applied on power supplies related to the IO structure described by the pin definition table.  
To sustain a voltage higher than 3.9 V the internal pull-up/pull-down resistors must be disabled.
4. Min(6.0,  $V_{DD}+3.9$ ,  $V_{DD3V3\_USBHS}+3.9$ ).  
It is recommended to not use OTG\_VBUS pin but rather any GPIO with an EXTI and external pull-up resistance in case the STM32MP13x device can be used with  $V_{DD}$  off while plugging OTG\_VBUS > 3.9 V (see AN4879: USB hardware and PCB guidelines using STM32 MCUs for details).
5. Min(5.25,  $V_{DD}+3.9$ ,  $V_{DD3V3\_USBHS}+3.9$ ).  
It is recommended to not use OTG\_VBUS pin but rather any GPIO with an EXTI and external pull-up resistance in case the STM32MP13x device can be used with  $V_{DD}$  off while plugging OTG\_VBUS > 3.9 V (see AN4879: USB hardware and PCB guidelines using STM32 MCUs for details).

Table 11. Current characteristics<sup>(1)</sup>

| Symbols                 | Ratings                                                                         | Max   | Unit |
|-------------------------|---------------------------------------------------------------------------------|-------|------|
| $\Sigma I_{DD}$         | Total current into sum of all $V_{DD}$ power lines (source)                     | 440   | mA   |
| $I_{VDD}$               | Maximum current into each $V_{DD}$ power pin (source)                           | 100   |      |
| $I_{VSS}$               | Maximum current out of each $V_{SS}$ ground pin (sink)                          | 100   |      |
| $I_{IO}$                | Output current sunk by any I/O and control pin                                  | 20    |      |
| $\Sigma I_{(PIN)}$      | Total output current sunk by sum of all I/Os and control pins <sup>(2)</sup>    | 140   |      |
|                         | Total output current sourced by sum of all I/Os and control pins <sup>(2)</sup> | 140   |      |
| $I_{INJ(PIN)}^{(3)(4)}$ | Injected current on FT_XXX, TT_XX, NRST pins                                    | -5/+0 |      |
| $\Sigma I_{INJ(PIN)}$   | Total injected current (sum of all I/Os and control pins) <sup>(5)</sup>        | ±25   |      |

1. All power ( $V_{DD}$ ,  $V_{DDSD1}$ ,  $V_{DDSD2}$ ,  $V_{DDA}$ ,  $V_{DD3V3\_USBHS}$ ) and ground ( $V_{SS}$ ,  $V_{SSA}$ ,  $V_{SSX}$ ) pins must always be connected to the external/internal power supply, in the permitted range.
2. This current consumption must be correctly distributed over all I/Os and control pins. The total output current must not be sunk/sourced between two consecutive power supply pins.
3. Positive injection is not possible on these I/Os and does not occur for input voltages lower than the specified maximum value.

4. A positive injection is induced by  $V_{IN} > V_{DD}$  while a negative injection is induced by  $V_{IN} < V_{SS}$ .  $I_{INJ(PIN)}$  must never be exceeded. Refer also to [Table 10: Voltage characteristics](#) for the maximum allowed input voltage values.
5. When several inputs are submitted to a current injection, the maximum  $\sum I_{INJ(PIN)}$  is the absolute sum of the positive and negative injected currents (instantaneous values).

Table 12. Thermal characteristics

| Symbol    | Ratings                                 | Value       | Unit |
|-----------|-----------------------------------------|-------------|------|
| $T_{STG}$ | Storage temperature range               | -65 to +150 | °C   |
| $T_J$     | Maximum junction temperature (suffix 7) | 105         |      |
|           | Maximum junction temperature (suffix 3) | 125         |      |

## 6.3 Operating conditions

### 6.3.1 General operating conditions

Table 13. General operating conditions

| Symbol                                         | Parameter                                                             | Operating conditions | Min.                   | Typ | Max.  | Unit |
|------------------------------------------------|-----------------------------------------------------------------------|----------------------|------------------------|-----|-------|------|
| $F_{mpuss\_ck}$                                | Cortex-A7 subsystem                                                   | STM32MP133F          | 0                      | -   | 1000  | MHz  |
|                                                |                                                                       | STM32MP133C          | 0                      | -   | 650   |      |
| $F_{axiss\_ck}$ , $F_{hclk5}$ ,<br>$F_{hclk6}$ | Internal AXI, AHB5,<br>AHB6 clock<br>frequency                        | -                    | 0                      | -   | 266.5 |      |
| $F_{ahb\_ck}$                                  | Internal AHB clock<br>frequency                                       | -                    | 0                      | -   | 209   |      |
| $F_{pclk1}$                                    | Internal APB1 clock<br>frequency                                      | -                    | 0                      | -   | 104.5 |      |
| $F_{pclk2}$                                    | Internal APB2 clock<br>frequency                                      | -                    | 0                      | -   | 104.5 |      |
| $F_{pclk3}$                                    | Internal APB3 clock<br>frequency                                      | -                    | 0                      | -   | 104.5 |      |
| $F_{pclk4}$                                    | Internal APB4 clock<br>frequency                                      | -                    | 0                      | -   | 133   |      |
| $F_{pclk5}$                                    | Internal APB5 clock<br>frequency                                      | -                    | 0                      | -   | 133   |      |
| $F_{pclk6}$                                    | Internal APB6 clock<br>frequency                                      | -                    | 0                      | -   | 133   |      |
| $V_{DD}$                                       | I/Os and embedded<br>regulators (REG1V1,<br>REG1V8) supply<br>voltage | SYSCFG_HSLVENxR = 0  | 1.71 <sup>(1)(2)</sup> | -   | 3.6   | V    |
|                                                |                                                                       | SYSCFG_HSLVENxR ≠ 0  | 1.71                   | -   | 2.7   |      |
| $V_{DDSD1}$ , $V_{DDSD2}$                      | VDDSD1, VDDSD2,<br>power section I/O's                                | SYSCFG_HSLVENxR = 0  | 0 <sup>(3)</sup>       | -   | 3.6   | V    |
|                                                |                                                                       | SYSCFG_HSLVENxR ≠ 0  | 0                      | -   | 2.7   |      |

Table 13. General operating conditions (continued)

| Symbol                            | Parameter                                                     | Operating conditions                                                  | Min.  | Typ  | Max.                   | Unit |
|-----------------------------------|---------------------------------------------------------------|-----------------------------------------------------------------------|-------|------|------------------------|------|
| $V_{DD\_ANA}^{(4)}$               | System analog supply voltage                                  | -                                                                     | 1.71  | -    | 3.6                    | V    |
| $V_{DD\_PLL}, V_{DD\_PLL2}^{(5)}$ | PLL supply voltage                                            | -                                                                     | 1.71  | -    | 3.6                    | V    |
| $V_{DDCPU}$                       | Cortex®-A7 CPU                                                | Run Overdrive mode <sup>(6)</sup><br>( $F_{mpuss\_ck}$ above 650 MHz) | 1.32  | 1.35 | 1.38                   | V    |
|                                   |                                                               | Run mode <sup>(6)</sup><br>( $F_{mpuss\_ck}$ up to 650 MHz)           | 1.21  | 1.25 | 1.38 <sup>(7)</sup>    |      |
|                                   |                                                               | Run OppMin mode<br>( $F_{mpuss\_ck} = 64$ MHz)                        | 1.15  | -    | 1.38 <sup>(7)</sup>    |      |
|                                   |                                                               | Stop, LP-Stop mode                                                    | 1.15  | 1.25 | 1.38 <sup>(7)(8)</sup> |      |
|                                   |                                                               | LPLV-Stop mode on $V_{DDCPU}$                                         | 0.85  | 0.9  | 1.38 <sup>(7)(8)</sup> |      |
|                                   |                                                               | LPLV-Stop2 mode                                                       | 0     | 0    | 0                      |      |
| $V_{DDCORE}$                      | Digital core domain supply voltage                            | Run mode <sup>(6)</sup>                                               | 1.21  | 1.25 | 1.29                   | V    |
|                                   |                                                               | Stop, LP-Stop mode                                                    | 1.15  | 1.25 | 1.29                   |      |
|                                   |                                                               | LPLV-Stop mode                                                        | 0.85  | 0.90 | 1.29 <sup>(9)</sup>    |      |
|                                   |                                                               | LPLV-Stop2 mode                                                       | 0.85  | 0.90 | 1.29 <sup>(9)</sup>    |      |
|                                   |                                                               | Standby mode                                                          | 0     | 0    | 0.75                   |      |
| $V_{DDA}$                         | Analog operating voltage                                      | ADC used with $V_{REF} < 2$ V <sup>(10)</sup>                         | 1.62  | -    | 2.15                   | V    |
|                                   |                                                               | ADC used with $V_{REF} > 2$ V <sup>(10)</sup>                         | 2     | -    | 3.6                    |      |
|                                   |                                                               | VREFBUF with $V_{REF} = 1.65$ V                                       | 1.95  | -    | 3.6                    |      |
|                                   |                                                               | VREFBUF with $V_{REF} = 1.8$ V                                        | 2.1   | -    | 3.6                    |      |
|                                   |                                                               | VREFBUF with $V_{REF} = 2.048$ V                                      | 2.35  | -    | 3.6                    |      |
|                                   |                                                               | VREFBUF with $V_{REF} = 2.5$ V                                        | 2.8   | -    | 3.6                    |      |
|                                   |                                                               | ADC, $V_{REF}$ not used                                               | 0     | -    | 3.6                    |      |
| $V_{BAT}$                         | Backup operating voltage                                      | -                                                                     | 1.6   | -    | 3.6                    | V    |
| $V_{DD3V3\_USBHS}^{(11)}$         | USB HS I/O supply voltage                                     | USBH or USB OTG HS used                                               | 3.07  | 3.3  | 3.6                    | V    |
|                                   |                                                               | USBH and USB OTG HS not used                                          | 0     | -    | 3.6                    |      |
| $V_{DDQ\_DDR}^{(12)}$             | DDR PHY supply voltage                                        | DDR3 memory                                                           | 1.425 | 1.5  | 1.575                  | V    |
|                                   |                                                               | DDR3L memory                                                          | 1.283 | 1.35 | 1.45                   |      |
|                                   |                                                               | LPDDR2 or LPDDR3                                                      | 1.14  | 1.2  | 1.3                    |      |
| $V_{DDA1V8\_REG}$                 | USB HS PHY voltage supply with 1.8 V regulator in bypass mode | BYPASS_REG1V8 = $V_{DD}$                                              | 1.65  | 1.8  | 1.95                   | V    |



Table 13. General operating conditions (continued)

| Symbol         | Parameter                  | Operating conditions | Min. | Typ | Max.                  | Unit |
|----------------|----------------------------|----------------------|------|-----|-----------------------|------|
| VIN            | I/O Input voltage          | TTxa I/O             | -0.3 | -   | V <sub>DD</sub> +0.3  | V    |
|                |                            | OTG_VBUS I/O         | -0.3 | -   | 6 <sup>(13)(14)</sup> |      |
|                |                            | DDR I/O              | -0.3 | -   | V <sub>DDQ_DDR</sub>  |      |
|                |                            | USB HS I/O           | -1   | -   | 5.25                  |      |
|                |                            | All I/O except TTxa  | -0.3 | -   | See <sup>(15)</sup>   |      |
| T <sub>J</sub> | Junction temperature range | Suffix 7 version     | -40  | -   | 105                   | °C   |
|                |                            | Suffix 3 version     | -40  | -   | 125                   |      |

- Once nRST is released functionality is guaranteed down to V<sub>BOR</sub> falling edge max.
- Min V<sub>DD</sub> is 2.25 V when REG1V8 is used BYPASS\_REG1V8 = 0.
- V<sub>DDSD1</sub>, V<sub>DDSD2</sub> voltages should be above Max\_Vpad - 3.6V. Where Max\_Vpad is the maximum input voltage present on device I/O's.
- Should be connected to same power supply voltage as V<sub>DD</sub>.
- It is required to connect V<sub>DD\_PLL</sub> and V<sub>DD\_PLL2</sub> to same power supply as V<sub>DD</sub>.
- The min/typ/max values do not take into account any ripple. The values must be considered at the device power balls. It is not possible to start the device in overdrive mode since at reset the bit MPU\_RAM\_LOWSPEED = 1.
- The device is functional up to 1.38 V but using V<sub>DDCPU</sub> > 1.29 V does not guarantee life time according mission profile "Cortex<sup>®</sup>-A7 @650 MHz, -40 °C < T<sub>J</sub> < 125 °C"  
Refer also to the application note AN5438 "STM32MP1 Series lifetime estimates" available from the ST website [www.st.com](http://www.st.com).
- 1.38 V is the max allowed voltage, however LPLV-Stop mode is only relevant for V<sub>DDCPU</sub> up to 0.95 V.
- 1.29 V is the max allowed voltage, however LPLV-Stop mode is only relevant for V<sub>DDCORE</sub> up to 0.95 V. In LPLV-Stop mode, if V<sub>DDQ\_DDR</sub> is not shutdown, to avoid overconsumption on V<sub>DDQ\_DDR</sub>, the DDR memory must be put in SelfRefresh and DDR PHY must be set in retention mode (setting bit DDRRETEN: DDR retention enable of PWR control register 3 (PWR\_CR3)).
- V<sub>DDA</sub> should always be ≥ V<sub>REF</sub>.
- For operation with voltage higher than Min (V<sub>DD</sub>, V<sub>DDA</sub>) +0.3 V, the internal Pull-up and Pull-Down resistors must be disabled.
- Independent from any other supply.
- Min(6.0, V<sub>DD</sub>+3.6, V<sub>DD3V3\_USBHS</sub>+3.6)
- V<sub>DD</sub> must be present to support 6 V. If V<sub>DD</sub> = 0, the maximum voltage is 3.6 V.
- Min(5.5, V<sub>DD</sub>+3.6, V<sub>DDA</sub>+3.6). This formula has to be applied on power supplies related to the IO structure described by the pin definition table.

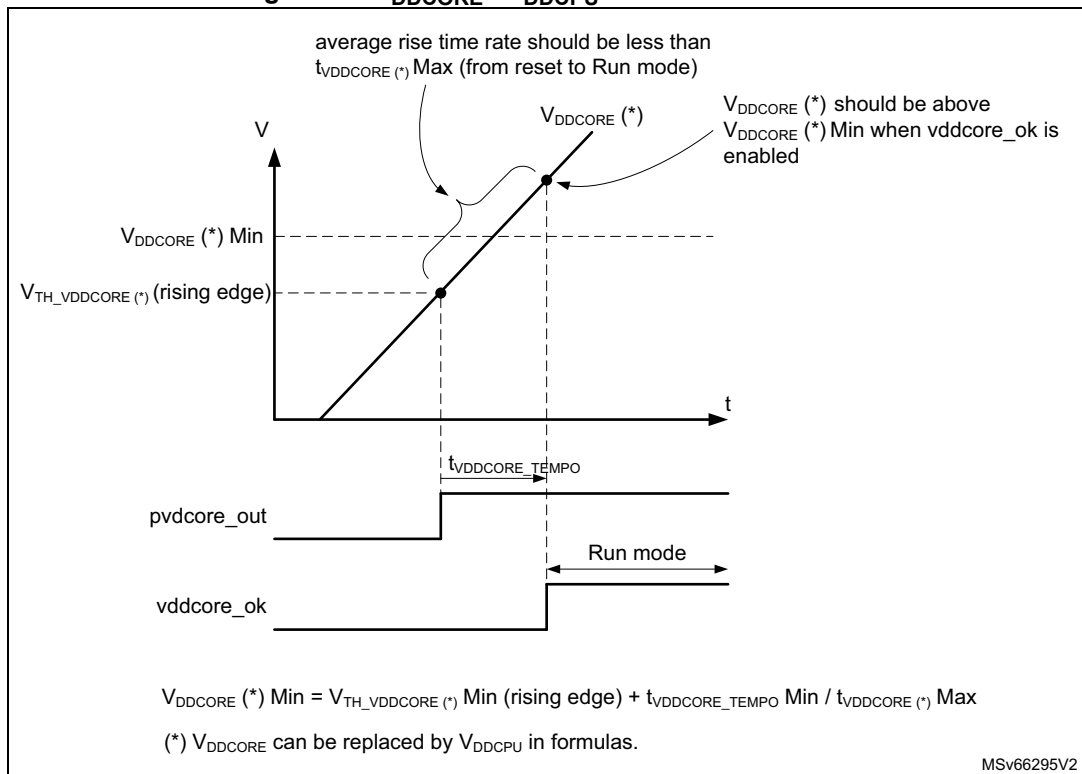
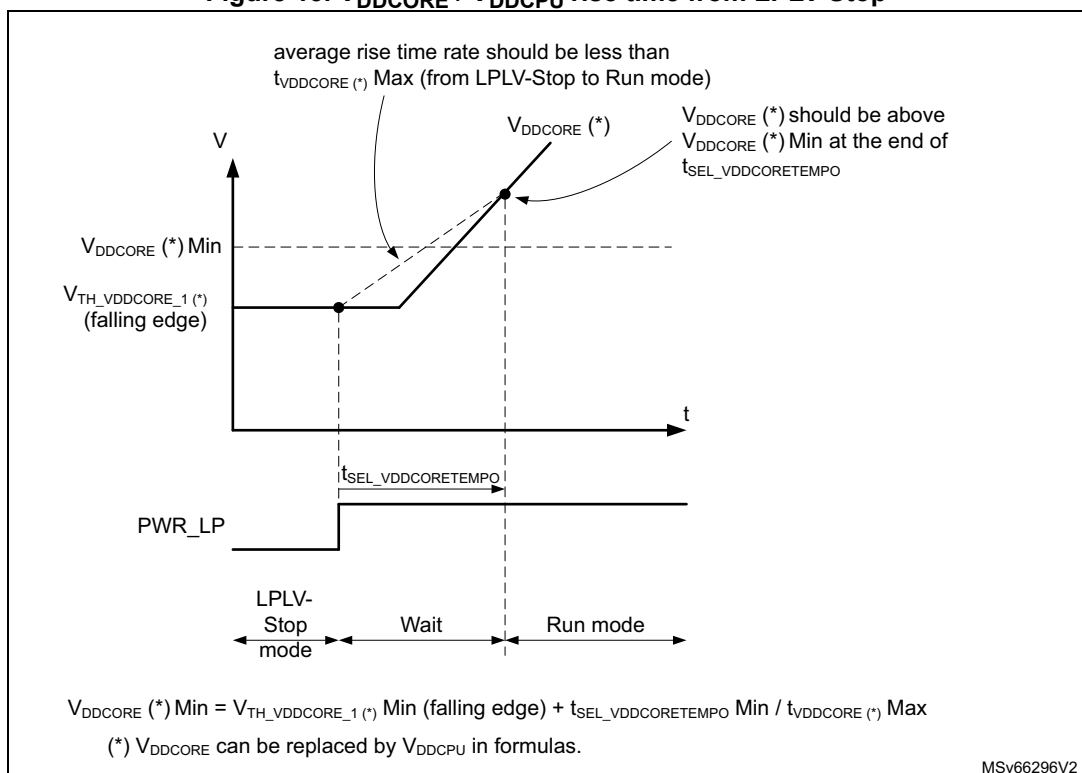
### 6.3.2 Operating conditions at power-up / power-down

Subject to general operating conditions.

Table 14. Operating conditions at power-up / power-down

| Symbol                    | Parameter                                                                   | Min  | Max                 | Unit      |
|---------------------------|-----------------------------------------------------------------------------|------|---------------------|-----------|
| $t_{VDD}^{(1)}$           | $V_{DD}$ rise time rate                                                     | 0    | $\infty$            | $\mu s/V$ |
|                           | $V_{DD}$ fall time rate                                                     | 20   | $\infty$            |           |
| $t_{VDDA}$                | $V_{DDA}$ rise time rate                                                    | 0    | $\infty$            |           |
|                           | $V_{DDA}$ fall time rate                                                    | 10   | $\infty$            |           |
| $t_{VDD3V3\_USBHS}^{(2)}$ | $V_{DD3V3\_USBHS}$ rise time rate                                           | 0    | $\infty$            |           |
|                           | $V_{DD3V3\_USBHS}$ fall time rate                                           | 10   | $\infty$            |           |
| $t_{VDDCPU}$              | $V_{DDCPU}$ rise time rate (from reset or LPLV-Stop2 mode to RUN mode)      | -    | 2000                | $\mu s/V$ |
|                           | $V_{DDCPU}$ rise time rate (from LPLV-Stop to RUN mode)                     | -    | 1000 <sup>(3)</sup> |           |
|                           | $V_{DDCPU}$ fall time rate                                                  | 7.33 | $\infty$            |           |
| $t_{VDDCORE}$             | $V_{DDCORE}$ rise time rate (from reset to RUN mode)                        | -    | 2000                |           |
|                           | $V_{DDCORE}$ rise time rate (from LPLV-Stop or LPLV-Stop2 mode to RUN mode) | -    | 1000 <sup>(3)</sup> |           |
|                           | $V_{DDCORE}$ fall time rate                                                 | 7.33 | $\infty$            |           |

1.  $V_{DD}$  must be present before  $V_{DDCORE}$  and  $V_{DDCPU}$ .
2.  $V_{DDA1V8\_REG}$  must be present before  $V_{DD3V3\_USBHS}$ .
3. In case  $V_{DDCORE}$  or  $V_{DDCPU}$  rise time at exit of LPLV-Stop is larger than 1 ms/V, there is a risk of unwanted reset due to  $V_{DDCORE}$  or  $V_{DDCPU}$  potentially not yet established after  $t_{SEL\_VDDCORETEMPO}$  (cf. [Table 14](#) and [Figure 13](#)). In such a case, the  $V_{DDCORE}$  or  $V_{DDCPU}$  supply should not be decreased during LPLV-Stop mode.

Figure 12.  $V_{DDCORE}$  /  $V_{DDCPU}$  rise time from resetFigure 13.  $V_{DDCORE}$  /  $V_{DDCPU}$  rise time from LPLV-Stop

### 6.3.3 Embedded reset and power control block characteristics

The parameters given in [Table 15](#) are derived from tests performed under ambient temperature and  $V_{DD}$  supply voltage conditions summarized in [Table 13: General operating conditions](#).

**Table 15. Embedded reset and power control block characteristics**

| Symbol                      | Parameter                                                      | Conditions               | Min   | Typ  | Max   | Unit    |
|-----------------------------|----------------------------------------------------------------|--------------------------|-------|------|-------|---------|
| $t_{RSTTEMPO}^{(1)}$        | Reset delay after BOR0 released                                | -                        | -     | 377  | 550   | $\mu s$ |
| $V_{BOR0}^{(1)(2)}$         | Brown-out reset threshold 0                                    | Rising edge              | 1.62  | 1.67 | 1.71  | V       |
|                             |                                                                | Falling edge             | 1.58  | 1.63 | 1.67  |         |
| $V_{BOR1}$                  | Brown-out reset threshold 1                                    | Rising edge              | 2.055 | 2.1  | 2.145 | V       |
|                             |                                                                | Falling edge             | 1.955 | 2    | 2.045 |         |
| $V_{BOR2}$                  | Brown-out reset threshold 2                                    | Rising edge              | 2.355 | 2.4  | 2.445 | V       |
|                             |                                                                | Falling edge             | 2.255 | 2.3  | 2.345 |         |
| $V_{BOR3}$                  | Brown-out reset threshold 3                                    | Rising edge              | 2.655 | 2.7  | 2.745 | V       |
|                             |                                                                | Falling edge             | 2.555 | 2.6  | 2.645 |         |
| $V_{PVD0}$                  | Programmable Voltage Detector threshold 0                      | Rising edge              | 1.905 | 1.95 | 1.995 | V       |
|                             |                                                                | Falling edge             | 1.805 | 1.85 | 1.895 |         |
| $V_{PVD1}$                  | Programmable Voltage Detector threshold 1                      | Rising edge              | 2.055 | 2.1  | 2.145 | V       |
|                             |                                                                | Falling edge             | 1.955 | 2    | 2.045 |         |
| $V_{PVD2}$                  | Programmable Voltage Detector threshold 2                      | Rising edge              | 2.205 | 2.25 | 2.295 | V       |
|                             |                                                                | Falling edge             | 2.105 | 2.15 | 2.195 |         |
| $V_{PVD3}$                  | Programmable Voltage Detector threshold 3                      | Rising edge              | 2.355 | 2.4  | 2.445 | V       |
|                             |                                                                | Falling edge             | 2.255 | 2.3  | 2.345 |         |
| $V_{PVD4}$                  | Programmable Voltage Detector threshold 4                      | Rising edge              | 2.505 | 2.55 | 2.595 | V       |
|                             |                                                                | Falling edge             | 2.405 | 2.45 | 2.495 |         |
| $V_{PVD5}$                  | Programmable Voltage Detector threshold 5                      | Rising edge              | 2.655 | 2.7  | 2.745 | V       |
|                             |                                                                | Falling edge             | 2.555 | 2.6  | 2.645 |         |
| $V_{PVD6}$                  | Programmable Voltage Detector threshold 6                      | Rising edge              | 2.805 | 2.85 | 2.895 | V       |
|                             |                                                                | Falling edge in RUN mode | 2.705 | 2.75 | 2.795 |         |
| $V_{hyst\_BOR0}$            | Hysteresis voltage of BOR0                                     | Hysteresis in RUN mode   | -     | 40   | -     | mV      |
| $V_{hyst\_BOR}$             | Hysteresis voltage of BOR                                      | Unless BOR0              | -     | 100  | -     | mV      |
| $V_{hyst\_BOR\_PVD}$        | Hysteresis voltage of BOR (unless BOR0) and PVD <sup>(3)</sup> | Hysteresis in RUN mode   | -     | 100  | -     | mV      |
| $I_{DD\_BOR\_PVD}^{(1)(4)}$ | BOR (unless BOR0) and PVD consumption from $V_{DD}$            | -                        | 0.246 | -    | 0.626 | $\mu A$ |

Table 15. Embedded reset and power control block characteristics (continued)

| Symbol                     | Parameter                                                                                                                               | Conditions      | Min   | Typ   | Max   | Unit    |
|----------------------------|-----------------------------------------------------------------------------------------------------------------------------------------|-----------------|-------|-------|-------|---------|
| $V_{AVM\_0}$               | Analog voltage ( $V_{DDA}$ ) detector threshold 0                                                                                       | Rising edge     | 1.655 | 1.7   | 1.745 | V       |
|                            |                                                                                                                                         | Falling edge    | 1.555 | 1.6   | 1.645 |         |
| $V_{AVM\_1}$               | Analog voltage ( $V_{DDA}$ ) detector threshold 1                                                                                       | Rising edge     | 2.055 | 2.1   | 2.145 | V       |
|                            |                                                                                                                                         | Falling edge    | 1.955 | 2     | 2.045 |         |
| $V_{AVM\_2}$               | Analog voltage ( $V_{DDA}$ ) detector threshold 2                                                                                       | Rising edge     | 2.455 | 2.5   | 2.545 | V       |
|                            |                                                                                                                                         | Falling edge    | 2.355 | 2.4   | 2.445 |         |
| $V_{AVM\_3}$               | Analog voltage ( $V_{DDA}$ ) detector threshold 3                                                                                       | Rising edge     | 2.755 | 2.8   | 2.845 | V       |
|                            |                                                                                                                                         | Falling edge    | 2.655 | 2.7   | 2.745 |         |
| $V_{hyst\_VDDA}$           | Hysteresis of analog voltage ( $V_{DDA}$ ) detector                                                                                     | -               | -     | 100   | -     | mV      |
| $I_{VDD\_AVM}^{(1)}$       | Analog Voltage Monitoring ( $V_{DDA}$ ) consumption on $V_{DD}$                                                                         | -               | -     | -     | 0.248 | $\mu A$ |
| $I_{VDDA\_AVM}^{(1)}$      | Analog Voltage Monitoring ( $V_{DDA}$ ) consumption on $V_{DDA}$                                                                        | Resistor bridge | -     | 2.12  | -     | $\mu A$ |
| $V_{TH\_VDDCORE}^{(5)}$    | Digital core domain supply voltage ( $V_{DDCORE}$ ) detector threshold 0 (Run)                                                          | Rising edge     | 0.95  | 0.995 | 1.04  | V       |
|                            |                                                                                                                                         | Falling edge    | 0.91  | 0.955 | 1     |         |
| $V_{TH\_VDDCORE\_1}^{(6)}$ | Digital core domain supply voltage ( $V_{DDCORE}$ ) detector threshold 1 (LPLV_Stop)                                                    | Falling edge    | 0.71  | 0.755 | 0.8   | V       |
| $V_{hyst\_VDDCORE}$        | Hysteresis of Digital core domain supply voltage ( $V_{DDCORE}$ ) detector                                                              | -               | -     | 40    | -     | mV      |
| $t_{VDDCORE\_TEMPO}$       | Delay on $V_{TH\_VDDCORE}$ at rising edge of $V_{DDCORE}$ to ensure that $V_{DDCORE}$ is fully established                              | -               | 200   | 340   | 550   | $\mu s$ |
| $t_{SEL\_VDDCORETE MPO}$   | Delay on $V_{TH\_VDDCORE\_1}$ at rising edge of $V_{DDCORE}$ to ensure that $V_{DDCORE}$ is fully established on exit of LPLV-Stop mode | -               | 234   | 380   | 700   | $\mu s$ |
| $I_{VDD\_VDDCOREVM}^{(1)}$ | $V_{DDCORE}$ Voltage Monitoring consumption on $V_{DD}$                                                                                 | -               | 1.7   | 2.6   | 4.2   | $\mu A$ |
| $V_{TH\_VDDCPU}^{(7)}$     | Digital MPU domain supply voltage ( $V_{DDCPU}$ ) detector threshold 0 (Run)                                                            | Rising edge     | 0.95  | 0.995 | 1.04  | V       |
|                            |                                                                                                                                         | Falling edge    | 0.91  | 0.955 | 1     |         |
| $V_{TH\_VDDCPU\_1}^{(8)}$  | Digital MPU domain supply voltage ( $V_{DDCPU}$ ) detector threshold 1 (LPLV_Stop)                                                      | Falling edge    | 0.71  | 0.755 | 0.8   | V       |
| $V_{hyst\_VDDCPU}$         | Hysteresis of Digital MPU domain supply voltage ( $V_{DDCPU}$ ) detector                                                                | -               | -     | 40    | -     | mV      |

**Table 15. Embedded reset and power control block characteristics (continued)**

| Symbol                         | Parameter                                                                                                                            | Conditions | Min | Typ  | Max | Unit    |
|--------------------------------|--------------------------------------------------------------------------------------------------------------------------------------|------------|-----|------|-----|---------|
| $t_{VDDCPU\_TEMPO}$            | Delay on $V_{TH\_VDDCPU}$ at rising edge of $V_{DDCPU}$ to ensure that $V_{DDCPU}$ is fully established                              | -          | 200 | 340  | 550 | $\mu s$ |
| $t_{SEL\_VDDCPU\_TEMPO}^{(9)}$ | Delay on $V_{TH\_VDDCPU\_1}$ at rising edge of $V_{DDCPU}$ to ensure that $V_{DDCPU}$ is fully established on exit of LPLV-Stop mode | -          | 234 | 380  | 700 | $\mu s$ |
| $I_{VDD\_VDDCPUVM}^{(1)}$      | $V_{DDCPU}$ Voltage Monitoring consumption on $V_{DD}$                                                                               | -          | 2.2 | 3.5  | 5.2 | $\mu A$ |
| $V_{TH\_VDDUSB}$               | $V_{DD3V3\_USBHS}$ Threshold voltage                                                                                                 | -          | -   | 1.21 | -   | V       |
| $V_{TH\_VDDSD1}$               | $V_{DDSD1}$ Threshold voltage                                                                                                        | -          | -   | 1.21 | -   | V       |
| $V_{TH\_VDDSD2}$               | $V_{DDSD2}$ Threshold voltage                                                                                                        | -          | -   | 1.21 | -   | V       |

1. Specified by design, not tested in production.
2. VPOR (power-on reset Voltage threshold) = BOR0 rising edge value  
VPDR (power-down reset Voltage threshold) = BOR0 falling edge value
3. No hysteresis when using PVD\_IN pin.
4. BOR0 is enabled in all modes and its consumption is therefore included in the supply current characteristics tables.
5. During the first rising edge of  $V_{DDCORE}$ , the slope should be less than 2 ms/V to ensure  $V_{DDCORE}$  is fully established before the end of the  $t_{VDDCORE\_TEMPO}$ .
6. When exiting from LPLV-Stop mode to RUN mode the rising slope for  $V_{DDCORE}$  should be less than 1 ms/V to ensure  $V_{DDCORE}$  is fully established before the end of the  $t_{VDDCORE\_TEMPO}$ .
7. During the first rising edge of  $V_{DDCORE}$ , the slope should be less than 2 ms/V to ensure  $V_{DDCORE}$  is fully established before the end of the  $t_{VDDCORE\_TEMPO}$ .
8. When exiting from LPLV-Stop mode to RUN mode the rising slope for  $V_{DDCPU}$  should be less than 1 ms/V to ensure  $V_{DDCPU}$  is fully established before the end of the  $t_{VDDCPU\_TEMPO}$ .
9.  $t_{SEL\_VDDCPU\_TEMPO}$  is identical to  $t_{SEL\_VDDCORE\_TEMPO}$  since both  $V_{DDCORE}$  and  $V_{DDCPU}$  are following same supply voltage increase on exit from LPLV-Stop mode.

### 6.3.4 Embedded reference voltage

The parameters given in [Table 16](#), [Table 17](#) are derived from tests performed under ambient temperature and  $V_{DD}$  supply voltage conditions summarized in [Table 13: General operating conditions](#).

**Table 16. Embedded reference voltage**

| Symbol       | Parameter                   | Conditions                                                        | Min   | Typ   | Max   | Unit |
|--------------|-----------------------------|-------------------------------------------------------------------|-------|-------|-------|------|
| $V_{REFINT}$ | Internal reference voltages | $-40\text{ }^{\circ}\text{C} < T_J < 125\text{ }^{\circ}\text{C}$ | 1.175 | 1.210 | 1.241 | V    |

Table 16. Embedded reference voltage (continued)

| Symbol                    | Parameter                                                                     | Conditions                                          | Min | Typ  | Max  | Unit             |
|---------------------------|-------------------------------------------------------------------------------|-----------------------------------------------------|-----|------|------|------------------|
| $t_{S\_vrefint}^{(1)(2)}$ | ADC sampling time when reading the internal reference voltage                 | -                                                   | 4.3 | -    | -    | $\mu s$          |
| $t_{S\_vbat}^{(1)}$       | $V_{BAT}$ sampling time when reading the internal $V_{BAT}$ reference voltage | -                                                   | 9.8 | -    | -    |                  |
| $t_{start\_vrefint}$      | Start time of reference voltage buffer when ADC is enable                     | -                                                   | 0.8 | -    | 4.6  |                  |
| $I_{refbuf}^{(2)}$        | Reference Buffer consumption for ADC                                          | $V_{DDA} = 3.3\text{ V}$                            | 9.1 | 13.6 | 27.7 | $\mu A$          |
| $\Delta V_{REFINT}^{(2)}$ | Internal reference voltage spread over the temperature range                  | $-40\text{ }^{\circ}C < T_J < 125\text{ }^{\circ}C$ | -   | 4.3  | 15   | mV               |
| $T_{coeff\_VREFINT}$      | Average temperature coefficient                                               | Average temperature coefficient                     | -   | 19   | 67   | ppm/ $^{\circ}C$ |
| $V_{DDcoeff}$             | Average Voltage coefficient                                                   | $3.0\text{ V} < V_{DD} < 3.6\text{ V}$              | -   | 10   | 1370 | ppm/V            |

1. The shortest sampling time for the application can be determined by multiple iterations.
2. Specified by design, not tested in production.

Table 17. Embedded reference voltage calibration value

| Symbol           | Parameter                                                                                       | Memory address                 |
|------------------|-------------------------------------------------------------------------------------------------|--------------------------------|
| $V_{REFIN\_CAL}$ | Raw data acquired at temperature of $30\text{ }^{\circ}C$ , $V_{DDA} = V_{REF+} = 3.3\text{ V}$ | $0x5C00\ 5250[31:16]^{(1)(2)}$ |

1. Mandatory to read in 32-bits word and do relevant mask and shift to isolate required bits.
2. These address is inside BSEC which should be enabled in RCC to allow access.

### 6.3.5 Embedded regulators characteristics

The parameters given in [Table 18](#), [Table 19](#) are derived from tests performed under ambient temperature and  $V_{DD}$  supply voltage conditions summarized in [Table 13: General operating conditions](#).

#### REG1V1 embedded regulator (USB\_PHY)

Table 18. REG1V1 embedded regulator (USB\_PHY) characteristics<sup>(1)</sup>

| Symbol            | Parameter                           | Condition | Min   | Typ                | Max   | Unit       |
|-------------------|-------------------------------------|-----------|-------|--------------------|-------|------------|
| $V_{DDA1V1\_REG}$ | Regulated output voltage            | -         | 1.045 | 1.1                | 1.155 | V          |
| $C_L$             | Load Capacitor                      | -         | 1.1   | 2.2 <sup>(2)</sup> | 3.3   | $\mu F$    |
| esr               | Equivalent Serial Resistor of Cload | -         | 0.1   | 25                 | 600   | m $\Omega$ |
| $I_{load}$        | Static load current <sup>(3)</sup>  | -         | 0     | -                  | 30    | mA         |

Table 18. REG1V1 embedded regulator (USB\_PHY) characteristics<sup>(1)</sup> (continued)

| Symbol              | Parameter                                                          | Condition                                       | Min | Typ | Max | Unit |
|---------------------|--------------------------------------------------------------------|-------------------------------------------------|-----|-----|-----|------|
| t <sub>START</sub>  | Start-up time. from PWR_CR3.REG11EN = 1 to PWR_CR3.REG11RDY = 1    | C <sub>L</sub> =2.2μF                           | -   | 93  | -   | μs   |
|                     |                                                                    | C <sub>L</sub> =3.3μF                           | -   | -   | 180 |      |
| I <sub>INRUSH</sub> | V <sub>DD</sub> Inrush Current to load external capacitor at start | -                                               | -   | 50  | 60  | mA   |
| I <sub>VDD</sub>    | Regulator Current consumption on V <sub>DD</sub>                   | Regulator Enabled and I <sub>load</sub> = 0 mA  | -   | 150 | 205 | μA   |
|                     |                                                                    | Regulator Enabled and I <sub>load</sub> = 30 mA | -   | 176 | 242 |      |

1. Specified by design, not tested in production.
2. For better dynamic performances a 2.2 μF typical value external capacitor is recommended.
3. Load is for internal STM32MP133C/F analog blocks, no additional external load is accepted unless mentioned.

Table 19. REG1V8 embedded regulator (USB\_PHY) characteristics<sup>(1)</sup>

| Symbol                  | Parameter                                                          | Condition                                       | Min  | Typ                | Max | Unit |
|-------------------------|--------------------------------------------------------------------|-------------------------------------------------|------|--------------------|-----|------|
| V <sub>DD</sub>         | Regulator input voltage                                            | -                                               | 2.25 | 3.3                | 3.6 | V    |
| V <sub>DDA1V8_REG</sub> | Regulated output voltage                                           | after trimming                                  | 1.7  | 1.8                | 1.9 | V    |
| C <sub>L</sub>          | Load Capacitor                                                     | -                                               | 0.5  | 2.2 <sup>(2)</sup> | 3.3 | μF   |
| esr                     | Equivalent Serial Resistor of Cload                                | -                                               | 0.1  | 25                 | 600 | mΩ   |
| I <sub>load</sub>       | Static load current <sup>(3)</sup>                                 | -                                               | -    | -                  | 70  | mA   |
| t <sub>START</sub>      | Start-up time. from PWR_CR3.REG11EN = 1 to PWR_CR3.REG11RDY = 1    | C <sub>L</sub> =2.2μF                           | -    | 81                 | -   | μs   |
|                         |                                                                    | C <sub>L</sub> =3.3μF                           | -    | -                  | 150 |      |
| I <sub>INRUSH</sub>     | V <sub>DD</sub> Inrush Current to load external capacitor at start | -                                               | -    | 80                 | 100 | mA   |
| I <sub>VDD</sub>        | Regulator Current consumption on V <sub>DD</sub>                   | Regulator Enabled and I <sub>load</sub> = 0 mA  | -    | 130                | 181 | μA   |
|                         |                                                                    | Regulator Enabled and I <sub>load</sub> = 70 mA | -    | 170                | 231 |      |

1. Specified by design, not tested in production.
2. For better dynamic performances a 2.2 μF typical value external capacitor is recommended.
3. Load is for internal STM32MP133C/F analog blocks, no additional external load is accepted unless mentioned.

### 6.3.6 Supply current characteristics

The current consumption is a function of several parameters and factors such as the operating voltage, ambient temperature, I/O pin loading, device software configuration, operating frequencies, I/O pin switching rate, program location in memory and executed binary code.

The current consumption is measured as described in [Figure 11: Current consumption measurement scheme](#).



All the Run mode current consumption measurements given in this section are performed with a CoreMark code unless otherwise specified.

### Typical and maximum current consumption

The device is placed under the following conditions:

- All I/O pins are in analog input mode except when explicitly mentioned.
- All peripherals are disabled except when explicitly mentioned.
- The maximum values are obtained for  $V_{DD}/V_{BAT} = 3.6$  V,  $V_{DDCORE} = 1.29$  V, and  $V_{DDCPU} = 1.29$  V, and the typical values for  $V_{DD}/V_{BAT} = 3.3$  V,  $V_{DDCORE} = 1.25$  V and  $V_{DDCPU} = 1.25$  V unless otherwise specified.

The parameters given in [Table 22](#) to [Table 27](#) are derived from tests performed under supply voltage conditions summarized in [Table 13: General operating conditions](#).

**Table 20. Current consumption ( $I_{DDCORE}$ ) in Run mode**

| Symbol              | Parameter                  | Conditions                             |             |                                    |               | Typ        | Max        |            |             |             |    | Unit |
|---------------------|----------------------------|----------------------------------------|-------------|------------------------------------|---------------|------------|------------|------------|-------------|-------------|----|------|
|                     |                            | -                                      | MPU SS mode | Oscillator                         | AXI clk (MHz) | Tj = 25 °C | Tj = 25 °C | Tj = 85 °C | Tj = 105 °C | Tj = 125 °C |    |      |
| I <sub>DDCORE</sub> | Supply current in Run mode | All peripherals enabled <sup>(1)</sup> | CRun        | AHB clock = 64 MHz <sup>(2)</sup>  | 266           | 115        | 143        | 213        | 267         | 340         | mA |      |
| I <sub>DDCORE</sub> | Supply current in Run mode | All peripherals disabled               | CRun        | AHB clock = 200 MHz <sup>(3)</sup> | 266           | 82         | 99         | 172        | 224         | 301         | mA |      |
|                     |                            |                                        |             | AHB clock = 64 MHz <sup>(4)</sup>  | 266           | 62         | 83.4       | 156        | 208         | 284         |    |      |
|                     |                            |                                        |             |                                    | 150           | 41         | 59.7       | 133        | 183         | 256         |    |      |
|                     |                            |                                        |             |                                    | 64            | 30         | 47.6       | 121        | 171         | 244         |    |      |
|                     |                            |                                        |             |                                    | 24            | 24         | 41.1       | 115        | 168         | 237         |    |      |

1. Activity on peripherals and bus masters other than processors, could lead to additional power consumption above these values, largely dependent on the amount of initialized peripherals and their activity.
2. Peripheral clocks set at default values (see table "Peripheral clock distribution overview" in reference manual) with pll4\_r\_ck = pll4\_q\_ck = 50 MHz, pll4\_p\_ck = 125 Mhz, pclk1/2/3 = 32 MHz, pclk4 = 132 MHz, pclk5 = 66 MHz, pclk6 = 64 MHz.
3. pclk1/2/3 = 100 MHz, pclk4 = 132 MHz, pclk5 = 66 MHz, pclk6 = 104.5 MHz.
4. pclk1/2/3 = 32 MHz, pclk4 = AXI clock/2, pclk5 = AXI clock/4, pclk6 = 64 MHz.

**Table 21. Current consumption ( $I_{DDCPU}$ ) in Run mode**

| Symbol             | Parameter                         | Conditions                                |                     | Typ        | Max        |            |             |             |    | Unit |
|--------------------|-----------------------------------|-------------------------------------------|---------------------|------------|------------|------------|-------------|-------------|----|------|
|                    |                                   | MPU SS mode                               | MPU clk (MHz)       | Tj = 25 °C | Tj = 25 °C | Tj = 85 °C | Tj = 105 °C | Tj = 125 °C |    |      |
| I <sub>DDCPU</sub> | Supply current in Run mode        | CRun                                      | 1000 <sup>(1)</sup> | 150        | 167        | 225        | 268         | -           | mA |      |
|                    |                                   |                                           | 900 <sup>(1)</sup>  | 135        | 153        | 211        | 254         | -           |    |      |
|                    |                                   |                                           | 780 <sup>(1)</sup>  | 115        | 135        | 194        | 235         | -           |    |      |
|                    |                                   |                                           | 650                 | 88.5       | 104        | 153        | 188         | 239         |    |      |
|                    |                                   |                                           | 600                 | 82         | 98         | 147        | 181         | 232         |    |      |
|                    |                                   |                                           | 400                 | 56         | 69         | 119        | 153         | 203         |    |      |
|                    |                                   |                                           | 300                 | 43         | 54.7       | 105        | 139         | 188         |    |      |
|                    |                                   |                                           | 150                 | 30         | 40.9       | 91.5       | 125         | 174         |    |      |
|                    |                                   |                                           | 64                  | 12         | 22.5       | 73.2       | 107         | 156         |    |      |
|                    |                                   |                                           | 24                  | 6.65       | 16.5       | 67.1       | 100.6       | 149         |    |      |
| I <sub>DDCPU</sub> | Supply current in Run mode OppMin | CRun                                      | 64 <sup>(2)</sup>   | 10.5       | 19.7       | 64.1       | 93.5        | 136         | mA |      |
| I <sub>DDCPU</sub> | Supply current in Run mode        | CSleep (MPU in CSleep with WFI (CLK OFF)) | 900 <sup>(1)</sup>  | 20         | 32.9       | 93.8       | 133         | -           | mA |      |
|                    |                                   |                                           | 780 <sup>(1)</sup>  | 18         | 30.8       | 91.6       | 131         | -           |    |      |
|                    |                                   |                                           | 650                 | 13.5       | 23.9       | 74.3       | 108         | 156         |    |      |
|                    |                                   |                                           | 600                 | 13         | 23.1       | 73.5       | 107         | 156         |    |      |
|                    |                                   |                                           | 300                 | 8.2        | 18.2       | 68.6       | 102.2       | 151         |    |      |
|                    |                                   |                                           | 150                 | 6.65       | 16.5       | 66.9       | 100.5       | 149         |    |      |
|                    |                                   |                                           | 64                  | 4.5        | 14.3       | 64.7       | 98.2        | 147         |    |      |
|                    |                                   |                                           | 24                  | 3.85       | 13.6       | 64.0       | 97.5        | 146         |    |      |

1. Typical value given with  $V_{DDCPU} = 1.35$  V, maximum values given with  $V_{DDCPU} = 1.37$  V.

2. Typical and maximum values given with  $V_{DDCPU} = 1.15$  V,  $V_{DDCORE} = 1.25$  V,  $V_{DD} = 3.3$  V.

Table 22. Current consumption ( $I_{DD}$ ) in Run mode<sup>(1)</sup>

| Symbol          | Parameter                  | Conditions  |                                | Typ           | Max           |               |                |                     |    | Unit |
|-----------------|----------------------------|-------------|--------------------------------|---------------|---------------|---------------|----------------|---------------------|----|------|
|                 |                            | MPU SS mode | Oscillator                     | Tj =<br>25 °C | Tj =<br>25 °C | Tj =<br>85 °C | Tj =<br>105 °C | Tj =<br>125 °C      |    |      |
| I <sub>DD</sub> | Supply current in Run mode | CRun        | HSE+HSI+LSI+CSI+<br>PLL1,2,3,4 | 2.75          | 2.98          | 2.95          | 2.96           | 2.61 <sup>(2)</sup> | mA |      |
| I <sub>DD</sub> | Supply current in Run mode | CSleep      | HSI+PLL1,2                     | 1.95          | 2.1           | 2.1           | 2.1            | 2.1                 | mA |      |
|                 |                            |             | HSE+HSI                        | 0.56          | 0.64          | 0.65          | 0.67           | 0.70                |    |      |
|                 |                            |             | HSI                            | 0.29          | 0.33          | 0.33          | 0.34           | 0.36                |    |      |

1. HSE = 24 MHz.

2. Value provided with PLL1 @648 MHz while other values on the same row are provided with PLL1 @1 GHz (not allowed at 125°C).

Table 23. Current consumption in Stop mode

| Symbol       | Parameter                   | Conditions               |             | Typ                    |                        |                         |                         | Max                    |                        |                         |                         | Unit |
|--------------|-----------------------------|--------------------------|-------------|------------------------|------------------------|-------------------------|-------------------------|------------------------|------------------------|-------------------------|-------------------------|------|
|              |                             | -                        | MPU SS mode | T <sub>j</sub> = 25 °C | T <sub>j</sub> = 85 °C | T <sub>j</sub> = 105 °C | T <sub>j</sub> = 125 °C | T <sub>j</sub> = 25 °C | T <sub>j</sub> = 85 °C | T <sub>j</sub> = 105 °C | T <sub>j</sub> = 125 °C |      |
| $I_{DD}$     | Supply current in Stop mode | All peripherals disabled | CStop       | 10.0                   | 13.0                   | 17.5                    | 28                      | 15.1                   | 22.4                   | 37.4                    | 74.0                    | μA   |
| $I_{DDCORE}$ |                             |                          |             | 5.35                   | 29                     | 52.5                    | 89.5                    | 20.2                   | 92.0                   | 142                     | 211                     | mA   |
| $I_{DDCPU}$  |                             |                          |             | 3.45                   | 19                     | 34                      | 58.5                    | 12.6                   | 60.2                   | 92.4                    | 137                     |      |

**Table 24. Current consumption in LPLV-Stop mode**

| Symbol              | Parameter                        | Conditions              |             | Typ <sup>(1)</sup> |            |             |             | Max <sup>(2)</sup> |            |             |             | Unit |
|---------------------|----------------------------------|-------------------------|-------------|--------------------|------------|-------------|-------------|--------------------|------------|-------------|-------------|------|
|                     |                                  | -                       | MPU SS mode | Tj = 25 °C         | Tj = 85 °C | Tj = 105 °C | Tj = 125 °C | Tj = 25 °C         | Tj = 85 °C | Tj = 105 °C | Tj = 125 °C |      |
| I <sub>DD</sub>     | Supply current in LPLV-Stop mode | All Peripheral disabled | CStop       | 10.0               | 13.0       | 17.5        | 28          | 15.1               | 22.4       | 37.4        | 74.0        | μA   |
| I <sub>DDCORE</sub> |                                  |                         |             | 1.85               | 12.0       | 21.5        | 40.0        | 6.55               | 38.2       | 62.8        | 98.9        | mA   |
| I <sub>DDCPU</sub>  |                                  |                         |             | 1.30               | 8.00       | 14.0        | 26.5        | 4.17               | 25.4       | 41.3        | 64.9        |      |

1. V<sub>DDCORE</sub> = 0.9 V, V<sub>DDCPU</sub> = 0.9 V.

2. V<sub>DDCORE</sub> = 0.95 V, V<sub>DDCPU</sub> = 0.95 V.

**Table 25. Current consumption in LPLV-Stop2 mode**

| Symbol              | Parameter                         | Conditions              |             | Typ <sup>(1)</sup> |            |             |             | Max <sup>(2)</sup> |            |             |             | Unit |
|---------------------|-----------------------------------|-------------------------|-------------|--------------------|------------|-------------|-------------|--------------------|------------|-------------|-------------|------|
|                     |                                   | -                       | MPU SS mode | Tj = 25 °C         | Tj = 85 °C | Tj = 105 °C | Tj = 125 °C | Tj = 25 °C         | Tj = 85 °C | Tj = 105 °C | Tj = 125 °C |      |
| I <sub>DD</sub>     | Supply current in LPLV-Stop2 mode | All Peripheral disabled | CStandby    | 7.50               | 10.5       | 13.5        | 21.5        | 11.5               | 17.1       | 28.3        | 54.9        | μA   |
| I <sub>DDCORE</sub> |                                   |                         |             | 1.80               | 13.0       | 22.0        | 37.5        | 6.6                | 38.3       | 62.8        | 98.9        | mA   |
| I <sub>DDCPU</sub>  |                                   |                         |             | 0                  | 0          | 0           | 0           | 0                  | 0          | 0           | 0           |      |

1. V<sub>DDCORE</sub> = 0.9 V, V<sub>DDCPU</sub> = 0 V.

2. V<sub>DDCORE</sub> = 0.95 V, V<sub>DDCPU</sub> = 0 V.

Table 26. Current consumption in Standby mode<sup>(1)</sup>

| Symbol          | Parameter                      | Conditions                                        |             | Typ                    |                        |                         |                         | Max                    |                        |                         |                         | Unit |
|-----------------|--------------------------------|---------------------------------------------------|-------------|------------------------|------------------------|-------------------------|-------------------------|------------------------|------------------------|-------------------------|-------------------------|------|
|                 |                                | -                                                 | MPU SS mode | T <sub>j</sub> = 25 °C | T <sub>j</sub> = 85 °C | T <sub>j</sub> = 105 °C | T <sub>j</sub> = 125 °C | T <sub>j</sub> = 25 °C | T <sub>j</sub> = 85 °C | T <sub>j</sub> = 105 °C | T <sub>j</sub> = 125 °C |      |
| I <sub>DD</sub> | Supply current in Standby mode | Backup SRAM OFF, RTC OFF, LSE OFF                 | CStandby    | 3.65                   | 5.95                   | 9                       | 16                      | 3.91                   | 7.63                   | 13.1                    | 26.6                    | μA   |
|                 |                                | Backup SRAM ON, RTC ON, LSE ON, medium_high drive |             | 8.2                    | 21                     | 33.5                    | 56.5                    | 17                     | 33                     | 57                      | 116                     |      |

1. IWDG OFF, LSI OFF, V<sub>DDCORE</sub> = V<sub>DDCPU</sub> = 0 V.

Table 27. Current consumption in V<sub>BAT</sub> mode

| Symbol              | Parameter                               | Conditions                                                                                  |                      | Typ                    |                        |                         |                         | Max                    |                        |                         |                         | Unit |
|---------------------|-----------------------------------------|---------------------------------------------------------------------------------------------|----------------------|------------------------|------------------------|-------------------------|-------------------------|------------------------|------------------------|-------------------------|-------------------------|------|
|                     |                                         | -                                                                                           | V <sub>BAT</sub> (V) | T <sub>j</sub> = 25 °C | T <sub>j</sub> = 85 °C | T <sub>j</sub> = 105 °C | T <sub>j</sub> = 125 °C | T <sub>j</sub> = 25 °C | T <sub>j</sub> = 85 °C | T <sub>j</sub> = 105 °C | T <sub>j</sub> = 125 °C |      |
| I <sub>DDVBAT</sub> | Supply current in V <sub>BAT</sub> mode | Backup SRAM OFF, RTC OFF, LSE OFF, LSE CSS OFF, temperature monitoring OFF                  | 1.6                  | < 0.1                  | 0.120                  | 0.330                   | 0.905                   | < 0.1                  | 0.726                  | 2.52                    | 7.24                    | μA   |
|                     |                                         |                                                                                             | 2.4                  | < 0.1                  | 0.135                  | 0.365                   | 0.975                   | < 0.1                  | 0.937                  | 2.84                    | 7.82                    |      |
|                     |                                         |                                                                                             | 3                    | < 0.1                  | 0.195                  | 0.505                   | 1.20                    | < 0.1                  | 1.13                   | 3.12                    | 8.30                    |      |
|                     |                                         |                                                                                             | 3.3                  | < 0.1                  | 0.515                  | 1.30                    | 3.30                    | < 0.1                  | 1.27                   | 3.34                    | 8.66                    |      |
|                     |                                         |                                                                                             | 3.6                  | < 0.1                  | 0.610                  | 1.45                    | 3.50                    | 0.207                  | 1.55                   | 3.71                    | 9.21                    |      |
|                     |                                         | Backup SRAM OFF, RTC ON, LSE ON, medium_high drive, LSE CSS OFF, temperature monitoring OFF | 1.6                  | 0.915                  | 1.10                   | 1.35                    | 1.95                    | 0.378                  | 1.35                   | 3.17                    | 7.90                    |      |
|                     |                                         |                                                                                             | 2.4                  | 1.25                   | 1.45                   | 1.70                    | 2.35                    | 0.985                  | 2.03                   | 3.95                    | 8.96                    |      |
|                     |                                         |                                                                                             | 3                    | 1.55                   | 1.80                   | 2.15                    | 2.95                    | 1.79                   | 2.79                   | 4.78                    | 9.95                    |      |
|                     |                                         |                                                                                             | 3.3                  | 1.70                   | 2.30                   | 3.15                    | 5.20                    | 2.32                   | 3.28                   | 5.32                    | 10.60                   |      |
|                     |                                         |                                                                                             | 3.6                  | 1.95                   | 2.60                   | 3.50                    | 5.65                    | 2.92                   | 3.93                   | 6.04                    | 11.6                    |      |
|                     |                                         | Backup SRAM ON, RTC ON, LSE ON, medium_high drive, LSE CSS OFF, temperature monitoring OFF  | 1.6                  | 3.20                   | 12.5                   | 21.0                    | 35.5                    | 5.22                   | 23.6                   | 42.3                    | 74.9                    |      |
|                     |                                         |                                                                                             | 2.4                  | 3.65                   | 13.0                   | 22.0                    | 36.5                    | 6.93                   | 27.2                   | 46.8                    | 81.8                    |      |
|                     |                                         |                                                                                             | 3                    | 4.05                   | 13.5                   | 22.5                    | 38.5                    | 8.07                   | 29.4                   | 49.2                    | 84.8                    |      |
|                     |                                         |                                                                                             | 3.3                  | 4.40                   | 14.5                   | 24.5                    | 41.5                    | 8.78                   | 30.9                   | 50.9                    | 86.4                    |      |
|                     |                                         |                                                                                             | 3.6                  | 4.70                   | 15.5                   | 26.0                    | 43.5                    | 9.59                   | 32.3                   | 52.9                    | 88.5                    |      |
|                     |                                         | Backup SRAM ON, RTC ON, LSE ON, high drive, LSE CSS OFF, temperature monitoring OFF         | 1.6                  | 3.55                   | 12.5                   | 21.5                    | 35.5                    | 5.19                   | 23.6                   | 42.3                    | 74.9                    |      |
|                     |                                         |                                                                                             | 2.4                  | 3.95                   | 13.5                   | 22.0                    | 37.0                    | 5.83                   | 25.6                   | 45.2                    | 79.7                    |      |
|                     |                                         |                                                                                             | 3                    | 4.40                   | 14.0                   | 23.0                    | 39.0                    | 8.08                   | 29.5                   | 49.2                    | 84.7                    |      |
|                     |                                         |                                                                                             | 3.3                  | 4.70                   | 15.0                   | 25.0                    | 41.5                    | 8.79                   | 30.9                   | 51.1                    | 86.5                    |      |
|                     |                                         |                                                                                             | 3.6                  | 5.05                   | 16.0                   | 26.0                    | 43.0                    | 9.60                   | 33.3                   | 52.9                    | 88.6                    |      |

Table 27. Current consumption in V<sub>BAT</sub> mode (continued)

| Symbol              | Parameter                               | Conditions                                                                        |                      | Typ                    |                        |                         |                         | Max                    |                        |                         |                         | Unit |
|---------------------|-----------------------------------------|-----------------------------------------------------------------------------------|----------------------|------------------------|------------------------|-------------------------|-------------------------|------------------------|------------------------|-------------------------|-------------------------|------|
|                     |                                         | -                                                                                 | V <sub>BAT</sub> (V) | T <sub>j</sub> = 25 °C | T <sub>j</sub> = 85 °C | T <sub>j</sub> = 105 °C | T <sub>j</sub> = 125 °C | T <sub>j</sub> = 25 °C | T <sub>j</sub> = 85 °C | T <sub>j</sub> = 105 °C | T <sub>j</sub> = 125 °C |      |
| I <sub>DDVBAT</sub> | Supply current in V <sub>BAT</sub> mode | Backup SRAM ON, RTC ON, LSE ON, high drive, LSE CSS ON, temperature monitoring ON | 1.6                  | 3.55                   | 12.5                   | 21.0                    | 36.0                    | 7.95                   | 28.0                   | 47.9                    | 82.3                    | μA   |
|                     |                                         |                                                                                   | 2.4                  | 3.95                   | 13.5                   | 22.0                    | 37.0                    | 8.99                   | 29.6                   | 49.4                    | 84.3                    |      |
|                     |                                         |                                                                                   | 3                    | 4.45                   | 14.0                   | 23.0                    | 38.5                    | 10.02                  | 32.1                   | 51.8                    | 87.2                    |      |
|                     |                                         |                                                                                   | 3.3                  | 4.65                   | 15.0                   | 24.5                    | 41.5                    | 10.7                   | 33.2                   | 53.6                    | 89.0                    |      |
|                     |                                         |                                                                                   | 3.6                  | 5.00                   | 16.0                   | 26.0                    | 43.5                    | 11.2                   | 35.9                   | 55.5                    | 90.8                    |      |





### I/O system current consumption

The current consumption of the I/O system has two components: static and dynamic.

#### I/O static current consumption

All the I/Os used as inputs with pull-up generate a current consumption when the pin is externally held low. The value of this current consumption can be simply computed by using the pull-up/pull-down resistors values given in [Table 54: I/O static characteristics](#).

For the output pins, any external pull-down or external load must also be considered to estimate the current consumption.

An additional I/O current consumption is due to I/Os configured as inputs if an intermediate voltage level is externally applied. This current consumption is caused by the input Schmitt trigger circuits used to discriminate the input value. Unless this specific configuration is required by the application, this supply current consumption can be avoided by configuring these I/Os in analog mode. This is notably the case of ADC input pins which should be configured as analog inputs.

**Caution:** Any floating input pin can also settle to an intermediate voltage level or switch inadvertently, as a result of external electromagnetic noise. To avoid a current consumption related to floating pins, they must either be configured in analog mode, or forced internally to a definite digital value. This can be done either by using pull-up/down resistors or by configuring the pins in output mode.

#### I/O dynamic current consumption

The I/Os used by an application contribute to the current consumption. When an I/O pin switches, it uses the current from the MCU supply voltage to supply the I/O pin circuitry and to charge/discharge the capacitive load (internal or external) connected to the pin.

The theoretical formula is provided below:

$$I_{SW} = V_{DDX} \times f_{SW} \times C_L$$

where

$I_{SW}$  is the current sunk by a switching I/O to charge/discharge the capacitive load

$V_{DDX}$  is the MCU supply voltage

$f_{SW}$  is the I/O switching frequency

$C_L$  is the total capacitance seen by the I/O pin:  $C = C_{INT} + C_{EXT}$

### 6.3.7 Wakeup time from low-power modes

The wakeup times given in [Table 28](#) are measured starting from the wakeup event trigger up to the first instruction executed by the MPU:

- For CSleep modes:
  - the MPU goes in low-power mode after WFE (Wait For Event) instruction.
- For CStop modes:
  - the MPU goes in low-power mode after WFI (Wait For Interrupt) instruction.
- WKUPx pin is used to wakeup from low-power modes.

All timings are derived from tests performed under ambient temperature and  $V_{DD} = 3.3\text{ V}$ .

Table 28. Low-power mode wakeup timings

| Symbol                   | Parameter                                               | System mode | Conditions (after wakeup)  | Typ <sup>(1)</sup>  | Max <sup>(1)</sup>  | Unit                  |
|--------------------------|---------------------------------------------------------|-------------|----------------------------|---------------------|---------------------|-----------------------|
| <b>MPU wakeup</b>        |                                                         |             |                            |                     |                     |                       |
| $t_{WUCSLEEP\_MPU}$      | MPU wakeup from CSleep                                  | Run         | HSE 24 MHz, SYSRAM         | 31                  | 32                  | mpuss_ck clock cycles |
| $t_{WUCSTOP\_MPU}$       | MPU wakeup from CStop                                   | Stop        | HSI 64 MHz, SYSRAM         | 16                  | 17                  | $\mu s$               |
|                          |                                                         |             | HSE + PLL 1000 MHz, SYSRAM | 64                  | 73                  |                       |
|                          |                                                         |             | HSE + PLL 650 MHz, SYSRAM  | 64                  | 73                  |                       |
| $t_{WULPLV\_Stop\_MPU}$  | MPU wakeup from CStop with system in LPLV-Stop (LVDS=1) | LPLV-Stop   | HSI 64 MHz, SYSRAM         | 410                 | 470                 |                       |
| $t_{WULPLV\_Stop2\_MPU}$ | MPU wakeup from CStandby with system in LPLV-Stop2      | LPLV-Stop2  | HSI 64 MHz, SYSRAM         | 9000 <sup>(2)</sup> | 9000 <sup>(2)</sup> |                       |

1. Evaluated by characterization, not tested in production unless otherwise specified.
2. On exit from LPLV-Stop2 the boot ROM is activated and a branch is done to the address stored in the BSEC\_SCRATCH register. A system initialization is done which duration depends on the user application. Here are application dependent parameters used for characterization:
  - MMU description table size: 32 Bytes (could be up to 20 Kbytes for a Linux application)
  - HSI frequency: 64 kHz (waking up with a fast PLL would significantly reduce  $t_{WULPLV\_Stop2\_MPU}$ )
 Note: branching directly to a function that toggles a GPIO would result in  $t_{WULPLV\_Stop2\_MPU} \approx 1500 \mu s$ .

Table 29. Wakeup time using USART<sup>(1)</sup>

| Symbol        | Parameter                                                                                                                      | Conditions | Typ | Max                | Unit    |
|---------------|--------------------------------------------------------------------------------------------------------------------------------|------------|-----|--------------------|---------|
| $t_{WUUSART}$ | Wakeup time needed to calculate the maximum USART baud rate allowing the wakeup from stop mode when USART clock source is HSI. | Stop       | -   | 6.7                | $\mu s$ |
|               |                                                                                                                                | LPLV-Stop  | -   | 318 <sup>(2)</sup> | $\mu s$ |

1. Specified by design, not tested in production.
2. Including the  $t_{SEL\_VDDCORETEMPO} = 234 \mu s$ .

### 6.3.8 External clock source characteristics

#### High-speed external user clock generated from an external source

In bypass mode the HSE oscillator is switched off and the input pin is a standard I/O.

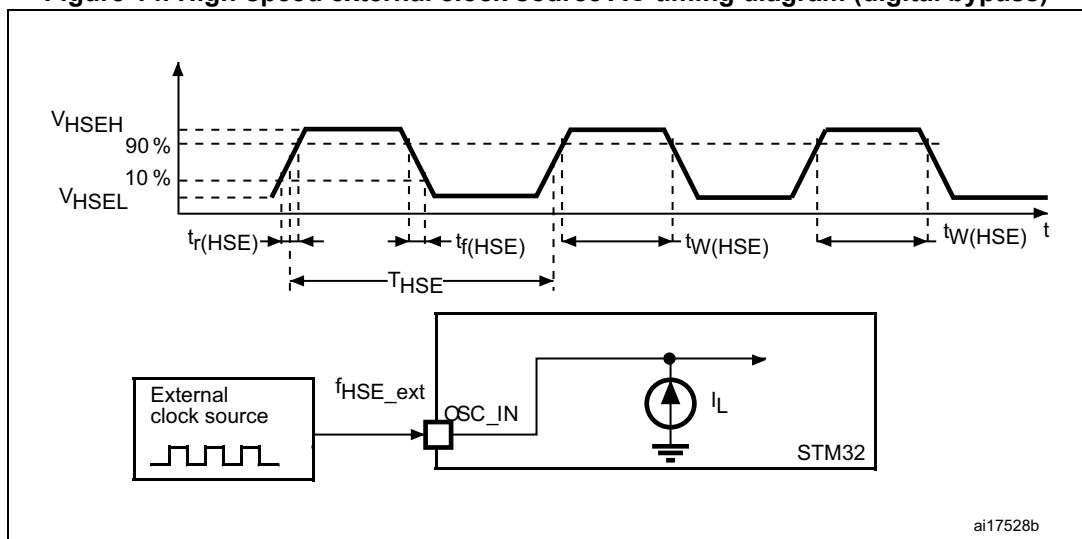
Digital and analog bypass modes are available.

The external clock signal has to respect the [Table 54: I/O static characteristics](#). However, the recommended clock input waveform is shown in [Figure 14](#) for digital bypass mode and in [Figure 15](#) for analog bypass mode. In analog bypass mode the clock can be a sinusoidal waveform.

**Table 30. High-speed external user clock characteristics (digital bypass)<sup>(1)</sup>**

| Symbol         | Parameter                            | Min                 | Typ | Max                 | Unit |
|----------------|--------------------------------------|---------------------|-----|---------------------|------|
| $f_{HSE\_ext}$ | User external clock source frequency | 8                   | 24  | 48                  | MHz  |
| $V_{HSEH}$     | OSC_IN input pin high level voltage  | $0.7 \times V_{DD}$ | -   | $V_{DD}$            | V    |
| $V_{HSEL}$     | OSC_IN input pin low level voltage   | $V_{SS}$            | -   | $0.3 \times V_{DD}$ |      |
| $t_{W(HSE)}$   | OSC_IN high or low time              | 7                   | -   | -                   | ns   |

1. Specified by design, not tested in production.

**Figure 14. High-speed external clock source AC timing diagram (digital bypass)****Table 31. High-speed external user clock characteristics (analog bypass)<sup>(1)</sup>**

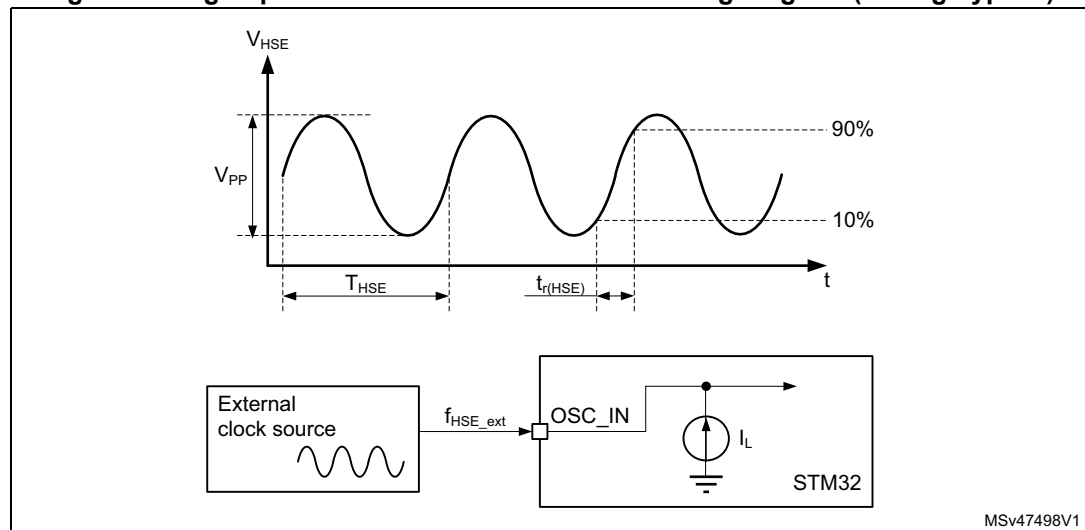
| Symbol            | Parameter                                                                            | Min                   | Typ            | Max                  | Unit    |
|-------------------|--------------------------------------------------------------------------------------|-----------------------|----------------|----------------------|---------|
| $f_{HSE\_ext}$    | User external clock source frequency                                                 | 8                     | 24             | 48                   | MHz     |
|                   | duty cycle (Square wave)                                                             | 45                    | 50             | 55                   | %       |
|                   | duty cycle deterioration                                                             | 0                     | $\pm 10^{(2)}$ | $\pm 20^{(3)}$       | %       |
| $V_{HSE}$         | Absolute input range                                                                 | 0                     | -              | $V_{DD}$             | -       |
| $V_{PP}$          | OSC_IN peak-to-peak amplitude                                                        | $0.2^{(4)}$           | -              | $0.67 \times V_{DD}$ | V       |
| $t_{SU}^{(5)}$    | Time to start                                                                        | -                     | 1              | $10^{(6)}$           | $\mu s$ |
| $t_r/t_f^{(HSE)}$ | Rise and Fall time (10% to 90% threshold levels of the input peak-to-peak amplitude) | $0.05 \times T_{HSE}$ | -              | $0.3 \times T_{HSE}$ | ns      |
| $I_{(HSE)}$       | Power consumption                                                                    | -                     | $150^{(7)}$    | $500^{(8)}$          | $\mu A$ |

1. Specified by design, not tested in production.

2. Specified by design, not tested in production: with a square wave signal (@25 °C,  $V_{DD}=3.3\text{ V}$  /  $V_{PP} = 400\text{ mV}$  /  $V_{DC}=1\text{ V}$ ) where  $V_{DC}$  is the DC component of the input signal.

3. Specified by design, not tested in production: with a square wave signal (@25 °C,  $V_{DD}=1.71\text{ V}$  /  $V_{PP} = 200\text{ mV}$  /  $V_{DC}=0.8\text{ V}$ ) where  $V_{DC}$  is the DC component of the input signal.
4. minimum peak-to-peak amplitude (@25 °C,  $0.1 < V_{DC} < V_{DD}-0.1\text{ V}$ ) where  $V_{DC}$  is the DC component of the input signal.
5.  $t_{SU(HSE)}$  is the startup time measured from the moment it is enabled (by software) to a stabilized analog bypass clock interface is reached. This value is measured with 200 mV peak-to-peak amplitude.
6. Maximum start-up time is obtained with 200 mV peak-to-peak amplitude.
7. with a sine wave signal ( $V_{PP} = 400\text{ mV}$  /  $V_{DC}=0.4\text{ V}$ ) where  $V_{DC}$  is the DC component of the input signal.
8. with a sine wave signal ( $V_{DD} = 3.6\text{ V}$  /  $V_{PP} = 800\text{ mV}$  /  $V_{DC} = 1.8\text{ V}$ ) where  $V_{DC}$  is the DC component of the input signal.

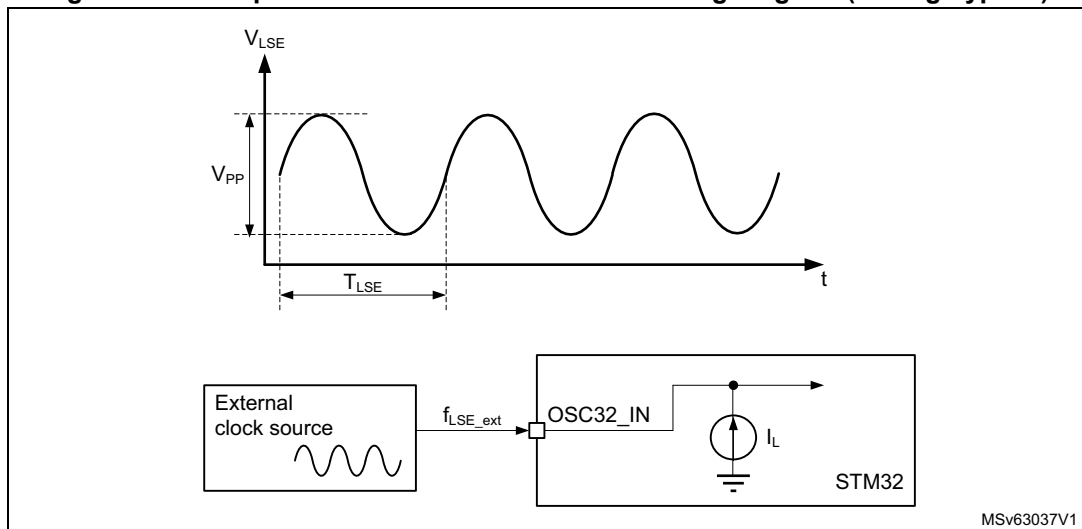
Figure 15. High-speed external clock source AC timing diagram (analog bypass)

Table 32. Low-speed external user clock characteristics (analog bypass)<sup>(1)</sup>

| Symbol         | Parameter                            | Min         | Typ    | Max            | Unit |
|----------------|--------------------------------------|-------------|--------|----------------|------|
| $f_{LSE\_ext}$ | User external clock source frequency | -           | 32.768 | -              | kHz  |
| $V_{LSE}$      | Absolute input range                 | 0           | -      | $V_{SW}^{(2)}$ | -    |
| $V_{PP}$       | OSC32_IN peak-to-peak amplitude      | $0.2^{(3)}$ | 1      | -              | V    |
| $I_{(LSE)}$    | Power consumption                    | -           | 120    | -              | nA   |

1. Specified by design, not tested in production.
2.  $V_{SW}$  is equal to  $V_{DD}$  when present or  $V_{BAT}$  otherwise
3. Minimum peak-to-peak amplitude (@25 °C,  $0.1 < V_{DC} < V_{SW} - 0.1\text{ V}$ ) where  $V_{DC}$  is the DC component of the input signal.

Figure 16. Low-speed external clock source AC timing diagram (analog bypass)



### Low-speed external user clock generated from an external source

In bypass mode the LSE oscillator is switched off and the input pin is a standard I/O. The external clock signal has to respect the [Table 54: I/O static characteristics](#). However, the recommended clock input waveform is shown in [Figure 17](#) for digital bypass and [Figure 16](#) for analog bypass.

Table 33. Low-speed external user clock characteristics (digital bypass)<sup>(1)</sup>

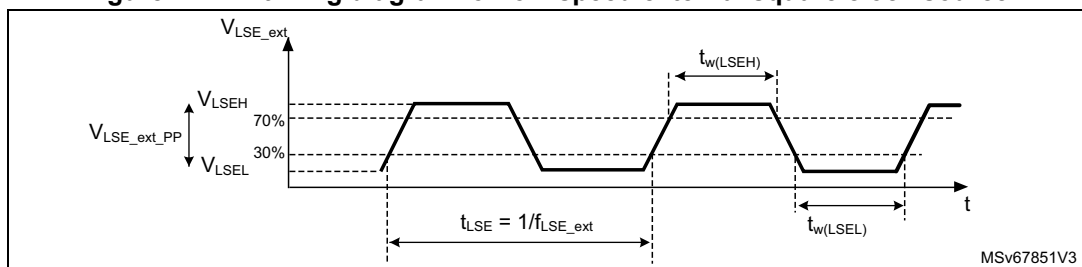
| Symbol                         | Parameter                                         | Min | Typ    | Max            | Unit |
|--------------------------------|---------------------------------------------------|-----|--------|----------------|------|
| $f_{LSE\_ext}$                 | User external clock source frequency              | 5   | 32.768 | 40             | kHz  |
| $V_{LSE\_ext\_PP}$             | OSC32_IN peak-to-peak amplitude                   | 0.3 | -      | $V_{SW}^{(2)}$ | V    |
| $V_{LSE\_ext}$                 | OSC32_IN input range                              | 0   | -      | $V_{SW}^{(2)}$ |      |
| $t_{w(LSEH)}$<br>$t_{w(LSEL)}$ | OSC32_IN high or low time for square signal input | 10  | -      | -              | ns   |

1. Specified by design. Not tested in production.

2.  $V_{SW} = V_{DD}$  when  $V_{DD}$  is above  $V_{BOR0}$ , and  $V_{SW} = V_{BAT}$  when  $V_{DD}$  is below  $V_{BOR0}$ .

**Note:** For information on selecting the crystal, refer to the application note AN2867 "Oscillator design guide for ST microcontrollers" available from the ST website [www.st.com](http://www.st.com).

Figure 17. AC timing diagram for low-speed external square clock source



### High-speed external clock generated from a crystal/ceramic resonator

The high-speed external (HSE) clock can be supplied with a 8 to 48 MHz crystal/ceramic resonator oscillator. All the information given in this paragraph are based on characterization results obtained with typical external components specified in [Table 34](#). In the application, the resonator and the load capacitors have to be placed as close as possible to the oscillator pins in order to minimize output distortion and startup stabilization time. Refer to the crystal resonator manufacturer for more details on the resonator characteristics (frequency, package, accuracy).

**Table 34. 8-48 MHz HSE oscillator characteristics<sup>(1)</sup>**

| Symbol                           | Parameter                   | Operating conditions <sup>(2)</sup>                                                 | Min | Typ  | Max  | Unit |
|----------------------------------|-----------------------------|-------------------------------------------------------------------------------------|-----|------|------|------|
| F                                | Oscillator frequency        | -                                                                                   | 8   | 24   | 48   | MHz  |
| R <sub>F</sub>                   | Feedback resistor           | -                                                                                   | -   | 200  | -    | kΩ   |
| I <sub>DD(HSE)</sub>             | HSE current consumption     | During startup <sup>(3)</sup>                                                       | -   | -    | 8    | mA   |
|                                  |                             | V <sub>DD</sub> = 3.3 V, R <sub>m</sub> = 150 Ω<br>C <sub>L</sub> = 12 pF at 4 MHz  | -   | 0.53 | -    |      |
|                                  |                             | V <sub>DD</sub> = 3.3 V, R <sub>m</sub> = 120 Ω<br>C <sub>L</sub> = 10 pF at 16 MHz | -   | 0.61 | -    |      |
|                                  |                             | V <sub>DD</sub> = 3.3 V, R <sub>m</sub> = 100 Ω<br>C <sub>L</sub> = 10 pF at 24 MHz | -   | 0.63 | -    |      |
|                                  |                             | V <sub>DD</sub> = 3.3 V, R <sub>m</sub> = 80 Ω<br>C <sub>L</sub> = 8 pF at 32 MHz   | -   | 0.63 | -    |      |
|                                  |                             | V <sub>DD</sub> = 3.3 V, R <sub>m</sub> = 80 Ω<br>C <sub>L</sub> = 8 pF at 48 MHz   | -   | 0.81 | -    |      |
| G <sub>m<sub>crit</sub>max</sub> | Maximum critical crystal gm | Startup                                                                             | -   | -    | 1.15 | mA/V |
| t <sub>SU</sub> <sup>(4)</sup>   | Start-up time               | V <sub>DD</sub> is stabilized                                                       | -   | 2    | -    | ms   |

1. Specified by design, not tested in production.

2. Resonator characteristics given by the crystal/ceramic resonator manufacturer.

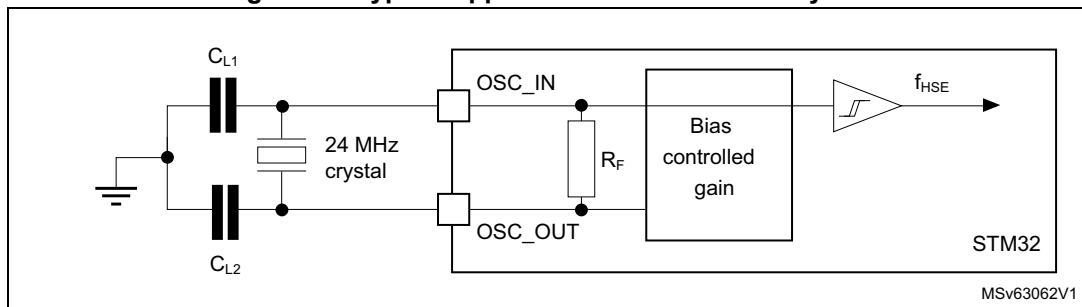
3. This consumption level occurs during the first 2/3 of the t<sub>SU(HSE)</sub> startup time.

4. t<sub>SU(HSE)</sub> is the startup time measured from the moment it is enabled (by software) to a stabilized 8 MHz oscillation is reached. This value is measured for a standard crystal resonator and it can vary significantly with the crystal manufacturer.

For C<sub>L1</sub> and C<sub>L2</sub>, it is recommended to use high-quality external ceramic capacitors in the 5 pF to 25 pF range (typical), designed for high-frequency applications, and selected to match the requirements of the crystal or resonator (see [Figure 18](#)). C<sub>L1</sub> and C<sub>L2</sub> are usually the same size. The crystal manufacturer typically specifies a load capacitance which is the series combination of C<sub>L1</sub> and C<sub>L2</sub>. The PCB and MCU pin capacitance must be included (4 pF can be used as a rough estimate of the combined pin and board capacitance) when sizing C<sub>L1</sub> and C<sub>L2</sub>.

**Note:** For information on selecting the crystal, refer to the application note AN2867 "Oscillator design guide for ST microcontrollers" available from the ST website [www.st.com](http://www.st.com).

Figure 18. Typical application with a 24 MHz crystal



### Low-speed external clock generated from a crystal/ceramic resonator

The low-speed external (LSE) clock can be supplied with a 32.768 kHz crystal/ceramic resonator oscillator. All the information given in this paragraph are based on characterization results obtained with typical external components specified in [Table 35](#). In the application, the resonator and the load capacitors have to be placed as close as possible to the oscillator pins in order to minimize output distortion and startup stabilization time. Refer to the crystal resonator manufacturer for more details on the resonator characteristics (frequency, package, accuracy).

Table 35. Low-speed external user clock characteristics<sup>(1)</sup>

| Symbol                            | Parameter                   | Operating conditions <sup>(2)</sup>               | Min | Typ    | Max  | Unit |
|-----------------------------------|-----------------------------|---------------------------------------------------|-----|--------|------|------|
| F                                 | Oscillator frequency        | -                                                 | -   | 32.768 | -    | kHz  |
| I <sub>DD</sub>                   | LSE current consumption     | LSEDRV[1:0] = 00,<br>Low drive capability         | -   | 303    | -    | nA   |
|                                   |                             | LSEDRV[1:0] = 01,<br>Medium Low drive capability  | -   | 466    | -    |      |
|                                   |                             | LSEDRV[1:0] = 10,<br>Medium high drive capability | -   | 636    | -    |      |
|                                   |                             | LSEDRV[1:0] = 11,<br>High drive capability        | -   | 1028   | -    |      |
| G <sub>m</sub> <sub>critmax</sub> | Maximum critical crystal gm | LSEDRV[1:0] = 00,<br>Low drive capability         | -   | -      | 0.5  | μA/V |
|                                   |                             | LSEDRV[1:0] = 01,<br>Medium Low drive capability  | -   | -      | 0.75 |      |
|                                   |                             | LSEDRV[1:0] = 10,<br>Medium high drive capability | -   | -      | 1.7  |      |
|                                   |                             | LSEDRV[1:0] = 11,<br>High drive capability        | -   | -      | 2.7  |      |
| t <sub>SU</sub> <sup>(3)</sup>    | Startup time                | V <sub>DD</sub> is stabilized                     | -   | 2      | -    | s    |

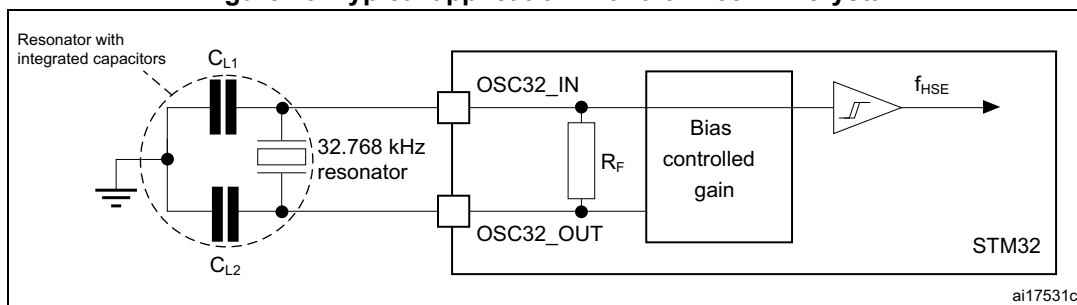
1. Specified by design, not tested in production.

2. Refer to the note and caution paragraphs below the table, and to the application note AN2867 "Oscillator design guide for ST microcontrollers.

3. t<sub>SU</sub> is the startup time measured from the moment it is enabled (by software) to a stabilized 32.768 kHz oscillation is reached. This value is measured for a standard crystal resonator and it can vary significantly with the crystal manufacturer.

**Note:** For information on selecting the crystal, refer to the application note AN2867 “Oscillator design guide for ST microcontrollers” available from the ST website [www.st.com](http://www.st.com).

**Figure 19. Typical application with a 32.768 kHz crystal**



1. Adding an external resistor between OSC32\_IN and OSC32\_OUT is forbidden.

### 6.3.9 External clock source security characteristics

**Table 36. High-speed external user clock security system (HSE CSS)<sup>(1)</sup>**

| Symbol              | Parameter                                       | Min | Typ | Max | Unit    |
|---------------------|-------------------------------------------------|-----|-----|-----|---------|
| $t_{DCM}(HSE\_CSS)$ | Time to detect clock missing                    | -   | 2   | -   | $\mu s$ |
| $t_{DCP}(HSE\_CSS)$ | Time to detect clock presence                   | -   | -   | 250 | ns      |
| $I_{VDD}(HSE\_CSS)$ | Power consumption ( $f_{HSE} = 48\text{ MHz}$ ) | -   | -   | 50  | $\mu A$ |

1. Specified by design, not tested in production.

### 6.3.10 Internal clock source characteristics

The parameters given in [Table 37](#), [Table 38](#) and [Table 39](#) are derived from tests performed under ambient temperature and  $V_{DD}$  supply voltage conditions summarized in [Table 13: General operating conditions](#).

#### 64 MHz high-speed internal RC oscillator (HSI)

**Table 37. HSI oscillator characteristics<sup>(1)</sup>**

| Symbol          | Parameter              | Conditions                                                                 | Min  | Typ   | Max  | Unit |
|-----------------|------------------------|----------------------------------------------------------------------------|------|-------|------|------|
| $f_{HSI}^{(2)}$ | HSI frequency          | $V_{DD} = 3.3\text{ V}$ , $T_J = 30\text{ }^\circ\text{C}$                 | 63.7 | 64    | 64.3 | MHz  |
| TRIM            | HSI user trimming step | Trimming is not a multiple of 32                                           | -    | 0.24  | 0.33 | %    |
|                 |                        | Trimming is 128, 256 and 384                                               | -    | -2.43 | -    |      |
|                 |                        | Trimming is 64, 192, 320 and 448                                           | -    | -0.70 | -    |      |
|                 |                        | Other trimming are a multiple of 32 (not including multiple of 64 and 128) | -    | -0.30 | -    |      |
| DuCy(HSI)       | Duty Cycle             | -                                                                          | 45   | -     | 55   | %    |



Table 37. HSI oscillator characteristics<sup>(1)</sup> (continued)

| Symbol                               | Parameter                                                                              | Conditions                 | Min   | Typ  | Max  | Unit    |
|--------------------------------------|----------------------------------------------------------------------------------------|----------------------------|-------|------|------|---------|
| $\Delta_{VDD}$ (HSI)                 | HSI oscillator frequency drift over $V_{DD}$ (reference is 3.3 V)                      | $V_{DD} = 1.71$ to $3.6$ V | -0.12 | -    | 0.03 | %       |
| $\Delta_{TEMP}$ (HSI) <sup>(3)</sup> | HSI oscillator frequency drift over temperature after factory calibration              | $T_J = -20$ to $110$ °C    | -1.25 | -    | 0.75 | %       |
|                                      |                                                                                        | $T_J = -40$ to $125$ °C    | -1.75 | -    | 0.95 |         |
| $t_{su}$ (HSI)                       | HSI oscillator start-up time (Time between Enable rising and First output clock edge.) | -                          | -     | 1.47 | 2    | $\mu$ s |
| $t_{stab}$ (HSI)                     | HSI oscillator stabilization time                                                      | at 1% of target frequency  | -     | 3    | -    | $\mu$ s |
| $I_{DD}$ (HSI)                       | HSI oscillator power consumption                                                       | -                          | -     | 300  | 400  | $\mu$ A |

1. Specified by design, not tested in production unless otherwise specified.
2. Guaranteed by testing.
3. Evaluated by characterization, not tested in production.

#### 4 MHz low-power internal RC oscillator (CSI)

Table 38. CSI oscillator characteristics<sup>(1)</sup>

| Symbol                                                      | Parameter                                                             | Conditions                                         | Min  | Typ        | Max  | Unit    |
|-------------------------------------------------------------|-----------------------------------------------------------------------|----------------------------------------------------|------|------------|------|---------|
| $f_{CSI}$ <sup>(2)</sup>                                    | CSI frequency                                                         | $V_{DD} = 3.3$ V, $T_J = 30$ °C                    | 3.98 | 4          | 4.02 | MHz     |
| TRIM                                                        | Trimming step                                                         | Trimming code is not a multiple of 16              | -    | 0.85       | 1    | %       |
|                                                             |                                                                       | Trimming code is a multiple of 16                  | -    | -1.65      | -    | -       |
| DuCy(CSI)                                                   | Duty Cycle                                                            | -                                                  | 45   | -          | 55   | %       |
| $\Delta_{VDD}$ (CSI) + $\Delta_{TEMP}$ (CSI) <sup>(3)</sup> | CSI oscillator frequency drift over $V_{DD}$ & drift over temperature | $V_{DD} = 1.71$ to $3.6$ V<br>$T_J = 0$ to $85$ °C | -    | $\pm 1.43$ | -    | %       |
| $t_{su}$ (CSI)                                              | CSI oscillator startup time                                           | -                                                  | -    | 1.5        | 2.4  | $\mu$ s |
| $t_{stab}$ (CSI)                                            | CSI oscillator stabilization time (to reach $\pm 5\%$ of $f_{CSI}$ )  | $T_J = 0$ to $85$ °C                               | -    | 5          | -    | cycle   |
| $I_{DD}$ (CSI)                                              | CSI oscillator power consumption                                      | -                                                  | -    | 30         | -    | $\mu$ A |

1. Specified by design, not tested in production.
2. Guaranteed by testing.
3. Evaluated by characterization, not tested in production.

## 32 kHz low-speed internal (LSI) RC oscillator

Table 39. LSI oscillator characteristics<sup>(1)</sup>

| Symbol                 | Parameter                                                                             | Conditions                                                                                           | Min  | Typ | Max  | Unit          |
|------------------------|---------------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------|------|-----|------|---------------|
| $f_{\text{LSI}}$       | LSI frequency                                                                         | $T_J = 30\text{ }^{\circ}\text{C}$ , <sup>(2)</sup><br>$V_{\text{DD}} = 3.3\text{ V}$                | 31.4 | 32  | 32.6 | kHz           |
|                        |                                                                                       | $T_J = -40\text{ to }125\text{ }^{\circ}\text{C}$ ,<br>$V_{\text{DD}} = 1.71\text{ to }3.6\text{ V}$ | 29   | 32  | 33.6 |               |
| $t_{\text{su(LSI)}}$   | LSI oscillator startup time (Time between Enable rising and First output clock edge.) | -                                                                                                    | -    | 64  | 125  | $\mu\text{s}$ |
| $t_{\text{stab(LSI)}}$ | LSI oscillator stabilization time (5% of final value)                                 | -                                                                                                    | -    | 110 | 170  |               |
| $I_{\text{DD(LSI)}}$   | LSI oscillator power consumption                                                      | -                                                                                                    | -    | 120 | 230  | nA            |

1. Specified by design, not tested in production.

2. Guaranteed by testing.

## 6.3.11 PLL characteristics

The parameters given in [Table 41](#), [Table 42](#), [Table 43](#) are derived from tests performed under temperature and  $V_{\text{DD}}$  supply voltage conditions summarized in [Table 13: General operating conditions](#).

## PLL1 characteristics

Table 40. PLL1 characteristics<sup>(1)</sup>

| Symbol                         | Parameter                         | Conditions                                | Min                               | Typ                           | Max                               | Unit |
|--------------------------------|-----------------------------------|-------------------------------------------|-----------------------------------|-------------------------------|-----------------------------------|------|
| $f_{\text{PLL\_IN}}$           | PLL input clock                   | Normal mode and Sigma delta mode          | 8                                 | -                             | 16                                | MHz  |
|                                | PLL input clock duty cycle        | -                                         | 10                                | -                             | 90                                | %    |
| $f_{\text{PLL\_P\_Q\_R\_OUT}}$ | PLL P,Q,R multiplier output clock | -                                         | 3.875                             | -                             | 1000 <sup>(2)</sup>               | MHz  |
|                                | PLL P,Q,R clock duty cycle        | Division by 1                             | 47.5                              | 50                            | 52.5                              | %    |
|                                |                                   | Even divisions<br>(N multiple of 2)       | 47.5                              | 50                            | 52.5                              |      |
|                                |                                   | Odd divisions<br>(N not multiple of 2)    | $\frac{100 \times (N+1)}{2N} - 5$ | $\frac{100 \times (N+1)}{2N}$ | $\frac{100 \times (N+1)}{2N} + 5$ |      |
| $f_{\text{VCO\_OUT}}$          | PLL VCO output                    | Direct VCO clock after internal divider/2 | 496                               | -                             | 1000                              | MHz  |
|                                | PLL VCO Duty Cycle                |                                           | 47.5                              | 50                            | 52.5                              | %    |

Table 40. PLL1 characteristics<sup>(1)</sup> (continued)

| Symbol                      | Parameter                                                              | Conditions                                                                                                                    | Min | Typ                | Max     | Unit           |
|-----------------------------|------------------------------------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------|-----|--------------------|---------|----------------|
| $t_{\text{LOCK}}$           | PLL lock time                                                          | Normal mode                                                                                                                   | -   | 50                 | 150     | $\mu\text{s}$  |
|                             |                                                                        | Sigma-delta mode (CKIN $\geq$ 8 MHz)                                                                                          | -   | 65                 | 170     |                |
| $A_{\text{LOCK}}$           | Lock Accuracy<br>(Ratio VCO frequency versus target frequency at lock) | -                                                                                                                             | -   | -                  | $\pm 2$ | %              |
| Jitter                      | RMS cycle-to-cycle jitter                                              | $f_{\text{PLL\_P\_Q\_R\_OUT}}$ division = 1 to 16<br>Without Fractional mode<br>VCO = 992 MHz                                 | -   | 24 <sup>(3)</sup>  | -       | $\pm\text{ps}$ |
|                             |                                                                        | VCO = 1066 MHz                                                                                                                | -   | 24 <sup>(3)</sup>  | -       |                |
|                             |                                                                        | VCO = 2000 MHz                                                                                                                | -   | 23 <sup>(3)</sup>  | -       |                |
|                             |                                                                        | $f_{\text{PLL\_P\_Q\_R\_OUT}}$ division = 1 to 16<br>With Fractional mode<br>VCO = 992 MHz                                    | -   | 23 <sup>(3)</sup>  | -       |                |
|                             | RMS period jitter                                                      | VCO = 2000 MHz                                                                                                                | -   | 24 <sup>(3)</sup>  | -       | $\pm\text{ps}$ |
|                             |                                                                        | $f_{\text{PLL\_P\_Q\_R\_OUT}}$ division = 1 to 16<br>Without Fractional mode<br>VCO = 992 MHz                                 | -   | 16 <sup>(3)</sup>  | -       |                |
|                             |                                                                        | VCO = 1066 MHz                                                                                                                | -   | 16 <sup>(3)</sup>  | -       |                |
|                             |                                                                        | VCO = 2000 MHz                                                                                                                | -   | 14 <sup>(3)</sup>  | -       |                |
|                             | Long term jitter                                                       | $f_{\text{PLL\_P\_Q\_R\_OUT}}$ division = 1 to 16<br>$f_{\text{PLL\_IN}}$ = 8 MHz<br>Without Fractional mode<br>VCO = 992 MHz | -   | 22 <sup>(3)</sup>  | -       | ps             |
|                             |                                                                        | VCO = 2000 MHz                                                                                                                | -   | 15 <sup>(3)</sup>  | -       |                |
|                             |                                                                        | $f_{\text{PLL\_P\_Q\_R\_OUT}}$ division = 1 to 16<br>$f_{\text{PLL\_IN}}$ = 8 MHz<br>Without Fractional mode<br>VCO = 992 MHz | -   | 185 <sup>(4)</sup> | -       |                |
|                             |                                                                        | VCO = 1066 MHz                                                                                                                | -   | 180 <sup>(4)</sup> | -       |                |
|                             |                                                                        | VCO = 2000 MHz                                                                                                                | -   | 103 <sup>(4)</sup> | -       |                |
|                             |                                                                        | $f_{\text{PLL\_P\_Q\_R\_OUT}}$ division = 1 to 16<br>$f_{\text{PLL\_IN}}$ = 8 MHz<br>With Fractional mode<br>VCO = 992 MHz    | -   | 270 <sup>(4)</sup> | -       |                |
|                             |                                                                        | VCO = 1066 MHz                                                                                                                | -   | 260 <sup>(4)</sup> | -       |                |
|                             |                                                                        | VCO = 2000 MHz                                                                                                                | -   | 104 <sup>(4)</sup> | -       |                |
|                             | Peak to Peak Period Jitter                                             | $f_{\text{VCO\_OUT}}$<br>1000 MHz                                                                                             | -30 | -                  | 30      | ps             |
| $I_{\text{VDD\_PLL}}^{(2)}$ | PLL power consumption on VDD_PLL (Analog)                              | VCO freq = 2000 MHz                                                                                                           | -   | 1000               | 1050    | $\mu\text{A}$  |
|                             |                                                                        | VCO freq = 992 MHz                                                                                                            | -   | 560                | 600     |                |
| $I_{\text{VDDCORE}}^{(2)}$  | PLL power consumption on VDDCORE (Digital)                             | VCO freq = 2000 MHz ( $V_{\text{DDCORE}}$ = 1.26 V)                                                                           | -   | 4300               | 10000   | $\mu\text{A}$  |
|                             |                                                                        | VCO freq = 992 MHz ( $V_{\text{DDCORE}}$ = 1.26 V)                                                                            | -   | 2300               | 7000    |                |

1. Specified by design, not tested in production unless otherwise specified.

2. Evaluated by characterization, not tested in production.

3. Measured on DDR high speed IO.

4. Measured on DDR high speed IO for 10000 output clock cycles.

## PLL2 characteristics

Table 41. PLL2 characteristics<sup>(1)</sup>

| Symbol                  | Parameter                                                              | Conditions                                | Min                                       | Typ                                   | Max                                       | Unit    |
|-------------------------|------------------------------------------------------------------------|-------------------------------------------|-------------------------------------------|---------------------------------------|-------------------------------------------|---------|
| $f_{PLL\_IN}$           | PLL input clock                                                        | Normal mode and Sigma delta mode          | 8                                         | -                                     | 16                                        | MHz     |
|                         | PLL input clock duty cycle                                             | -                                         | 10                                        | -                                     | 90                                        | %       |
| $f_{PLL\_P\_Q\_R\_OUT}$ | PLL P,Q,R multiplier output clock                                      | -                                         | 3.125                                     | -                                     | 800 <sup>(2)</sup>                        | MHz     |
|                         | PLL P,Q,R clock duty cycle                                             | Division by 1                             | 45                                        | 50                                    | 55                                        | %       |
|                         |                                                                        | Even divisions<br>(N multiple of 2)       | 45                                        | 50                                    | 55                                        |         |
|                         |                                                                        | Odd divisions<br>(N not multiple of 2)    | $\lceil 100 \times (N+1) / 2N \rceil - 5$ | $\lceil 100 \times (N+1) / 2N \rceil$ | $\lceil 100 \times (N+1) / 2N \rceil + 5$ |         |
| $f_{VCO\_OUT}$          | PLL VCO output                                                         | Direct VCO clock after internal divider/2 | 400                                       | -                                     | 800                                       | MHz     |
|                         | PLL VCO Duty Cycle                                                     |                                           | 45                                        | 50                                    | 55                                        | %       |
| $t_{LOCK}$              | PLL lock time                                                          | Normal mode                               | -                                         | 50                                    | 150                                       | $\mu s$ |
|                         |                                                                        | Sigma-delta mode (CKIN $\geq$ 8 MHz)      | -                                         | 65                                    | 170                                       |         |
| $A_{LOCK}$              | Lock Accuracy<br>(Ratio VCO frequency versus target frequency at lock) | -                                         | -                                         | -                                     | $\pm 2$                                   | %       |

Table 41. PLL2 characteristics<sup>(1)</sup> (continued)

| Symbol                              | Parameter                                              | Conditions                                                                                              |                | Min                | Typ                | Max | Unit |
|-------------------------------------|--------------------------------------------------------|---------------------------------------------------------------------------------------------------------|----------------|--------------------|--------------------|-----|------|
| Jitter                              | RMS cycle-to-cycle jitter                              | f <sub>PLL_P_Q_R_OUT</sub> division = 1 to 16<br>Without Fractional mode                                | VCO = 800 MHz  | -                  | 18 <sup>(3)</sup>  | -   | ±ps  |
|                                     |                                                        |                                                                                                         | VCO = 1066 MHz | -                  | 14 <sup>(3)</sup>  | -   |      |
|                                     |                                                        |                                                                                                         | VCO = 1600 MHz | -                  | 12 <sup>(3)</sup>  | -   |      |
|                                     |                                                        | f <sub>PLL_P_Q_R_OUT</sub> division = 1 to 16<br>With Fractional mode                                   | VCO = 1066 MHz | -                  | 20 <sup>(3)</sup>  | -   |      |
|                                     |                                                        |                                                                                                         | VCO = 1600 MHz | -                  | 18 <sup>(3)</sup>  | -   |      |
|                                     |                                                        |                                                                                                         |                |                    |                    |     |      |
|                                     | RMS period jitter                                      | f <sub>PLL_P_Q_R_OUT</sub> division = 1 to 16<br>Without Fractional mode                                | VCO = 800 MHz  | -                  | 16 <sup>(3)</sup>  | -   | ±ps  |
|                                     |                                                        |                                                                                                         | VCO = 1066 MHz | -                  | 12 <sup>(3)</sup>  | -   |      |
|                                     |                                                        |                                                                                                         | VCO = 1600 MHz | -                  | 10 <sup>(3)</sup>  | -   |      |
|                                     |                                                        | f <sub>PLL_P_Q_R_OUT</sub> division = 1 to 16<br>With Fractional mode                                   | VCO = 1066 MHz | -                  | 16 <sup>(3)</sup>  | -   |      |
|                                     |                                                        |                                                                                                         | VCO = 1600 MHz | -                  | 15 <sup>(3)</sup>  | -   |      |
|                                     |                                                        |                                                                                                         |                |                    |                    |     |      |
|                                     | Long term jitter                                       | f <sub>PLL_P_Q_R_OUT</sub> division = 1 to 16<br>f <sub>PLL_IN</sub> = 8 MHz<br>Without Fractional mode | VCO = 800 MHz  | -                  | 225 <sup>(4)</sup> | -   | ps   |
|                                     |                                                        |                                                                                                         | VCO = 1066 MHz | -                  | 200 <sup>(4)</sup> | -   |      |
|                                     |                                                        |                                                                                                         | VCO = 1600 MHz | -                  | 100 <sup>(4)</sup> | -   |      |
|                                     |                                                        | f <sub>PLL_P_Q_R_OUT</sub> division = 1 to 16<br>f <sub>PLL_IN</sub> = 8 MHz<br>With Fractional mode    | VCO = 800 MHz  | -                  | 350 <sup>(4)</sup> | -   |      |
| VCO = 1066 MHz                      |                                                        |                                                                                                         | -              | 250 <sup>(4)</sup> | -                  |     |      |
| VCO = 1600 MHz                      |                                                        |                                                                                                         | -              | 150 <sup>(4)</sup> | -                  |     |      |
| I <sub>VDD_PLL</sub> <sup>(2)</sup> | PLL power consumption on V <sub>DD_PLL</sub> (Analog)  | VCO freq = 1600 MHz                                                                                     |                | -                  | 930                | -   | µA   |
|                                     |                                                        | VCO freq = 800 MHz                                                                                      |                | -                  | 560                | -   |      |
| I <sub>VDDCORE</sub> <sup>(2)</sup> | PLL power consumption on V <sub>DDCORE</sub> (Digital) | VCO freq = 1600 MHz (V <sub>DDCORE</sub> = 1.26 V)                                                      |                | -                  | 4200               | -   | µA   |
|                                     |                                                        | VCO freq = 800 MHz (V <sub>DDCORE</sub> = 1.26 V)                                                       |                | -                  | 2100               | -   |      |

1. Specified by design, not tested in production unless otherwise specified.

2. Evaluated by characterization, not tested in production.

3. Measured on DDR high speed IO.

4. Measured on DDR high speed IO for 10000 output clock cycles.

### PLL3, PLL4 characteristics

Table 42. PLL3, PLL4 characteristics<sup>(1)</sup>

| Symbol               | Parameter                  | Conditions       | Min | Typ | Max | Unit |
|----------------------|----------------------------|------------------|-----|-----|-----|------|
| $f_{\text{PLL\_IN}}$ | PLL input clock            | Normal mode      | 4   | -   | 16  | MHz  |
|                      | -                          | Sigma delta mode | 8   | -   | 16  |      |
|                      | PLL input clock duty cycle | -                | 10  | -   | 90  | %    |

Table 42. PLL3, PLL4 characteristics<sup>(1)</sup> (continued)

| Symbol                         | Parameter                                                              | Conditions                                                                                                     | Min                                       | Typ                                   | Max                                       | Unit           |
|--------------------------------|------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------|-------------------------------------------|---------------------------------------|-------------------------------------------|----------------|
| $f_{\text{PLL\_P\_Q\_R\_OUT}}$ | PLL P,Q,R multiplier output clock                                      | -                                                                                                              | 3.125                                     | -                                     | 800 <sup>(2)</sup>                        | MHz            |
|                                | PLL P,Q,R clock duty cycle                                             | Even divisions<br>(N multiple of 2)                                                                            | 45                                        | 50                                    | 55                                        | %              |
|                                |                                                                        | Odd divisions<br>(N not multiple of 2)                                                                         | $\lceil 100 \times (N+1) / 2N \rceil - 5$ | $\lceil 100 \times (N+1) / 2N \rceil$ | $\lceil 100 \times (N+1) / 2N \rceil + 5$ |                |
| $f_{\text{VCO\_OUT}}$          | PLL VCO output                                                         | Direct VCO clock (no internal divider/2)                                                                       | 400                                       | -                                     | 800                                       | MHz            |
|                                | PLL VCO Duty Cycle                                                     |                                                                                                                | 40                                        | -                                     | 60                                        | %              |
| $t_{\text{LOCK}}$              | PLL lock time                                                          | Normal mode                                                                                                    | 15                                        | 50                                    | 150                                       | $\mu\text{s}$  |
|                                |                                                                        | Sigma-delta mode (CKIN $\geq$ 8 MHz)                                                                           | 25                                        | 65                                    | 170                                       |                |
| $A_{\text{LOCK}}$              | Lock accuracy<br>(Ratio VCO frequency versus target frequency at lock) | -                                                                                                              | -                                         | -                                     | $\pm 2$                                   | %              |
| Jitter                         | RMS cycle-to-cycle jitter                                              | $f_{\text{PLL\_P\_Q\_R\_OUT}}$ division = 25 to 100<br>Without Fractional mode                                 | VCO = 400 MHz                             | -                                     | 80 <sup>(3)</sup>                         | $\pm\text{ps}$ |
|                                |                                                                        |                                                                                                                | VCO = 600 MHz                             | -                                     | 50 <sup>(3)</sup>                         |                |
|                                |                                                                        |                                                                                                                | VCO = 800 MHz                             | -                                     | 45 <sup>(3)</sup>                         |                |
|                                |                                                                        | $f_{\text{PLL\_P\_Q\_R\_OUT}}$ division = 25 to 100<br>With Fractional mode                                    | VCO = 600 MHz                             | -                                     | 65 <sup>(3)</sup>                         |                |
|                                |                                                                        |                                                                                                                | VCO = 800 MHz                             | -                                     | 60 <sup>(3)</sup>                         |                |
|                                |                                                                        |                                                                                                                |                                           |                                       |                                           |                |
|                                | RMS period jitter                                                      | $f_{\text{PLL\_P\_Q\_R\_OUT}}$ division = 25 to 100<br>Without Fractional mode                                 | VCO = 400 MHz                             | -                                     | 75 <sup>(3)</sup>                         | $\pm\text{ps}$ |
|                                |                                                                        |                                                                                                                | VCO = 600 MHz                             | -                                     | 38 <sup>(3)</sup>                         |                |
|                                |                                                                        |                                                                                                                | VCO = 800 MHz                             | -                                     | 30 <sup>(3)</sup>                         |                |
|                                |                                                                        | $f_{\text{PLL\_P\_Q\_R\_OUT}}$ division = 25 to 100<br>With Fractional mode                                    | VCO = 600 MHz                             | -                                     | 55 <sup>(3)</sup>                         |                |
|                                |                                                                        |                                                                                                                | VCO = 800 MHz                             | -                                     | 50 <sup>(3)</sup>                         |                |
|                                |                                                                        |                                                                                                                |                                           |                                       |                                           |                |
|                                | Long term jitter                                                       | $f_{\text{PLL\_P\_Q\_R\_OUT}}$ division = 25 to 100<br>$f_{\text{PLL\_IN}}$ = 8 MHz<br>Without Fractional mode | VCO = 400 MHz                             | -                                     | 225 <sup>(4)</sup>                        | ps             |
|                                |                                                                        |                                                                                                                | VCO = 600 MHz                             | -                                     | 150 <sup>(4)</sup>                        |                |
|                                |                                                                        |                                                                                                                | VCO = 800 MHz                             | -                                     | 125 <sup>(4)</sup>                        |                |
|                                |                                                                        | $f_{\text{PLL\_P\_Q\_R\_OUT}}$ division = 25 to 100<br>$f_{\text{PLL\_IN}}$ = 8 MHz<br>With Fractional mode    | VCO = 400 MHz                             | -                                     | 300 <sup>(4)</sup>                        |                |
|                                |                                                                        |                                                                                                                | VCO = 600 MHz                             | -                                     | 200 <sup>(4)</sup>                        |                |
|                                |                                                                        |                                                                                                                | VCO = 800 MHz                             | -                                     | 150 <sup>(4)</sup>                        |                |
| $I_{\text{VDD\_PLL}}$          | PLL power consumption on V <sub>DD\_PLL</sub> (Analog)                 | VCO freq = 800 MHz                                                                                             | -                                         | 600                                   | 610                                       | $\mu\text{A}$  |
|                                |                                                                        | VCO freq = 400 MHz                                                                                             | -                                         | 320                                   | 350                                       |                |

Table 42. PLL3, PLL4 characteristics<sup>(1)</sup> (continued)

| Symbol               | Parameter                                              | Conditions                                        | Min | Typ  | Max  | Unit |
|----------------------|--------------------------------------------------------|---------------------------------------------------|-----|------|------|------|
| I <sub>VDDCORE</sub> | PLL power consumption on V <sub>DDCORE</sub> (Digital) | VCO freq = 800 MHz (V <sub>DDCORE</sub> = 1.26 V) | -   | 2200 | 5250 | μA   |
|                      |                                                        | VCO freq = 400 MHz (V <sub>DDCORE</sub> = 1.26 V) | -   | 1130 | 4550 |      |

1. Specified by design, not tested in production unless otherwise specified.
2. Evaluated by characterization, not tested in production.
3. Measured on GPIO.
4. Measured on GPIO for 10000 output clock cycles.

### PLL\_USB (2880 MHz) characteristics

Table 43. USB\_PLL characteristics<sup>(1)</sup>

| Symbol                       | Parameter                                                              | Condition                       | Min  | Typ  | Max  | Unit |
|------------------------------|------------------------------------------------------------------------|---------------------------------|------|------|------|------|
| f <sub>PLL_IN</sub>          | PLL input clock                                                        |                                 | 19.2 | 24   | 38.4 | MHz  |
| f <sub>PLL_INFIN</sub>       | PFD input clock                                                        |                                 | 19.2 | 24   | 38.4 | MHz  |
| f <sub>PLL_OUT</sub>         | PLL multiplier output clock                                            |                                 | -    | 480  | -    | MHz  |
| f <sub>VCO_OUT</sub>         | PLL VCO output                                                         |                                 | -    | 2880 | -    | MHz  |
| t <sub>LOCK</sub>            | PLL lock time                                                          |                                 | -    | -    | 100  | μs   |
| t <sub>PDN</sub>             | PLL power down time                                                    |                                 | 10   | -    | -    | μs   |
| I <sub>DDA1V1_REG(PLL)</sub> | PLL power consumption on V <sub>DDA1V1_REG</sub> (internal connection) | PLL in power down               | -    | 5    | 425  | μA   |
|                              |                                                                        | f <sub>VCO_OUT</sub> = 2880 MHz | -    | 4.4  | 5.6  | mA   |
| I <sub>DDA1V8_REG(PLL)</sub> | PLL power consumption on V <sub>DDA1V8_REG</sub> (internal connection) | PLL in power down               | -    | -    | 2    | μA   |
|                              |                                                                        | f <sub>VCO_OUT</sub> = 2880 MHz | -    | 2    | 2.5  | mA   |

1. Specified by design, not tested in production unless otherwise specified.

### 6.3.12 PLL spread spectrum clock generation (SSCG) characteristics

The spread spectrum clock generation (SSCG) feature allows the reduction of electromagnetic interferences (see [Table 49: EMI characteristics for fhSE = 24 MHz and Fmpuss\\_ck = 650 MHz](#)). It is available only on the PLL1 and PLL2.

Table 44. SSCG parameters constraint

| Symbol            | Parameter             | Min  | Typ | Max <sup>(1)</sup> | Unit |
|-------------------|-----------------------|------|-----|--------------------|------|
| f <sub>Mod</sub>  | Modulation frequency  | 20   | -   | 60                 | kHz  |
| md                | Peak modulation depth | 0.25 | -   | 2                  | %    |
| MODEPER * INCSTEP | -                     | -    | -   | 2 <sup>15</sup> -1 | -    |

1. Specified by design, not tested in production.

Equation 1

The frequency modulation period (MODEPER) is given by the equation below:

$$\text{MODEPER} = \text{round}[f_{\text{PLL\_IN}} / (4 \times f_{\text{Mod}})]$$

$f_{\text{PLL\_IN}}$  and  $f_{\text{Mod}}$  must be expressed in Hz.

As an example:

If  $f_{\text{PLL\_IN}} = 8 \text{ MHz}$ , and  $f_{\text{MOD}} = 40 \text{ kHz}$ , the modulation depth (MODEPER) is given by equation 1:

$$\text{MODEPER} = \text{round}[8 \times 10^6 / 4 \times 40 \times 10^3] = 50$$

Equation 2

Equation 2 allows the increment step (INCSTEP) calculation:

$$\text{INCSTEP} = \text{round}[(2^{15} - 1) \times \text{md} \times \text{PLLN}] / (100 \times 5 \times \text{MODEPER})$$

$f_{\text{VCO\_OUT}}$  must be expressed in MHz.

With a modulation depth (md) =  $\pm 2\%$  (4% peak-to-peak), and PLLN = 240 (in MHz):

$$\text{INCSTEP} = \text{round}[(2^{15} - 1) \times 2 \times 240] / (100 \times 5 \times 50) = 629 \text{md}(\text{quantitized})\%$$

An amplitude quantization error may be generated because the linear modulation profile is obtained by taking the quantized values (rounded to the nearest integer) of MODPER and INCSTEP. As a result, the achieved modulation depth is quantized. The percentage quantized modulation depth is given by the following formula:

$$\text{md}_{\text{quantized}}\% = (\text{MODEPER} \times \text{INCSTEP} \times 100 \times 5) / ((2^{15} - 1) \times \text{PLLN})$$

As a result:

$$\text{md}_{\text{quantized}}\% = (50 \times 629 \times 100 \times 5) / ((2^{15} - 1) \times 240) = 2\%(\text{peak})$$

[Figure 20](#) and [Figure 21](#) show the main PLL output clock waveforms in center spread and down spread modes, where:

$F_0$  is  $f_{\text{PLL\_OUT}}$  nominal.

$T_{\text{mode}}$  is the modulation period.

md is the modulation depth.



Figure 20. PLL output clock waveforms in center spread mode

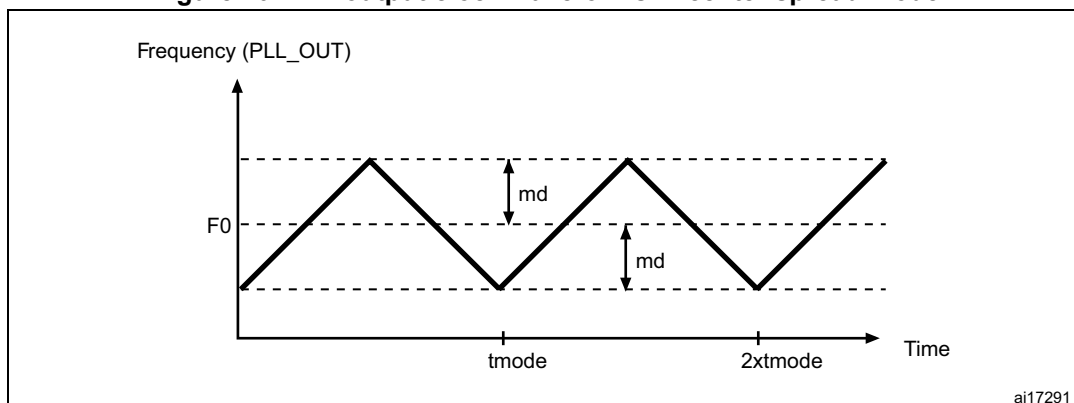
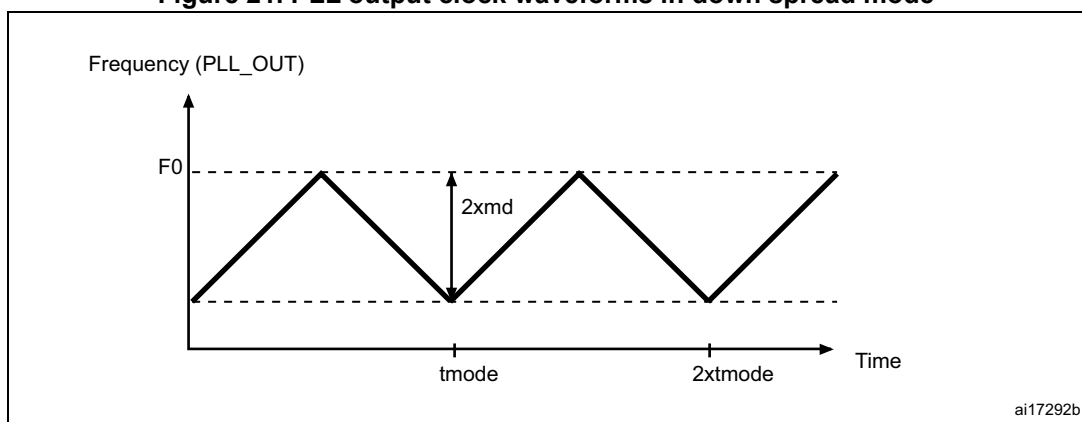


Figure 21. PLL output clock waveforms in down spread mode



### 6.3.13 Memory characteristics

#### OTP characteristics

The characteristics are given at  $T_J = -40$  to  $125\text{ }^{\circ}\text{C}$  unless otherwise specified.

Table 45. OTP characteristics

| Symbol                  | Parameter                        | Conditions  | Min | Max   | Unit          |
|-------------------------|----------------------------------|-------------|-----|-------|---------------|
| $I_{VDDCORE}$           | OTP consumption on $V_{DDCORE}$  | Programming | -   | 450   | $\mu\text{A}$ |
|                         |                                  | Reading     | -   | 490   | $\mu\text{A}$ |
|                         |                                  | PowerDown   | -   | 4.2   | $\mu\text{A}$ |
| $I_{VDD}$               | OTP consumption on $V_{DD}$      | Programming | -   | 10000 | $\mu\text{A}$ |
|                         |                                  | Reading     | -   | 2200  | $\mu\text{A}$ |
|                         |                                  | PowerDown   | -   | 1     | $\mu\text{A}$ |
| $F_{OTP}^{(1)}$         | OTP operating Frequency          | -           | -   | 67    | MHz           |
| NB_CYCLE <sup>(2)</sup> | Maximum number of reading cycles | -           | -   | 500   | Million       |

1. Specified by design, not tested in production.

2. Evaluated by characterization, not tested in production.

**DDR characteristics**DDR3, DDR3L I/O DC specifications

The following table provides input and output DC threshold values and on-die-termination (ODT) recommended values. The conditions for the output threshold values are un-terminated outputs loaded with 1 pF capacitor load. The ODT values are measured after impedance calibration.

**Table 46. DC specifications – DDR3 or DDR3L mode<sup>(1)</sup>**

| Symbol       | Parameter                                         | Min                  | Typ             | Max                  | Unit     |
|--------------|---------------------------------------------------|----------------------|-----------------|----------------------|----------|
| $V_{IH(DC)}$ | DC input voltage high                             | $V_{REF} + 0.09$     | -               | $V_{DDQ}$            | V        |
| $V_{IL(DC)}$ | DC input voltage low                              | $V_{SSQ} - 0.3$      | -               | $V_{REF} - 0.09$     | V        |
| $V_{OH}$     | DC output logic high                              | $0.8 \times V_{DDQ}$ | -               | -                    | V        |
| $V_{OL}$     | DC output logic low                               | -                    | -               | $0.2 \times V_{DDQ}$ | V        |
| $R_{TT}$     | Input termination resistance (ODT) to $V_{DDQ}/2$ | 100<br>54<br>36      | 120<br>60<br>40 | 140<br>66<br>44      | $\Omega$ |
| $I_{LS}$     | Input leakage current, SSTL mode, unterminated    | -                    | 0.01            | 4.8                  | $\mu A$  |

1. Specified by design, not tested in production.

LPDDR2, LPDDR3 I/O DC specifications

The following table provides input and output DC threshold values. The conditions for the output threshold values are un-terminated outputs loaded with 1 pF capacitor load.

**Table 47. DC specifications – LPDDR2 or LPDDR3 mode<sup>(1)</sup>**

| Symbol       | Parameter             | Min                  | Typ  | Max                  | Unit    |
|--------------|-----------------------|----------------------|------|----------------------|---------|
| $V_{IH(DC)}$ | DC input voltage high | $V_{REF} + 0.13$     | -    | $V_{DDQ}$            | V       |
| $V_{IL(DC)}$ | DC input voltage low  | $V_{SSQ}$            | -    | $V_{REF} - 0.13$     | V       |
| $V_{OH}$     | DC output logic high  | $0.9 \times V_{DDQ}$ | -    | -                    | V       |
| $V_{OL}$     | DC output logic low   | -                    | -    | $0.1 \times V_{DDQ}$ | V       |
| $I_{LEAK}$   | Input leakage current | -                    | 0.01 | 4.51                 | $\mu A$ |

1. Specified by design, not tested in production.

**6.3.14 EMC characteristics**

Susceptibility tests are performed on a sample basis during device characterization.

### Functional EMS (electromagnetic susceptibility)

While a simple application is executed on the device (toggling 2 LEDs through I/O ports), the device is stressed by two electromagnetic events until a failure occurs. The failure is indicated by the LEDs:

- **Electrostatic discharge (ESD)** (positive and negative) is applied to all device pins until a functional disturbance occurs. This test is compliant with the IEC 61000-4-2 standard.
- **FTB**: a burst of fast transient voltage (positive and negative) is applied to  $V_{DD}$  and  $V_{SS}$  through a 100 pF capacitor, until a functional disturbance occurs. This test is compliant with the IEC 61000-4-4 standard.

A device reset allows normal operations to be resumed.

The test results are given in [Table 48](#). They are based on the EMS levels and classes defined in application note AN1709 available from the ST website [www.st.com](http://www.st.com).

**Table 48. EMS characteristics**

| Symbol     | Parameter                                                                                                                         | Conditions                                                                                                                                    | Level/Class |
|------------|-----------------------------------------------------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------|-------------|
| $V_{FESD}$ | Voltage limits to be applied on any I/O pin to induce a functional disturbance                                                    | $V_{DD} = 3.3\text{ V}$ , $T_A = +25\text{ °C}$ , TFBGA320,<br>$F_{mpuss\_ck} = 650\text{ or }1000\text{ MHz}$ ,<br>conforms to IEC 61000-4-2 | 2B          |
| $V_{FTB}$  | Fast transient voltage burst limits to be applied through 100 pF on $V_{DD}$ and $V_{SS}$ pins to induce a functional disturbance |                                                                                                                                               | 5A          |

As a consequence, it is recommended to add a serial resistor (1 k $\Omega$ ), located as close as possible to the STM32MP133 device, to the pins exposed to noise (connected to tracks longer than 50 mm on PCB).

### Designing hardened software to avoid noise problems

EMC characterization and optimization are performed at component level with a typical application environment and simplified MCU software. It should be noted that good EMC performance is highly dependent on the user application and the software in particular.

Therefore it is recommended that the user applies EMC software optimization and prequalification tests in relation with the EMC level requested for his application.

### Software recommendations

The software flowchart must include the management of runaway conditions such as:

- Corrupted program counter
- Unexpected reset
- Critical Data corruption (control registers...)

### Prequalification trials

Most of the common failures (unexpected reset and program counter corruption) can be reproduced by manually forcing a low state on the NRST pin or the Oscillator pins for 1 second.

To complete these trials, ESD stress can be applied directly on the device, over the range of specification values. When unexpected behavior is detected, the software can be hardened

to prevent unrecoverable errors occurring (see application note AN1015 available from the ST website [www.st.com](http://www.st.com)).

### Electromagnetic Interference (EMI)

The electromagnetic field emitted by the device are monitored while a simple application, executing EEMBC code, is running. This emission test is compliant with SAE IEC61967-2 standard which specifies the test board and the pin loading.

**Table 49. EMI characteristics for  $f_{HSE} = 24$  MHz and  $F_{mpuss\_ck} = 650$  MHz**

| Symbol    | Parameter            | Conditions                                                                   | Monitored frequency band | Value | Unit |
|-----------|----------------------|------------------------------------------------------------------------------|--------------------------|-------|------|
| $S_{EMI}$ | Peak <sup>(1)</sup>  | $V_{DD} = 3.6$ V, $T_A = 25$ °C, TFBFGA320 package, conforming to IEC61967-2 | 0.1 to 30 MHz            | 4     | dBμV |
|           |                      |                                                                              | 30 to 130 MHz            | 8     |      |
|           |                      |                                                                              | 130 MHz to 1 GHz         | 21    |      |
|           |                      |                                                                              | 1 GHz to 2 GHz           | 16    |      |
|           | Level <sup>(2)</sup> | -                                                                            | 0.1 MHz to 2 GHz         | 3.5   | -    |

1. Refer to AN1709 "EMI radiated test" section.
2. Refer to AN1709 "EMI level classification" section.

**Table 50. EMI characteristics for  $f_{HSE} = 24$  MHz and  $F_{mpuss\_ck} = 1$  GHz**

| Symbol    | Parameter            | Conditions                                                                   | Monitored frequency band | Value | Unit |
|-----------|----------------------|------------------------------------------------------------------------------|--------------------------|-------|------|
| $S_{EMI}$ | Peak <sup>(1)</sup>  | $V_{DD} = 3.6$ V, $T_A = 25$ °C, TFBFGA320 package, conforming to IEC61967-2 | 0.1 to 30 MHz            | 4     | dBμV |
|           |                      |                                                                              | 30 to 130 MHz            | 16    |      |
|           |                      |                                                                              | 130 MHz to 1 GHz         | 19    |      |
|           |                      |                                                                              | 1 GHz to 2 GHz           | 20    |      |
|           | Level <sup>(2)</sup> | -                                                                            | 0.1 MHz to 2 GHz         | 4     | -    |

1. Refer to AN1709 "EMI radiated test" section.
2. Refer to AN1709 "EMI level classification" section.

### 6.3.15 Absolute maximum ratings (electrical sensitivity)

Based on three different tests (ESD, LU) using specific measurement methods, the device is stressed in order to determine its performance in terms of electrical sensitivity.

#### Electrostatic discharge (ESD)

Electrostatic discharges (a positive then a negative pulse) are applied to the pins of each sample according to each pin combination. This test conforms to the ANSI/ESDA/JEDEC JS-001 and ANSI/ESDA/JEDEC JS-002 standards.

Table 51. ESD absolute maximum ratings

| Symbol         | Ratings                                               | Conditions                                                 | Packages | Class | Maximum value <sup>(1)</sup> | Unit |
|----------------|-------------------------------------------------------|------------------------------------------------------------|----------|-------|------------------------------|------|
| $V_{ESD(HBM)}$ | Electrostatic discharge voltage (human body model)    | $T_A = +25\text{ °C}$ conforming to ANSI/ESDA/JEDEC JS-001 | All      | 2     | 2000                         | V    |
| $V_{ESD(CDM)}$ | Electrostatic discharge voltage (charge device model) | $T_A = +25\text{ °C}$ conforming to ANSI/ESDA/JEDEC JS-002 | All      | C2a   | 500                          |      |

1. Evaluated by characterization, not tested in production.

### Static latchup

Two complementary static tests are required on three parts to assess the latchup performance:

- A supply overvoltage is applied to each power supply pin
- A current injection is applied to each input, output and configurable I/O pin

These tests are compliant with JESD78 IC latchup standard.

Table 52. Electrical sensitivities

| Symbol | Parameter            | Conditions                  | Class      |
|--------|----------------------|-----------------------------|------------|
| LU     | Static latchup class | 130 °C conforming to JESD78 | II level A |

### 6.3.16 I/O current injection characteristics

As a general rule, a current injection to the I/O pins, due to external voltage below  $V_{SS}$  or above  $V_{DD}$  (for standard, 3.3 V-capable I/O pins) should be avoided during the normal product operation. However, in order to give an indication of the robustness of the device in cases when an abnormal injection accidentally happens, susceptibility tests are performed on a sample basis during the device characterization.

#### Functional susceptibility to I/O current injection

While a simple application is executed on the device, the device is stressed by injecting current into the I/O pins programmed in floating input mode. While current is injected into the I/O pin, one at a time, the device is checked for functional failures.

The failure is indicated by an out of range parameter: ADC error above a certain limit (higher than 5 LSB TUE), out of conventional limits of induced leakage current on adjacent pins (out of  $-5\text{ }\mu\text{A}/+0\text{ }\mu\text{A}$  range), or other functional failure (for example reset, oscillator frequency deviation).

The following tables are the compilation of the SIC1/SIC2 and functional ESD results.

Negative induced A negative induced leakage current is caused by negative injection and positive induced leakage current by positive injection.

Table 53. I/O current injection susceptibility<sup>(1)</sup>

| Symbol    | Description         | Negative injection | Positive injection | Unit |
|-----------|---------------------|--------------------|--------------------|------|
| $I_{INJ}$ | PB5, PE13           | 0                  | NA                 | mA   |
|           | All other FTxx I/Os | 5                  | NA                 |      |

1. Evaluated by characterization, not tested in production.

### 6.3.17 I/O port characteristics

General input/output characteristics

Unless otherwise specified, the parameters given in [Table 54: I/O static characteristics](#) are derived from tests performed under the conditions summarized in [Table 13: General operating conditions](#). All I/Os are CMOS and TTL compliant.

Table 54. I/O static characteristics

| Symbol     | Parameter                                         | Condition                                                   | Min                               | Typ                 | Max                               | Unit |
|------------|---------------------------------------------------|-------------------------------------------------------------|-----------------------------------|---------------------|-----------------------------------|------|
| $V_{IL}$   | I/O input low level voltage                       | $1.71\text{ V} < V_{DD} < 3.6\text{ V}$                     | -                                 | -                   | $0.3 \times V_{DD}^{(1)}$         | V    |
|            |                                                   |                                                             | -                                 | -                   | $0.39 \times V_{DD} - 0.07^{(2)}$ |      |
| $V_{IH}$   | I/O input high level voltage                      | $1.71\text{ V} < V_{DD} < 3.6\text{ V}$                     | $0.7 \times V_{DD}^{(1)}$         | -                   | -                                 | V    |
|            |                                                   |                                                             | $0.45 \times V_{DD} + 0.35^{(2)}$ | -                   | -                                 |      |
| $V_{HYS}$  | TT_xx, FT_xxx and NRST I/O input hysteresis       | $1.71\text{ V} < V_{DD} < 3.6\text{ V}$                     | -                                 | $0.1 \times V_{DD}$ | -                                 | mV   |
| $I_{leak}$ | FT_xx input leakage current                       | $0 < V_{IN} \leq \text{Max}(V_{DD})^{(5)}$                  | -                                 | -                   | 250                               | nA   |
|            |                                                   | $\text{Max}(V_{DD}) < V_{IN} \leq 5.5\text{ V}^{(3)(4)(5)}$ | -                                 | -                   | 3500                              |      |
|            | FT_u, IO                                          | $0 < V_{IN} \leq \text{Max}(V_{DD})^{(5)}$                  | -                                 | -                   | 500                               |      |
|            |                                                   | $\text{Max}(V_{DD}) < V_{IN} \leq 5.5\text{ V}^{(3)(4)(5)}$ | -                                 | -                   | 5000 <sup>(6)</sup>               |      |
|            | TT_xx input leakage current                       | $0 < V_{IN} \leq \text{Max}(V_{DD})^{(5)}$                  | -                                 | -                   | 100                               |      |
| $R_{PU}$   | Weak pull-up equivalent resistor <sup>(7)</sup>   | $V_{IN}=V_{SS}$                                             | 25                                | 40                  | 55                                | kΩ   |
| $R_{PD}$   | Weak pull-down equivalent resistor <sup>(7)</sup> | $V_{IN}=V_{DD}^{(5)}$                                       | 25                                | 40                  | 55                                |      |
| $C_{IO}$   | I/O pin capacitance                               | -                                                           | -                                 | 5                   | -                                 | pF   |

1. Compliant with CMOS requirements.

2. Specified by Design, not tested in production.

3. All FT\_xx IO except FT\_uf, FT\_u.

4.  $V_{IN}$  must be less than  $\text{Max}(V_{DD}) + 3.6\text{ V}$ .

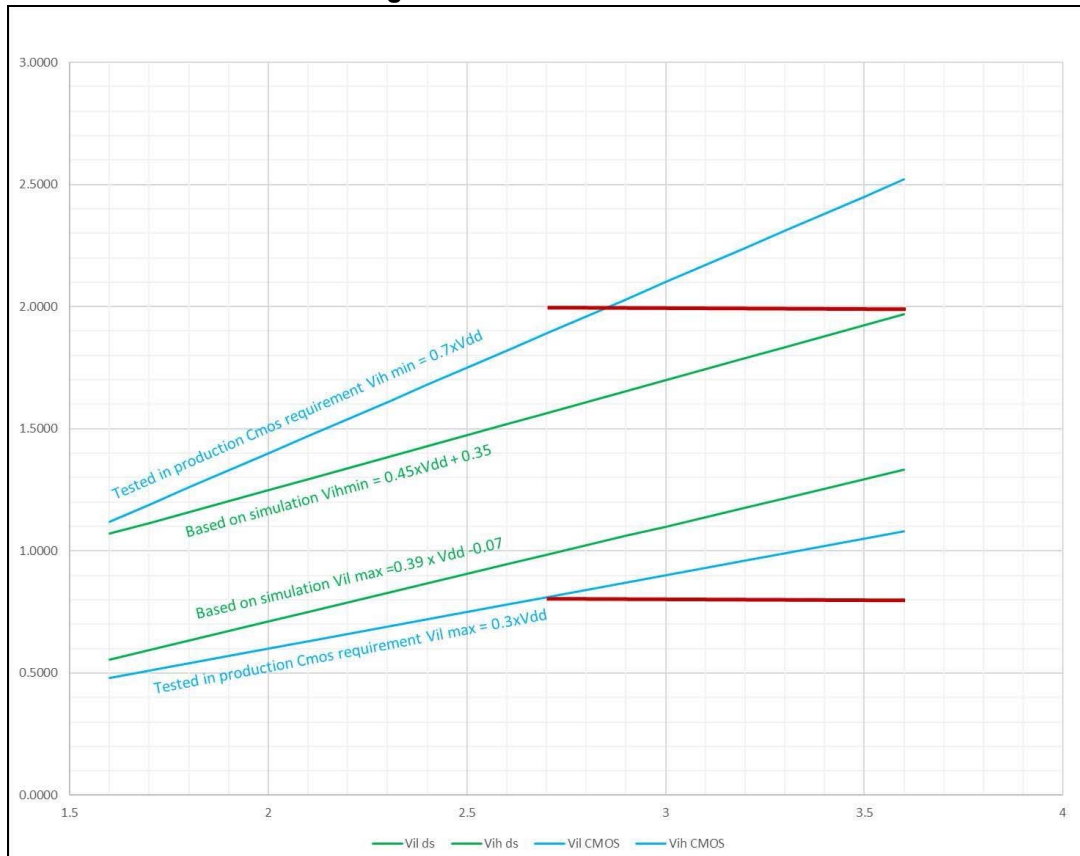
5.  $\text{Max}(V_{DD})$  is the maximum value of all the I/O supplies.

6. To sustain a voltage higher than  $\text{MIN}(V_{DD}, V_{DDA}, V_{DD3V3\_USBHS}) + 0.3\text{ V}$ , the internal pull-up and pull-down resistors must be disabled.

7. The pull-up and pull-down resistors are designed with a true resistance in series with a switchable PMOS/NMOS. This PMOS/NMOS contribution to the series resistance is minimal (~10% order).

All I/Os are CMOS and TTL compliant (no software configuration required). Their characteristics cover more than the strict CMOS-technology or TTL parameters. The coverage of these requirements for FT I/Os is shown in [Figure 22](#).

**Figure 22. VIL/VIH for FT I/Os**



### Output driving current

The GPIOs (general purpose input/outputs) can sink or source up to  $\pm 8$  mA, and sink or source up to  $\pm 20$  mA (with a relaxed  $V_{OL}/V_{OH}$ ).

In the user application, the number of I/O pins which can drive current must be limited to respect the absolute maximum rating specified in [Section 6.2](#). In particular:

- The sum of the currents sourced by all the I/Os on  $V_{DD}$ , plus the maximum Run mode consumption of the MCU sourced on  $V_{DD}$ , cannot exceed the absolute maximum rating  $\Sigma I_{VDD}$  (see [Table 11](#)).
- The sum of the currents sunk by all the I/Os on  $V_{SS}$  plus the maximum Run mode consumption of the MCU sunk on  $V_{SS}$  cannot exceed the absolute maximum rating  $\Sigma I_{VSS}$  (see [Table 11](#)).

### Output voltage levels

Unless otherwise specified, the parameters given in [Table 55](#) are derived from tests performed under ambient temperature and  $V_{DD}$  supply voltage conditions summarized in [Table 13: General operating conditions](#). All I/Os are CMOS and TTL compliant.

**Table 55. Output voltage characteristics for all I/Os except PC13, PC14, PC15, PI0 PI1, PI2, PI3<sup>(1)</sup>**

| Symbol            | Parameter                                               | Conditions <sup>(3)</sup>                                                                              | Min           | Max  | Unit |
|-------------------|---------------------------------------------------------|--------------------------------------------------------------------------------------------------------|---------------|------|------|
| $V_{OL}$          | Output low level voltage                                | CMOS port <sup>(2)</sup><br>$I_{IO} = 8 \text{ mA}$<br>$2.0 \text{ V} \leq V_{DD} \leq 3.6 \text{ V}$  | -             | 0.4  | V    |
| $V_{OH}$          | Output high level voltage                               | CMOS port <sup>(2)</sup><br>$I_{IO} = -8 \text{ mA}$<br>$2.0 \text{ V} \leq V_{DD} \leq 3.6 \text{ V}$ | $V_{DD}-0.4$  | -    |      |
| $V_{OL}^{(3)}$    | Output low level voltage                                | TTL port <sup>(2)</sup><br>$I_{IO} = 8 \text{ mA}$<br>$2.0 \text{ V} \leq V_{DD} \leq 3.6 \text{ V}$   | -             | 0.4  |      |
| $V_{OH}^{(3)}$    | Output high level voltage                               | TTL port <sup>(2)</sup><br>$I_{IO} = -8 \text{ mA}$<br>$2.0 \text{ V} \leq V_{DD} \leq 3.6 \text{ V}$  | 2.4           | -    |      |
| $V_{OL}^{(3)}$    | Output low level voltage                                | $I_{IO} = 20 \text{ mA}$<br>$2.7 \text{ V} \leq V_{DD} \leq 3.6 \text{ V}$                             | -             | 1.3  |      |
| $V_{OH}^{(3)}$    | Output high level voltage                               | $I_{IO} = -20 \text{ mA}$<br>$2.7 \text{ V} \leq V_{DD} \leq 3.6 \text{ V}$                            | $V_{DD}-1.3$  | -    |      |
| $V_{OL}^{(3)}$    | Output low level voltage                                | $I_{IO} = 1 \text{ mA}$<br>$1.71 \text{ V} \leq V_{DD} \leq 3.6 \text{ V}$                             | -             | 0.2  |      |
|                   |                                                         | $I_{IO} = 4 \text{ mA}$<br>$1.71 \text{ V} \leq V_{DD} \leq 3.6 \text{ V}$                             | -             | 0.45 |      |
| $V_{OH}^{(3)}$    | Output high level voltage                               | $I_{IO} = -1 \text{ mA}$<br>$1.71 \text{ V} \leq V_{DD} \leq 3.6 \text{ V}$                            | $V_{DD}-0.2$  | -    |      |
|                   |                                                         | $I_{IO} = -4 \text{ mA}$<br>$1.71 \text{ V} \leq V_{DD} \leq 3.6 \text{ V}$                            | $V_{DD}-0.45$ | -    |      |
| $V_{OLFM+}^{(3)}$ | Output low level voltage for an FT_f IO pin in FM+ mode | $I_{IO} = 20 \text{ mA}$<br>$2.7 \text{ V} \leq V_{DD} \leq 3.6 \text{ V}$                             | -             | 0.4  |      |
|                   |                                                         | $I_{IO} = 10 \text{ mA}$<br>$1.71 \text{ V} \leq V_{DD} \leq 3.6 \text{ V}$                            | -             | 0.4  |      |

1. The IIO current sourced or sunk by the device must always respect the absolute maximum rating specified in [Table 10: Voltage characteristics](#), and the sum of the currents sourced or sunk by all the I/Os (I/O ports and control pins) must always respect the absolute maximum ratings  $\sum IIO$ .
2. TTL and CMOS outputs are compatible with JEDEC standards JESD36 and JESD52.
3. Specified by design, not tested in production.



Table 56. Output voltage characteristics for PC13, PC14, PC15, PI0, PI1, PI2, PI3<sup>(1)</sup>

| Symbol         | Parameter                 | Conditions <sup>(3)</sup>                                                                              | Min            | Max | Unit |
|----------------|---------------------------|--------------------------------------------------------------------------------------------------------|----------------|-----|------|
| $V_{OL}$       | Output low level voltage  | CMOS port <sup>(2)</sup><br>$I_{IO} = 3 \text{ mA}$<br>$2.7 \text{ V} \leq V_{DD} \leq 3.6 \text{ V}$  | -              | 0.4 | V    |
| $V_{OH}$       | Output high level voltage | CMOS port <sup>(2)</sup><br>$I_{IO} = -3 \text{ mA}$<br>$2.7 \text{ V} \leq V_{DD} \leq 3.6 \text{ V}$ | $V_{DD} - 0.4$ | -   |      |
| $V_{OL}^{(3)}$ | Output low level voltage  | TTL port <sup>(2)</sup><br>$I_{IO} = 3 \text{ mA}$<br>$2.7 \text{ V} \leq V_{DD} \leq 3.6 \text{ V}$   | -              | 0.4 |      |
| $V_{OH}^{(2)}$ | Output high level voltage | TTL port <sup>(2)</sup><br>$I_{IO} = -3 \text{ mA}$<br>$2.7 \text{ V} \leq V_{DD} \leq 3.6 \text{ V}$  | 2.4            | -   |      |
| $V_{OL}^{(2)}$ | Output low level voltage  | $I_{IO} = 1.5 \text{ mA}$<br>$1.71 \text{ V} \leq V_{DD} \leq 3.6 \text{ V}$                           | -              | 0.4 |      |
| $V_{OH}^{(2)}$ | Output high level voltage | $I_{IO} = -1.5 \text{ mA}$<br>$1.71 \text{ V} \leq V_{DD} \leq 3.6 \text{ V}$                          | $V_{DD} - 0.4$ | -   |      |

1. The  $I_{IO}$  current sourced or sunk by the device must always respect the absolute maximum rating specified in [Table 10: Voltage characteristics](#), and the sum of the currents sourced or sunk by all the I/Os (I/O ports and control pins) must always respect the absolute maximum ratings  $\sum I_{IO}$ .
2. TTL and CMOS outputs are compatible with JEDEC standards JESD36 and JESD52.
3. Specified by design, not tested in production.

## Output buffer timing characteristics (HSLV option disabled)

Table 57. Output timing characteristics (HSLV OFF)<sup>(1)(2)</sup>

| Speed | Symbol                                        | Parameter                                                                 | conditions                                  | Min | Max  | Unit |
|-------|-----------------------------------------------|---------------------------------------------------------------------------|---------------------------------------------|-----|------|------|
| 00    | F <sub>max</sub> <sup>(3)</sup>               | Maximum frequency                                                         | C = 50 pF, 2.7 V ≤ V <sub>DD</sub> ≤ 3.6 V  | -   | 19   | MHz  |
|       |                                               |                                                                           | C = 30 pF, 2.7 V ≤ V <sub>DD</sub> ≤ 3.6 V  | -   | 21   |      |
|       |                                               |                                                                           | C = 20 pF, 2.7 V ≤ V <sub>DD</sub> ≤ 3.6 V  | -   | 23   |      |
|       |                                               |                                                                           | C = 10 pF, 2.7 V ≤ V <sub>DD</sub> ≤ 3.6 V  | -   | 25   |      |
|       |                                               |                                                                           | C = 50 pF, 1.71 V ≤ V <sub>DD</sub> ≤ 2.7 V | -   | 5    |      |
|       |                                               |                                                                           | C = 30 pF, 1.71 V ≤ V <sub>DD</sub> ≤ 2.7 V | -   | 5    |      |
|       |                                               |                                                                           | C = 20 pF, 1.71 V ≤ V <sub>DD</sub> ≤ 2.7 V | -   | 5    |      |
|       |                                               |                                                                           | C = 10 pF, 1.71 V ≤ V <sub>DD</sub> ≤ 2.7 V | -   | 5    |      |
|       | t <sub>r</sub> /t <sub>f</sub> <sup>(4)</sup> | Output high to low level fall time and output low to high level rise time | C = 50 pF, 2.7 V ≤ V <sub>DD</sub> ≤ 3.6 V  | -   | 12   | ns   |
|       |                                               |                                                                           | C = 30 pF, 2.7 V ≤ V <sub>DD</sub> ≤ 3.6 V  | -   | 10   |      |
|       |                                               |                                                                           | C = 20 pF, 2.7 V ≤ V <sub>DD</sub> ≤ 3.6 V  | -   | 9    |      |
|       |                                               |                                                                           | C = 10 pF, 2.7 V ≤ V <sub>DD</sub> ≤ 3.6 V  | -   | 8    |      |
|       |                                               |                                                                           | C = 50 pF, 1.71 V ≤ V <sub>DD</sub> ≤ 2.7 V | -   | 22   |      |
|       |                                               |                                                                           | C = 30 pF, 1.71 V ≤ V <sub>DD</sub> ≤ 2.7 V | -   | 19   |      |
|       |                                               |                                                                           | C = 20 pF, 1.71 V ≤ V <sub>DD</sub> ≤ 2.7 V | -   | 17   |      |
|       |                                               |                                                                           | C = 10 pF, 1.71 V ≤ V <sub>DD</sub> ≤ 2.7 V | -   | 15   |      |
| 01    | F <sub>max</sub> <sup>(3)</sup>               | Maximum frequency                                                         | C = 50 pF, 2.7 V ≤ V <sub>DD</sub> ≤ 3.6 V  | -   | 33   | MHz  |
|       |                                               |                                                                           | C = 30 pF, 2.7 V ≤ V <sub>DD</sub> ≤ 3.6 V  | -   | 44   |      |
|       |                                               |                                                                           | C = 20 pF, 2.7 V ≤ V <sub>DD</sub> ≤ 3.6 V  | -   | 55   |      |
|       |                                               |                                                                           | C = 10 pF, 2.7 V ≤ V <sub>DD</sub> ≤ 3.6 V  | -   | 66   |      |
|       |                                               |                                                                           | C = 50 pF, 1.71 V ≤ V <sub>DD</sub> ≤ 2.7 V | -   | 15   |      |
|       |                                               |                                                                           | C = 30 pF, 1.71 V ≤ V <sub>DD</sub> ≤ 2.7 V | -   | 15   |      |
|       |                                               |                                                                           | C = 20 pF, 1.71 V ≤ V <sub>DD</sub> ≤ 2.7 V | -   | 15   |      |
|       |                                               |                                                                           | C = 10 pF, 1.71 V ≤ V <sub>DD</sub> ≤ 2.7 V | -   | 15   |      |
|       | t <sub>r</sub> /t <sub>f</sub> <sup>(4)</sup> | Output high to low level fall time and output low to high level rise time | C = 50 pF, 2.7 V ≤ V <sub>DD</sub> ≤ 3.6 V  | -   | 6.2  | ns   |
|       |                                               |                                                                           | C = 30 pF, 2.7 V ≤ V <sub>DD</sub> ≤ 3.6 V  | -   | 5.2  |      |
|       |                                               |                                                                           | C = 20 pF, 2.7 V ≤ V <sub>DD</sub> ≤ 3.6 V  | -   | 4.5  |      |
|       |                                               |                                                                           | C = 10 pF, 2.7 V ≤ V <sub>DD</sub> ≤ 3.6 V  | -   | 3.6  |      |
|       |                                               |                                                                           | C = 50 pF, 1.71 V ≤ V <sub>DD</sub> ≤ 2.7 V | -   | 11.0 |      |
|       |                                               |                                                                           | C = 30 pF, 1.71 V ≤ V <sub>DD</sub> ≤ 2.7 V | -   | 9.0  |      |
|       |                                               |                                                                           | C = 20 pF, 1.71 V ≤ V <sub>DD</sub> ≤ 2.7 V | -   | 8.0  |      |
|       |                                               |                                                                           | C = 10 pF, 1.71 V ≤ V <sub>DD</sub> ≤ 2.7 V | -   | 7.0  |      |

Table 57. Output timing characteristics (HSLV OFF)<sup>(1)(2)</sup> (continued)

| Speed | Symbol           | Parameter                                                                 | conditions                                                               | Min | Max | Unit |
|-------|------------------|---------------------------------------------------------------------------|--------------------------------------------------------------------------|-----|-----|------|
| 10    | $F_{\max}^{(3)}$ | Maximum frequency                                                         | $C = 50 \text{ pF}, 2.7 \text{ V} \leq V_{DD} \leq 3.6 \text{ V}^{(5)}$  | -   | 83  | MHz  |
|       |                  |                                                                           | $C = 30 \text{ pF}, 2.7 \text{ V} \leq V_{DD} \leq 3.6 \text{ V}^{(5)}$  | -   | 100 |      |
|       |                  |                                                                           | $C = 20 \text{ pF}, 2.7 \text{ V} \leq V_{DD} \leq 3.6 \text{ V}^{(5)}$  | -   | 133 |      |
|       |                  |                                                                           | $C = 10 \text{ pF}, 2.7 \text{ V} \leq V_{DD} \leq 3.6 \text{ V}^{(5)}$  | -   | 166 |      |
|       |                  |                                                                           | $C = 50 \text{ pF}, 1.71 \text{ V} \leq V_{DD} \leq 2.7 \text{ V}^{(5)}$ | -   | 32  |      |
|       |                  |                                                                           | $C = 30 \text{ pF}, 1.71 \text{ V} \leq V_{DD} \leq 2.7 \text{ V}^{(5)}$ | -   | 37  |      |
|       |                  |                                                                           | $C = 20 \text{ pF}, 1.71 \text{ V} \leq V_{DD} \leq 2.7 \text{ V}^{(5)}$ | -   | 42  |      |
|       |                  |                                                                           | $C = 10 \text{ pF}, 1.71 \text{ V} \leq V_{DD} \leq 2.7 \text{ V}^{(5)}$ | -   | 50  |      |
|       | $t_r/t_f^{(4)}$  | Output high to low level fall time and output low to high level rise time | $C = 50 \text{ pF}, 2.7 \text{ V} \leq V_{DD} \leq 3.6 \text{ V}^{(5)}$  | -   | 3.5 | ns   |
|       |                  |                                                                           | $C = 30 \text{ pF}, 2.7 \text{ V} \leq V_{DD} \leq 3.6 \text{ V}^{(5)}$  | -   | 2.7 |      |
|       |                  |                                                                           | $C = 20 \text{ pF}, 2.7 \text{ V} \leq V_{DD} \leq 3.6 \text{ V}^{(5)}$  | -   | 2.2 |      |
|       |                  |                                                                           | $C = 10 \text{ pF}, 2.7 \text{ V} \leq V_{DD} \leq 3.6 \text{ V}^{(5)}$  | -   | 1.6 |      |
|       |                  |                                                                           | $C = 50 \text{ pF}, 1.71 \text{ V} \leq V_{DD} \leq 2.7 \text{ V}^{(5)}$ | -   | 6.6 |      |
|       |                  |                                                                           | $C = 30 \text{ pF}, 1.71 \text{ V} \leq V_{DD} \leq 2.7 \text{ V}^{(5)}$ | -   | 5.0 |      |
|       |                  |                                                                           | $C = 20 \text{ pF}, 1.71 \text{ V} \leq V_{DD} \leq 2.7 \text{ V}^{(5)}$ | -   | 4.2 |      |
|       |                  |                                                                           | $C = 10 \text{ pF}, 1.71 \text{ V} \leq V_{DD} \leq 2.7 \text{ V}^{(5)}$ | -   | 3.3 |      |
| 11    | $F_{\max}^{(3)}$ | Maximum frequency                                                         | $C = 50 \text{ pF}, 2.7 \text{ V} \leq V_{DD} \leq 3.6 \text{ V}^{(5)}$  | -   | 133 | MHz  |
|       |                  |                                                                           | $C = 30 \text{ pF}, 2.7 \text{ V} \leq V_{DD} \leq 3.6 \text{ V}^{(5)}$  | -   | 166 |      |
|       |                  |                                                                           | $C = 20 \text{ pF}, 2.7 \text{ V} \leq V_{DD} \leq 3.6 \text{ V}^{(5)}$  | -   | 200 |      |
|       |                  |                                                                           | $C = 10 \text{ pF}, 2.7 \text{ V} \leq V_{DD} \leq 3.6 \text{ V}^{(5)}$  | -   | 233 |      |
|       |                  |                                                                           | $C = 50 \text{ pF}, 1.71 \text{ V} \leq V_{DD} \leq 2.7 \text{ V}^{(5)}$ | -   | 45  |      |
|       |                  |                                                                           | $C = 30 \text{ pF}, 1.71 \text{ V} \leq V_{DD} \leq 2.7 \text{ V}^{(5)}$ | -   | 50  |      |
|       |                  |                                                                           | $C = 20 \text{ pF}, 1.71 \text{ V} \leq V_{DD} \leq 2.7 \text{ V}^{(5)}$ | -   | 55  |      |
|       |                  |                                                                           | $C = 10 \text{ pF}, 1.71 \text{ V} \leq V_{DD} \leq 2.7 \text{ V}^{(5)}$ | -   | 60  |      |
|       | $t_r/t_f^{(4)}$  | Output high to low level fall time and output low to high level rise time | $C = 50 \text{ pF}, 2.7 \text{ V} \leq V_{DD} \leq 3.6 \text{ V}^{(5)}$  | -   | 2.9 | ns   |
|       |                  |                                                                           | $C = 30 \text{ pF}, 2.7 \text{ V} \leq V_{DD} \leq 3.6 \text{ V}^{(5)}$  | -   | 2.0 |      |
|       |                  |                                                                           | $C = 20 \text{ pF}, 2.7 \text{ V} \leq V_{DD} \leq 3.6 \text{ V}^{(5)}$  | -   | 1.7 |      |
|       |                  |                                                                           | $C = 10 \text{ pF}, 2.7 \text{ V} \leq V_{DD} \leq 3.6 \text{ V}^{(5)}$  | -   | 1.3 |      |
|       |                  |                                                                           | $C = 50 \text{ pF}, 1.71 \text{ V} \leq V_{DD} \leq 2.7 \text{ V}^{(5)}$ | -   | 5.4 |      |
|       |                  |                                                                           | $C = 30 \text{ pF}, 1.71 \text{ V} \leq V_{DD} \leq 2.7 \text{ V}^{(5)}$ | -   | 4.0 |      |
|       |                  |                                                                           | $C = 20 \text{ pF}, 1.71 \text{ V} \leq V_{DD} \leq 2.7 \text{ V}^{(5)}$ | -   | 3.3 |      |
|       |                  |                                                                           | $C = 10 \text{ pF}, 1.71 \text{ V} \leq V_{DD} \leq 2.7 \text{ V}^{(5)}$ | -   | 2.5 |      |

1. Specified by design, not tested in production.

2. GPIO under VSW domain (PC13, PC14, PC15, PI0, PI1, PI2, PI3) are frequency limited. The maximum frequency is 2 MHz with a maximum load of 30 pF. Only one I/O at a time can be used as GPIO output and these I/Os must not be used as a current source (e.g. to drive a LED). For these IOs, the speed value must be kept to (default) 00.

3. The maximum frequency is defined with the following conditions:  $(t_r + t_f) \leq 2/3$ , skew  $\leq 1/20$  T and  $45\% < \text{duty cycle} < 55\%$ .
4. The fall and rise times are defined between 90% and 10% and between 10% and 90% of the output waveform, respectively.
5. Compensation system enabled.

### Output buffer timing characteristics (IO structure with \_h, HSLV option enabled)

The HSLVEN bits of SYSCFG\_HSLVENxR register (together with OTP bit PRODUCT\_BELOW\_2V5) can be used to optimize the I/O speed when the product voltage is below 2.5 V typ. (2.7 V max.).

**Table 58. Output timing characteristics (HSLV ON, \_h IO structure)<sup>(1)</sup>**

| Speed | Symbol           | Parameter                                                                 | conditions                                                       | Min | Max  | Unit |
|-------|------------------|---------------------------------------------------------------------------|------------------------------------------------------------------|-----|------|------|
| 00    | $F_{\max}^{(2)}$ | Maximum frequency                                                         | C = 50 pF, $1.71 \text{ V} \leq V_{DD} \leq 2.7 \text{ V}$       | -   | 21   | MHz  |
|       |                  |                                                                           | C = 30 pF, $1.71 \text{ V} \leq V_{DD} \leq 2.7 \text{ V}$       | -   | 23   |      |
|       |                  |                                                                           | C = 20 pF, $1.71 \text{ V} \leq V_{DD} \leq 2.7 \text{ V}$       | -   | 25   |      |
|       |                  |                                                                           | C = 10 pF, $1.71 \text{ V} \leq V_{DD} \leq 2.7 \text{ V}$       | -   | 27   |      |
|       | $t_r/t_f^{(3)}$  | Output high to low level fall time and output low to high level rise time | C = 50 pF, $1.71 \text{ V} \leq V_{DD} \leq 2.7 \text{ V}$       | -   | 12.5 | ns   |
|       |                  |                                                                           | C = 30 pF, $1.71 \text{ V} \leq V_{DD} \leq 2.7 \text{ V}$       | -   | 10.5 |      |
|       |                  |                                                                           | C = 20 pF, $1.71 \text{ V} \leq V_{DD} \leq 2.7 \text{ V}$       | -   | 9    |      |
|       |                  |                                                                           | C = 10 pF, $1.71 \text{ V} \leq V_{DD} \leq 2.7 \text{ V}$       | -   | 7.5  |      |
| 01    | $F_{\max}^{(2)}$ | Maximum frequency                                                         | C = 50 pF, $1.71 \text{ V} \leq V_{DD} \leq 2.7 \text{ V}$       | -   | 33   | MHz  |
|       |                  |                                                                           | C = 30 pF, $1.71 \text{ V} \leq V_{DD} \leq 2.7 \text{ V}$       | -   | 44   |      |
|       |                  |                                                                           | C = 20 pF, $1.71 \text{ V} \leq V_{DD} \leq 2.7 \text{ V}$       | -   | 55   |      |
|       |                  |                                                                           | C = 10 pF, $1.71 \text{ V} \leq V_{DD} \leq 2.7 \text{ V}$       | -   | 66   |      |
|       | $t_r/t_f^{(3)}$  | Output high to low level fall time and output low to high level rise time | C = 50 pF, $1.71 \text{ V} \leq V_{DD} \leq 2.7 \text{ V}$       | -   | 7.3  | ns   |
|       |                  |                                                                           | C = 30 pF, $1.71 \text{ V} \leq V_{DD} \leq 2.7 \text{ V}$       | -   | 5.7  |      |
|       |                  |                                                                           | C = 20 pF, $1.71 \text{ V} \leq V_{DD} \leq 2.7 \text{ V}$       | -   | 4.8  |      |
|       |                  |                                                                           | C = 10 pF, $1.71 \text{ V} \leq V_{DD} \leq 2.7 \text{ V}$       | -   | 3.8  |      |
| 10    | $F_{\max}^{(2)}$ | Maximum frequency                                                         | C = 50 pF, $1.71 \text{ V} \leq V_{DD} \leq 2.7 \text{ V}^{(4)}$ | -   | 66   | MHz  |
|       |                  |                                                                           | C = 30 pF, $1.71 \text{ V} \leq V_{DD} \leq 2.7 \text{ V}^{(4)}$ | -   | 90   |      |
|       |                  |                                                                           | C = 20 pF, $1.71 \text{ V} \leq V_{DD} \leq 2.7 \text{ V}^{(4)}$ | -   | 110  |      |
|       |                  |                                                                           | C = 10 pF, $1.71 \text{ V} \leq V_{DD} \leq 2.7 \text{ V}^{(4)}$ | -   | 133  |      |
|       | $t_r/t_f^{(3)}$  | Output high to low level fall time and output low to high level rise time | C = 50 pF, $1.71 \text{ V} \leq V_{DD} \leq 2.7 \text{ V}^{(4)}$ | -   | 5.0  | ns   |
|       |                  |                                                                           | C = 30 pF, $1.71 \text{ V} \leq V_{DD} \leq 2.7 \text{ V}^{(4)}$ | -   | 3.5  |      |
|       |                  |                                                                           | C = 20 pF, $1.71 \text{ V} \leq V_{DD} \leq 2.7 \text{ V}^{(4)}$ | -   | 2.7  |      |
|       |                  |                                                                           | C = 10 pF, $1.71 \text{ V} \leq V_{DD} \leq 2.7 \text{ V}^{(4)}$ | -   | 2.0  |      |

Table 58. Output timing characteristics (HSLV ON, \_h IO structure)<sup>(1)</sup> (continued)

| Speed | Symbol           | Parameter                                                                 | conditions                                                                      | Min | Max | Unit |
|-------|------------------|---------------------------------------------------------------------------|---------------------------------------------------------------------------------|-----|-----|------|
| 11    | $F_{\max}^{(2)}$ | Maximum frequency                                                         | $C = 50 \text{ pF}, 1.71 \text{ V} \leq V_{\text{DD}} \leq 2.7 \text{ V}^{(4)}$ | -   | 100 | MHz  |
|       |                  |                                                                           | $C = 30 \text{ pF}, 1.71 \text{ V} \leq V_{\text{DD}} \leq 2.7 \text{ V}^{(4)}$ | -   | 133 |      |
|       |                  |                                                                           | $C = 20 \text{ pF}, 1.71 \text{ V} \leq V_{\text{DD}} \leq 2.7 \text{ V}^{(4)}$ | -   | 166 |      |
|       |                  |                                                                           | $C = 10 \text{ pF}, 1.71 \text{ V} \leq V_{\text{DD}} \leq 2.7 \text{ V}^{(4)}$ | -   | 200 |      |
|       | $t_r/t_f^{(3)}$  | Output high to low level fall time and output low to high level rise time | $C = 50 \text{ pF}, 1.71 \text{ V} \leq V_{\text{DD}} \leq 2.7 \text{ V}^{(4)}$ | -   | 4.6 | ns   |
|       |                  |                                                                           | $C = 30 \text{ pF}, 1.71 \text{ V} \leq V_{\text{DD}} \leq 2.7 \text{ V}^{(4)}$ | -   | 3.1 |      |
|       |                  |                                                                           | $C = 20 \text{ pF}, 1.71 \text{ V} \leq V_{\text{DD}} \leq 2.7 \text{ V}^{(4)}$ | -   | 2.4 |      |
|       |                  |                                                                           | $C = 10 \text{ pF}, 1.71 \text{ V} \leq V_{\text{DD}} \leq 2.7 \text{ V}^{(4)}$ | -   | 1.7 |      |

- Specified by design, not tested in production.
- The maximum frequency is defined with the following conditions:  $(t_r+t_f) \leq 2/3$ , skew  $\leq 1/20 T$  and  $45\% < \text{duty cycle} < 55\%$ .
- The fall and rise times are defined between 90% and 10% and between 10% and 90% of the output waveform, respectively.
- Compensation system enabled.

### Output buffer timing characteristics (IO structure with \_vh, HSLV option disabled)

Table 59. Output timing characteristics (HSLV OFF, \_vh IO structure)<sup>(1)</sup>

| Speed | Symbol           | Parameter                                                                 | conditions                                                                               | Min | Max  | Unit |
|-------|------------------|---------------------------------------------------------------------------|------------------------------------------------------------------------------------------|-----|------|------|
| 00    | $F_{\max}^{(2)}$ | Maximum frequency                                                         | $C = 10, 20, 30, 50 \text{ pF}, 2.7 \text{ V} \leq V_{\text{DDIOX}} \leq 3.6 \text{ V}$  | -   | 17   | MHz  |
|       |                  |                                                                           | $C = 10, 20, 30, 50 \text{ pF}, 1.71 \text{ V} \leq V_{\text{DDIOX}} \leq 2.7 \text{ V}$ | -   | 5    |      |
|       | $t_r/t_f^{(3)}$  | Output high to low level fall time and output low to high level rise time | $C = 10, 20, 30, 50 \text{ pF}, 2.7 \text{ V} \leq V_{\text{DDIOX}} \leq 3.6 \text{ V}$  | -   | 12   | ns   |
|       |                  |                                                                           | $C = 10, 20, 30, 50 \text{ pF}, 1.71 \text{ V} \leq V_{\text{DDIOX}} \leq 2.7 \text{ V}$ | -   | 22   |      |
| 01    | $F_{\max}^{(2)}$ | Maximum frequency                                                         | $C = 50 \text{ pF}, 2.7 \text{ V} \leq V_{\text{DDIOX}} \leq 3.6 \text{ V}$              | -   | 33   | MHz  |
|       |                  |                                                                           | $C = 30 \text{ pF}, 2.7 \text{ V} \leq V_{\text{DDIOX}} \leq 3.6 \text{ V}$              | -   | 44   |      |
|       |                  |                                                                           | $C = 20 \text{ pF}, 2.7 \text{ V} \leq V_{\text{DDIOX}} \leq 3.6 \text{ V}$              | -   | 55   |      |
|       |                  |                                                                           | $C = 10 \text{ pF}, 2.7 \text{ V} \leq V_{\text{DDIOX}} \leq 3.6 \text{ V}$              | -   | 66   |      |
|       |                  |                                                                           | $C = 10, 20, 30, 50 \text{ pF}, 1.71 \text{ V} \leq V_{\text{DDIOX}} \leq 2.7 \text{ V}$ | -   | 15   |      |
|       | $t_r/t_f^{(3)}$  | Output high to low level fall time and output low to high level rise time | $C = 50 \text{ pF}, 2.7 \text{ V} \leq V_{\text{DDIOX}} \leq 3.6 \text{ V}$              | -   | 6.2  | ns   |
|       |                  |                                                                           | $C = 30 \text{ pF}, 2.7 \text{ V} \leq V_{\text{DDIOX}} \leq 3.6 \text{ V}$              | -   | 5.2  |      |
|       |                  |                                                                           | $C = 20 \text{ pF}, 2.7 \text{ V} \leq V_{\text{DDIOX}} \leq 3.6 \text{ V}$              | -   | 4.5  |      |
|       |                  |                                                                           | $C = 10 \text{ pF}, 2.7 \text{ V} \leq V_{\text{DDIOX}} \leq 3.6 \text{ V}$              | -   | 3.6  |      |
|       |                  |                                                                           | $C = 10, 20, 30, 50 \text{ pF}, 1.71 \text{ V} \leq V_{\text{DDIOX}} \leq 2.7 \text{ V}$ | -   | 11.0 |      |

Table 59. Output timing characteristics (HSLV OFF, \_vh IO structure)<sup>(1)</sup> (continued)

| Speed | Symbol           | Parameter                                                                 | conditions                                                                                     | Min | Max | Unit |
|-------|------------------|---------------------------------------------------------------------------|------------------------------------------------------------------------------------------------|-----|-----|------|
| 10    | $F_{\max}^{(2)}$ | Maximum frequency                                                         | $C = 50 \text{ pF}, 2.7 \text{ V} \leq V_{\text{DDIOX}} \leq 3.6 \text{ V}^{(4)}$              | -   | 83  | MHz  |
|       |                  |                                                                           | $C = 30 \text{ pF}, 2.7 \text{ V} \leq V_{\text{DDIOX}} \leq 3.6 \text{ V}^{(4)}$              | -   | 100 |      |
|       |                  |                                                                           | $C = 20 \text{ pF}, 2.7 \text{ V} \leq V_{\text{DDIOX}} \leq 3.6 \text{ V}^{(4)}$              | -   | 133 |      |
|       |                  |                                                                           | $C = 10 \text{ pF}, 2.7 \text{ V} \leq V_{\text{DDIOX}} \leq 3.6 \text{ V}^{(4)}$              | -   | 166 |      |
|       |                  |                                                                           | $C = 10, 20, 30, 50 \text{ pF}, 1.71 \text{ V} \leq V_{\text{DDIOX}} \leq 2.0 \text{ V}^{(4)}$ | -   | 30  |      |
|       | $t_r/t_f^{(3)}$  | Output high to low level fall time and output low to high level rise time | $C = 50 \text{ pF}, 2.7 \text{ V} \leq V_{\text{DDIOX}} \leq 3.6 \text{ V}^{(4)}$              | -   | 3.5 | ns   |
|       |                  |                                                                           | $C = 30 \text{ pF}, 2.7 \text{ V} \leq V_{\text{DDIOX}} \leq 3.6 \text{ V}^{(4)}$              | -   | 2.7 |      |
|       |                  |                                                                           | $C = 20 \text{ pF}, 2.7 \text{ V} \leq V_{\text{DDIOX}} \leq 3.6 \text{ V}^{(4)}$              | -   | 2.2 |      |
|       |                  |                                                                           | $C = 10 \text{ pF}, 2.7 \text{ V} \leq V_{\text{DDIOX}} \leq 3.6 \text{ V}^{(4)}$              | -   | 1.6 |      |
|       |                  |                                                                           | $C = 10, 20, 30, 50 \text{ pF}, 1.71 \text{ V} \leq V_{\text{DDIOX}} \leq 2.0 \text{ V}^{(4)}$ | -   | 6.6 |      |
| 11    | $F_{\max}^{(2)}$ | Maximum frequency                                                         | $C = 50 \text{ pF}, 2.7 \text{ V} \leq V_{\text{DDIOX}} \leq 3.6 \text{ V}^{(4)}$              | -   | 133 | MHz  |
|       |                  |                                                                           | $C = 30 \text{ pF}, 2.7 \text{ V} \leq V_{\text{DDIOX}} \leq 3.6 \text{ V}^{(4)}$              | -   | 166 |      |
|       |                  |                                                                           | $C = 20 \text{ pF}, 2.7 \text{ V} \leq V_{\text{DDIOX}} \leq 3.6 \text{ V}^{(4)}$              | -   | 200 |      |
|       |                  |                                                                           | $C = 10 \text{ pF}, 2.7 \text{ V} \leq V_{\text{DDIOX}} \leq 3.6 \text{ V}^{(4)}$              | -   | 233 |      |
|       |                  |                                                                           | $C = 10, 20, 30, 50 \text{ pF}, 1.71 \text{ V} \leq V_{\text{DDIOX}} \leq 2.0 \text{ V}^{(4)}$ | -   | 45  |      |
|       | $t_r/t_f^{(3)}$  | Output high to low level fall time and output low to high level rise time | $C = 50 \text{ pF}, 2.7 \text{ V} \leq V_{\text{DDIOX}} \leq 3.6 \text{ V}^{(4)}$              | -   | 2.9 | ns   |
|       |                  |                                                                           | $C = 30 \text{ pF}, 2.7 \text{ V} \leq V_{\text{DDIOX}} \leq 3.6 \text{ V}^{(4)}$              | -   | 2.0 |      |
|       |                  |                                                                           | $C = 20 \text{ pF}, 2.7 \text{ V} \leq V_{\text{DDIOX}} \leq 3.6 \text{ V}^{(4)}$              | -   | 1.7 |      |
|       |                  |                                                                           | $C = 10 \text{ pF}, 2.7 \text{ V} \leq V_{\text{DDIOX}} \leq 3.6 \text{ V}^{(4)}$              | -   | 1.3 |      |
|       |                  |                                                                           | $C = 10, 20, 30, 50 \text{ pF}, 1.71 \text{ V} \leq V_{\text{DDIOX}} \leq 2.0 \text{ V}^{(4)}$ | -   | 5.4 |      |

- Specified by design, not tested in production.
- The maximum frequency is defined with the following conditions:  $(t_r+t_f) \leq 2/3$ , skew  $\leq 1/20 \text{ T}$  and  $45\% < \text{Duty cycle} < 55\%$ .
- The fall and rise times are defined between 90% and 10% and between 10% and 90% of the output waveform, respectively.
- Compensation system enabled.

### Output buffer timing characteristics (IO structure with \_vh, HSLV option enabled)

The HSLVEN bits of SYSCFG\_HSLVENxR register (together with OTP bit PRODUCT\_BELOW\_2V5) can be used to optimize the I/O speed when the product voltage is below 2.5 V typ. (2.7 V max.).

Table 60. Output timing characteristics (HSLV ON, \_vh IO structure)<sup>(1)</sup>

| Speed | Symbol           | Parameter                                                                 | conditions                                                                      | Min | Max | Unit |
|-------|------------------|---------------------------------------------------------------------------|---------------------------------------------------------------------------------|-----|-----|------|
| 00    | $F_{\max}^{(2)}$ | Maximum frequency                                                         | $C = 50 \text{ pF}, 1.71 \text{ V} \leq V_{\text{DD}} \leq 2.7 \text{ V}$       | -   | 25  | MHz  |
|       |                  |                                                                           | $C = 30 \text{ pF}, 1.71 \text{ V} \leq V_{\text{DD}} \leq 2.7 \text{ V}$       | -   | 30  |      |
|       |                  |                                                                           | $C = 20 \text{ pF}, 1.71 \text{ V} \leq V_{\text{DD}} \leq 2.7 \text{ V}$       | -   | 35  |      |
|       |                  |                                                                           | $C = 10 \text{ pF}, 1.71 \text{ V} \leq V_{\text{DD}} \leq 2.7 \text{ V}$       | -   | 40  |      |
|       | $t_r/t_f^{(3)}$  | Output high to low level fall time and output low to high level rise time | $C = 50 \text{ pF}, 1.71 \text{ V} \leq V_{\text{DD}} \leq 2.7 \text{ V}$       | -   | 9.5 | ns   |
|       |                  |                                                                           | $C = 30 \text{ pF}, 1.71 \text{ V} \leq V_{\text{DD}} \leq 2.7 \text{ V}$       | -   | 7.7 |      |
|       |                  |                                                                           | $C = 20 \text{ pF}, 1.71 \text{ V} \leq V_{\text{DD}} \leq 2.7 \text{ V}$       | -   | 6.6 |      |
|       |                  |                                                                           | $C = 10 \text{ pF}, 1.71 \text{ V} \leq V_{\text{DD}} \leq 2.7 \text{ V}$       | -   | 5.4 |      |
| 01    | $F_{\max}^{(2)}$ | Maximum frequency                                                         | $C = 50 \text{ pF}, 1.71 \text{ V} \leq V_{\text{DD}} \leq 2.7 \text{ V}$       | -   | 44  | MHz  |
|       |                  |                                                                           | $C = 30 \text{ pF}, 1.71 \text{ V} \leq V_{\text{DD}} \leq 2.7 \text{ V}$       | -   | 55  |      |
|       |                  |                                                                           | $C = 20 \text{ pF}, 1.71 \text{ V} \leq V_{\text{DD}} \leq 2.7 \text{ V}$       | -   | 66  |      |
|       |                  |                                                                           | $C = 10 \text{ pF}, 1.71 \text{ V} \leq V_{\text{DD}} \leq 2.7 \text{ V}$       | -   | 77  |      |
|       | $t_r/t_f^{(3)}$  | Output high to low level fall time and output low to high level rise time | $C = 50 \text{ pF}, 1.71 \text{ V} \leq V_{\text{DD}} \leq 2.7 \text{ V}$       | -   | 6.5 | ns   |
|       |                  |                                                                           | $C = 30 \text{ pF}, 1.71 \text{ V} \leq V_{\text{DD}} \leq 2.7 \text{ V}$       | -   | 4.9 |      |
|       |                  |                                                                           | $C = 20 \text{ pF}, 1.71 \text{ V} \leq V_{\text{DD}} \leq 2.7 \text{ V}$       | -   | 4.1 |      |
|       |                  |                                                                           | $C = 10 \text{ pF}, 1.71 \text{ V} \leq V_{\text{DD}} \leq 2.7 \text{ V}$       | -   | 3.1 |      |
| 10    | $F_{\max}^{(2)}$ | Maximum frequency                                                         | $C = 50 \text{ pF}, 1.71 \text{ V} \leq V_{\text{DD}} \leq 2.7 \text{ V}^{(4)}$ | -   | 66  | MHz  |
|       |                  |                                                                           | $C = 30 \text{ pF}, 1.71 \text{ V} \leq V_{\text{DD}} \leq 2.7 \text{ V}^{(4)}$ | -   | 90  |      |
|       |                  |                                                                           | $C = 20 \text{ pF}, 1.71 \text{ V} \leq V_{\text{DD}} \leq 2.7 \text{ V}^{(4)}$ | -   | 110 |      |
|       |                  |                                                                           | $C = 10 \text{ pF}, 1.71 \text{ V} \leq V_{\text{DD}} \leq 2.7 \text{ V}^{(4)}$ | -   | 133 |      |
|       | $t_r/t_f^{(3)}$  | Output high to low level fall time and output low to high level rise time | $C = 50 \text{ pF}, 1.71 \text{ V} \leq V_{\text{DD}} \leq 2.7 \text{ V}^{(4)}$ | -   | 5.1 | ns   |
|       |                  |                                                                           | $C = 30 \text{ pF}, 1.71 \text{ V} \leq V_{\text{DD}} \leq 2.7 \text{ V}^{(4)}$ | -   | 3.6 |      |
|       |                  |                                                                           | $C = 20 \text{ pF}, 1.71 \text{ V} \leq V_{\text{DD}} \leq 2.7 \text{ V}^{(4)}$ | -   | 2.8 |      |
|       |                  |                                                                           | $C = 10 \text{ pF}, 1.71 \text{ V} \leq V_{\text{DD}} \leq 2.7 \text{ V}^{(4)}$ | -   | 2.1 |      |
| 11    | $F_{\max}^{(2)}$ | Maximum frequency                                                         | $C = 50 \text{ pF}, 1.71 \text{ V} \leq V_{\text{DD}} \leq 2.7 \text{ V}^{(4)}$ | -   | 110 | MHz  |
|       |                  |                                                                           | $C = 30 \text{ pF}, 1.71 \text{ V} \leq V_{\text{DD}} \leq 2.7 \text{ V}^{(4)}$ | -   | 150 |      |
|       |                  |                                                                           | $C = 20 \text{ pF}, 1.71 \text{ V} \leq V_{\text{DD}} \leq 2.7 \text{ V}^{(4)}$ | -   | 190 |      |
|       |                  |                                                                           | $C = 10 \text{ pF}, 1.71 \text{ V} \leq V_{\text{DD}} \leq 2.7 \text{ V}^{(4)}$ | -   | 233 |      |
|       | $t_r/t_f^{(3)}$  | Output high to low level fall time and output low to high level rise time | $C = 50 \text{ pF}, 1.71 \text{ V} \leq V_{\text{DD}} \leq 2.7 \text{ V}^{(4)}$ | -   | 4.5 | ns   |
|       |                  |                                                                           | $C = 30 \text{ pF}, 1.71 \text{ V} \leq V_{\text{DD}} \leq 2.7 \text{ V}^{(4)}$ | -   | 3.0 |      |
|       |                  |                                                                           | $C = 20 \text{ pF}, 1.71 \text{ V} \leq V_{\text{DD}} \leq 2.7 \text{ V}^{(4)}$ | -   | 2.2 |      |
|       |                  |                                                                           | $C = 10 \text{ pF}, 1.71 \text{ V} \leq V_{\text{DD}} \leq 2.7 \text{ V}^{(4)}$ | -   | 1.5 |      |

1. Specified by design, not tested in production.

2. The maximum frequency is defined with the following conditions:  $(t_r+t_f) \leq 2/3$ , skew  $\leq 1/20 \text{ T}$  and  $45\% < \text{Duty cycle} < 55\%$ .

3. The fall and rise times are defined between 90% and 10% and between 10% and 90% of the output waveform, respectively.

4. Compensation system enabled.

### 6.3.18 NRST pin characteristics

The NRST pin input driver uses CMOS technology. It is connected to a permanent pull-up resistor,  $R_{PU}$  (see [Table 54: I/O static characteristics](#)).

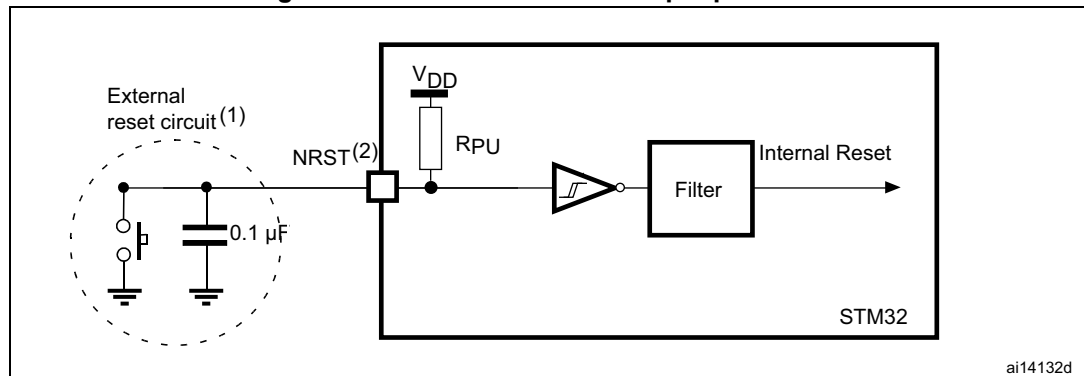
Unless otherwise specified, the parameters given in [Table 61](#) are derived from tests performed under the ambient temperature and  $V_{DD}$  supply voltage conditions summarized in [Table 13: General operating conditions](#).

**Table 61. NRST pin characteristics**

| Symbol               | Parameter                                       | Conditions                              | Min | Typ | Max | Unit       |
|----------------------|-------------------------------------------------|-----------------------------------------|-----|-----|-----|------------|
| $R_{PU}^{(2)}$       | Weak pull-up equivalent resistor <sup>(1)</sup> | $V_{IN} = V_{SS}$                       | 30  | 40  | 50  | k $\Omega$ |
| $V_{F(NRST)}^{(2)}$  | NRST input filtered pulse                       | $1.71\text{ V} < V_{DD} < 3.6\text{ V}$ | -   | -   | 50  | ns         |
| $V_{NF(NRST)}^{(2)}$ | NRST input not filtered pulse                   | $1.71\text{ V} < V_{DD} < 3.6\text{ V}$ | 350 | -   | -   |            |

1. The pull-up is designed with a true resistance in series with a switchable PMOS. This PMOS contribution to the series resistance must be minimum (~10% order).
2. Specified by design, not tested in production.

**Figure 23. Recommended NRST pin protection**



1. The reset network protects the device against parasitic resets.
2. The user must ensure that the level on the NRST pin can go below the  $V_{IL(NRST)}$  max level specified in [Table 54](#). Otherwise the reset is not taken into account by the device.

### 6.3.19 FMC characteristics

Unless otherwise specified, the parameters given in [Table 62](#) to [Table 75](#) for the FMC interface are derived from tests performed under the ambient temperature,  $F_{mc\_hclk}$  ( $F_{hclk6}$ ) frequency and  $V_{DD}$  supply voltage conditions summarized in [Table 13: General operating conditions](#), with the following configuration:

- Output speed is set to  $OSPEEDRy[1:0] = 11$
- Measurement points are done at CMOS levels:  $0.5 \times V_{DD}$

Refer to [Section 6.3.17: I/O port characteristics](#) for more details on the input/output characteristics.



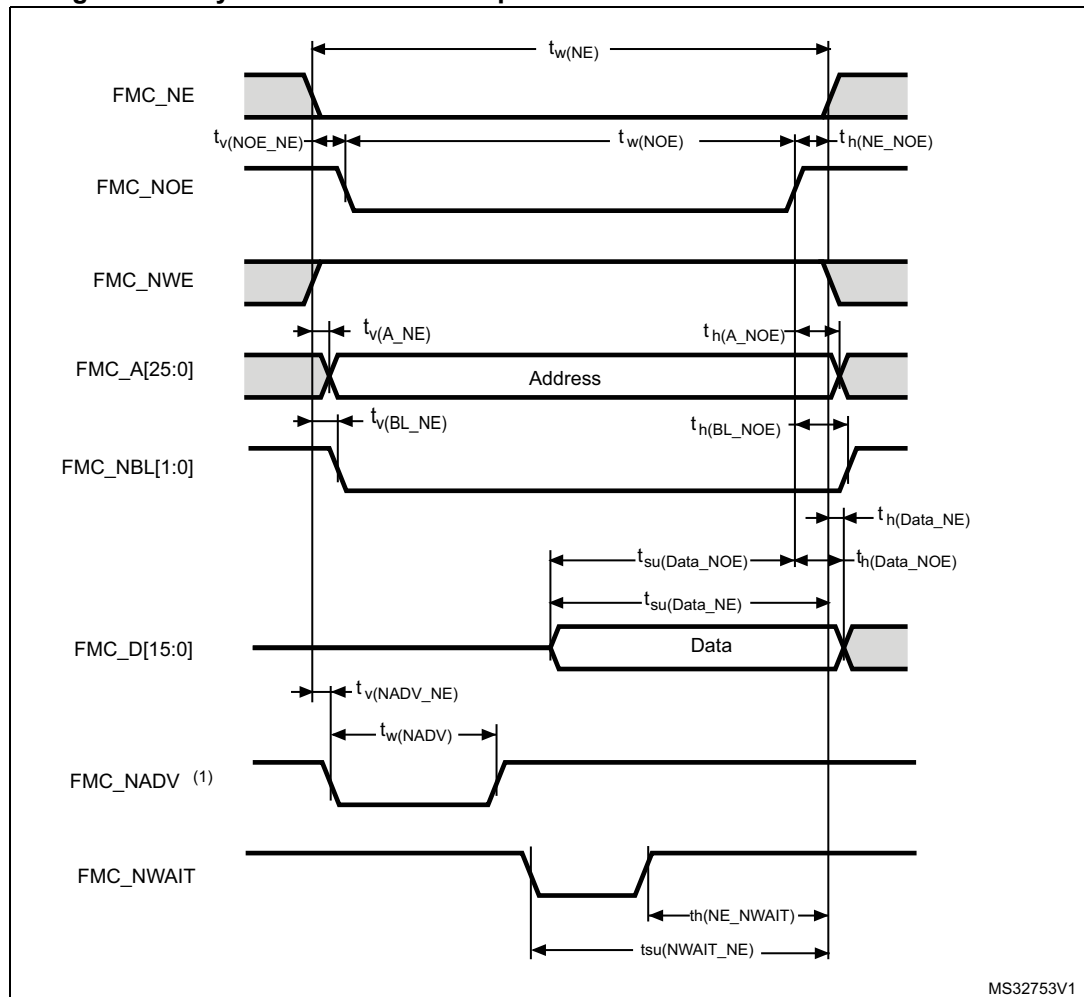
## Asynchronous waveforms and timings

Figure 24 through Figure 27 represent asynchronous waveforms and Table 62 through Table 69 provide the corresponding timings. The results shown in these tables are obtained with the following FMC configuration:

- AddressSetupTime = 0x1
- AddressHoldTime = 0x1
- DataSetupTime = 0x1 (except for asynchronous NWAIT mode, DataSetupTime = 0x5)
- DataHoldTime = 0x1 ( $1 \times T_{\text{fmc\_ker\_ck}}$  for read operations and  $2 \times T_{\text{fmc\_ker\_ck}}$  for write operations)
- ByteLaneSetup = 0x1
- BusTurnAroundDuration = 0x0
- Capacitive load  $C_L = 30 \text{ pF}$

In all the timing tables, the  $T_{\text{fmc\_ker\_ck}}$  is the fmc\_ker\_ck clock period.

**Figure 24. Asynchronous non-multiplexed SRAM/PSRAM/NOR read waveforms**



1. Mode 2/B, C and D only. In Mode 1, FMC\_NADV is not used.

**Table 62. Asynchronous non-multiplexed SRAM/PSRAM/NOR read timings<sup>(1)</sup>**

| Symbol              | Parameter                             | Min                     | Max                     | Unit |
|---------------------|---------------------------------------|-------------------------|-------------------------|------|
| $t_{w(NE)}$         | FMC_NE low time                       | $3T_{fmc\_ker\_ck}-1$   | $3T_{fmc\_ker\_ck}+0.5$ | ns   |
| $t_{v(NOE\_NE)}$    | FMC_NEx low to FMC_NOE low            | 0                       | 1                       |      |
| $t_{w(NOE)}$        | FMC_NOE low time                      | $2T_{fmc\_ker\_ck}-1$   | $2T_{fmc\_ker\_ck}+0.5$ |      |
| $t_{h(NE\_NOE)}$    | FMC_NOE high to FMC_NE high hold time | $T_{fmc\_ker\_ck}-1$    | -                       |      |
| $t_{v(A\_NE)}$      | FMC_NEx low to FMC_A valid            | -                       | 1                       |      |
| $t_{h(A\_NOE)}$     | Address hold time after FMC_NOE high  | $2T_{fmc\_ker\_ck}-1$   | -                       |      |
| $t_{su(Data\_NE)}$  | Data to FMC_NEx high setup time       | $T_{fmc\_ker\_ck}+15.5$ | -                       |      |
| $t_{su(Data\_NOE)}$ | Data to FMC_NOEx high setup time      | 16                      | -                       |      |
| $t_{h(Data\_NOE)}$  | Data hold time after FMC_NOE high     | 0                       | -                       |      |
| $t_{h(Data\_NE)}$   | Data hold time after FMC_NEx high     | 0                       | -                       |      |
| $t_{v(NADV\_NE)}$   | FMC_NEx low to FMC_NADV low           | -                       | 0                       |      |
| $t_{w(NADV)}$       | FMC_NADV low time                     | -                       | $T_{fmc\_ker\_ck}+1$    |      |

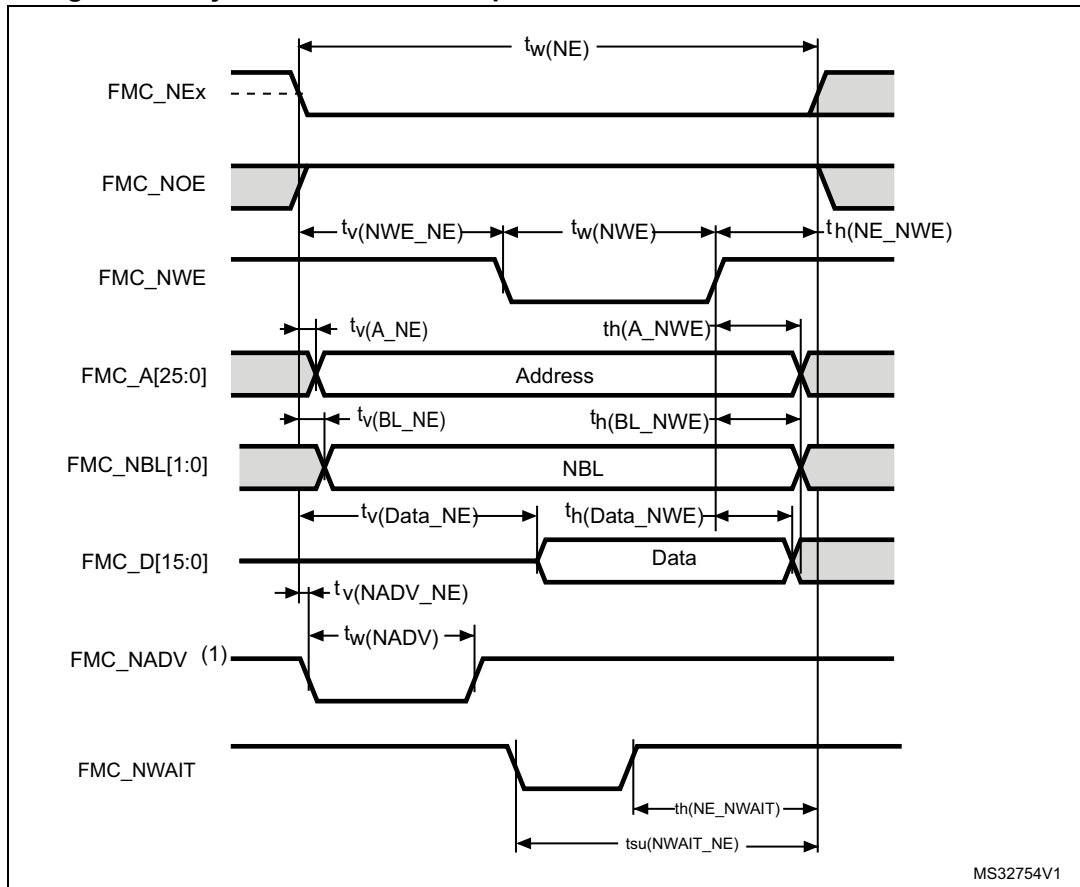
1. Evaluated by characterization, not tested in production.

**Table 63. Asynchronous non-multiplexed SRAM/PSRAM/NOR read - NWAIT timings<sup>(1)(2)</sup>**

| Symbol              | Parameter                                 | Min                     | Max                   | Unit |
|---------------------|-------------------------------------------|-------------------------|-----------------------|------|
| $t_{w(NE)}$         | FMC_NE low time                           | $7T_{fmc\_ker\_ck}-0.5$ | $7T_{fmc\_ker\_ck}+1$ | ns   |
| $t_{w(NOE)}$        | FMC_NWE low time                          | $6T_{fmc\_ker\_ck}-0.5$ | $6T_{fmc\_ker\_ck}+1$ |      |
| $t_{w(NWAIT)}$      | FMC_NWAIT low time                        | $T_{fmc\_ker\_ck}$      | -                     |      |
| $t_{su(NWAIT\_NE)}$ | FMC_NWAIT valid before FMC_NEx high       | $7T_{fmc\_ker\_ck}+2$   | -                     |      |
| $t_{h(NE\_NWAIT)}$  | FMC_NEx hold time after FMC_NWAIT invalid | $5T_{fmc\_ker\_ck}$     | -                     |      |

1. Evaluated by characterization, not tested in production.

2.  $N_{WAIT}$  pulse width is equal to 1 AHB cycle.

**Figure 25. Asynchronous non-multiplexed SRAM/PSRAM/NOR write waveforms**

1. Mode 2/B, C and D only. In Mode 1, FMC\_NADV is not used.

**Table 64. Asynchronous non-multiplexed SRAM/PSRAM/NOR write timings<sup>(1)</sup>**

| Symbol             | Parameter                             | Min                     | Max                     | Unit |
|--------------------|---------------------------------------|-------------------------|-------------------------|------|
| $t_{w(NE)}$        | FMC_NEx low time                      | $4T_{fmc\_ker\_ck}-0.5$ | $4T_{fmc\_ker\_ck}+0.5$ | ns   |
| $t_{v(NWE\_NE)}$   | FMC_NEx low to FMC_NWE low            | $T_{fmc\_ker\_ck}-0.5$  | $T_{fmc\_ker\_ck}+1$    |      |
| $t_{w(NWE)}$       | FMC_NWE low time                      | $T_{fmc\_ker\_ck}-0.5$  | $T_{fmc\_ker\_ck}+0.5$  |      |
| $t_{h(NE\_NWE)}$   | FMC_NWE high to FMC_NE high hold time | $2T_{fmc\_ker\_ck}-0.5$ | -                       |      |
| $t_{v(A\_NE)}$     | FMC_NEx low to FMC_A valid            | -                       | 0                       |      |
| $t_{h(A\_NWE)}$    | Address hold time after FMC_NWE high  | $3T_{fmc\_ker\_ck}-1$   | -                       |      |
| $t_{v(BL\_NE)}$    | FMC_NEx low to FMC_BL valid           | -                       | 0.5                     |      |
| $t_{h(BL\_NWE)}$   | FMC_BL hold time after FMC_NWE high   | $3T_{fmc\_ker\_ck}-0.5$ | -                       |      |
| $t_{v(Data\_NE)}$  | Data to FMC_NEx low to Data valid     | -                       | 3.5                     |      |
| $t_{h(Data\_NWE)}$ | Data hold time after FMC_NWE high     | $2T_{fmc\_ker\_ck}-1$   | -                       |      |
| $t_{v(NADV\_NE)}$  | FMC_NEx low to FMC_NADV low           | -                       | 0.5                     |      |
| $t_{w(NADV)}$      | FMC_NADV low time                     | -                       | $T_{fmc\_ker\_ck}+1$    |      |

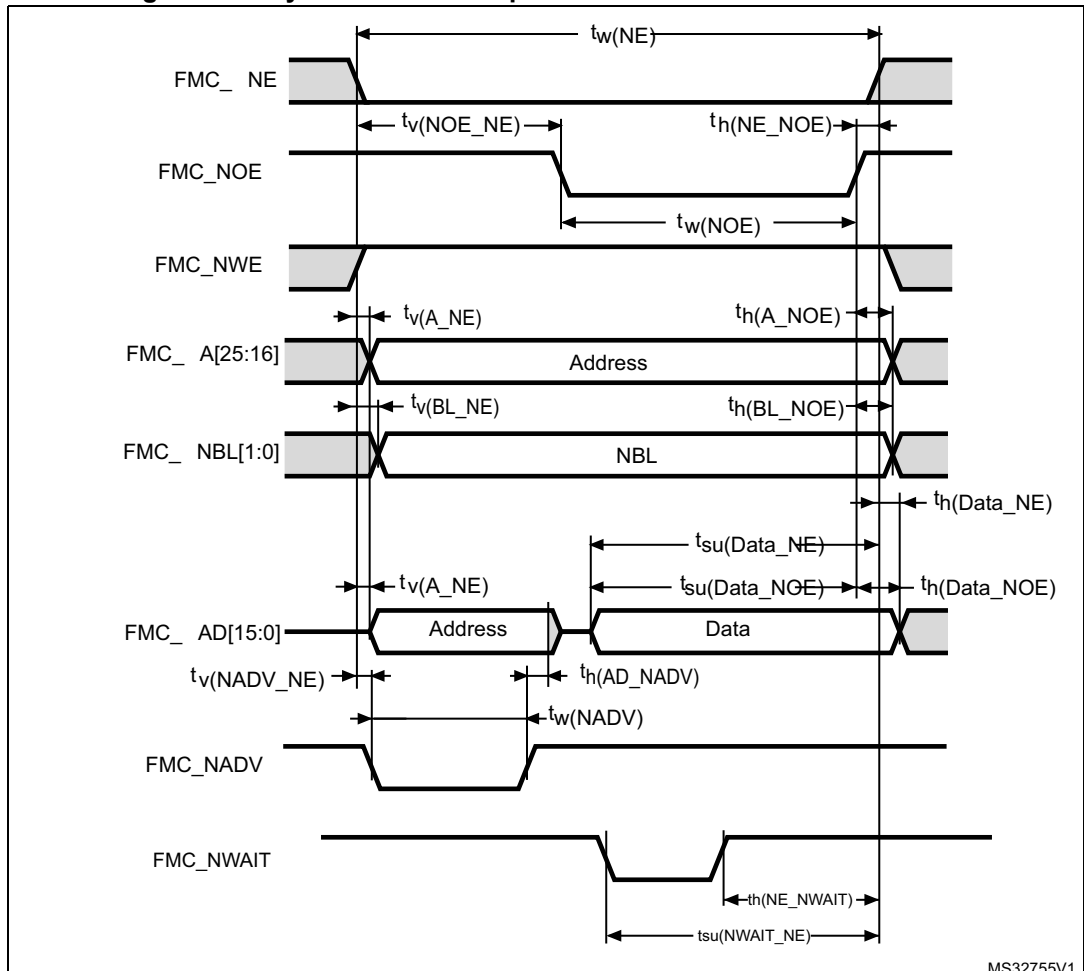
1. Evaluated by characterization, not tested in production.

**Table 65. Asynchronous non-multiplexed SRAM/PSRAM/NOR write - NWAIT timings<sup>(1)(2)</sup>**

| Symbol              | Parameter                                 | Min                     | Max                     | Unit |
|---------------------|-------------------------------------------|-------------------------|-------------------------|------|
| $t_{w(NE)}$         | FMC_NE low time                           | $8T_{fmc\_ker\_ck}-0.5$ | $8T_{fmc\_ker\_ck}+0.5$ | ns   |
| $t_{w(NWE)}$        | FMC_NWE low time                          | $5T_{fmc\_ker\_ck}-0.5$ | $5T_{fmc\_ker\_ck}+1$   |      |
| $t_{su(NWAIT\_NE)}$ | FMC_NWAIT valid before FMC_NEx high       | $8T_{fmc\_ker\_ck}+4$   | -                       |      |
| $t_{h(NE\_NWAIT)}$  | FMC_NEx hold time after FMC_NWAIT invalid | $6T_{fmc\_ker\_ck}$     | -                       |      |

1. Evaluated by characterization, not tested in production.

2.  $N_{WAIT}$  pulse width is equal to 1 AHB cycle.

**Figure 26. Asynchronous multiplexed PSRAM/NOR read waveforms**

**Table 66. Asynchronous multiplexed PSRAM/NOR read timings<sup>(1)</sup>**

| Symbol              | Parameter                                           | Min                                    | Max                    | Unit |
|---------------------|-----------------------------------------------------|----------------------------------------|------------------------|------|
| $t_{w(NE)}$         | FMC_NE low time                                     | $4T_{fmc\_ker\_ck}-0.5$                | $4T_{fmc\_ker\_ck}+1$  | ns   |
| $t_{v(NOE\_NE)}$    | FMC_NEx low to FMC_NOE low                          | $2T_{fmc\_ker\_ck}-0.5$                | $2T_{fmc\_ker\_ck}+1$  |      |
| $t_{w(NOE)}$        | FMC_NOE low time                                    | $T_{fmc\_ker\_ck}-0.5$                 | $T_{fmc\_ker\_ck}+0.5$ |      |
| $t_{h(NE\_NOE)}$    | FMC_NOE high to FMC_NE high hold time               | $T_{fmc\_ker\_ck}-1$                   | -                      |      |
| $t_{v(A\_NE)}$      | FMC_NEx low to FMC_A valid                          | -                                      | 4                      |      |
| $t_{v(NADV\_NE)}$   | FMC_NEx low to FMC_NADV low                         | 0                                      | 1                      |      |
| $t_{w(NADV)}$       | FMC_NADV low time                                   | $T_{fmc\_ker\_ck}$                     | $T_{fmc\_ker\_ck}+1$   |      |
| $t_{h(AD\_NADV)}$   | FMC_AD(address) valid hold time after FMC_NADV high | $T_{fmc\_ker\_ck}-3$                   | -                      |      |
| $t_{h(A\_NOE)}$     | Address hold time after FMC_NOE high                | Address held until next read operation | -                      |      |
| $t_{su(Data\_NE)}$  | Data to FMC_NEx high setup time                     | $T_{fmc\_ker\_ck}+15$                  | -                      |      |
| $t_{su(Data\_NOE)}$ | Data to FMC_NOE high setup time                     | 16                                     | -                      |      |
| $t_{h(Data\_NE)}$   | Data hold time after FMC_NEx high                   | 0                                      | -                      |      |
| $t_{h(Data\_NOE)}$  | Data hold time after FMC_NOE high                   | 0                                      | -                      |      |

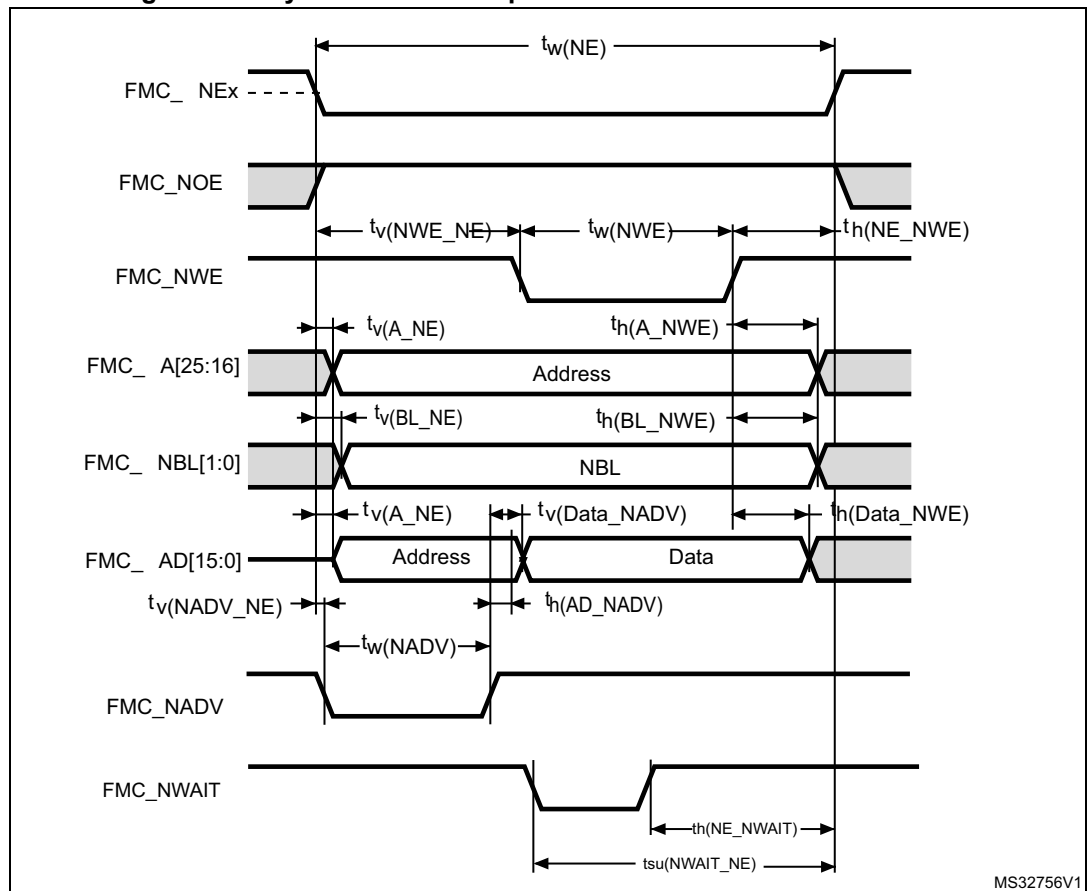
1. Evaluated by characterization, not tested in production.

**Table 67. Asynchronous multiplexed PSRAM/NOR read-NWAIT timings<sup>(1)</sup>**

| Symbol              | Parameter                                 | Min                     | Max                   | Unit |
|---------------------|-------------------------------------------|-------------------------|-----------------------|------|
| $t_{w(NE)}$         | FMC_NE low time                           | $8T_{fmc\_ker\_ck}-0.5$ | $8T_{fmc\_ker\_ck}+1$ | ns   |
| $t_{w(NOE)}$        | FMC_NWE low time                          | $5T_{fmc\_ker\_ck}-0.5$ | $5T_{fmc\_ker\_ck}+1$ |      |
| $t_{su(NWAIT\_NE)}$ | FMC_NWAIT valid before FMC_NEx high       | $7T_{fmc\_ker\_ck}+2$   | -                     |      |
| $t_{h(NE\_NWAIT)}$  | FMC_NEx hold time after FMC_NWAIT invalid | $5T_{fmc\_ker\_ck}$     | -                     |      |

1. Evaluated by characterization, not tested in production.

Figure 27. Asynchronous multiplexed PSRAM/NOR write waveforms



**Table 68. Asynchronous multiplexed PSRAM/NOR write timings<sup>(1)</sup>**

| Symbol              | Parameter                                           | Min                                     | Max                     | Unit |
|---------------------|-----------------------------------------------------|-----------------------------------------|-------------------------|------|
| $t_{w(NE)}$         | FMC_NE low time                                     | $5T_{fmc\_ker\_ck}-0.5$                 | $5T_{fmc\_ker\_ck}+1$   | ns   |
| $t_{v(NWE\_NE)}$    | FMC_NEx low to FMC_NWE low                          | $T_{fmc\_ker\_ck}-0.5$                  | $T_{fmc\_ker\_ck}+1$    |      |
| $t_{w(NWE)}$        | FMC_NWE low time                                    | $2T_{fmc\_ker\_ck}-1$                   | $2T_{fmc\_ker\_ck}+0.5$ |      |
| $t_{h(NE\_NWE)}$    | FMC_NWE high to FMC_NE high hold time               | $2T_{fmc\_ker\_ck}-0.5$                 | -                       |      |
| $t_{v(A\_NE)}$      | FMC_NEx low to FMC_A valid                          | -                                       | 0.5                     |      |
| $t_{v(NADV\_NE)}$   | FMC_NEx low to FMC_NADV low                         | 0                                       | 1                       |      |
| $t_{w(NADV)}$       | FMC_NADV low time                                   | $T_{fmc\_ker\_ck}+0.5$                  | $T_{fmc\_ker\_ck}+1.5$  |      |
| $t_{h(AD\_NADV)}$   | FMC_AD(address) valid hold time after FMC_NADV high | $T_{fmc\_ker\_ck}+0.5$                  | -                       |      |
| $t_{h(A\_NWE)}$     | Address hold time after FMC_NWE high                | Address held until next write operation | -                       |      |
| $t_{h(BL\_NWE)}$    | FMC_BL hold time after FMC_NWE high                 | $3T_{fmc\_ker\_ck}-1$                   | -                       |      |
| $t_{v(BL\_NE)}$     | FMC_NEx low to FMC_BL valid                         | -                                       | 0.5                     |      |
| $t_{v(Data\_NADV)}$ | FMC_NADV high to Data valid                         | -                                       | $T_{fmc\_ker\_ck}+5$    |      |
| $t_{h(Data\_NWE)}$  | Data hold time after FMC_NWE high                   | $2T_{fmc\_ker\_ck}+0.5$                 | -                       |      |

1. Evaluated by characterization, not tested in production.

**Table 69. Asynchronous multiplexed PSRAM/NOR write-NWAIT timings<sup>(1)</sup>**

| Symbol              | Parameter                                 | Min                     | Max                     | Unit |
|---------------------|-------------------------------------------|-------------------------|-------------------------|------|
| $t_{w(NE)}$         | FMC_NE low time                           | $9T_{fmc\_ker\_ck}-0.5$ | $9T_{fmc\_ker\_ck}+0.5$ | ns   |
| $t_{w(NWE)}$        | FMC_NWE low time                          | $6T_{fmc\_ker\_ck}-0.5$ | $6T_{fmc\_ker\_ck}+1$   |      |
| $t_{su(NWAIT\_NE)}$ | FMC_NWAIT valid before FMC_NEx high       | $8T_{fmc\_ker\_ck}+4$   | -                       |      |
| $t_{h(NE\_NWAIT)}$  | FMC_NEx hold time after FMC_NWAIT invalid | $6T_{fmc\_ker\_ck}$     | -                       |      |

1. Evaluated by characterization, not tested in production.

### Synchronous waveforms and timings

[Figure 28](#) through [Figure 31](#) represent synchronous waveforms and [Table 70](#) through [Table 73](#) provide the corresponding timings. The results shown in these tables are obtained with the following FMC configuration:

- BurstAccessMode = FMC\_BurstAccessMode\_Enable
- MemoryType = FMC\_MemoryType\_CRAM
- WriteBurst = FMC\_WriteBurst\_Enable
- CLKDivision = 1
- DataLatency = 1 for NOR flash; DataLatency = 0 for PSRAM

In all the timing tables, the  $T_{fmc\_ker\_ck}$  is the `fmc_ker_ck` clock period, with the following FMC\_CLK maximum values:

- For  $2.7\text{ V} < V_{DD} < 3.6\text{ V}$ , FMC\_CLK = 130 MHz at 20 pF
- For  $1.71\text{ V} < V_{DD} < 1.9\text{ V}$ , FMC\_CLK = 78 MHz at 20 pF

**Figure 28. Synchronous multiplexed NOR/PSRAM read timings**

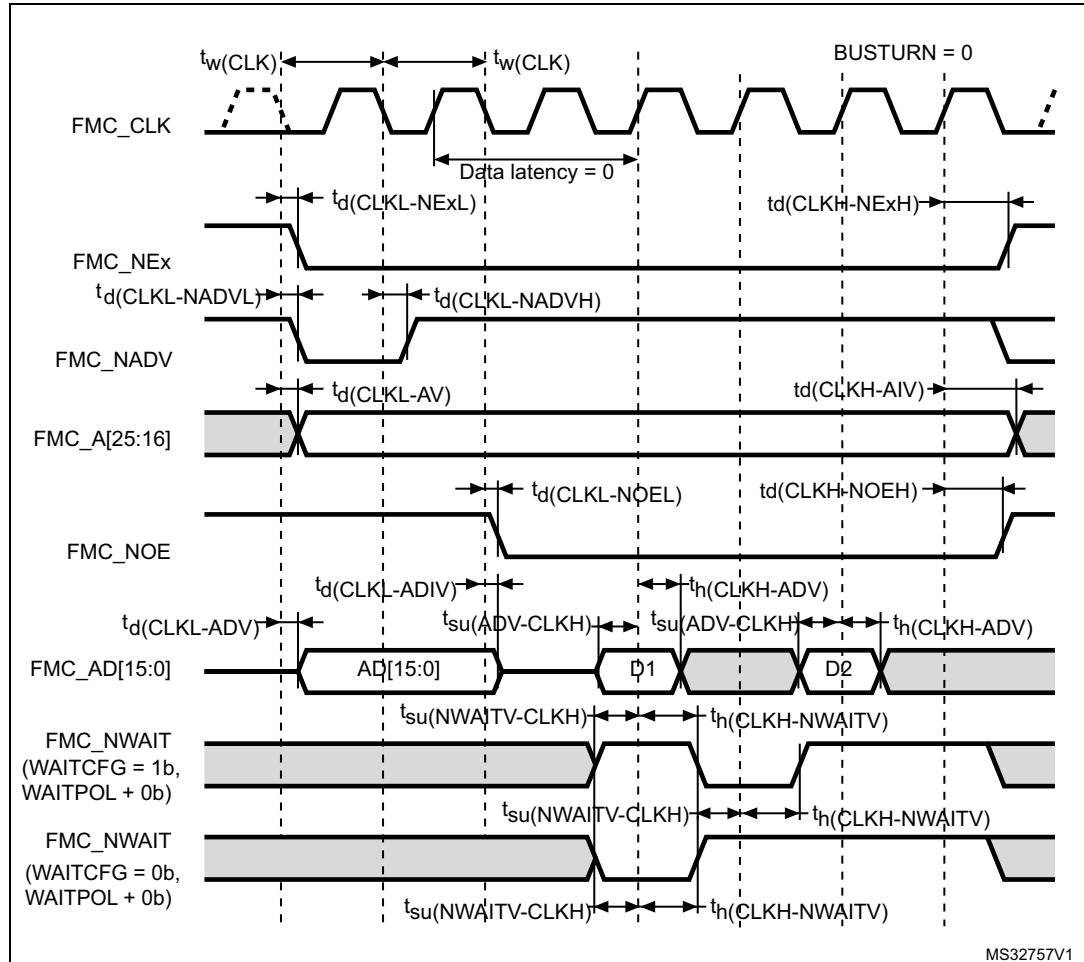




Table 70. Synchronous multiplexed NOR/PSRAM read timings<sup>(1)</sup>

| Symbol                  | Parameter                                     | Min                                         | Max | Unit |
|-------------------------|-----------------------------------------------|---------------------------------------------|-----|------|
| $t_{w(CLK)}$            | FMC_CLK period                                | $R \times T_{fmc\_ker\_ck} - 1^{(2)}$       | -   | ns   |
| $t_{d(CLK\_L-NExL)}$    | FMC_CLK low to FMC_NEx low ( $x=0..2$ )       | -                                           | 1   |      |
| $t_{d(CLK\_H-NExH)}$    | FMC_CLK high to FMC_NEx high ( $x=0..2$ )     | $R \times T_{fmc\_ker\_ck} / 2 + 0.5^{(2)}$ | -   |      |
| $t_{d(CLK\_L-NADV\_L)}$ | FMC_CLK low to FMC_NADV low                   | -                                           | 1   |      |
| $t_{d(CLK\_L-NADV\_H)}$ | FMC_CLK low to FMC_NADV high                  | 0                                           | -   |      |
| $t_{d(CLK\_L-AV)}$      | FMC_CLK low to FMC_Ax valid ( $x=16..25$ )    | -                                           | 1   |      |
| $t_{d(CLK\_H-AIV)}$     | FMC_CLK high to FMC_Ax invalid ( $x=16..25$ ) | $R \times T_{fmc\_ker\_ck} / 2 + 1.5^{(2)}$ | -   |      |
| $t_{d(CLK\_L-NOE\_L)}$  | FMC_CLK low to FMC_NOE low                    | -                                           | 2   |      |
| $t_{d(CLK\_H-NOE\_H)}$  | FMC_CLK high to FMC_NOE high                  | $R \times T_{fmc\_ker\_ck} / 2^{(2)}$       | -   |      |
| $t_{d(CLK\_L-ADV)}$     | FMC_CLK low to FMC_AD[15:0] valid             | -                                           | 3   |      |
| $t_{d(CLK\_L-ADIV)}$    | FMC_CLK low to FMC_AD[15:0] invalid           | 1                                           | -   |      |
| $t_{su(ADV-CLKH)}$      | FMC_A/D[15:0] valid data before FMC_CLK high  | 3                                           | -   |      |
| $t_h(CLKH-ADV)$         | FMC_A/D[15:0] valid data after FMC_CLK high   | 1                                           | -   |      |
| $t_{su(NWAIT-CLKH)}$    | FMC_NWAIT valid before FMC_CLK high           | 3                                           | -   |      |
| $t_h(CLKH-NWAIT)$       | FMC_NWAIT valid after FMC_CLK high            | 1.5                                         | -   |      |

1. Evaluated by characterization, not tested in production.

2. Clock ratio  $R = (FMC\_CLK \text{ period} / fmc\_ker\_ck \text{ period})$ .

Figure 29. Synchronous multiplexed PSRAM write timings

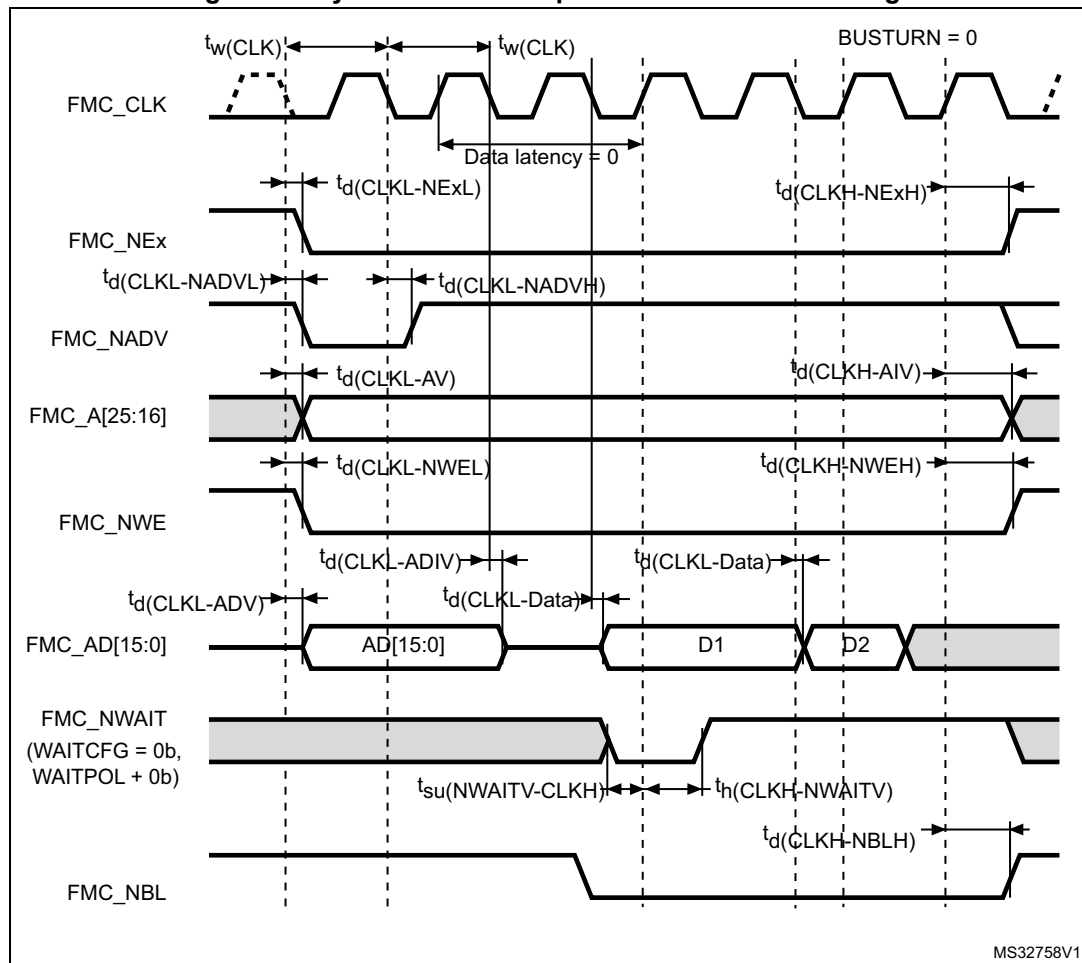


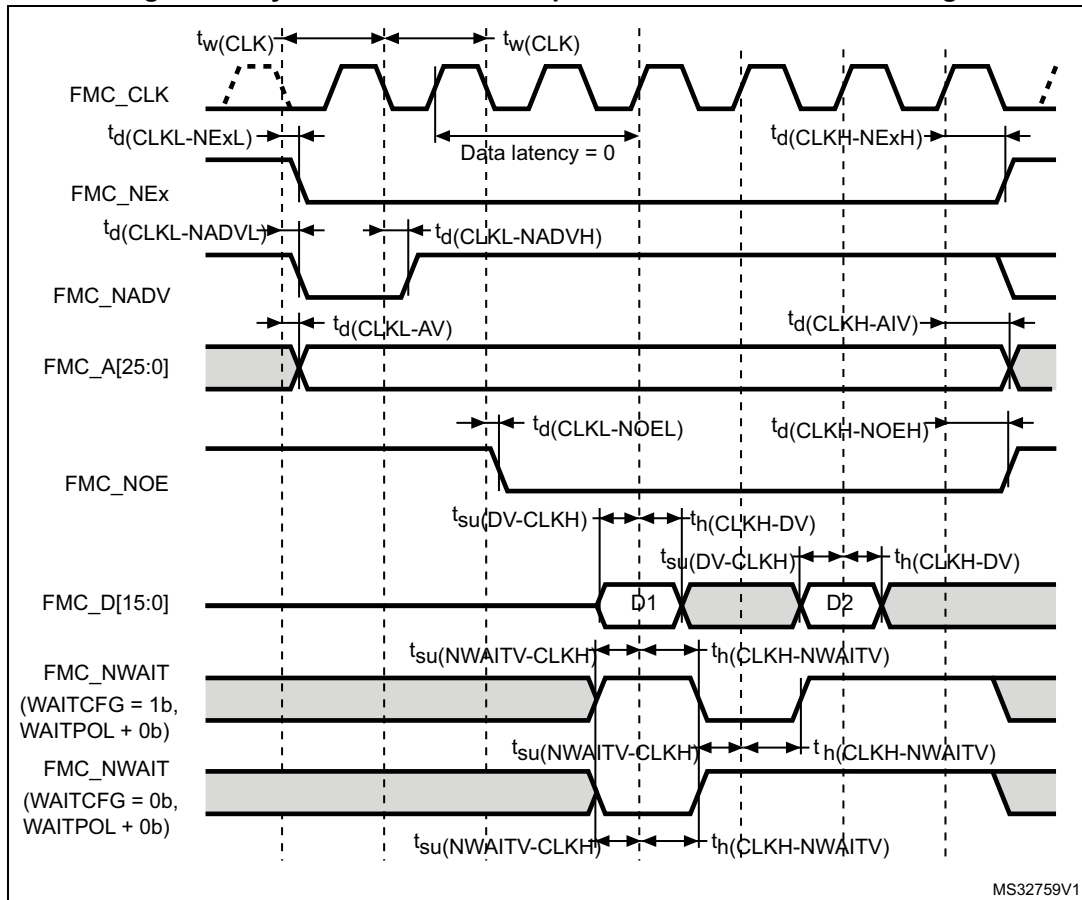
Table 71. Synchronous multiplexed PSRAM write timings<sup>(1)</sup>

| Symbol               | Parameter                                     | Min                                     | Max | Unit |
|----------------------|-----------------------------------------------|-----------------------------------------|-----|------|
| $t_{w(CLK)}$         | FMC_CLK period, $V_{DD}$ range = 2.7 to 3.6 V | $R \times T_{fmc\_ker\_ck}^{-1(2)}$     | -   | ns   |
| $t_{d(CLKL-NExL)}$   | FMC_CLK low to FMC_NEx low ( $x=0..2$ )       | -                                       | 1   |      |
| $t_{d(CLKH-NExH)}$   | FMC_CLK high to FMC_NEx high ( $x=0..2$ )     | $R \times T_{fmc\_ker\_ck}/2+0.5^{(2)}$ | -   |      |
| $t_{d(CLKL-NADV L)}$ | FMC_CLK low to FMC_NADV low                   | -                                       | 1.5 |      |
| $t_{d(CLKL-NADV H)}$ | FMC_CLK low to FMC_NADV high                  | 1                                       | -   |      |
| $t_{d(CLKL-AV)}$     | FMC_CLK low to FMC_Ax valid ( $x=16..25$ )    | -                                       | 1   |      |
| $t_{d(CLKH-AIV)}$    | FMC_CLK high to FMC_Ax invalid ( $x=16..25$ ) | $R \times T_{fmc\_ker\_ck}/2+1.5^{(2)}$ | -   |      |
| $t_{d(CLKL-NWEL)}$   | FMC_CLK low to FMC_NWE low                    | -                                       | 1   |      |
| $t_{d(CLKH-NWEH)}$   | FMC_CLK high to FMC_NWE high                  | $R \times T_{fmc\_ker\_ck}/2+0.5^{(2)}$ | -   |      |
| $t_{d(CLKL-ADV)}$    | FMC_CLK low to FMC_AD[15:0] valid             | -                                       | 1.5 |      |
| $t_{d(CLKL-ADIV)}$   | FMC_CLK low to FMC_AD[15:0] invalid           | 1                                       | -   |      |
| $t_{d(CLKL-DATA)}$   | FMC_A/D[15:0] valid data after FMC_CLK low    | -                                       | 3   |      |
| $t_{d(CLKL-NBLL)}$   | FMC_CLK low to FMC_NBL low                    | 1                                       | -   |      |
| $t_{d(CLKH-NBLH)}$   | FMC_CLK high to FMC_NBL high                  | $R \times T_{fmc\_ker\_ck}/2+0.5^{(2)}$ | -   |      |
| $t_{su(NWAIT-CLKH)}$ | FMC_NWAIT valid before FMC_CLK high           | 3                                       | -   |      |
| $t_h(CLKH-NWAIT)$    | FMC_NWAIT valid after FMC_CLK high            | 1.5                                     | -   |      |

1. Evaluated by characterization, not tested in production.

2. Clock ratio  $R = (FMC\_CLK \text{ period} / fmc\_ker\_ck \text{ period})$ .

Figure 30. Synchronous non-multiplexed NOR/PSRAM read timings

Table 72. Synchronous non-multiplexed NOR/PSRAM read timings<sup>(1)</sup>

| Symbol                              | Parameter                                     | Min                                            | Max | Unit |
|-------------------------------------|-----------------------------------------------|------------------------------------------------|-----|------|
| $t_w(\text{CLK})$                   | FMC_CLK period                                | $R \times T_{\text{fmc\_ker\_ck}}^{-1(2)}$     | -   | ns   |
| $t_{\text{d}}(\text{CLKL-NExL})$    | FMC_CLK low to FMC_NEx low ( $x=0..2$ )       | -                                              | 1   |      |
| $t_{\text{d}}(\text{CLKH-NExH})$    | FMC_CLK high to FMC_NEx high ( $x=0..2$ )     | $R \times T_{\text{fmc\_ker\_ck}}/2+0.5^{(2)}$ | -   |      |
| $t_{\text{d}}(\text{CLKL-NADV})$    | FMC_CLK low to FMC_NADV low                   | -                                              | 1.5 |      |
| $t_{\text{d}}(\text{CLKL-NADVH})$   | FMC_CLK low to FMC_NADV high                  | 1                                              | -   |      |
| $t_{\text{d}}(\text{CLKL-AV})$      | FMC_CLK low to FMC_Ax valid ( $x=16..25$ )    | -                                              | 1   |      |
| $t_{\text{d}}(\text{CLKH-AIV})$     | FMC_CLK high to FMC_Ax invalid ( $x=16..25$ ) | $R \times T_{\text{fmc\_ker\_ck}}/2+1.5^{(2)}$ | -   |      |
| $t_{\text{d}}(\text{CLKL-NOEL})$    | FMC_CLK low to FMC_NOE low                    | -                                              | 2   |      |
| $t_{\text{d}}(\text{CLKH-NOEH})$    | FMC_CLK high to FMC_NOE high                  | $R \times T_{\text{fmc\_ker\_ck}}/2+1.5^{(2)}$ | -   |      |
| $t_{\text{su}}(\text{DV-CLKH})$     | FMC_D[15:0] valid data before FMC_CLK high    | 3                                              | -   |      |
| $t_{\text{h}}(\text{CLKH-DV})$      | FMC_D[15:0] valid data after FMC_CLK high     | 1                                              | -   |      |
| $t_{\text{su}}(\text{NWAITV-CLKH})$ | FMC_NWAIT valid before FMC_CLK high           | 3                                              | -   |      |
| $t_{\text{h}}(\text{CLKH-NWAITV})$  | FMC_NWAIT valid after FMC_CLK high            | 1.5                                            | -   |      |

1. Evaluated by characterization, not tested in production.

2. Clock ratio  $R = (\text{FMC\_CLK period} / \text{fmc\_ker\_ck period})$ .

**Figure 31. Synchronous non-multiplexed PSRAM write timings**

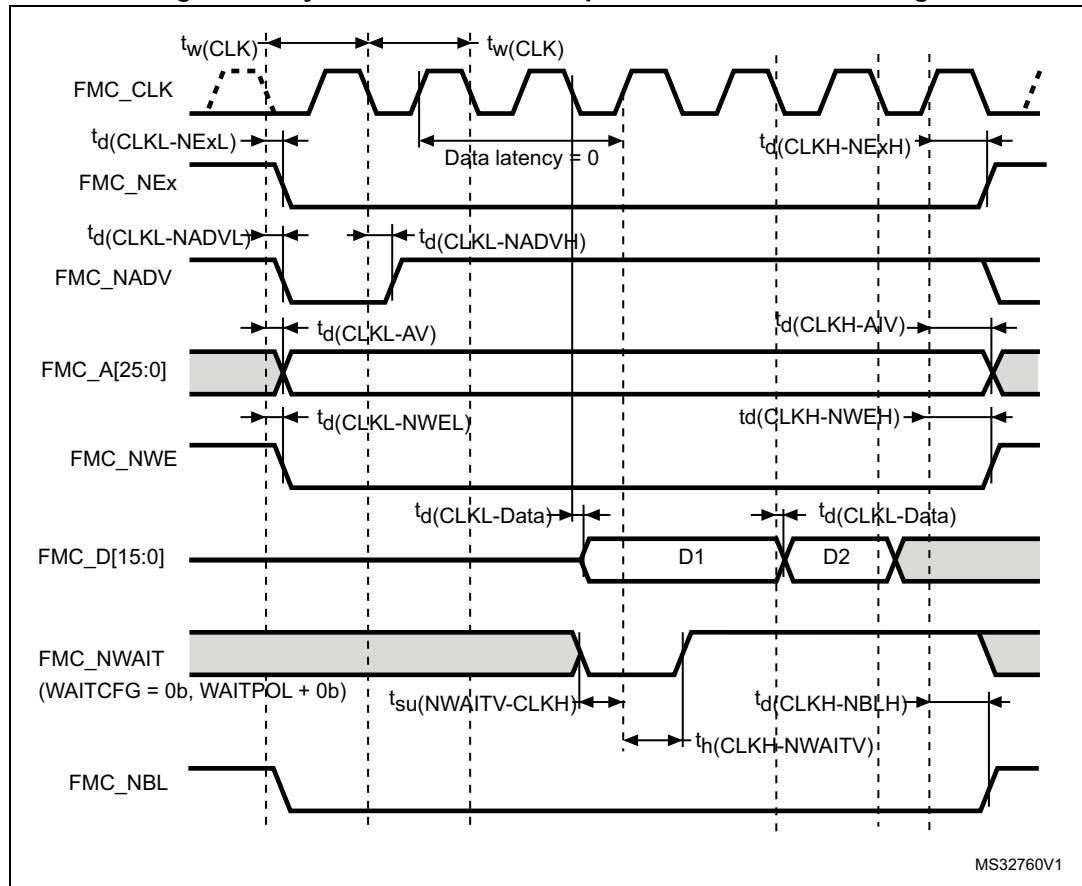


Table 73. Synchronous non-multiplexed PSRAM write timings<sup>(1)</sup>

| Symbol               | Parameter                                     | Min                                         | Max | Unit |
|----------------------|-----------------------------------------------|---------------------------------------------|-----|------|
| $t_{(CLK)}$          | FMC_CLK period                                | $R \times T_{fmc\_ker\_ck} - 1^{(2)}$       | -   | ns   |
| $t_{d(CLKL-NExL)}$   | FMC_CLK low to FMC_NEx low ( $x=0..2$ )       | -                                           | 1   |      |
| $t_{(CLKH-NExH)}$    | FMC_CLK high to FMC_NEx high ( $x=0..2$ )     | $R \times T_{fmc\_ker\_ck} / 2 + 0.5^{(2)}$ | -   |      |
| $t_{d(CLKL-NADV_L)}$ | FMC_CLK low to FMC_NADV low                   | -                                           | 1.5 |      |
| $t_{d(CLKL-NADV_H)}$ | FMC_CLK low to FMC_NADV high                  | 1                                           | -   |      |
| $t_{d(CLKL-AV)}$     | FMC_CLK low to FMC_Ax valid ( $x=16..25$ )    | -                                           | 1   |      |
| $t_{d(CLKH-AIV)}$    | FMC_CLK high to FMC_Ax invalid ( $x=16..25$ ) | $R \times T_{fmc\_ker\_ck} / 2 + 1.5^{(2)}$ | -   |      |
| $t_{d(CLKL-NWEL)}$   | FMC_CLK low to FMC_NWE low                    | -                                           | 1   |      |
| $t_{d(CLKH-NWEH)}$   | FMC_CLK high to FMC_NWE high                  | $R \times T_{fmc\_ker\_ck} / 2 + 0.5^{(2)}$ | -   |      |
| $t_{d(CLKL-Data)}$   | FMC_D[15:0] valid data after FMC_CLK low      | -                                           | 3   |      |
| $t_{d(CLKL-NBL_L)}$  | FMC_CLK low to FMC_NBL low                    | 1                                           | -   |      |
| $t_{d(CLKH-NBL_H)}$  | FMC_CLK high to FMC_NBL high                  | $R \times T_{fmc\_ker\_ck} / 2 + 0.5^{(2)}$ | -   |      |
| $t_{su(NWAIT-CLKH)}$ | FMC_NWAIT valid before FMC_CLK high           | 3                                           | -   |      |
| $t_h(CLKH-NWAIT)$    | FMC_NWAIT valid after FMC_CLK high            | 1.5                                         | -   |      |

1. Evaluated by characterization, not tested in production.

2. Clock ratio  $R = (FMC\_CLK \text{ period} / fmc\_ker\_ck \text{ period})$ .

### NAND controller waveforms and timings

Figure 32 through Figure 35 represent synchronous waveforms, and Table 74 and Table 75 provide the corresponding timings. The results shown in this table are obtained with the following FMC configuration:

- FMC\_SetupTime = 0x01
- FMC\_WaitSetupTime = 0x03
- FMC\_HoldSetupTime = 0x02
- FMC\_HiZSetupTime = 0x01
- Bank = FMC\_Bank\_NAND
- MemoryDataWidth = FMC\_MemoryDataWidth\_16b
- ECC = FMC\_ECC\_Enable
- ECCPageSize = FMC\_ECCPageSize\_512Bytes
- TCLRSetupTime = 0
- TARSetupTime = 0
- $C_L = 30 \text{ pF}$

In all timing tables, the  $T_{fmc\_ker\_ck}$  is the  $fmc\_ker\_ck$  clock period.

Figure 32. NAND controller waveforms for read access

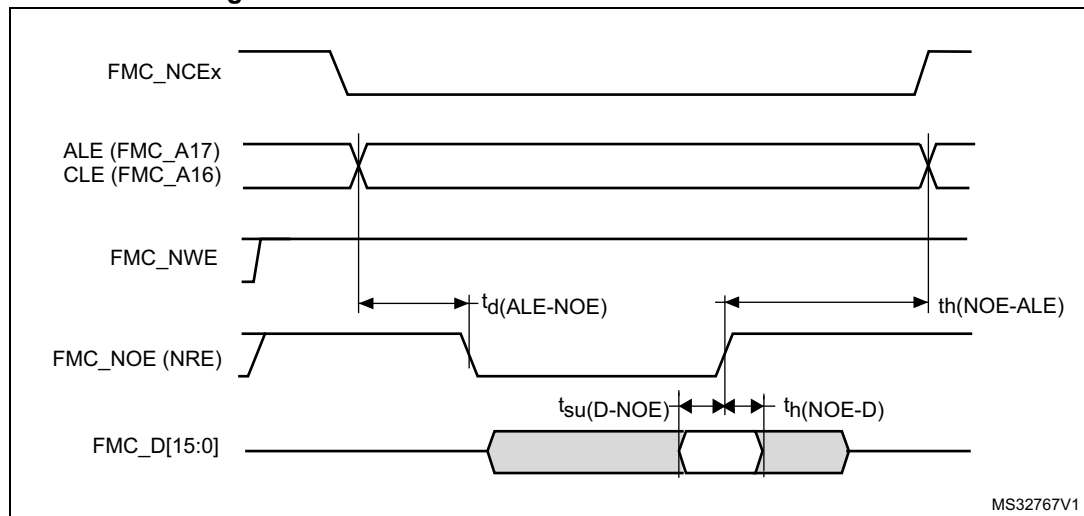


Figure 33. NAND controller waveforms for write access

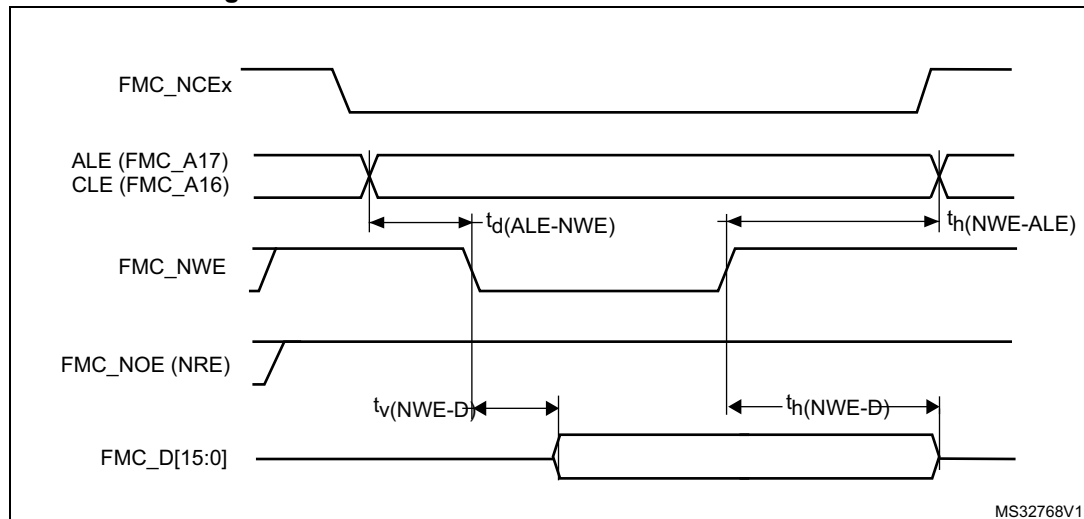


Figure 34. NAND controller waveforms for common memory read access

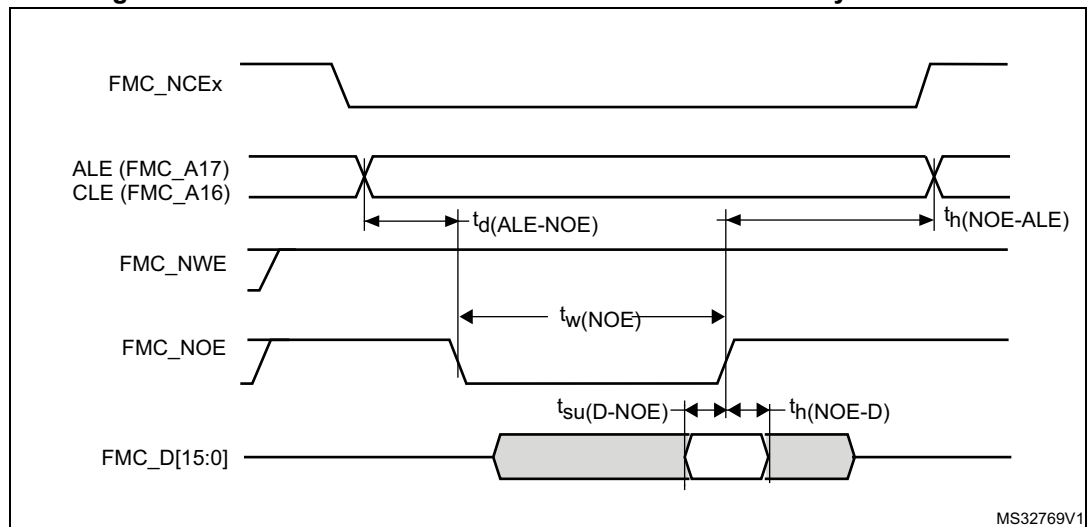
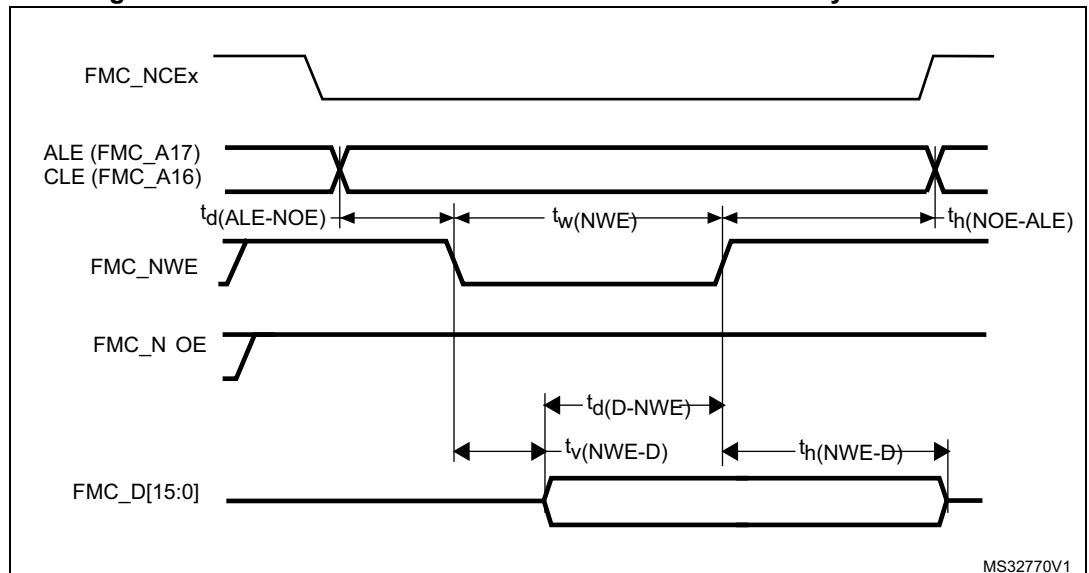


Figure 35. NAND controller waveforms for common memory write access

Table 74. Switching characteristics for NAND flash read cycles<sup>(1)</sup>

| Symbol                        | Parameter                                  | Min                            | Max                          | Unit |
|-------------------------------|--------------------------------------------|--------------------------------|------------------------------|------|
| $t_w(\text{NOE})$             | FMC_NOE low width                          | $4T_{\text{fmc\_ker\_ck}}-1$   | $4T_{\text{fmc\_ker\_ck}}+1$ | ns   |
| $t_{\text{su}}(\text{D-NOE})$ | FMC_D[15:0] valid data before FMC_NOE high | 11                             | -                            |      |
| $t_h(\text{NOE-D})$           | FMC_D[15:0] valid data after FMC_NOE high  | 0                              | -                            |      |
| $t_d(\text{ALE-NOE})$         | FMC_ALE valid before FMC_NOE low           | -                              | $2T_{\text{fmc\_ker\_ck}}+1$ |      |
| $t_h(\text{NOE-ALE})$         | FMC_NWE high to FMC_ALE invalid            | $3T_{\text{fmc\_ker\_ck}}+0.5$ | -                            |      |

1. Evaluated by characterization, not tested in production.



**Table 75. Switching characteristics for NAND flash write cycles<sup>(1)</sup>**

| Symbol           | Parameter                             | Min                     | Max                   | Unit |
|------------------|---------------------------------------|-------------------------|-----------------------|------|
| $t_{w(NWE)}$     | FMC_NWE low width                     | $4T_{fmc\_ker\_ck}-1$   | $4T_{fmc\_ker\_ck}+1$ | ns   |
| $t_{v(NWE-D)}$   | FMC_NWE low to FMC_D[15-0] valid      | 0                       | -                     |      |
| $t_{h(NWE-D)}$   | FMC_NWE high to FMC_D[15-0] invalid   | $3T_{fmc\_ker\_ck}$     | -                     |      |
| $t_{d(D-NWE)}$   | FMC_D[15-0] valid before FMC_NWE high | $4T_{fmc\_ker\_ck}-3.5$ | -                     |      |
| $t_{d(ALE-NWE)}$ | FMC_ALE valid before FMC_NWE low      | -                       | $2T_{fmc\_ker\_ck}+1$ |      |
| $t_{h(NWE-ALE)}$ | FMC_NWE high to FMC_ALE invalid       | $3T_{fmc\_ker\_ck}+0.5$ | -                     |      |

1. Evaluated by characterization, not tested in production.

### 6.3.20 QUADSPI interface characteristics

Unless otherwise specified, the parameters given in [Table 76](#) and [Table 77](#) for QUADSPI are derived from tests performed under the ambient temperature,  $F_{axiss\_ck}$  frequency and  $V_{DD}$  supply voltage conditions summarized in [Table 13: General operating conditions](#), with the following configuration:

- Output speed is set to OSPEEDRy[1:0] = 11
- Measurement points are done at CMOS levels:  $0.5 \times V_{DD}$
- I/O compensation cell enabled
- HSLV activated when  $V_{DD} \leq 2.7$  V

Refer to [Section 6.3.17: I/O port characteristics](#) for more details on the input/output alternate function characteristics.

**Table 76. QUADSPI characteristics in SDR mode**

| Symbol           | Parameter                       | Conditions                                                        | Min                 | Typ | Max                 | Unit |
|------------------|---------------------------------|-------------------------------------------------------------------|---------------------|-----|---------------------|------|
| $F_{ck1/t(CLK)}$ | QUADSPI clock frequency         | $2.7\text{ V} \leq V_{DD} < 3.6\text{ V}$<br>$C_L = 20\text{ pF}$ | -                   | -   | 166                 | MHz  |
|                  |                                 | $1.71\text{ V} < V_{DD} < 3.6\text{ V}$<br>$C_L = 15\text{ pF}$   | -                   | -   | 90                  |      |
| $t_{w(CLKH)}$    | QUADSPI clock high and low time | -                                                                 | $t_{(CLK)}/2 - 0.5$ | -   | $t_{(CLK)}/2 + 0.5$ | ns   |
| $t_{w(CLKL)}$    |                                 |                                                                   | $t_{(CLK)}/2 - 0.5$ | -   | $t_{(CLK)}/2 + 0.5$ |      |
| $t_{s(IN)}$      | Data input setup time           | -                                                                 | 2.5                 | -   | -                   |      |
| $t_{h(IN)}$      | Data input hold time            | -                                                                 | 1.5                 | -   | -                   |      |
| $t_{v(OUT)}$     | Data output valid time          | -                                                                 | -                   | 1   | 1.5                 |      |
| $t_{h(OUT)}$     | Data output hold time           | -                                                                 | 0                   | -   | -                   |      |

Table 77. QUADSPI characteristics in DDR mode

| Symbol                     | Parameter                       | Conditions                                          | Min                 | Typ               | Max                 | Unit |
|----------------------------|---------------------------------|-----------------------------------------------------|---------------------|-------------------|---------------------|------|
| $F_{ck1/t(CLK)}$           | QUADSPI clock frequency         | $2.7\text{ V} < V_{DD} < 3.6\text{ V}$<br>CL=20 pF  | -                   | -                 | 90                  | MHz  |
|                            |                                 | $1.71\text{ V} < V_{DD} < 3.6\text{ V}$<br>CL=15 pF | -                   | -                 | 90                  |      |
| $t_{w(CLKH)}$              | QUADSPI clock high and low time | -                                                   | $t_{(CLK)}/2 - 0.5$ | -                 | $t_{(CLK)}/2 + 0.5$ | ns   |
| $t_{w(CLKL)}$              |                                 | -                                                   | $t_{(CLK)}/2 - 0.5$ | -                 | $t_{(CLK)}/2 + 0.5$ |      |
| $t_{sr(IN)}, t_{sf(IN)}$   | Data input setup time           | -                                                   | 2                   | -                 | -                   |      |
| $t_{hr(IN)}, t_{hf(IN)}$   | Data input hold time            | -                                                   | 1.5                 | -                 | -                   |      |
| $t_{vr(OUT)}, t_{vf(OUT)}$ | Data output valid time          | DHHC = 0                                            | -                   | 1                 | 1.5                 |      |
|                            |                                 | DHHC = 1<br>Pres = 1, 2...                          | -                   | $t_{(CLK)}/4 + 1$ | $t_{(CLK)}/4 + 1.5$ |      |
| $t_{hr(OUT)}, t_{hf(OUT)}$ | Data output hold time           | DHHC = 0                                            | 0                   | -                 | -                   |      |
|                            |                                 | DHHC = 1<br>Pres = 1, 2...                          | $t_{(CLK)}/4$       | -                 | -                   |      |

Figure 36. QUADSPI timing diagram - SDR mode

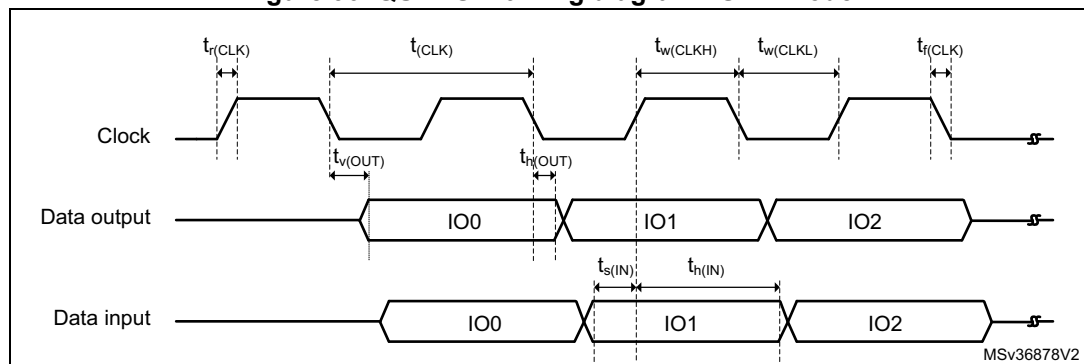
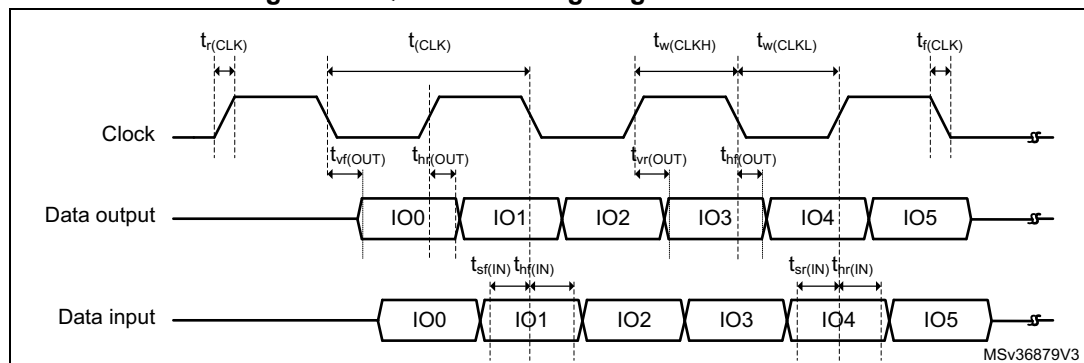


Figure 37. QUADSPI timing diagram - DDR mode



### 6.3.21 Delay block (DLYB) characteristics

Unless otherwise specified, the parameters given in [Table 78](#) for the delay block are derived from tests performed under the ambient temperature,  $f_{\text{rcc\_c\_ck}}$  frequency and  $V_{\text{DD}}$  supply voltage summarized in [Table 13: General operating conditions](#).

**Table 78. Dynamics characteristics: Delay block characteristics**

| Symbol            | Parameter     | Conditions | Min | Typ | Max | Unit |
|-------------------|---------------|------------|-----|-----|-----|------|
| $t_{\text{init}}$ | Initial delay | -          | 350 | 500 | 800 | ps   |
| $t_{\Delta}$      | Unit Delay    | -          | 37  | 40  | 43  |      |

### 6.3.22 12-bit ADC characteristics

Unless otherwise specified, the parameters given in [Table 79](#), [Table 80](#) and [Table 81](#) are derived from tests performed under the ambient temperature and  $V_{\text{DDA}}$  supply voltage conditions summarized in [Table 13: General operating conditions](#). In [Table 79](#), [Table 80](#) and [Table 81](#),  $f_{\text{ADC}}$  refers to  $f_{\text{adc\_ker\_ck}}$ .

*Note:* When both ADCs are used, the kernel clock should be the same for both ADCs and the embedded ADC prescalers cannot be used.

Table 79. 12-bit ADC characteristics<sup>(1)(2)</sup>

| Symbol            | Parameter                                  | Conditions                                                            |                                |                                                                               | Min              | Typ | Max              | Unit |
|-------------------|--------------------------------------------|-----------------------------------------------------------------------|--------------------------------|-------------------------------------------------------------------------------|------------------|-----|------------------|------|
| V <sub>DDA</sub>  | Analog power supply for ADC ON             | -                                                                     |                                |                                                                               | 1.62             | -   | 3.6              | V    |
| V <sub>REF+</sub> | Positive reference voltage                 | V <sub>DDA</sub> ≥ V <sub>REF+</sub>                                  |                                |                                                                               | 1.62             | -   | V <sub>DDA</sub> |      |
| V <sub>REF-</sub> | Negative reference voltage                 | -                                                                     |                                |                                                                               | V <sub>SSA</sub> | -   | -                |      |
| f <sub>ADC</sub>  | ADC clock frequency                        | 1,62 V ≤ V <sub>DDA</sub> ≤ 3.6 V                                     |                                |                                                                               | 1.5              | -   | 75               | MHz  |
| f <sub>s</sub>    | Sampling rate for fast channels (VIN[0:5]) | Resolution = 12 bits<br>-40 °C ≤ T <sub>J</sub> ≤ 125 °C<br>SMP = 2.5 | Continuous mode <sup>(3)</sup> | 1.8 V ≤ V <sub>DDA</sub> ≤ 3.6 V<br>f <sub>ADC</sub> = 75 MHz                 | -                | -   | 5.00             | MSPS |
|                   |                                            |                                                                       |                                | 1.62 V ≤ V <sub>DDA</sub> ≤ 3.6 V<br>f <sub>ADC</sub> = 70 MHz                | -                | -   | 4.66             |      |
|                   |                                            |                                                                       | Single or Discontinuous mode   | 2.4 V ≤ V <sub>DDA</sub> ≤ 3.6 V<br>f <sub>ADC</sub> = 60 MHz <sup>(4)</sup>  | -                | -   | 4.00             |      |
|                   |                                            |                                                                       |                                | 1.62 V ≤ V <sub>DDA</sub> ≤ 3.6 V<br>f <sub>ADC</sub> = 50 MHz <sup>(4)</sup> | -                | -   | 3.33             |      |
|                   |                                            | Resolution = 10 bits<br>-40 °C ≤ T <sub>J</sub> ≤ 125 °C<br>SMP = 2.5 | Continuous mode <sup>(3)</sup> | 1.62 V ≤ V <sub>DDA</sub> ≤ 3.6 V<br>f <sub>ADC</sub> = 75 MHz                | -                | -   | 5.77             |      |
|                   |                                            |                                                                       | Single or Discontinuous mode   | 2.4 V ≤ V <sub>DDA</sub> ≤ 3.6 V<br>f <sub>ADC</sub> = 75 MHz <sup>(4)</sup>  | -                | -   | 5.77             |      |
|                   |                                            |                                                                       |                                | 1.62 V ≤ V <sub>DDA</sub> ≤ 3.6 V<br>f <sub>ADC</sub> = 65 MHz <sup>(4)</sup> | -                | -   | 5.00             |      |
|                   |                                            | Resolution = 8 bits<br>-40 °C ≤ T <sub>J</sub> ≤ 125 °C<br>SMP = 2.5  | All modes <sup>(3)</sup>       | 1.62 V ≤ V <sub>DDA</sub> ≤ 3.6 V<br>f <sub>ADC</sub> = 75 MHz                | -                | -   | 6.82             |      |
|                   |                                            | Resolution = 6 bits<br>-40 °C ≤ T <sub>J</sub> ≤ 125 °C<br>SMP = 2.5  | All modes <sup>(3)</sup>       | 1.62 V ≤ V <sub>DDA</sub> ≤ 3.6 V<br>f <sub>ADC</sub> = 75 MHz                | -                | -   | 8.33             |      |
|                   |                                            |                                                                       |                                |                                                                               |                  |     |                  |      |

**Table 79. 12-bit ADC characteristics<sup>(1)(2)</sup> (continued)**

| Symbol                                         | Parameter                          | Conditions                                                            |   | Min                                      | Typ                 | Max                      | Unit                     |      |
|------------------------------------------------|------------------------------------|-----------------------------------------------------------------------|---|------------------------------------------|---------------------|--------------------------|--------------------------|------|
| f <sub>S</sub>                                 | Sampling rate for slow channels    | Resolution = 12 bits<br>–40 °C ≤ T <sub>J</sub> ≤ 125 °C<br>SMP = 2.5 | - | f <sub>ADC</sub> = 35 MHz <sup>(4)</sup> | -                   | -                        | 2.3                      | MSPS |
|                                                |                                    | Resolution = 10 bits<br>–40 °C ≤ T <sub>J</sub> ≤ 125 °C<br>SMP = 2.5 |   |                                          | -                   | -                        | 2.7                      |      |
|                                                |                                    | Resolution = 8 bits<br>–40 °C ≤ T <sub>J</sub> ≤ 125 °C<br>SMP = 2.5  |   | f <sub>ADC</sub> = 50 MHz <sup>(4)</sup> | -                   | -                        | 4.5                      |      |
|                                                |                                    | Resolution = 6 bits<br>–40 °C ≤ T <sub>J</sub> ≤ 125 °C<br>SMP = 2.5  |   |                                          | -                   | -                        | 5.5                      |      |
| t <sub>TRIG</sub>                              | External trigger period            | Resolution = 12 bits                                                  |   | -                                        | -                   | 15                       | 1/f <sub>ADC</sub>       |      |
| V <sub>AIN</sub>                               | Conversion voltage range           | -                                                                     |   | 0                                        | -                   | V <sub>REF+</sub>        | V                        |      |
| V <sub>CMIV</sub>                              | Common mode input voltage          | Differential mode                                                     |   | V <sub>REF</sub> /2– 10%                 | V <sub>REF</sub> /2 | V <sub>REF</sub> /2+ 10% |                          |      |
| R <sub>AIN</sub> <sup>(5)</sup>                | External input impedance           | Resolution = 12 bits, T <sub>J</sub> = 125 °C                         |   | -                                        | -                   | 220                      | Ω                        |      |
|                                                |                                    | Resolution = 10 bits, T <sub>J</sub> = 125 °C                         |   | -                                        | -                   | 2100                     |                          |      |
|                                                |                                    | Resolution = 8 bits, T <sub>J</sub> = 125 °C                          |   | -                                        | -                   | 12000                    |                          |      |
|                                                |                                    | Resolution = 6 bits, T <sub>J</sub> = 125 °C                          |   | -                                        | -                   | 80000                    |                          |      |
| C <sub>ADC</sub>                               | Internal sample and hold capacitor | -                                                                     |   | -                                        | 3                   | -                        | pF                       |      |
| t <sub>ADC</sub><br>V <sub>REG</sub> _<br>STUP | ADC LDO startup time               | -                                                                     |   | -                                        | 5                   | 10                       | μs                       |      |
| t <sub>STAB</sub>                              | ADC power-up time                  | LDO already started                                                   |   | 1                                        | -                   | -                        | con-<br>version<br>cycle |      |

Table 79. 12-bit ADC characteristics<sup>(1)(2)</sup> (continued)

| Symbol                       | Parameter                                                                                         | Conditions                   | Min                      | Typ | Max   | Unit               |
|------------------------------|---------------------------------------------------------------------------------------------------|------------------------------|--------------------------|-----|-------|--------------------|
| t <sub>OFF_CAL</sub>         | Offset calibration time                                                                           | -                            | 135                      |     |       | 1/f <sub>ADC</sub> |
| t <sub>LATR</sub>            | Trigger conversion latency for regular and injected channels without aborting the conversion      | CKMODE = 00                  | 1.5                      | 2   | 2.5   |                    |
|                              |                                                                                                   | CKMODE = 01                  | -                        | -   | 2.5   |                    |
|                              |                                                                                                   | CKMODE = 10                  | -                        | -   | 2.5   |                    |
|                              |                                                                                                   | CKMODE = 11                  | -                        | -   | 2.25  |                    |
| t <sub>LATR_INJ</sub>        | Trigger conversion latency for regular and injected channels when a regular conversion is aborted | CKMODE = 00                  | 2.5                      | 3   | 3.5   |                    |
|                              |                                                                                                   | CKMODE = 01                  | -                        | -   | 3.5   |                    |
|                              |                                                                                                   | CKMODE = 10                  | -                        | -   | 3.5   |                    |
|                              |                                                                                                   | CKMODE = 11                  | -                        | -   | 3.25  |                    |
| t <sub>S</sub>               | Sampling time <sup>(6)</sup>                                                                      | -                            | 2.5                      | -   | 640.5 |                    |
| t <sub>CONV</sub>            | Total conversion time (including sampling time)                                                   | N-bits resolution            | t <sub>S</sub> + 0.5 + N | -   | -     |                    |
| I <sub>DDA_D</sub><br>(ADC)  | ADC consumption on V <sub>DDA</sub> and V <sub>REF</sub> , Differential mode                      | f <sub>S</sub> = 5 MSPS      | -                        | 540 | -     | μA                 |
|                              |                                                                                                   | f <sub>S</sub> = 1 MSPS      | -                        | 190 | -     |                    |
|                              |                                                                                                   | f <sub>S</sub> = 0.1 MSPS    | -                        | 49  | -     |                    |
| I <sub>DDA_SE</sub><br>(ADC) | ADC consumption on V <sub>DDA</sub> and V <sub>REF</sub> , Single-ended mode                      | f <sub>S</sub> = 5 MSPS      | -                        | 416 | -     |                    |
|                              |                                                                                                   | f <sub>S</sub> = 1 MSPS      | -                        | 153 | -     |                    |
|                              |                                                                                                   | f <sub>S</sub> = 0.1 MSPS    | -                        | 46  | -     |                    |
| I <sub>DD</sub><br>(ADC)     | ADC consumption on V <sub>DD</sub>                                                                | f <sub>ADC</sub> = 75 MHz    | -                        | 180 | -     | μA                 |
|                              |                                                                                                   | f <sub>ADC</sub> = 50 MHz    | -                        | 135 | -     |                    |
|                              |                                                                                                   | f <sub>ADC</sub> = 25 MHz    | -                        | 90  | -     |                    |
|                              |                                                                                                   | f <sub>ADC</sub> = 12.5 MHz  | -                        | 45  | -     |                    |
|                              |                                                                                                   | f <sub>ADC</sub> = 6.25 MHz  | -                        | 22  | -     |                    |
|                              |                                                                                                   | f <sub>ADC</sub> = 3.125 MHz | -                        | 11  | -     |                    |

1. Specified by design, not tested in production.

2. The voltage booster on ADC switches must be used for  $V_{DDA} < 2.4$  V (embedded I/O switches).
3. The conversion of the first element in the group is excluded.
4.  $f_{ADC}$  value corresponds to the maximum frequency that can be reached considering a 2.5 sampling period. For other SMPy sampling periods, the maximum frequency is  $f_{ADC} \text{ value} * SMPy / 2.5$  with a limitation to 75 MHz.
5. The tolerance is 2 LSBs for 12-bit, 10-bit and 8-bit resolutions. It is otherwise specified.
6. The sampling time can vary depending on the condition with  $\pm 0.5$  clock cycles. Resulting in minimum of 2.0 cycles and maximum of 641 cycles. Refer to the detailed description in the reference manual.



Table 80. Minimum sampling time vs  $R_{AIN}$  (12-bit ADC)<sup>(1)(2)</sup>

| Resolution | $R_{AIN}$ ( $\Omega$ ) | Minimum sampling time (s)    |                              |
|------------|------------------------|------------------------------|------------------------------|
|            |                        | Fast channels <sup>(3)</sup> | Slow channels <sup>(4)</sup> |
| 12 bits    | 47                     | 3.75E-08                     | 6.12E-08                     |
|            | 68                     | 3.94E-08                     | 6.25E-08                     |
|            | 100                    | 4.36E-08                     | 6.51E-08                     |
|            | 150                    | 5.11E-08                     | 7.00E-08                     |
|            | 220                    | 6.54E-08                     | 7.86E-08                     |
|            | 330                    | 8.80E-08                     | 9.57E-08                     |
|            | 470                    | 1.17E-07                     | 1.23E-07                     |
|            | 680                    | 1.60E-07                     | 1.65E-07                     |
| 10 bits    | 47                     | 3.19E-08                     | 5.17E-08                     |
|            | 68                     | 3.35E-08                     | 5.28E-08                     |
|            | 100                    | 3.66E-08                     | 5.45E-08                     |
|            | 150                    | 4.35E-08                     | 5.83E-08                     |
|            | 220                    | 5.43E-08                     | 6.50E-08                     |
|            | 330                    | 7.18E-08                     | 7.89E-08                     |
|            | 470                    | 9.46E-08                     | 1.00E-07                     |
|            | 680                    | 1.28E-07                     | 1.33E-07                     |
|            | 1000                   | 1.81E-07                     | 1.83E-07                     |
|            | 1500                   | 2.63E-07                     | 2.63E-07                     |
|            | 2200                   | 3.79E-07                     | 3.76E-07                     |
|            | 3300                   | 5.57E-07                     | 5.52E-07                     |
| 8 bits     | 47                     | 2.64E-08                     | 4.17E-08                     |
|            | 68                     | 2.76E-08                     | 4.24E-08                     |
|            | 100                    | 3.02E-08                     | 4.39E-08                     |
|            | 150                    | 3.51E-08                     | 4.66E-08                     |
|            | 220                    | 4.27E-08                     | 5.13E-08                     |
|            | 330                    | 5.52E-08                     | 6.19E-08                     |
|            | 470                    | 7.17E-08                     | 7.72E-08                     |
|            | 680                    | 9.68E-08                     | 1.00E-07                     |
|            | 1000                   | 1.34E-07                     | 1.37E-07                     |
|            | 1500                   | 1.93E-07                     | 1.94E-07                     |
|            | 2200                   | 2.76E-07                     | 2.74E-07                     |
|            | 3300                   | 4.06E-07                     | 4.01E-07                     |
|            | 4700                   | 5.73E-07                     | 5.62E-07                     |



Table 80. Minimum sampling time vs  $R_{AIN}$  (12-bit ADC)<sup>(1)(2)</sup> (continued)

| Resolution            | $R_{AIN}$ ( $\Omega$ ) | Minimum sampling time (s)    |                              |
|-----------------------|------------------------|------------------------------|------------------------------|
|                       |                        | Fast channels <sup>(3)</sup> | Slow channels <sup>(4)</sup> |
| 8 bits<br>(continued) | 6800                   | 8.21E-07                     | 7.99E-07                     |
|                       | 10000                  | 1.20E-06                     | 1.17E-06                     |
|                       | 15000                  | 1.79E-06                     | 1.74E-06                     |
| 6 bits                | 47                     | 2.14E-08                     | 3.16E-08                     |
|                       | 68                     | 2.23E-08                     | 3.21E-08                     |
|                       | 100                    | 2.40E-08                     | 3.31E-08                     |
|                       | 150                    | 2.68E-08                     | 3.52E-08                     |
|                       | 220                    | 3.13E-08                     | 3.87E-08                     |
|                       | 330                    | 3.89E-08                     | 4.51E-08                     |
|                       | 470                    | 4.88E-08                     | 5.39E-08                     |
|                       | 680                    | 6.38E-08                     | 6.79E-08                     |
|                       | 1000                   | 8.70E-08                     | 8.97E-08                     |
|                       | 1500                   | 1.23E-07                     | 1.24E-07                     |
|                       | 2200                   | 1.73E-07                     | 1.73E-07                     |
|                       | 3300                   | 2.53E-07                     | 2.49E-07                     |
|                       | 4700                   | 3.53E-07                     | 3.45E-07                     |
|                       | 6800                   | 5.04E-07                     | 4.90E-07                     |
|                       | 10000                  | 7.34E-07                     | 7.11E-07                     |
|                       | 15000                  | 1.09E-06                     | 1.05E-06                     |

1. Specified by design, not tested in production.
2. Data valid up to 130 °C, with a 22 pF PCB capacitor and  $V_{DDA} = 1.62$  V.
3. Fast channels correspond to ADCx\_INx[0:5].
4. Slow channels correspond to all ADC inputs except for the Fast channels.

Table 81. 12-bit ADC accuracy<sup>(1)(2)</sup>

| Symbol | Parameter                            | Conditions            |              | Min | Typ   | Max     | Unit |
|--------|--------------------------------------|-----------------------|--------------|-----|-------|---------|------|
| ET     | Total unadjusted error               | Fast and slow channel | Single ended | -   | ±3.5  | ±12     | ±LSB |
|        |                                      |                       | Differential | -   | ±2.5  | ±5      |      |
| EO     | Offset error                         | Single ended          |              | -   | ±3    | ±5.5    |      |
|        |                                      | Differential          |              | -   | ±2    | ±3.5    |      |
| EG     | Gain error                           | Single ended          |              | -   | ±3.5  | ±11     |      |
|        |                                      | Differential          |              | -   | ±2.5  | ±5      |      |
| ED     | Differential linearity error         | Single ended          |              | -   | ±0.75 | +1.5/-1 |      |
|        |                                      | Differential          |              | -   | ±0.75 | +2.5/-1 |      |
| EL     | Integral linearity error             | Fast and slow channel | Single ended | -   | ±2    | ±4.5    |      |
|        |                                      |                       | Differential | -   | ±1    | ±2      |      |
| ENOB   | Effective number of bits             | Single ended          |              | -   | 10.8  | -       | bits |
|        |                                      | Differential          |              | -   | 11.5  | -       |      |
| SINAD  | Signal-to-noise and distortion ratio | Single ended          |              | -   | 68    | -       | dB   |
|        |                                      | Differential          |              | -   | 71    | -       |      |
| SNR    | Signal-to-noise ratio                | Single ended          |              | -   | 70    | -       |      |
|        |                                      | Differential          |              | -   | 72    | -       |      |
| THD    | Total harmonic distortion            | Single ended          |              | -   | -70   | -       |      |
|        |                                      | Differential          |              | -   | -80   | -       |      |

1. Evaluated by characterization, not tested in production.

2. ADC DC accuracy values are measured after internal calibration in Continuous mode.

## 6.3.23 Voltage reference buffer characteristics

Table 82. VREFBUF characteristics<sup>(1)</sup>

| Symbol                  | Parameter                                    | Conditions                                                                      |                            | Min                                     | Typ   | Max   | Unit       |
|-------------------------|----------------------------------------------|---------------------------------------------------------------------------------|----------------------------|-----------------------------------------|-------|-------|------------|
| V <sub>DDA</sub>        | Analog supply voltage                        | Normal mode                                                                     | VSCALE = 000               | 2.8                                     | 3.3   | 3.6   | V          |
|                         |                                              |                                                                                 | VSCALE = 001               | 2.4                                     | -     | 3.6   |            |
|                         |                                              |                                                                                 | VSCALE = 010               | 2.1                                     | -     | 3.6   |            |
|                         |                                              |                                                                                 | VSCALE = 011               | 1.95                                    | -     | 3.6   |            |
|                         |                                              | Degraded mode <sup>(2)</sup>                                                    | VSCALE = 000               | 1.62                                    | -     | 2.80  |            |
|                         |                                              |                                                                                 | VSCALE = 001               | 1.62                                    | -     | 2.40  |            |
|                         |                                              |                                                                                 | VSCALE = 010               | 1.62                                    | -     | 2.10  |            |
|                         |                                              |                                                                                 | VSCALE = 011               | 1.62                                    | -     | 1.95  |            |
| V <sub>REFBUF_OUT</sub> | Voltage Reference Buffer Output              | Normal mode<br>@30 °C<br>@I <sub>load</sub> = 10 µA<br>V <sub>DDA</sub> = 3.3 V | VSCALE = 000               | 2.497                                   | 2.5   | 2.503 | V          |
|                         |                                              |                                                                                 | VSCALE = 001               | 2.045                                   | 2.048 | 2.051 |            |
|                         |                                              |                                                                                 | VSCALE = 010               | 1.798                                   | 1.8   | 1.802 |            |
|                         |                                              |                                                                                 | VSCALE = 011               | 1.648                                   | 1.65  | 1.652 |            |
|                         |                                              | Degraded mode <sup>(2)</sup>                                                    | VSCALE = 000               | Min<br>(V <sub>DDA</sub> - 0.22, 2.498) | -     | 2.502 |            |
|                         |                                              |                                                                                 | VSCALE = 001               | Min<br>(V <sub>DDA</sub> - 0.22, 2.047) | -     | 2.051 |            |
|                         |                                              |                                                                                 | VSCALE = 010               | Min<br>(V <sub>DDA</sub> - 0.22, 1.800) | -     | 1.807 |            |
|                         |                                              |                                                                                 | VSCALE = 011               | Min<br>(V <sub>DDA</sub> - 0.22, 1.65)  | -     | 1.657 |            |
| TRIM                    | Trim step resolution                         | -                                                                               | -                          | -                                       | ±0.05 | -     | %          |
| C <sub>L</sub>          | Load capacitor                               | -                                                                               | -                          | 0.5                                     | 1     | 1.50  | µF         |
| esr                     | Equivalent Serial Resistor of C <sub>L</sub> | -                                                                               | -                          | -                                       | -     | 2     | Ω          |
| I <sub>load</sub>       | Static load current                          | -                                                                               | -                          | -                                       | -     | 4     | mA         |
| I <sub>line_reg</sub>   | Line regulation                              | 2.8 V ≤ V <sub>DDA</sub> ≤ 3.6 V                                                | I <sub>load</sub> = 500 µA | -                                       | 200   | -     | ppm/V      |
|                         |                                              |                                                                                 | I <sub>load</sub> = 4 mA   | -                                       | 100   | -     |            |
| I <sub>load_reg</sub>   | Load regulation                              | 500 µA ≤ I <sub>LOAD</sub> ≤ 4 mA                                               | Normal Mode                | -                                       | 50    | -     | ppm/<br>mA |

Table 82. VREFBUF characteristics<sup>(1)</sup> (continued)

| Symbol                         | Parameter                                                                              | Conditions                                                         |   | Min | Typ                              | Max  | Unit                    |
|--------------------------------|----------------------------------------------------------------------------------------|--------------------------------------------------------------------|---|-----|----------------------------------|------|-------------------------|
| $T_{\text{coeff}}$             | Temperature coefficient                                                                | $-40\text{ }^{\circ}\text{C} < T_J < +125\text{ }^{\circ}\text{C}$ | - | -   | $T_{\text{coeff\_VREF\_INT}+75}$ | -    | ppm/ $^{\circ}\text{C}$ |
| PSRR                           | Power supply rejection                                                                 | DC                                                                 | - | -   | 60                               | -    | dB                      |
|                                |                                                                                        | 100 kHz                                                            | - | -   | 40                               | -    |                         |
| $t_{\text{START}}$             | Start-up time <sup>(3)</sup>                                                           | $C_L = 0.5\text{ }\mu\text{F}$                                     | - | -   | 300                              | 350  | $\mu\text{s}$           |
|                                |                                                                                        | $C_L = 1\text{ }\mu\text{F}$                                       | - | -   | 500                              | 650  |                         |
|                                |                                                                                        | $C_L = 1.5\text{ }\mu\text{F}$                                     | - | -   | 650                              | 800  |                         |
| $I_{\text{INRUSH}}$            | Control of maximum DC current drive on VREFBUF_OUT during startup phase <sup>(4)</sup> | -                                                                  | - | -   | 8                                | 13.5 | mA                      |
| $I_{\text{DDA(VREFBUF)}}$      | VREFBUF consumption from VDDA                                                          | $I_{\text{LOAD}} = 0\text{ }\mu\text{A}$                           | - | -   | 15                               | 16   | $\mu\text{A}$           |
|                                |                                                                                        | $I_{\text{LOAD}} = 500\text{ }\mu\text{A}$                         | - | -   | 16                               | 21   |                         |
|                                |                                                                                        | $I_{\text{LOAD}} = 4\text{ mA}$                                    | - | -   | 32                               | 41   |                         |
| $R_{\text{VREFBUF\_Pulldown}}$ | Pull-down resistor when ENVR = HIZ = 0                                                 | -                                                                  | - | -   | 100                              | -    | $\Omega$                |

1. Specified by design, not tested in production.

2. In degraded mode, the voltage reference buffer cannot accurately maintain the output voltage ( $V_{\text{DDA}}$ -drop voltage).

3. if VREF+ pin has residual voltage when VREFBUF is enabled (VREFBUF\_CSR.ENVR=1), this might create an overshoot on VREFBUF output longer than  $t_{\text{START}}$ . To avoid this, it is necessary that VREF+ pin is correctly discharged before being enabled (below VREFBUF\_OUT minus 1 V, for example below 1.5 V for VSCALE = 000). This could be achieved by ensuring VREFBUF is in OFF mode (VREFBUF\_CSR.ENVR=0 and VREFBUF\_CSR.HIZ=0) for sufficient time to discharge  $C_L$  through VREFBUF pull-down.

4. To properly control VREFBUF  $I_{\text{INRUSH}}$  current during the startup phase and the change of scaling,  $V_{\text{DDA}}$  voltage should be in the range of 1.95 V-3.6 V, 2.1 V-3.6 V, 2.4 V-3.6 V and 2.8 V-3.6 V for VSCALE = 011, 010, 001 and 000, respectively.

### 6.3.24 Temperature sensor characteristics

Table 83. Temperature sensor characteristics

| Symbol                        | Parameter                                                             | Min | Typ  | Max     | Unit                   |
|-------------------------------|-----------------------------------------------------------------------|-----|------|---------|------------------------|
| $T_L^{(1)}$                   | VSENSE linearity with temperature (from Vsensor voltage)              | -   | -    | $\pm 3$ | $^{\circ}\text{C}$     |
|                               | VSENSE linearity with temperature (from ADC counter)                  | -   | -    | $\pm 3$ |                        |
| Avg_Slope <sup>(2)</sup>      | Average slope (from Vsensor voltage)                                  | -   | 2    | -       | mV/ $^{\circ}\text{C}$ |
|                               | Average slope (from ADC counter)                                      | -   | 2    | -       |                        |
| $V_{30}^{(3)}$                | Voltage at $30\text{ }^{\circ}\text{C} \pm 5\text{ }^{\circ}\text{C}$ | -   | 0.62 | -       | V                      |
| $t_{\text{start\_run}}^{(1)}$ | Startup time in Run mode (buffer startup)                             | 5.3 | -    | 40.5    | $\mu\text{s}$          |
| $t_{\text{S\_temp}}^{(1)}$    | ADC sampling time when reading the temperature                        | 9.8 | -    | -       |                        |

Table 83. Temperature sensor characteristics (continued)

| Symbol              | Parameter                 | Min  | Typ  | Max  | Unit    |
|---------------------|---------------------------|------|------|------|---------|
| $I_{sens}^{(1)}$    | Sensor consumption        | 0.11 | 0.18 | 0.31 | $\mu A$ |
| $I_{sensbuf}^{(1)}$ | Sensor buffer consumption | 2.3  | 3.8  | 6.1  |         |

1. Specified by design, not tested in production.
2. Evaluated by characterization, not tested in production.
3. Measured at  $V_{DDA} = 3.3 V \pm 10 mV$ . The  $V_{30}$  ADC conversion result is stored in the TS\_CAL1 byte.

Table 84. Temperature sensor calibration values

| Symbol  | Parameter                                                                                                          | Memory address                       |
|---------|--------------------------------------------------------------------------------------------------------------------|--------------------------------------|
| TS_CAL1 | TS ADC raw data acquired at temperature of $30^{\circ}C \pm 5^{\circ}C$<br>$V_{DDA} = V_{REF+} = 3.3 V \pm 10 mV$  | 0x5C00 525C[15:0] <sup>(1)(2)</sup>  |
| TS_CAL2 | TS ADC raw data acquired at temperature of $130^{\circ}C \pm 2^{\circ}C$<br>$V_{DDA} = V_{REF+} = 3.3 V \pm 10 mV$ | 0x5C00 525C[31:16] <sup>(1)(2)</sup> |

1. It is mandatory to read a 32-bit word and to do relevant masking and shifting to isolate the required bits.
2. This address is located inside the BSEC and the access is allowed after being enabled in the RCC.

### 6.3.25 DTS characteristics

Table 85. DTS characteristics<sup>(1)</sup>

| Symbol             | Parameter                                                 | Conditions                 | Min | Typ  | Max       | Unit    |
|--------------------|-----------------------------------------------------------|----------------------------|-----|------|-----------|---------|
| $f_{DTS}$          | Output Clock frequency (PTAT clock)                       | -                          | -   | 500  | -         | kHz     |
| $T_{SLOPE}$        | Average slope                                             | -                          | -   | 1600 | -         | Hz/°C   |
| $T_L$              | Linearity with temperature (from Output clock frequency). | $V_{DDCORE} = 1.25 V$      | -   | -    | $\pm 3.8$ | °C      |
| $T_{TOTAL\_ERROR}$ | Temperature measurement error                             | Temperature: -40 to 125 °C | -5  | -    | +5        | °C      |
| $T_{VDD\_CORE}$    | Additional error due to $V_{DDCORE}$ variation            | -                          | -   | 10   | -         | °C/V    |
| $t_{TRIM}$         | Calibration time                                          | -                          | 2   | -    | -         | ms      |
| $t_{WAKE\_UP}$     | Wake-up time from off state until DTS ready signal = 1    | -                          | -   | 50   | -         | $\mu s$ |
| $I_{DDCORE\_DTS}$  | DTS consumption on $V_{DDCORE}$                           | -                          | -   | 20   | -         | $\mu A$ |

1. Specified by design, not tested in production.

### 6.3.26 $V_{BAT}$ ADC monitoring characteristics and charging characteristics

**Table 86.  $V_{BAT}$  ADC monitoring characteristics<sup>(1)</sup>**

| Symbol                             | Parameter                                      | Min | Typ  | Max | Unit |
|------------------------------------|------------------------------------------------|-----|------|-----|------|
| R                                  | Resistor bridge for $V_{BAT}$                  | -   | 4×26 | -   | kΩ   |
| Q                                  | Ratio on $V_{BAT}$ measurement                 | -   | 4    | -   | -    |
| Er <sup>(2)</sup>                  | Error on Q                                     | -10 | -    | +10 | %    |
| t <sub>S_vbat</sub> <sup>(2)</sup> | ADC sampling time when reading $V_{BAT}$ input | 9.8 | -    | -   | μs   |

1.  $1.20\text{ V} \leq V_{BAT} \leq 3.6\text{ V}$

2. Specified by design, not tested in production.

**Table 87.  $V_{BAT}$  charging characteristics**

| Symbol          | Parameter                 | Condition          | Min | Typ | Max | Unit |
|-----------------|---------------------------|--------------------|-----|-----|-----|------|
| R <sub>BC</sub> | Battery charging resistor | VBRS in PWR_CR3= 0 | -   | 5   | -   | kΩ   |
|                 |                           | VBRS in PWR_CR3= 1 | -   | 1.5 | -   |      |

### 6.3.27 Temperature and Backup domain supply thresholds monitoring

The temperature and Backup domain supply monitoring characteristics are provided in the technical note STM32MP13xC/F MPUs for PCI products (TN1358). A NDA is required.

### 6.3.28 $V_{DDCORE}$ , $V_{DDCPU}$ , $V_{DDQ\_DDR}$ monitoring characteristics

**Table 88.  $V_{DDCORE}$ ,  $V_{DDCPU}$ ,  $V_{DDQ\_DDR}$  monitoring characteristics**

| Symbol                                 | Parameter                                           | Min | Typ | Max | Unit |
|----------------------------------------|-----------------------------------------------------|-----|-----|-----|------|
| t <sub>S_vddcore</sub> <sup>(1)</sup>  | ADC sampling time when reading $V_{DDCORE}$ input   | 1   | -   | -   | μs   |
| t <sub>S_vddcpu</sub> <sup>(1)</sup>   | ADC sampling time when reading $V_{DDCPU}$ input    | 1   | -   | -   | μs   |
| t <sub>S_vddq_ddr</sub> <sup>(1)</sup> | ADC sampling time when reading $V_{DDQ\_DDR}$ input | 1   | -   | -   | μs   |

1. Specified by design, not tested in production.

### 6.3.29 Voltage booster for analog switch

**Table 89. Voltage booster for analog switch characteristics**

| Symbol                 | Parameter            | Condition                                     | Min  | Typ | Max | Unit |
|------------------------|----------------------|-----------------------------------------------|------|-----|-----|------|
| V <sub>DD</sub>        | Supply voltage       | -                                             | 1.71 | -   | 3.6 | V    |
| t <sub>SU(BOOST)</sub> | Booster startup time | -                                             | -    | -   | 50  | μs   |
| I <sub>DD(BOOST)</sub> | Booster consumption  | $1.71\text{ V} \leq V_{DD} \leq 2.7\text{ V}$ | -    | -   | 125 | μA   |
|                        |                      | $2.7\text{ V} < V_{DD} < 3.6\text{ V}$        | -    | -   | 250 |      |

### 6.3.30 Compensation cell

**Table 90. Compensation cell characteristics**

| Symbol                | Parameter                                                   | Condition                        | Min | Typ | Max | Unit |
|-----------------------|-------------------------------------------------------------|----------------------------------|-----|-----|-----|------|
| I <sub>COMPCELL</sub> | V <sub>DD</sub> current consumption during code calculation | 1.71 V ≤ V <sub>DD</sub> ≤ 2.7 V | -   | -   | 3.5 | mA   |
|                       |                                                             | 2.7 V < V <sub>DD</sub> < 3.6 V  | -   | -   | 10  |      |
| T <sub>READY</sub>    | Time needed for code calculation                            | 1.71 V ≤ V <sub>DD</sub> ≤ 2.7 V | -   | -   | 300 | μs   |
|                       |                                                             | 2.7 V < V <sub>DD</sub> < 3.6 V  | -   | -   | 250 |      |

### 6.3.31 Digital filter for sigma-delta modulators (DFSDM) characteristics

Unless otherwise specified, the parameters given in [Table 91](#) for DFSDM are derived from tests performed under the ambient temperature, f<sub>pclkx</sub> frequency and V<sub>DD</sub> supply voltage summarized in [Table 13: General operating conditions](#), with the following configuration:

- Output speed is set to OSPEEDRy[1:0] = 10
- Capacitive load C = 30 pF
- Measurement points are done at CMOS levels: 0.5×V<sub>DD</sub>

Refer to [Section 6.3.17: I/O port characteristics](#) for more details on the input/output alternate function characteristics (DFSDMx\_CKINx, DFSDMx\_DATINx, DFSDMx\_CKOUT for DFSDMx).

**Table 91. DFSDM measured timing**

| Symbol                                      | Parameter                         | Conditions                                                                                                 | Min | Typ | Max                 | Unit |
|---------------------------------------------|-----------------------------------|------------------------------------------------------------------------------------------------------------|-----|-----|---------------------|------|
| f <sub>DFSDMCLK</sub>                       | DFSDM clock                       | 1.71 V < V <sub>DD</sub> < 3.6 V                                                                           | -   | -   | f <sub>SYSCLK</sub> | MHz  |
| f <sub>CKIN</sub><br>(1/T <sub>CKIN</sub> ) | Input clock frequency             | SPI mode (SITP[1:0]=0,1),<br>External clock mode<br>(SPICKSEL[1:0]=0),<br>1.71 V < V <sub>DD</sub> < 3.6 V | -   | -   | 33                  |      |
|                                             |                                   | SPI mode (SITP[1:0]=0,1),<br>External clock mode<br>(SPICKSEL[1:0]=0),<br>2.7 < V <sub>DD</sub> < 3.6 V    | -   | -   | 33                  |      |
|                                             |                                   | SPI mode (SITP[1:0]=0,1),<br>Internal clock mode<br>(SPICKSEL[1:0]≠0),<br>1.71 < V <sub>DD</sub> < 3.6 V   | -   | -   | 33                  |      |
|                                             |                                   | SPI mode (SITP[1:0]=0,1),<br>Internal clock mode<br>(SPICKSEL[1:0]≠0),<br>2.7 < V <sub>DD</sub> < 3.6 V    | -   | -   | 33                  |      |
| f <sub>CKOUT</sub>                          | Output clock frequency            | 1.71 < V <sub>DD</sub> < 3.6 V                                                                             | -   | -   | 33                  | %    |
| DuCy <sub>CKOUT</sub>                       | Output clock frequency duty cycle | 1.71 < V <sub>DD</sub> < 3.6 V                                                                             | 45  | 50  | 55                  |      |

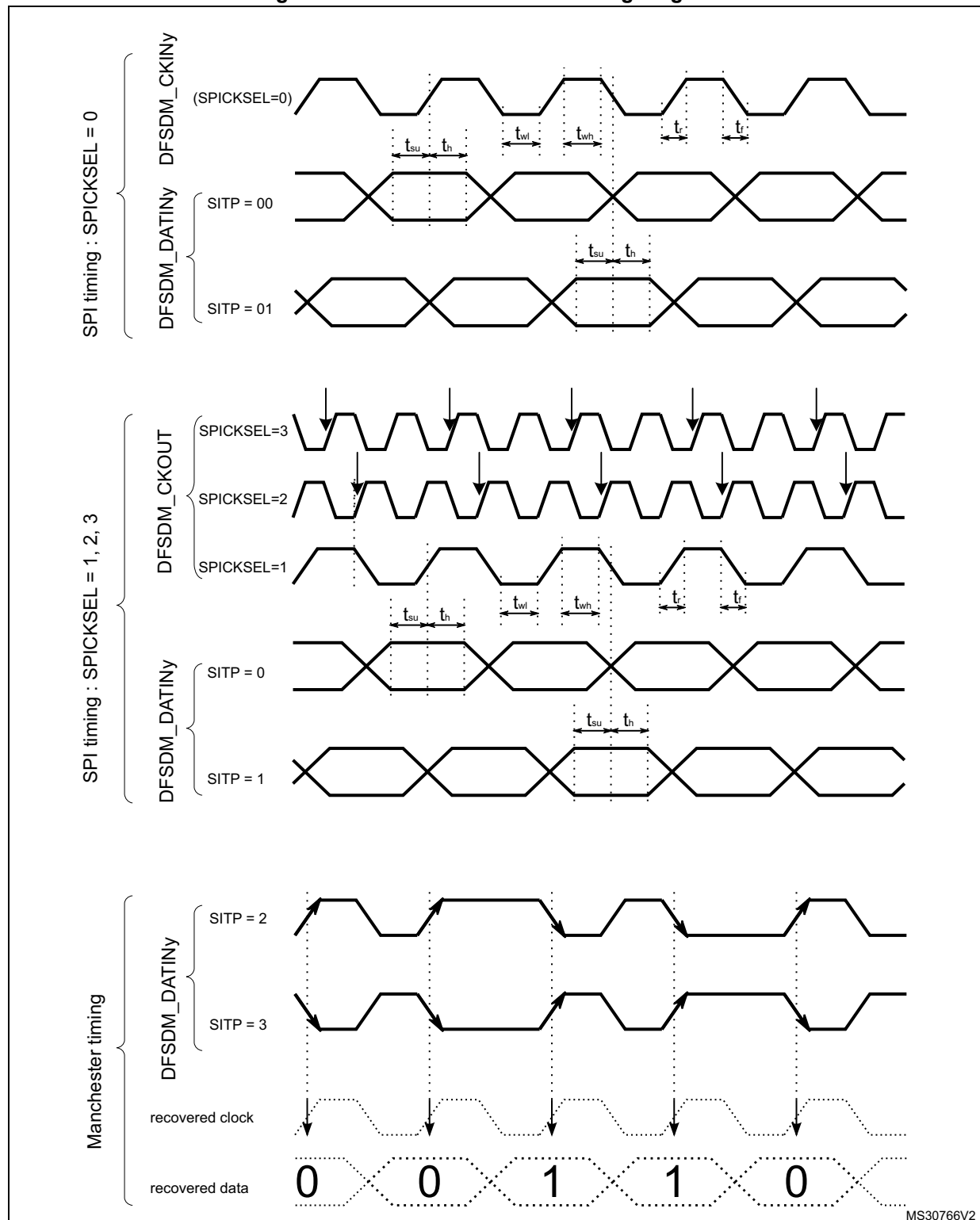
Table 91. DFSDM measured timing (continued)

| Symbol                           | Parameter                                       | Conditions                                                                                                   | Min                                      | Typ          | Max                                             | Unit |
|----------------------------------|-------------------------------------------------|--------------------------------------------------------------------------------------------------------------|------------------------------------------|--------------|-------------------------------------------------|------|
| $t_{wh(CKIN)}$<br>$t_{wl(CKIN)}$ | Input clock high and low time                   | SPI mode (SITP[1:0]=0,1),<br>External clock mode (SPICKSEL[1:0]=0),<br>1.71 < V <sub>DD</sub> < 3.6 V        | $T_{CKIN}/2 - 0.5$                       | $T_{CKIN}/2$ | -                                               | ns   |
| $t_{su}$                         | Data input setup time                           | SPI mode (SITP[1:0]=0,1),<br>External clock mode (SPICKSEL[1:0]=0),<br>1.71 < V <sub>DD</sub> < 3.6 V        | 1                                        | -            | -                                               |      |
| $t_h$                            | Data input hold time                            | SPI mode (SITP[1:0]=0,1),<br>External clock mode (SPICKSEL[1:0]=0),<br>1.71 < V <sub>DD</sub> < 3.6 V        | 1                                        | -            | -                                               |      |
| $T_{Manchester}$                 | Manchester data period (recovered clock period) | Manchester mode (SITP[1:0]=2,3),<br>Internal clock mode (SPICKSEL[1:0]≠0),<br>1.71 < V <sub>DD</sub> < 3.6 V | $(CKOUTDIV+1) \times T_{DFSDMCLK}^{(1)}$ | -            | $(2 \times CKOUTDIV) \times T_{DFSDMCLK}^{(1)}$ |      |

1. See DFSDM section in Reference manual for definition of CKOUTDIV.



Figure 38. Channel transceiver timing diagrams



### 6.3.32 Timer characteristics

The parameters given in [Table 92](#) are specified by design, not tested in production.

Refer to [Section 6.3.17: I/O port characteristics](#) for details on the input/output alternate function characteristics (output compare, input capture, external clock, PWM output).

**Table 92. TIMx characteristics<sup>(1)(2)</sup>**

| Symbol           | Parameter                                               | Min | Max                  | Unit          |
|------------------|---------------------------------------------------------|-----|----------------------|---------------|
| $t_{res(TIM)}$   | Timer resolution time                                   | 1   | -                    | $t_{TIMxCLK}$ |
| $f_{TIMxCLK}$    | Timer kernel clock                                      | 0   | 209                  | MHz           |
| $f_{EXT}$        | Timer external clock frequency on CH1 to CH4            | 0   | $f_{TIMxCLK}/2$      |               |
| $Res_{TIM}$      | Timer resolution                                        | -   | 16/32                | bit           |
| $t_{MAX\_COUNT}$ | Maximum possible count with 16-bit counters             | -   | 65536                | $t_{TIMxCLK}$ |
|                  | Maximum possible count with 32-bit counter (TIM2, TIM5) |     | $65536 \times 65536$ |               |

1. TIMx is used as a general term to refer to the TIM1 to TIM17 timers.

2. Specified by design, not tested in production.

**Table 93. LPTIMx characteristics<sup>(1)(2)</sup>**

| Symbol           | Parameter                                           | Min | Max               | Unit          |
|------------------|-----------------------------------------------------|-----|-------------------|---------------|
| $t_{res(TIM)}$   | Timer resolution time                               | 1   | -                 | $t_{TIMxCLK}$ |
| $f_{LPTIMxCLK}$  | Timer kernel clock                                  | 0   | 104.5             | MHz           |
| $f_{EXT}$        | Timer external clock frequency on Input1 and Input2 | 0   | $f_{LPTIMxCLK}/2$ |               |
| $Res_{TIM}$      | Timer resolution                                    | -   | 16                | bit           |
| $t_{MAX\_COUNT}$ | Maximum possible count                              | -   | 65536             | $t_{TIMxCLK}$ |

1. LPTIMx is used as a general term to refer to the LPTIM1 to LPTIM5 timers.

2. Specified by design, not tested in production.

### 6.3.33 Communications interfaces

#### I2C interface characteristics

The I2C interface meets the timings requirements of the I<sup>2</sup>C-bus specification for:

- Standard-mode (Sm): with a bit rate up to 100 kbit/s
- Fast-mode (Fm): with a bit rate up to 400 kbit/s.
- Fast-mode Plus (Fm+): with a bit rate up to 1 Mbit/s.

The I<sup>2</sup>C timings requirements are specified by design, not tested in production, when the I2C peripheral is properly configured and when the `i2c_ker_ck` frequency is greater than the minimum shown in the table below:

The SDA and SCL I/O requirements are met with the following restrictions:

- The SDA and SCL I/O pins are not “true” open-drain. When configured as open-drain, the PMOS connected between the I/O pin and  $V_{DD}$  is disabled, but is still present.
- The 20 mA output drive requirement in Fast-mode Plus is not supported. This limits the maximum load  $C_{load}$  supported in Fm+, which is given by these formulas:

$$t_{r(SDA/SCL)} = 0.8473 \times R_p \times C_{load}$$

$$R_{p(min)} = (V_{DD} - V_{OL(max)}) / I_{OL(max)}$$

Where  $R_p$  is the I2C lines pull-up. Refer to [Section 6.3.17: I/O port characteristics](#) for the I2C I/Os characteristics.

All I2C SDA and SCL I/Os embed an analog filter. Refer to [Table 94](#) for the analog filter characteristics:

**Table 94. I2C analog filter characteristics<sup>(1)</sup>**

| Symbol   | Parameter                                                              | Min               | Max                | Unit |
|----------|------------------------------------------------------------------------|-------------------|--------------------|------|
| $t_{AF}$ | Maximum pulse width of spikes that are suppressed by the analog filter | 50 <sup>(2)</sup> | 120 <sup>(3)</sup> | ns   |

1. Specified by design, not tested in production.
2. Spikes with widths below  $t_{AF(min)}$  are filtered.  
At -40 °C it is possible to have 40 ns instead of 50 ns as minimum pulse width.
3. Spikes with widths above  $t_{AF(max)}$  are not filtered.

The I2C pins can be set in FM+ mode in SYSCFG\_PMCR register.

Unless otherwise specified, the parameters given in Table 55 are derived from tests performed under the ambient temperature and  $V_{DD}$  supply voltage conditions summarized in [Table 13: General operating conditions](#).

**Table 95. I2C FM+ pin characteristics**

| Symbol          | Parameter                          | Conditions                            | Min | Max | Unit |
|-----------------|------------------------------------|---------------------------------------|-----|-----|------|
| $F_{max}^{(1)}$ | Maximum frequency                  | $C = 50 \text{ pF}$                   | -   | 1   | MHz  |
| $T_f^{(2)}$     | Output high to low level fall time | $1.71 \leq V_{DD} \leq 3.6 \text{ V}$ | -   | 5   | ns   |

1. The maximum frequency is defined with the following conditions:
  - $(T_r + T_f) \leq \frac{2}{3}T$
  - 45% < duty cycle < 55%.
2. The fall time is defined between 70% and 30% of the output waveform according to I<sup>2</sup>C specification NXP UM10204 rev- Oct 2012.

## SPI interface characteristics

Unless otherwise specified, the parameters given in [Table 96](#) for the SPI interface are derived from tests performed under the ambient temperature,  $f_{clkx}$  frequency and  $V_{DD}$

supply voltage conditions summarized in [Table 13: General operating conditions](#), with the following configuration:

- Output speed is set to OSPEEDRy[1:0] = 11
- Capacitive load C = 30 pF
- Measurement points are done at CMOS levels:  $0.5 \times V_{DD}$
- I/O compensation cell enabled
- HSLV activated when  $V_{DD} \leq 2.7$  V

Refer to [Section 6.3.17: I/O port characteristics](#) for more details on the input/output alternate function characteristics (NSS, SCK, MOSI, MISO for SPI).

**Table 96. SPI dynamic characteristics<sup>(1)</sup>**

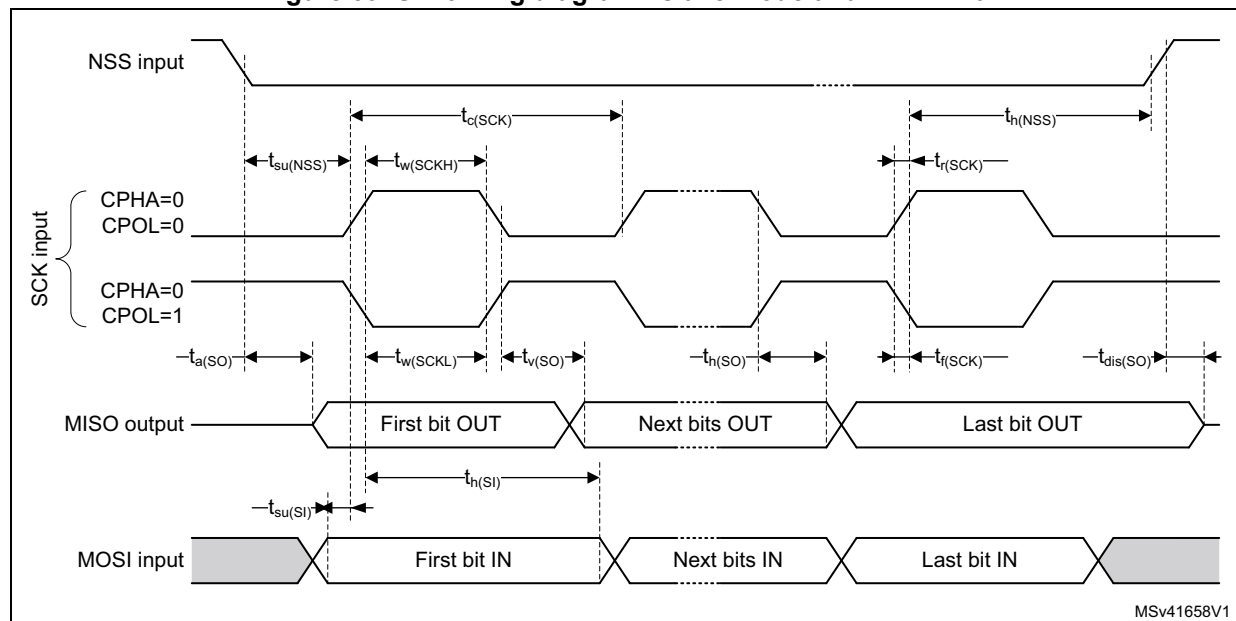
| Symbol                           | Parameter             | Conditions                                                                            | Min            | Typ        | Max               | Unit |
|----------------------------------|-----------------------|---------------------------------------------------------------------------------------|----------------|------------|-------------------|------|
| $f_{SCK}$                        | SPI clock frequency   | Master mode<br>$1.71 \text{ V} \leq V_{DD} \leq 3.6 \text{ V}$<br>SPI1,2,3,4          | -              | -          | 100               | MHz  |
|                                  |                       | Master mode<br>$1.71 \text{ V} \leq V_{DD} \leq 3.6 \text{ V}$<br>SPI5                |                |            | 52                |      |
|                                  |                       | Slave receiver mode<br>$1.71 \text{ V} \leq V_{DD} \leq 3.6 \text{ V}$<br>SPI1,2,3,4  |                |            | 100               |      |
|                                  |                       | Slave receiver mode<br>$1.71 \text{ V} \leq V_{DD} \leq 3.6 \text{ V}$<br>SPI5        |                |            | 52                |      |
|                                  |                       | Slave mode transmitter/full duplex<br>$2.7 \text{ V} \leq V_{DD} \leq 3.6 \text{ V}$  |                |            | 38 <sup>(2)</sup> |      |
|                                  |                       | Slave mode transmitter/full duplex<br>$1.71 \text{ V} \leq V_{DD} \leq 3.6 \text{ V}$ |                |            | 35 <sup>(2)</sup> |      |
| $t_{su(NSS)}$                    | NSS setup time        | Slave mode                                                                            | 2              | -          | -                 | ns   |
| $t_{h(NSS)}$                     | NSS hold time         |                                                                                       | 2              | -          | -                 |      |
| $t_{w(SCKH)}$ ,<br>$t_{w(SCKL)}$ | SCK high and low time | Master mode                                                                           | $T_{pclk} - 1$ | $T_{pclk}$ | $T_{pclk} + 1$    |      |

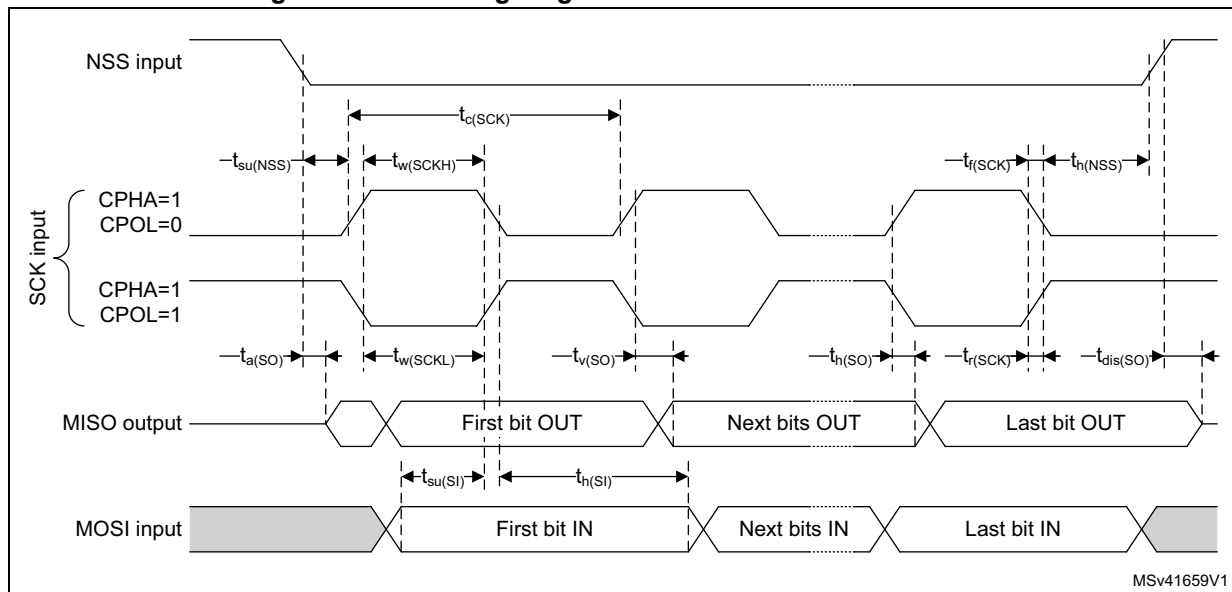
Table 96. SPI dynamic characteristics<sup>(1)</sup> (continued)

| Symbol        | Parameter                | Conditions                                                  | Min | Typ | Max | Unit |
|---------------|--------------------------|-------------------------------------------------------------|-----|-----|-----|------|
| $t_{su(MI)}$  | Data input setup time    | Master mode                                                 | 4   | -   | -   | ns   |
| $t_{su(SI)}$  |                          | Slave mode                                                  | 1   | -   | -   |      |
| $t_{h(MI)}$   | Data input hold time     | Master mode                                                 | 1.5 | -   | -   |      |
| $t_{h(SI)}$   |                          | Slave mode                                                  | 1.5 | -   | -   |      |
| $t_{a(SO)}$   | Data output access time  | Slave mode                                                  | 8.5 | 10  | 16  |      |
| $t_{dis(SO)}$ | Data output disable time | Slave mode                                                  | 4.5 | 5   | 7.5 |      |
| $t_{v(SO)}$   | Data output valid time   | Slave mode<br>$2.7\text{ V} \leq V_{DD} \leq 3.6\text{ V}$  | -   | 10  | 13  |      |
|               |                          | Slave mode<br>$1.71\text{ V} \leq V_{DD} \leq 3.6\text{ V}$ | -   | 11  | 14  |      |
| $t_{v(MO)}$   |                          | Master mode                                                 | -   | 1.5 | 2   |      |
| $t_{h(SO)}$   | Data output hold time    | Slave mode<br>$1.71\text{ V} \leq V_{DD} \leq 3.6\text{ V}$ | 8   | -   | -   |      |
| $t_{h(MO)}$   |                          | Master mode                                                 | 1   | -   | -   |      |

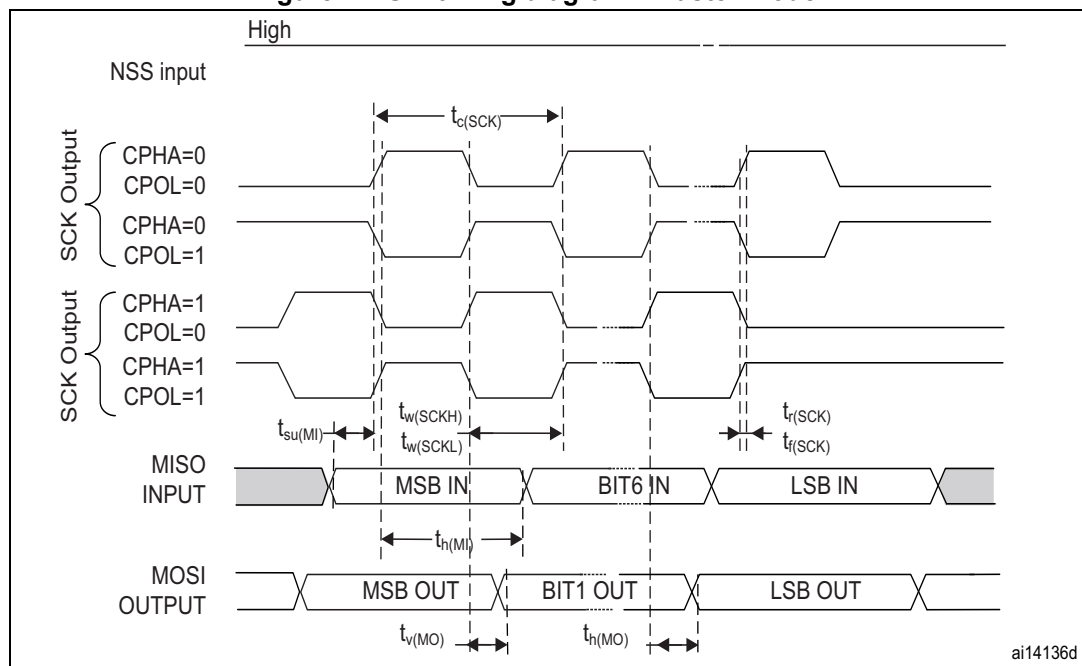
1. Evaluated by characterization, not tested in production.
2. Maximum frequency in slave transmitter mode is determined by the sum of  $t_{v(SO)}$  and  $t_{su(MI)}$  which has to fit into SCK low or high phase preceding the SCK sampling edge. This value can be achieved when the SPI communicates with a master having  $t_{su(MI)} = 0$  while Duty(SCK) = 50%.

Figure 39. SPI timing diagram - slave mode and CPHA = 0



**Figure 40. SPI timing diagram - slave mode and CPHA = 1<sup>(1)</sup>**

1. Measurement points are done at  $0.5 \times V_{DD}$  and with external  $C_L = 30$  pF.

**Figure 41. SPI timing diagram - master mode<sup>(1)</sup>**

1. Measurement points are done at  $0.5 \times V_{DD}$  and with external  $C_L = 30$  pF.

## I2S interface characteristics

Unless otherwise specified, the parameters given in [Table 97](#) for the I2S interface are derived from tests performed under the ambient temperature,  $f_{clkx}$  frequency and  $V_{DD}$

supply voltage conditions summarized in [Table 13: General operating conditions](#), with the following configuration:

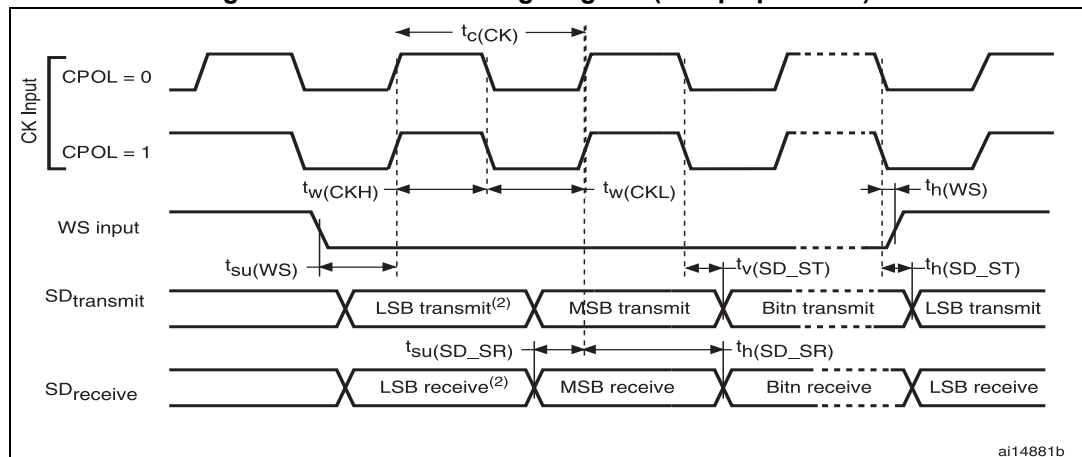
- Output speed is set to OSPEEDRy[1:0] = 10
- Capacitive load C = 30 pF
- Measurement points are done at CMOS levels:  $0.5 \times V_{DD}$
- I/O compensation cell enabled
- HSLV activated when  $V_{DD} \leq 2.7$  V

Refer to [Section 6.3.17: I/O port characteristics](#) for more details on the input/output alternate function characteristics (CK, SD, WS).

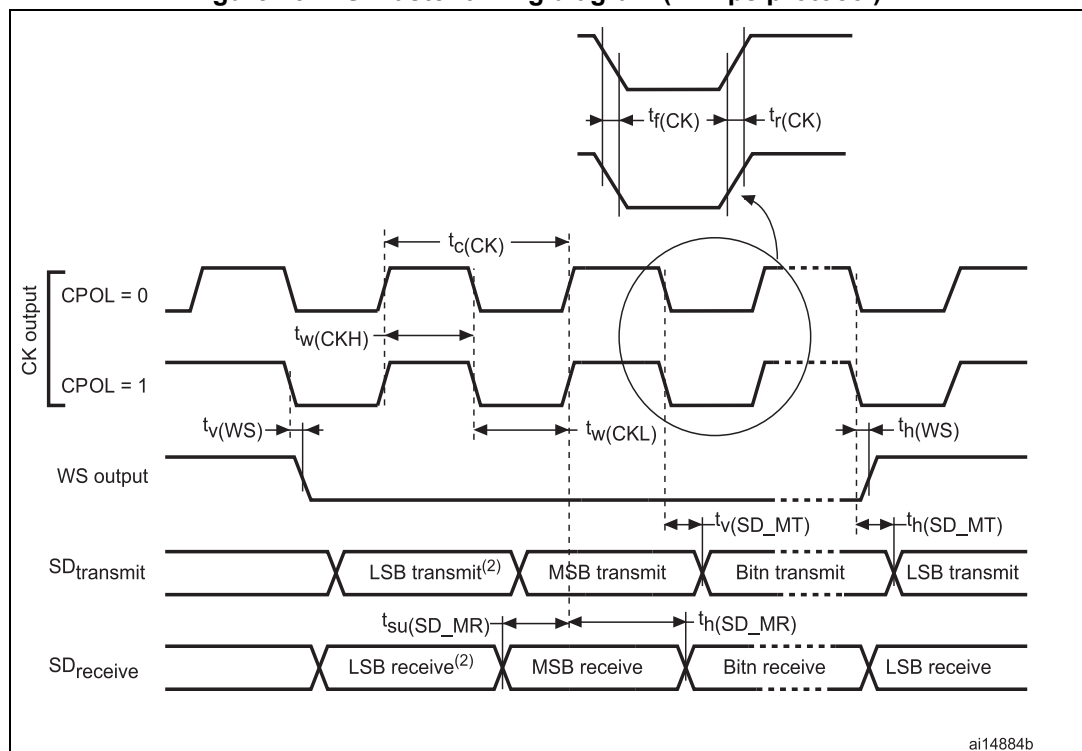
**Table 97. I2S dynamic characteristics<sup>(1)</sup>**

| Symbol           | Parameter              | Conditions                             | Min    | Max    | Unit |
|------------------|------------------------|----------------------------------------|--------|--------|------|
| $f_{MCK}$        | I2S main clock output  | -                                      | 256×8K | 256×Fs | MHz  |
| $f_{CK}$         | I2S clock frequency    | Master data                            | -      | 64×Fs  | MHz  |
|                  |                        | Slave data                             | -      | 64×Fs  |      |
| $t_{V(WS)}$      | WS valid time          | Master mode                            | -      | 2      | ns   |
| $t_{h(WS)}$      | WS hold time           | Master mode                            | 1      | -      |      |
| $t_{su(WS)}$     | WS setup time          | Slave mode                             | 3.5    | -      |      |
| $t_{h(WS)}$      | WS hold time           | Slave mode                             | 1      | -      |      |
| $t_{su(SD\_MR)}$ | Data input setup time  | Master receiver                        | 3.5    | -      |      |
| $t_{su(SD\_SR)}$ |                        | Slave receiver                         | 2      | -      |      |
| $t_{h(SD\_MR)}$  | Data input hold time   | Master receiver                        | 1      | -      |      |
| $t_{h(SD\_SR)}$  |                        | Slave receiver                         | 1      | -      |      |
| $t_{V(SD\_ST)}$  | Data output valid time | Slave transmitter (after enable edge)  | -      | 10     |      |
| $t_{V(SD\_MT)}$  |                        | Master transmitter (after enable edge) | -      | 1      |      |
| $t_{h(SD\_ST)}$  | Data output hold time  | Slave transmitter (after enable edge)  | 1      | -      |      |
| $t_{h(SD\_MT)}$  |                        | Master transmitter (after enable edge) | 0.5    | -      |      |

1. Evaluated by characterization, not tested in production.

Figure 42. I2S slave timing diagram (Philips protocol)<sup>(1)</sup>

1. LSB transmit/receive of the previously transmitted byte. No LSB transmit/receive is sent before the first byte.

Figure 43. I2S master timing diagram (Philips protocol)<sup>(1)</sup>

1. LSB transmit/receive of the previously transmitted byte. No LSB transmit/receive is sent before the first byte.

## SAI characteristics

Unless otherwise specified, the parameters given in [Table 98](#) for SAI are derived from tests performed under the ambient temperature,  $F_{\text{clk2}}$  frequency and  $V_{\text{DD}}$  supply voltage



conditions summarized in [Table 13: General operating conditions](#), with the following configuration:

- Output speed is set to OSPEEDRy[1:0] = 10
- Capacitive load C = 30 pF
- Measurement points are performed at CMOS levels:  $0.5 \times V_{DD}$

Refer to [Section 6.3.17: I/O port characteristics](#) for more details on the input/output alternate function characteristics (SCK,SD,WS).

**Table 98. SAI characteristics<sup>(1)</sup>**

| Symbol              | Parameter                              | Conditions                                                          | Min | Max | Unit |
|---------------------|----------------------------------------|---------------------------------------------------------------------|-----|-----|------|
| $f_{MCK}$           | SAI Main clock output                  | -                                                                   | -   | 50  | MHz  |
| $F_{CK}$            | SAI bit clock frequency <sup>(2)</sup> | Master transmitter<br>$2.7\text{ V} \leq V_{DD} \leq 3.6\text{ V}$  | -   | 45  | MHz  |
|                     |                                        | Master transmitter<br>$1.71\text{ V} \leq V_{DD} \leq 3.6\text{ V}$ | -   | 27  |      |
|                     |                                        | Master receiver<br>$1.71\text{ V} \leq V_{DD} \leq 3.6\text{ V}$    | -   | 27  |      |
|                     |                                        | Slave transmitter<br>$2.7\text{ V} \leq V_{DD} \leq 3.6\text{ V}$   | -   | 43  |      |
|                     |                                        | Slave transmitter<br>$1.71\text{ V} \leq V_{DD} \leq 3.6\text{ V}$  | -   | 30  |      |
|                     |                                        | Slave receiver<br>$1.71\text{ V} \leq V_{DD} \leq 3.6\text{ V}$     | -   | 50  |      |
| $t_{V(FS)}$         | FS valid time                          | Master mode<br>$2.7\text{ V} \leq V_{DD} \leq 3.6\text{ V}$         | -   | 11  | ns   |
|                     |                                        | Master mode<br>$1.71\text{ V} \leq V_{DD} \leq 3.6\text{ V}$        | -   | 18  |      |
| $t_{su(FS)}$        | FS setup time                          | Slave mode                                                          | 6.5 | -   |      |
| $t_{h(FS)}$         | FS hold time                           | Master mode                                                         | 2   | -   |      |
|                     |                                        | Slave mode                                                          | 2   | -   |      |
| $t_{su(SD\_A\_MR)}$ | Data input setup time                  | Master receiver                                                     | 3.5 | -   |      |
| $t_{su(SD\_B\_SR)}$ |                                        | Slave receiver                                                      | 2   | -   |      |
| $t_{h(SD\_A\_MR)}$  | Data input hold time                   | Master receiver                                                     | 1   | -   |      |
| $t_{h(SD\_B\_SR)}$  |                                        | Slave receiver                                                      | 0.5 | -   |      |

Table 98. SAI characteristics<sup>(1)</sup> (continued)

| Symbol             | Parameter              | Conditions                                                                              | Min | Max  | Unit |
|--------------------|------------------------|-----------------------------------------------------------------------------------------|-----|------|------|
| $t_{v(SD\_B\_ST)}$ | Data output valid time | Slave transmitter (after enable edge)<br>$2.7\text{ V} \leq V_{DD} \leq 3.6\text{ V}$   | -   | 11.5 | ns   |
|                    |                        | Slave transmitter (after enable edge)<br>$1.71\text{ V} \leq V_{DD} \leq 3.6\text{ V}$  | -   | 16.5 |      |
| $t_{h(SD\_B\_ST)}$ | Data output hold time  | Slave transmitter (after enable edge)                                                   | 8   | -    |      |
| $t_{v(SD\_A\_MT)}$ | Data output valid time | Master transmitter (after enable edge)<br>$2.7\text{ V} \leq V_{DD} \leq 3.6\text{ V}$  | -   | 10   |      |
|                    |                        | Master transmitter (after enable edge)<br>$1.71\text{ V} \leq V_{DD} \leq 3.6\text{ V}$ | -   | 18   |      |
| $t_{h(SD\_A\_MT)}$ | Data output hold time  | Master transmitter (after enable edge)                                                  | 6.5 | -    |      |

1. Evaluated by characterization, not tested in production.

2. APB clock frequency must be at least twice SAI clock frequency.

Figure 44. SAI master timing waveforms

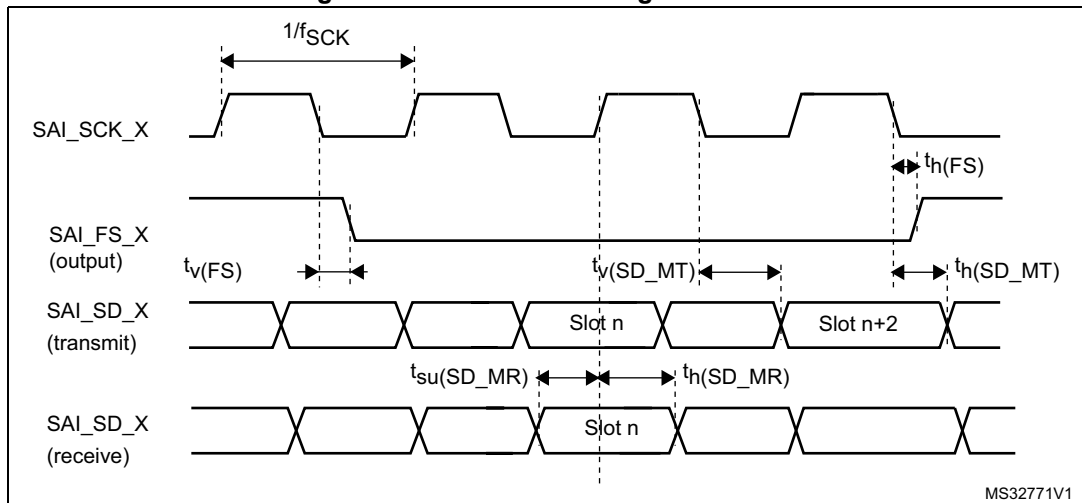
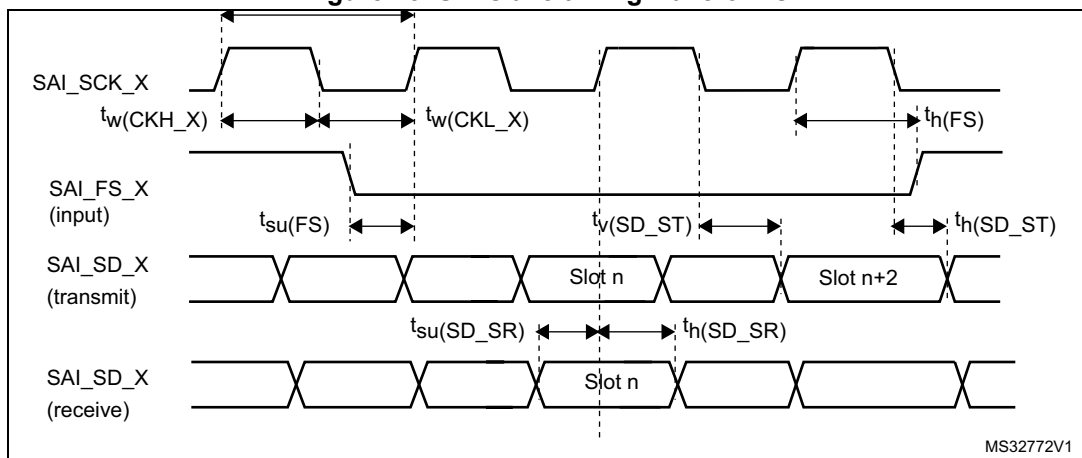


Figure 45. SAI slave timing waveforms



**SD/SDIO MMC card host interface (SDMMC) characteristics**

Unless otherwise specified, the parameters given in [Table 99](#) for the SDIO/MMC interface are derived from tests performed under the ambient temperature,  $F_{\text{hclk6}}$  frequency and  $V_{\text{DD}}$  supply voltage conditions summarized in [Table 13: General operating conditions](#), with the following configuration:

- Output speed is set to  $\text{OSPEEDRy}[1:0] = 11$
- Capacitive load  $C = 30 \text{ pF}$
- Measurement points are done at CMOS levels:  $0.5 \times V_{\text{DD}}$
- I/O compensation cell enabled
- HSLV activated when  $V_{\text{DD}} \leq 2.7 \text{ V}$
- Delay block disabled

Refer to [Section 6.3.17: I/O port characteristics](#) for more details on the input/output characteristics.

**Table 99. Dynamics characteristics: SD characteristics,  $V_{\text{DD}} = 1.71 \text{ V}$  to  $3.6 \text{ V}$  <sup>(1)(2)</sup>**

| Symbol                                                  | Parameter                                  | Conditions                     | Min | Typ | Max | Unit |
|---------------------------------------------------------|--------------------------------------------|--------------------------------|-----|-----|-----|------|
| f <sub>PP</sub>                                         | Clock frequency in data transfer mode      | 2.7 < V <sub>DD</sub> < 3.6 V  | -   | -   | 130 | MHz  |
|                                                         |                                            | 1.71 < V <sub>DD</sub> < 1.9 V | -   | -   | 105 |      |
| -                                                       | SDIO_CK/f <sub>PCLK2</sub> frequency ratio | -                              | -   | -   | 8/3 | -    |
| t <sub>W(CKL)</sub>                                     | Clock low time                             | f <sub>PP</sub> =52 MHz        | 8.5 | 9.5 | -   | ns   |
| t <sub>W(CKH)</sub>                                     | Clock high time                            | f <sub>PP</sub> =52 MHz        | 8.5 | 9.5 | -   |      |
| CMD, D inputs (referenced to CK) in SD HS/SDR/DDR mode  |                                            |                                |     |     |     |      |
| t <sub>ISU</sub>                                        | Input setup time HS                        | -                              | 2.5 | -   | -   | ns   |
| t <sub>IHD</sub>                                        | Input hold time HS                         | -                              | 0.5 | -   | -   |      |
| T <sub>idw</sub> <sup>(3)</sup>                         | Input valid window (variable window)       | -                              | 2.5 | -   | -   |      |
| CMD, D outputs (referenced to CK) in SD HS/SDR/DDR mode |                                            |                                |     |     |     |      |
| t <sub>OV</sub>                                         | Output valid time HS                       | -                              | -   | 5   | 6   | ns   |
| t <sub>OH</sub>                                         | Output hold time HS                        | -                              | 4.5 | -   | -   |      |
| CMD, D inputs (referenced to CK) in SD default mode     |                                            |                                |     |     |     |      |
| t <sub>ISUD</sub>                                       | Input setup time SD                        | -                              | 2.5 | -   | -   | ns   |
| t <sub>IHD</sub>                                        | Input hold time SD                         | -                              | 0.5 | -   | -   |      |
| CMD, D outputs (referenced to CK) in SD default mode    |                                            |                                |     |     |     |      |
| t <sub>OVD</sub>                                        | Output valid default time SD               | -                              | -   | 0.5 | 1   | ns   |
| t <sub>OHD</sub>                                        | Output hold default time SD                | -                              | 0   | -   | -   |      |

1. Data based on characterization results, not tested in production.

2. Above 100 MHz, CL applied is 20 pF.

3. The minimum window of time where the data need to be stable for proper sampling in tuning mode.

**Table 100. Dynamics characteristics: eMMC characteristics  $V_{DD} = 1.71\text{ V}$  to  $3.6\text{ V}$  <sup>(1)(2)</sup>**

| Symbol                                         | Parameter                                  | Conditions                     | Min | Typ | Max | Unit |
|------------------------------------------------|--------------------------------------------|--------------------------------|-----|-----|-----|------|
| f <sub>PP</sub>                                | Clock frequency in data transfer mode      | 2.7 < V <sub>DD</sub> < 3.6 V  | -   | -   | 130 | MHz  |
|                                                |                                            | 1.71 < V <sub>DD</sub> < 1.9 V | -   | -   | 105 |      |
| -                                              | SDIO_CK/f <sub>PCLK2</sub> frequency ratio | -                              | -   | -   | 8/3 | -    |
| t <sub>W(CKL)</sub>                            | Clock low time                             | f <sub>PP</sub> =52 MHz        | 8.5 | 9.5 | -   | ns   |
| t <sub>W(CKH)</sub>                            | Clock high time                            | f <sub>PP</sub> =52 MHz        | 8.5 | 9.5 | -   |      |
| CMD, D inputs (referenced to CK) in eMMC mode  |                                            |                                |     |     |     |      |
| t <sub>ISU</sub>                               | Input setup time HS                        | -                              | 2.5 | -   | -   | ns   |
| t <sub>IH</sub>                                | Input hold time HS                         | -                              | 0.5 | -   | -   |      |
| T <sub>idw</sub> <sup>(3)</sup>                | Input valid window (variable window)       | -                              | 2.5 | -   | -   |      |
| CMD, D outputs (referenced to CK) in eMMC mode |                                            |                                |     |     |     |      |
| t <sub>OV</sub>                                | Output valid time HS                       | -                              | -   | 5   | 6   | ns   |
| t <sub>OH</sub>                                | Output hold time HS                        | -                              | 4   | -   | -   |      |

1. Data based on characterization results, not tested in production.

2.  $C_{LOAD} = 20\text{ pF}$ .

3. The minimum window of time where the data need to be stable for proper sampling in tuning mode.

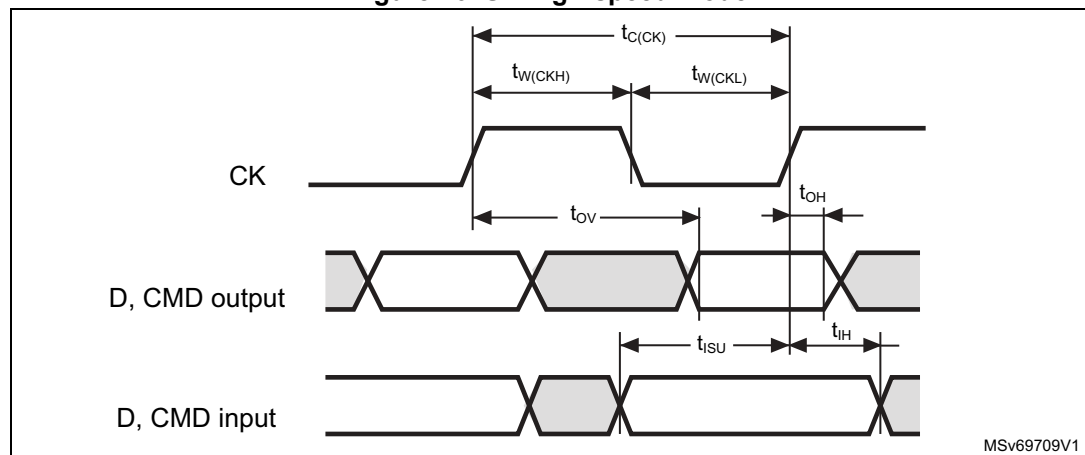
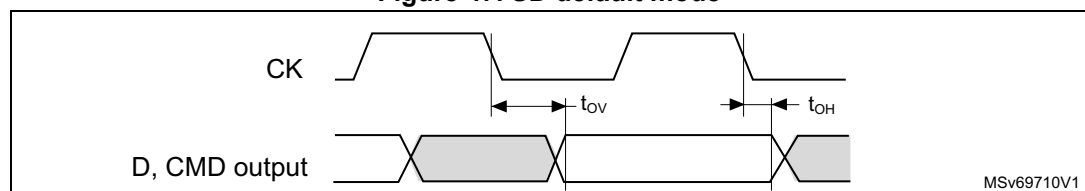
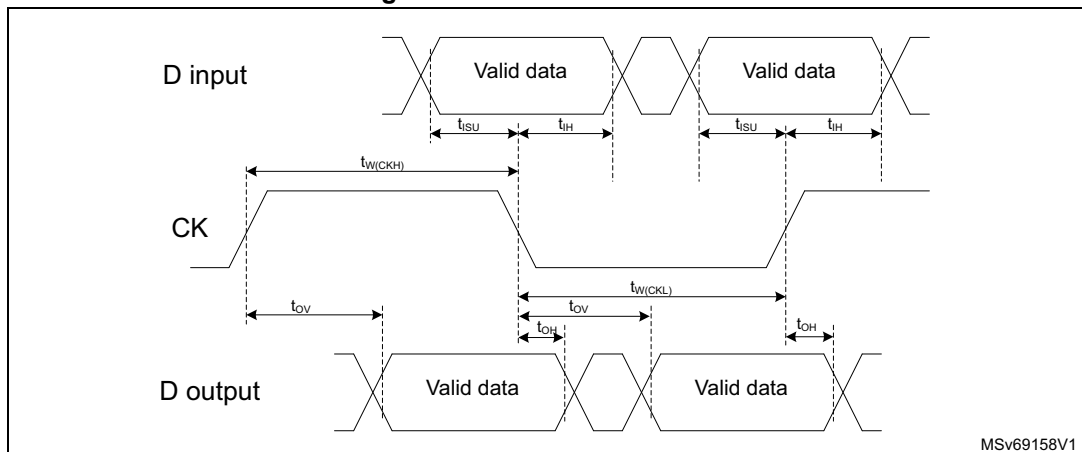
**Figure 46. SD high-speed mode****Figure 47. SD default mode**

Figure 48. SDMMC DDR mode



### FDCAN (controller area network) interface

Refer to [Section 6.3.17: I/O port characteristics](#) for more details on the input/output alternate function characteristics (FDCANx\_TX and FDCANx\_RX).

### USB OTG\_FS characteristics

The USB interface is fully compliant with the USB specification version 2.0 and is USB-IF certified (for Full-speed device operation).

Table 101. USB OTG\_FS electrical characteristics

| Symbol        | Parameter                                      | Condition           | Min                | Typ  | Max  | Unit     |
|---------------|------------------------------------------------|---------------------|--------------------|------|------|----------|
| $V_{DD33USB}$ | USB transceiver operating voltage              | -                   | 3.0 <sup>(1)</sup> | -    | 3.6  | V        |
| $R_{PUI}$     | Embedded USB_DP pull-up value during idle      | -                   | 900                | 1250 | 1600 | $\Omega$ |
| $R_{PUR}$     | Embedded USB_DP pull-up value during reception | -                   | 1400               | 2300 | 3200 |          |
| $Z_{DRV}$     | Output driver impedance <sup>(2)</sup>         | Driver high and low | 28                 | 36   | 44   |          |

1. The USB functionality is ensured down to 2.7 V but not the full USB electrical characteristics which are degraded in the 2.7 to 3.0 V voltage range.

2. No external termination series resistors are required on USB\_DP (D+) and USB\_DM (D-); the matching impedance is already included in the embedded driver.

*When VBUS sensing feature is enabled, a typical 200  $\mu$ A input current (required to determine the different sessions validity according to USB standard) can be observed.*

### Ethernet (ETH) characteristics

Unless otherwise specified, the parameters given in [Table 102](#), [Table 103](#), [Table 104](#) and [Table 105](#) for MDIO/SMA, RMII, RGMII and MII are derived from tests performed under the

ambient temperature,  $F_{\text{axiss\_ck}}$  frequency summarized in [Table 13: General operating conditions](#), with the following configuration:

- Output speed is set to  $\text{OSPEEDRy}[1:0] = 11$
- Capacitive load  $C = 20 \text{ pF}$
- Measurement points are done at CMOS levels:  $0.5 \times V_{\text{DD}}$ .
- HSLV activated when  $V_{\text{DD}} \leq 2.7 \text{ V}$

Refer to [Section 6.3.17: I/O port characteristics](#) for more details on the input/output characteristics.

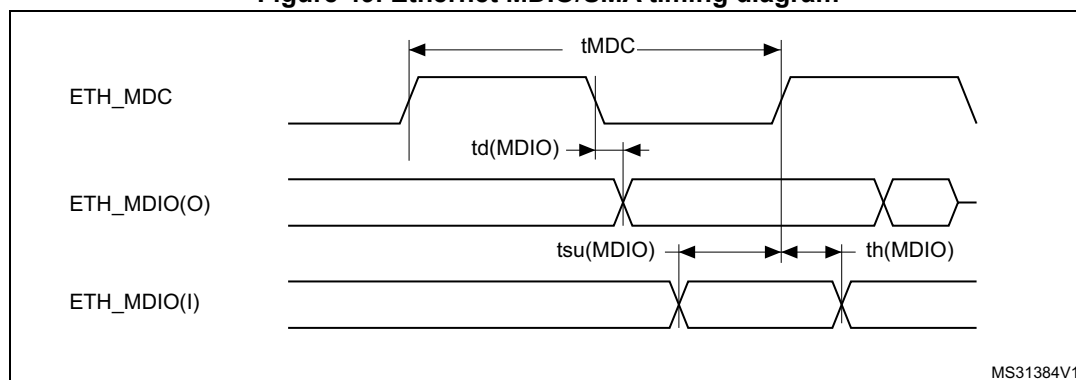
[Table 102](#) gives the list of Ethernet MAC timings for the MDIO/SMA and [Figure 49](#) shows the corresponding timing diagram.

**Table 102. Dynamics characteristics: Ethernet MAC timings for MDIO/SMA<sup>(1)</sup>**

| Symbol                | Parameter               | Min  | Typ | Max | Unit |
|-----------------------|-------------------------|------|-----|-----|------|
| $t_{\text{MDC}}$      | MDC cycle time(2.5 MHz) | 399  | 400 | 401 | ns   |
| $T_{\text{d(MDIO)}}$  | Write data valid time   | 0.5  | 1   | 3.5 |      |
| $t_{\text{su(MDIO)}}$ | Read data setup time    | 17.5 | -   | -   |      |
| $t_{\text{h(MDIO)}}$  | Read data hold time     | 0    | -   | -   |      |

1. Evaluated by characterization, not tested in production.

**Figure 49. Ethernet MDIO/SMA timing diagram**



MS31384V1

[Table 103](#) gives the list of Ethernet MAC timings for the RMI and [Figure 50](#) shows the corresponding timing diagram.

**Table 103. Dynamics characteristics: Ethernet MAC timings for RMI<sup>(1)</sup>**

| Symbol               | Parameter                        | Min | Typ | Max  | Unit |
|----------------------|----------------------------------|-----|-----|------|------|
| $t_{\text{su(RXD)}}$ | Receive data setup time          | 2   | -   | -    | ns   |
| $t_{\text{ih(RXD)}}$ | Receive data hold time           | 1.5 | -   | -    |      |
| $t_{\text{su(CRS)}}$ | Carrier sense setup time         | 1.5 | -   | -    |      |
| $t_{\text{ih(CRS)}}$ | Carrier sense hold time          | 1.5 | -   | -    |      |
| $t_{\text{d(TXEN)}}$ | Transmit enable valid delay time | 5.5 | 8.5 | 10.5 |      |
| $t_{\text{d(TXD)}}$  | Transmit data valid delay time   | 6   | 8.5 | 11   |      |

1. Evaluated by characterization, not tested in production.

Figure 50. Ethernet RMII timing diagram

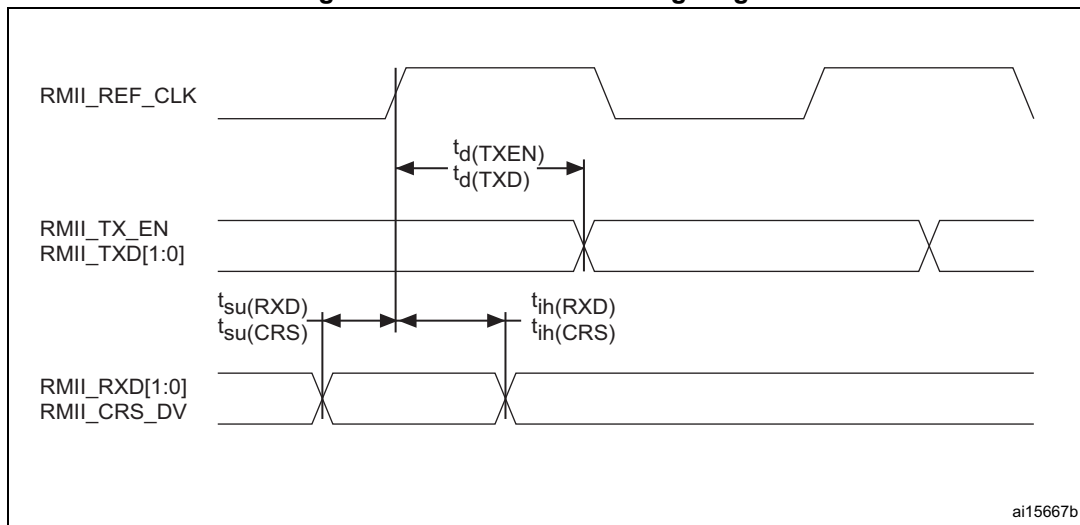


Table 104 gives the list of Ethernet MAC timings for MII and Figure 51 shows the corresponding timing diagram.

Table 104. Dynamics characteristics: Ethernet MAC timings for MII<sup>(1)</sup>

| Symbol        | Parameter                        | Min | Typ | Max | Unit |
|---------------|----------------------------------|-----|-----|-----|------|
| $t_{su}(RXD)$ | Receive data setup time          | 1.5 | -   | -   | ns   |
| $t_{ih}(RXD)$ | Receive data hold time           | 1.5 | -   | -   |      |
| $t_{su}(DV)$  | Data valid setup time            | 1   | -   | -   |      |
| $t_{ih}(DV)$  | Data valid hold time             | 1.5 | -   | -   |      |
| $t_{su}(ER)$  | Error setup time                 | 1.5 | -   | -   |      |
| $t_{ih}(ER)$  | Error hold time                  | 1   | -   | -   |      |
| $t_d(TXEN)$   | Transmit enable valid delay time | 7   | 9   | 12  |      |
| $t_d(TXD)$    | Transmit data valid delay time   | 7   | 9   | 12  |      |

1. Evaluated by characterization, not tested in production.

Figure 51. Ethernet MII timing diagram

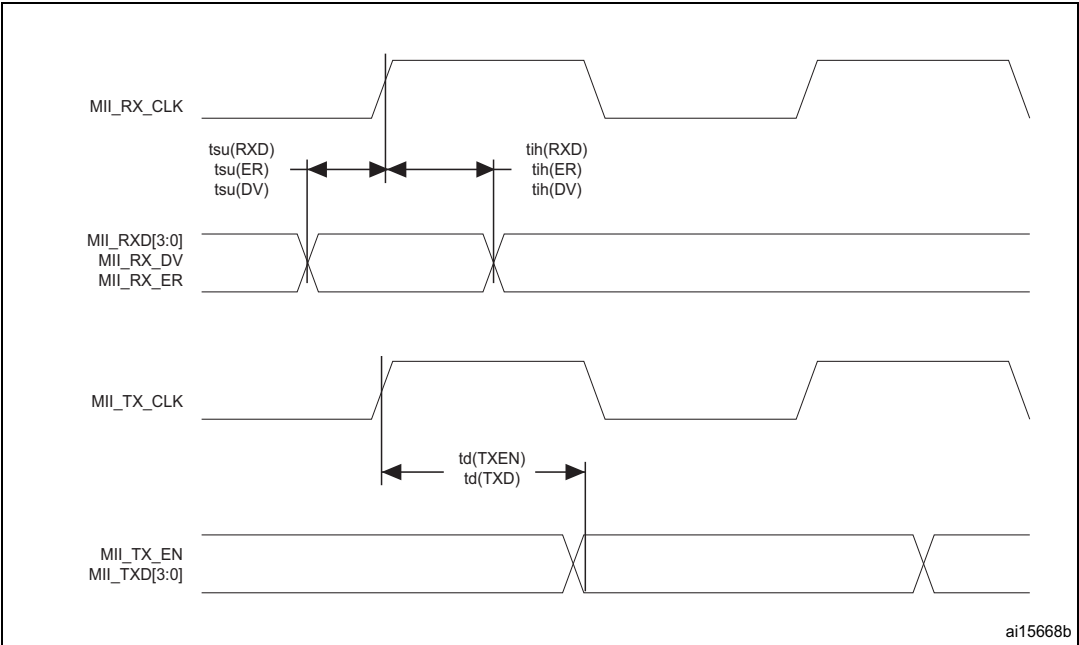
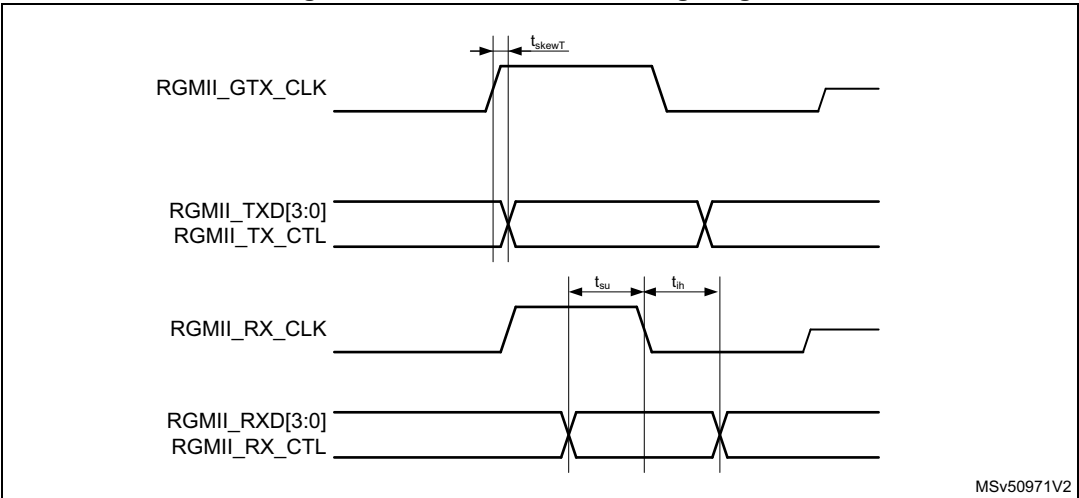


Table 105. Dynamics characteristics: Ethernet MAC signals for RGMII <sup>(1)</sup>

| Symbol               | Rating                            | Min   | Typ  | Max | Unit |
|----------------------|-----------------------------------|-------|------|-----|------|
| $t_{su}(RXD)$        | Receive data setup time           | 1     | -    | -   | ns   |
| $t_{ih}(RXD)$        | Receive data hold time            | 1.5   | -    | -   |      |
| $t_{su}(RX\_CTL)$    | Receive control valid setup time  | 1     | -    | -   |      |
| $t_{ih}(RX\_CTL)$    | Receive control valid hold time   | 1.5   | -    | -   |      |
| $T_{skewT}(TX\_CTL)$ | Transmit control valid delay time | -0.25 | 0.25 | 0.5 |      |
| $T_{skewT}(TXD)$     | Transmit data valid delay time    | -0.25 | 0.25 | 0.5 |      |

1. Evaluated by characterization, not tested in production.

Figure 52. Ethernet RGMII timing diagram





### 6.3.34 USART interface characteristics

Unless otherwise specified, the parameters given in [Table 106](#) for USART are derived from tests performed under the ambient temperature,  $f_{HCLK}$  frequency and  $V_{DD}$  supply voltage conditions summarized in [Table 106](#), with the following configuration:

- Output speed is set to OSPEEDRy[1:0] = 10
- Capacitive load C = 30 pF
- Measurement points are done at CMOS levels:  $0.5 \times V_{DD}$

Refer to [Section 6.3.17: I/O port characteristics](#) for more details on the input/output alternate function characteristics (NSS, CK, TX, RX for USART).

**Table 106. USART characteristics<sup>(1)</sup>**

| Symbol                         | Parameter              | Conditions  | Min              | Typ          | Max              | Unit |
|--------------------------------|------------------------|-------------|------------------|--------------|------------------|------|
| $f_{CK}$                       | USART clock frequency  | Master mode | -                | -            | 13               | MHz  |
|                                |                        | Slave mode  | -                | -            | 27               |      |
| $t_{su(NSS)}$                  | NSS setup time         | Slave mode  | $t_{ker}+2$      | -            | -                | ns   |
| $t_{h(NSS)}$                   | NSS hold time          | Slave mode  | 2                | -            | -                | ns   |
| $t_{w(CKH)}$ ,<br>$t_{w(CKL)}$ | CK high and low time   | Master mode | $1/f_{CK}/2 - 1$ | $1/f_{ck}/2$ | $1/f_{CK}/2 + 1$ | ns   |
| $t_{su(RX)}$                   | Data input setup time  | Master mode | 16               | -            | -                | ns   |
|                                |                        | Slave mode  | 2.5              | -            | -                |      |
| $t_{hRX)}$                     | Data input hold time   | Master mode | 0.5              | -            | -                | ns   |
|                                |                        | Slave mode  | 1                | -            | -                |      |
| $t_{v(TX)}$                    | Data output valid time | Slave mode  | -                | 10           | 18               | ns   |
|                                |                        | Master mode | -                | 1.5          | 2.5              |      |
| $t_h(TX)$                      | Data output hold time  | Slave mode  | 8                | -            | -                | ns   |
|                                |                        | Master mode | 0                | -            | -                |      |

1. 1.Evaluated by characterization, not tested in production.

### 6.3.35 USB High-Speed PHY characteristics

**Table 107. USB High-Speed PHY characteristics<sup>(1)</sup>**

| Symbol                 | Parameter                                         | Conditions    | Min  | Typ  | Max  | Unit |
|------------------------|---------------------------------------------------|---------------|------|------|------|------|
| $R_{REF}$              | Reference resistor on USB_RREF pin                | -             | 2.97 | 3.00 | 3.03 | kΩ   |
| $I_{DDA1V1\_REG(PHY)}$ | High-Speed TX <sup>(2)</sup>                      | One USB port  | -    | 1.4  | -    | mA   |
|                        |                                                   | Two USB ports | -    | 2.4  | -    |      |
|                        | High-Speed RX <sup>(3)</sup> / Idle               | One USB port  | -    | 5.4  | -    |      |
|                        |                                                   | Two USB ports | -    | 10.4 | -    |      |
|                        | Full-Speed and Low-Speed mode (Suspend, TX or RX) |               | -    | 0    | -    |      |

Table 107. USB High-Speed PHY characteristics<sup>(1)</sup> (continued)

| Symbol                         | Parameter                                         | Conditions    | Min | Typ  | Max | Unit |
|--------------------------------|---------------------------------------------------|---------------|-----|------|-----|------|
| I <sub>DDA1V8_REG(PHY)</sub>   | High-Speed TX <sup>(2)</sup>                      | One USB port  | -   | 25.5 | -   | mA   |
|                                |                                                   | Two USB ports | -   | 50.5 | -   |      |
|                                | High-Speed RX <sup>(3)</sup> / Idle               | One USB port  | -   | 2.5  | -   |      |
|                                |                                                   | Two USB ports | -   | 5.5  | -   |      |
|                                | Full-Speed and Low-Speed mode (Suspend, TX or RX) |               | -   | 0    | -   |      |
| I <sub>DDA3V3_USBHS(PHY)</sub> | High-Speed TX <sup>(2)</sup>                      | One USB port  | -   | 5    | -   | mA   |
|                                |                                                   | Two USB ports | -   | 7    | -   |      |
|                                | High-Speed RX <sup>(3)</sup> / Idle               | One USB port  | -   | 6    | -   |      |
|                                |                                                   | Two USB ports | -   | 10   | -   |      |
|                                | Full-Speed Suspend (host mode)                    | One USB port  | -   | 0    | -   |      |
|                                |                                                   | Two USB ports | -   | 0    | -   |      |
|                                | Full-Speed Suspend (peripheral mode)              | One USB port  | -   | 0.2  | -   |      |
|                                |                                                   | Two USB ports | -   | 0.4  | -   |      |
|                                | Full-Speed TX <sup>(2)</sup>                      | One USB port  | -   | 6.5  | -   |      |
|                                |                                                   | Two USB ports | -   | 10.5 | -   |      |
|                                | Full-Speed RX <sup>(3)</sup>                      | One USB port  | -   | 6.5  | -   |      |
|                                |                                                   | Two USB ports | -   | 11.5 | -   |      |
|                                | Low-Speed TX <sup>(2)</sup>                       | One USB port  | -   | 7    | -   |      |
|                                |                                                   | Two USB ports | -   | 11.5 | -   |      |
|                                | Low-Speed RX <sup>(3)</sup>                       | One USB port  | -   | 4.3  | -   |      |
|                                |                                                   | Two USB ports | -   | 6.1  | -   |      |

1. Specified by design, not tested in production unless otherwise specified.

2. USB link 100% of the time in transmission

3. USB link 100% of the time in reception

### 6.3.36 JTAG/SWD interface characteristics

Unless otherwise specified, the parameters given in [Table 108](#) and [Table 109](#) for JTAG/SWD are derived from tests performed under the ambient temperature,  $f_{\text{rcc\_c\_ck}}$  frequency and  $V_{\text{DD}}$  supply voltage summarized in [Table 13: General operating conditions](#), with the following configuration:

- Output speed is set to OSPEEDRy[1:0] = 0x10
- Capacitive load C = 30 pF
- Measurement points are done at CMOS levels:  $0.5 \times V_{\text{DD}}$

Refer to [Section 6.3.17: I/O port characteristics](#) for more details on the input/output characteristics.

Table 108. Dynamics characteristics: JTAG characteristics

| Symbol        | Parameter                | Conditions                              | Min | Typ | Max | Unit |
|---------------|--------------------------|-----------------------------------------|-----|-----|-----|------|
| $F_{pp}$      | $T_{CK}$ clock frequency | $2.7\text{ V} < V_{DD} < 3.6\text{ V}$  | -   | -   | 35  | MHz  |
| $1/t_c(TCK)$  |                          | $1.71\text{ V} < V_{DD} < 3.6\text{ V}$ | -   | -   | 27  |      |
| $t_{is}(TMS)$ | TMS input setup time     | -                                       | 2.5 | -   | -   | ns   |
| $t_{ih}(TMS)$ | TMS input hold time      | -                                       | 1   | -   | -   |      |
| $t_{is}(TDI)$ | TDI input setup time     | -                                       | 2   | -   | -   |      |
| $t_{ih}(TDI)$ | TDI input hold time      | -                                       | 1   | -   | -   |      |
| $t_{ov}(TDO)$ | TDO output valid time    | $2.7\text{ V} < V_{DD} < 3.6\text{ V}$  | -   | 9.5 | 14  |      |
|               |                          | $1.71\text{ V} < V_{DD} < 3.6\text{ V}$ | -   | 9.5 | 18  |      |
| $t_{oh}(TDO)$ | TDO output hold time     | -                                       | 8   | -   | -   |      |

Table 109. Dynamics characteristics: SWD characteristics

| Symbol          | Parameter               | Conditions                              | Min | Typ  | Max | Unit |
|-----------------|-------------------------|-----------------------------------------|-----|------|-----|------|
| $F_{pp}$        | SWCLK clock frequency   | $2.7\text{ V} < V_{DD} < 3.6\text{ V}$  | -   | -    | 71  | MHz  |
| $1/t_c(SWCLK)$  |                         | $1.71\text{ V} < V_{DD} < 3.6\text{ V}$ | -   | -    | 55  |      |
| $t_{is}(SWDIO)$ | SWDIO input setup time  | -                                       | 2.5 | -    | -   | ns   |
| $t_{ih}(SWDIO)$ | SWDIO input hold time   | -                                       | 1   | -    | -   |      |
| $t_{ov}(SWDIO)$ | SWDIO output valid time | $2.7\text{ V} < V_{DD} < 3.6\text{ V}$  | -   | 10.5 | 14  |      |
|                 |                         | $1.71\text{ V} < V_{DD} < 3.6\text{ V}$ | -   | 10.5 | 18  |      |
| $t_{oh}(SWDIO)$ | SWDIO output hold time  | -                                       | 9   | -    | -   |      |

Figure 53. JTAG timing diagram

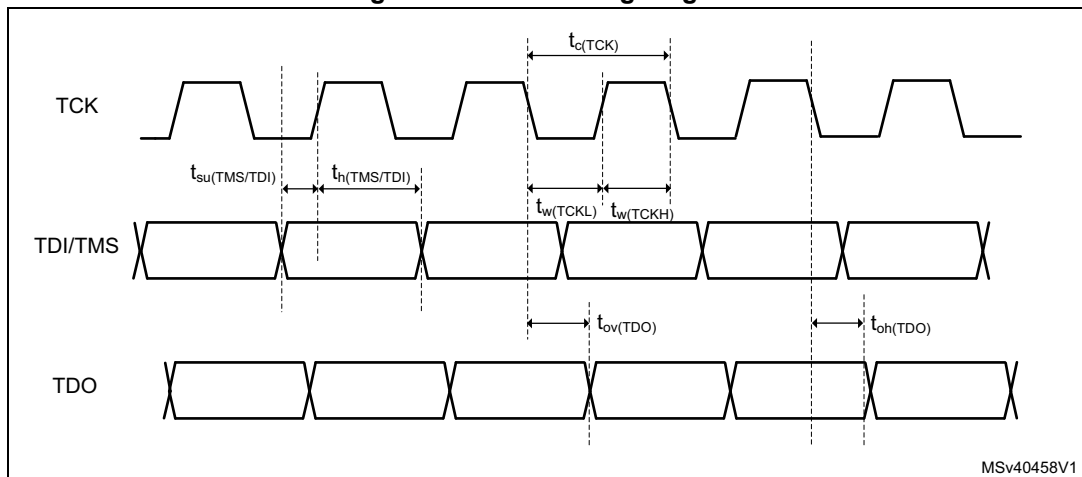
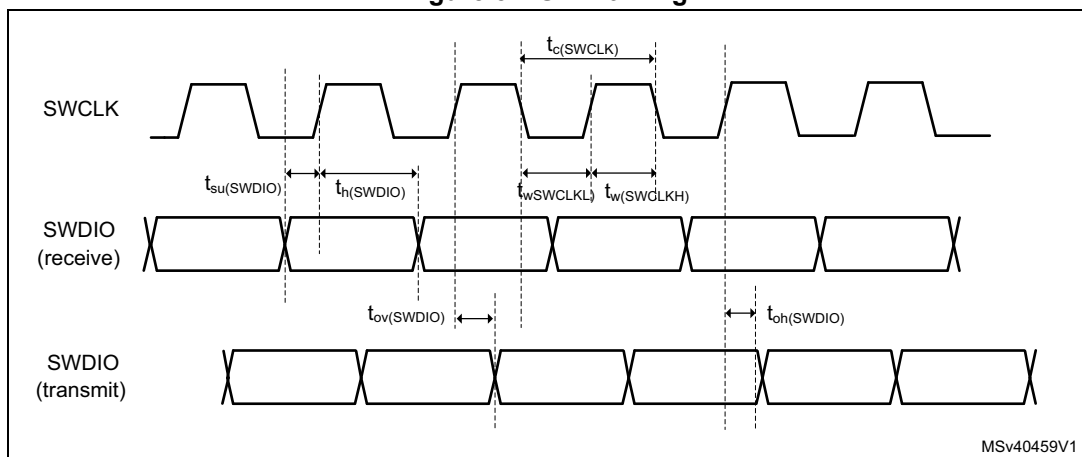


Figure 54. SWD timing



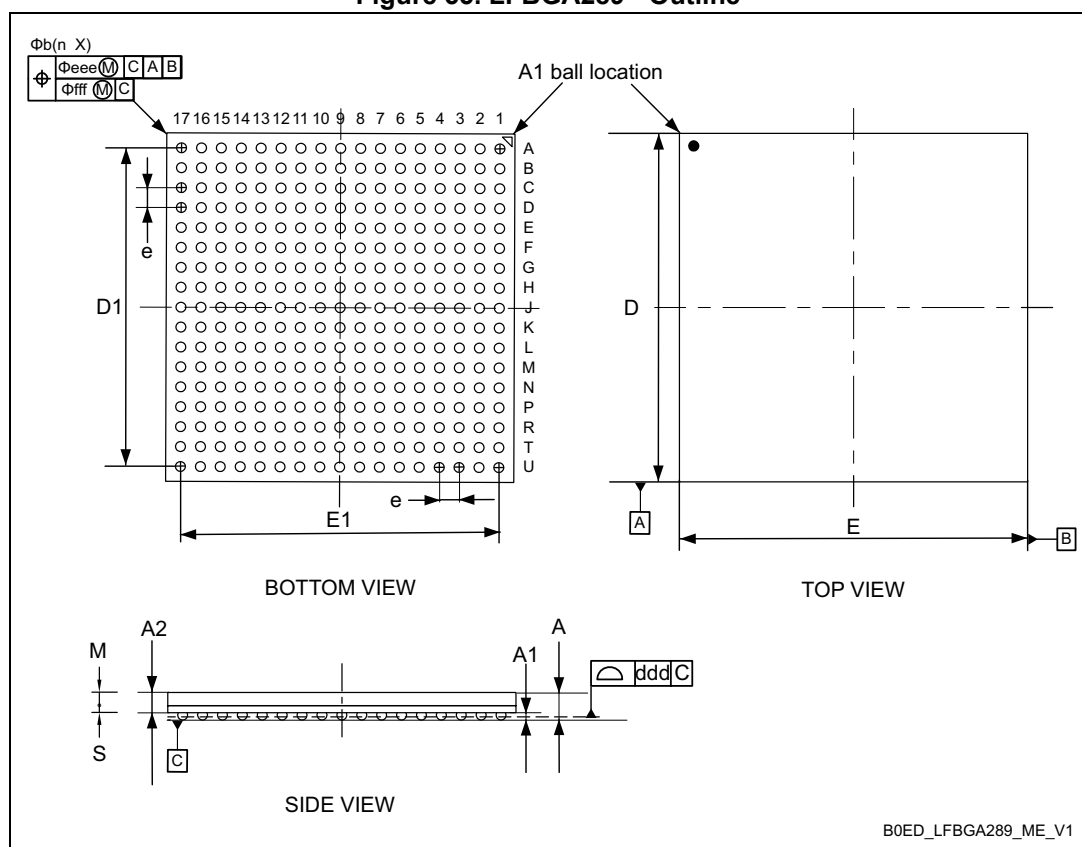
## 7 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com). ECOPACK is an ST trademark.

### 7.1 LFBGA289 package information

This LFBGA is a 289 ball, 14x14 mm, 0.8 mm pitch, low profile fine pitch ball grid array package.

Figure 55. LFBGA289 - Outline



1. Drawing is not to scale.
2. The tolerance of position controls the location of the balls within the matrix with respect to each other. For each ball there is a cylindrical tolerance zone fff perpendicular to datum C and located on true position as defined by e. The axis perpendicular to datum C of each ball must lie within this tolerance zone. Each tolerance zone fff in the array is contained entirely in the respective zone eee above. The axis of each ball must lie simultaneously in both tolerance zones.

Table 110. LFBGA289 - Mechanical data

| Symbol             | millimeters |        |        | inches <sup>(1)</sup> |         |        |
|--------------------|-------------|--------|--------|-----------------------|---------|--------|
|                    | Min         | Typ    | Max    | Min                   | Typ     | Max    |
| A <sup>(2)</sup>   | -           | -      | 1.700  | -                     | -       | 0.0669 |
| A1                 | 0.210       | 0.290  | -      | 0.0083                | 0.0114  | -      |
| A2                 | -           | 0.816  | -      | -                     | 32.1260 | -      |
| b <sup>(3)</sup>   | 0.350       | 0.400  | 0.450  | 0.0138                | 0.0157  | 0.0177 |
| D                  | 13.850      | 14.000 | 14.150 | 0.5453                | 0.5512  | 0.5571 |
| D1                 | -           | 12.800 | -      | -                     | 0.5039  | -      |
| E                  | 13.850      | 14.000 | 14.150 | 0.5453                | 0.5512  | 0.5571 |
| E1                 | -           | 12.800 | -      | -                     | 0.5039  | -      |
| e                  | -           | 0.800  | -      | -                     | 0.0315  | -      |
| M                  | -           | 0.530  | -      | -                     | 0.0209  | -      |
| S                  | -           | 0.286  | -      | -                     | 0.0113  | -      |
| ddd <sup>(4)</sup> | -           | 0.120  | -      | -                     | 0.0047  | -      |
| eee <sup>(5)</sup> | -           | 0.150  | -      | -                     | 0.0059  | -      |
| fff                | -           | 0.080  | -      | -                     | 0.0031  | -      |

1. Values in inches are converted from mm and rounded to 4 decimal digits.
2. LFBGA stands for low profile fine pitch ball grid array. The total profile height (Dim A) is measured from the seating plane to the top of the component.
3. Initial ball equal 0.400 mm
4. The tolerance of position that controls the location of the pattern of balls with respect to datums A and B. For each ball there is a cylindrical tolerance zone eee perpendicular to datum C and located on true position with respect to datums A and B as defined by e. The axis perpendicular to datum C of each ball must lie within this tolerance zone.
5. The tolerance of position that controls the location of the balls within the matrix with respect to each other. For each ball there is a cylindrical tolerance zone fff perpendicular to datum C and located on true position as defined by e. The axis perpendicular to datum C of each ball must lie within this tolerance zone. Each tolerance zone fff in the array is contained entirely in the respective zone eee above. The axis of each ball must lie simultaneously in both tolerance zones

Figure 56. LFBGA289 - Recommended footprint

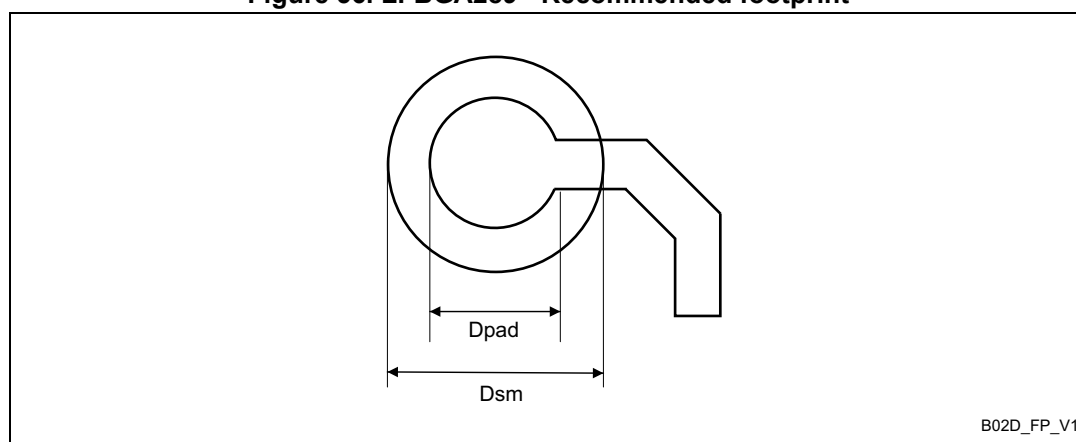


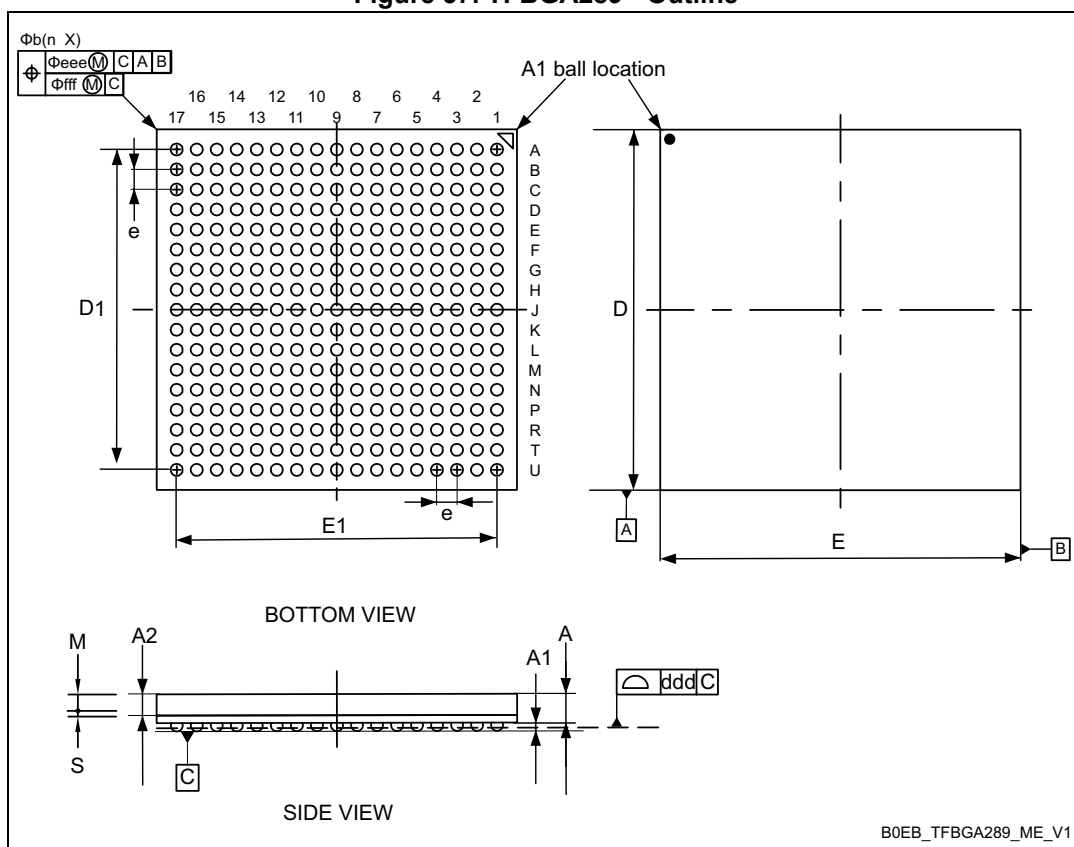
Table 111. LFBGA289 - Recommended PCB design rules

| Dimension         | Recommended values   |
|-------------------|----------------------|
| Pitch             | 0.8 mm               |
| Dpad              | 0.320 mm             |
| Dsm               | 0.420 mm typ.        |
| Stencil opening   | 0.320 mm             |
| Stencil thickness | 0.125 mm to 0.100 mm |

## 7.2 TFBGA289 package information

This TFBGA is a 289 ball, 9x9 mm, 0.5 mm pitch, thin profile fine pitch ball grid array package.

Figure 57. TFBGA289 - Outline



1. Drawing is not to scale.
2. The tolerance of position controls the location of the pattern of balls with respect to datums A and B. For each ball there is a cylindrical tolerance zone  $\phi e$  perpendicular to datum C and located on true position with respect to datums A and B as defined by e. The axis perpendicular to datum C of each ball must lie within this tolerance zone.

Table 112. TFBGA289 - Mechanical data

| Symbol             | millimeters |       |       | inches <sup>(1)</sup> |         |        |
|--------------------|-------------|-------|-------|-----------------------|---------|--------|
|                    | Min         | Typ   | Max   | Min                   | Typ     | Max    |
| A <sup>(2)</sup>   | -           | -     | 1.200 | -                     | -       | 0.0472 |
| A1                 | 0.140       | 0.210 | -     | 0.0055                | 0.0083  | -      |
| A2                 | -           | 0.716 | -     | -                     | 28.1890 | -      |
| b <sup>(3)</sup>   | 0.250       | 0.300 | 0.350 | 0.0098                | 0.0118  | 0.0138 |
| D                  | 8.850       | 9.000 | 9.150 | 0.3484                | 0.3543  | 0.3602 |
| D1                 | -           | 8.000 | -     | -                     | 0.3150  | -      |
| E                  | 8.850       | 9.000 | 9.150 | 0.3484                | 0.3543  | 0.3602 |
| E1                 | -           | 8.000 | -     | -                     | 0.3150  | -      |
| e                  | -           | 0.500 | -     | -                     | 0.0197  | -      |
| M                  | -           | 0.530 | -     | -                     | 0.0209  | -      |
| S                  | -           | 0.186 | -     | -                     | 0.0073  | -      |
| ddd <sup>(4)</sup> | -           | 0.080 | -     | -                     | 0.0031  | -      |
| eee <sup>(5)</sup> | -           | 0.150 | -     | -                     | 0.0059  | -      |
| fff                | -           | 0.080 | -     | -                     | 0.0031  | -      |

1. Values in inches are converted from mm and rounded to 4 decimal digits.
2. TFBGA stands for thin profile fine pitch ball grid array. The total profile height (dim A) is measured from the seating plane to the top of the component.
3. Initial ball equal 0.300 mm.
4. The tolerance of position that controls the location of the pattern of balls with respect to datums A and B. For each ball there is a cylindrical tolerance zone eee perpendicular to datum C and located on true position with respect to datums A and B as defined by e. The axis perpendicular to datum C of each ball must lie within this tolerance zone.
5. The tolerance of position that controls the location of the balls within the matrix with respect to each other. For each ball there is a cylindrical tolerance zone fff perpendicular to datum C and located on true position as defined by e. The axis perpendicular to datum C of each ball must lie within this tolerance zone. Each tolerance zone fff in the array is contained entirely in the respective zone eee above. The axis of each ball must lie simultaneously in both tolerance zones



Figure 58. TFBGA289 - Recommended footprint

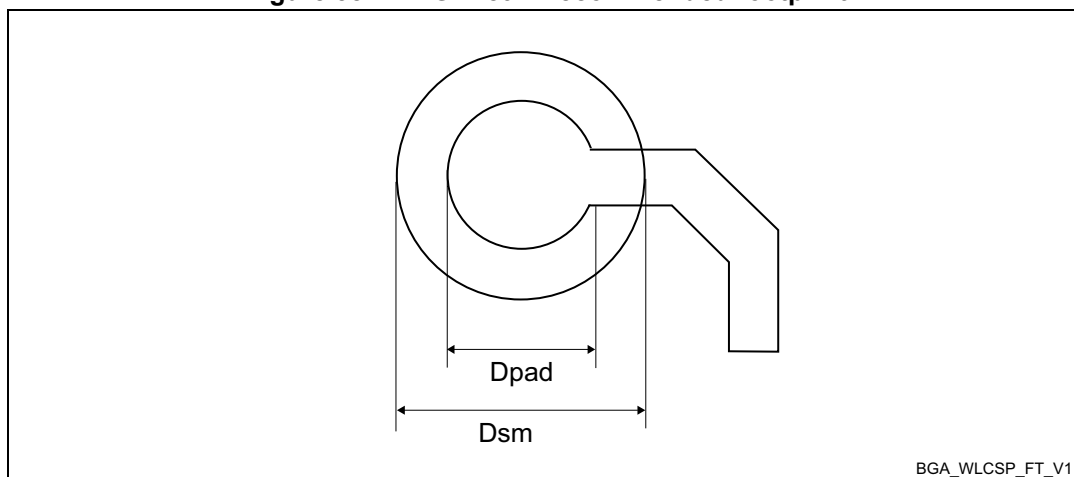


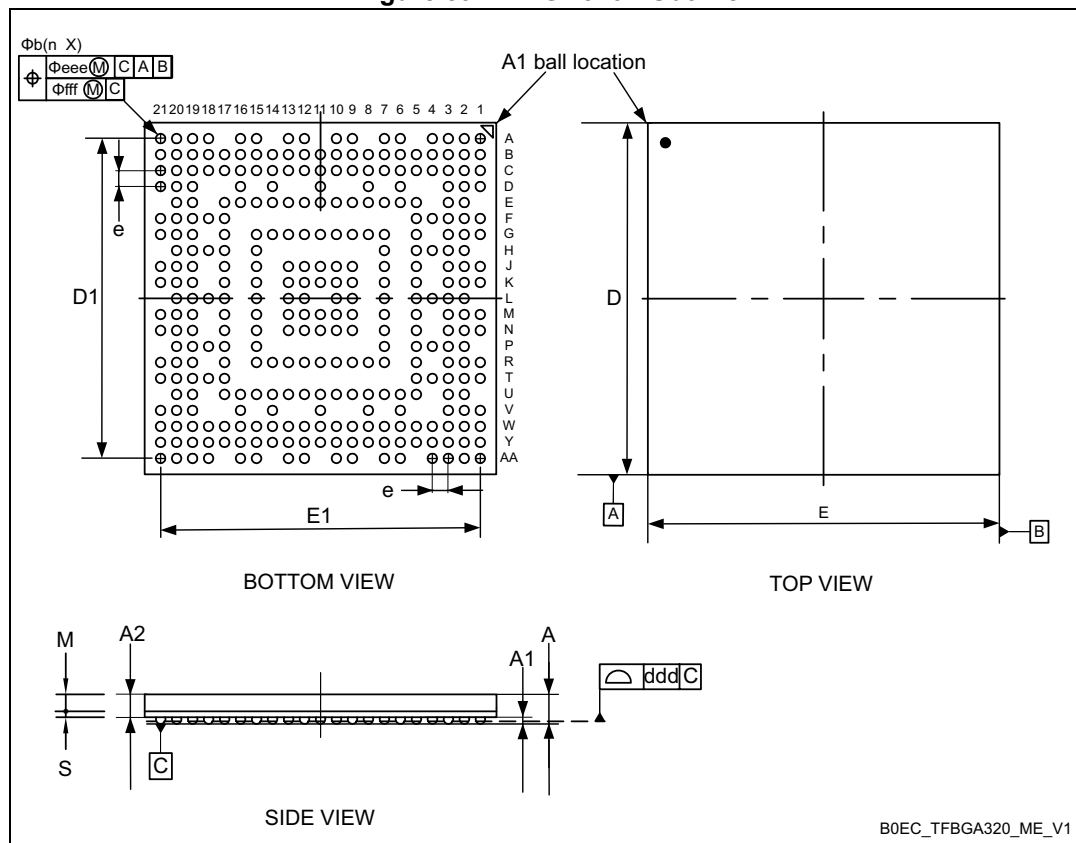
Table 113. TFBGA289 - Recommended PCB design rules

| Dimension         | Recommended values   |
|-------------------|----------------------|
| Pitch             | 0.5 mm               |
| $D_{pad}$         | 0.230 mm             |
| $D_{sm}$          | 0.330 mm typ.        |
| Stencil opening   | 0.230 mm             |
| Stencil thickness | 0.125 mm to 0.100 mm |

## 7.3 TFBGA320 package information

This TFBGA is a 320 ball, 11x11 mm, 0.5 mm pitch, thin profile fine pitch ball grid array package.

**Figure 59. TFBGA320 - Outline**



1. Drawing is not to scale.
2. The tolerance of position controls the location of the pattern of balls with respect to datums A and B. For each ball there is a cylindrical tolerance zone  $\phi_{eee}$  perpendicular to datum C and located on true position with respect to datums A and B as defined by e. The axis perpendicular to datum C of each ball must lie within this tolerance zone.

**Table 114. TFBGA320 - Mechanical data**

| Symbol           | millimeters |        |        | inches <sup>(1)</sup> |        |        |
|------------------|-------------|--------|--------|-----------------------|--------|--------|
|                  | Min         | Typ    | Max    | Min                   | Typ    | Max    |
| A <sup>(2)</sup> | -           | -      | 1.200  | -                     | -      | 0.0472 |
| A1               | 0.140       | 0.210  | -      | 0.0055                | 0.0083 | -      |
| A2               | -           | 0.716  | -      | -                     | 0.0282 | -      |
| b <sup>(3)</sup> | 0.250       | 0.300  | 0.350  | 0.0098                | 0.0118 | 0.0138 |
| D                | 10.850      | 11.000 | 11.150 | 0.4272                | 0.4331 | 0.4390 |
| D1               | -           | 10.000 | -      | -                     | 0.3937 | -      |
| E                | 10.850      | 11.000 | 11.150 | 0.4272                | 0.4331 | 0.4390 |
| E1               | -           | 10.000 | -      | -                     | 0.3937 | -      |

Table 114. TFBGA320 - Mechanical data (continued)

| Symbol             | millimeters |       |     | inches <sup>(1)</sup> |        |     |
|--------------------|-------------|-------|-----|-----------------------|--------|-----|
|                    | Min         | Typ   | Max | Min                   | Typ    | Max |
| e                  | -           | 0.500 | -   | -                     | 0.0197 | -   |
| M                  | -           | 0.530 | -   | -                     | 0.0209 | -   |
| S                  | -           | 0.186 | -   | -                     | 0.0073 | -   |
| ddd <sup>(4)</sup> | -           | 0.080 | -   | -                     | 0.0031 | -   |
| eee <sup>(5)</sup> | -           | 0.150 | -   | -                     | 0.0059 | -   |
| fff                | -           | 0.080 | -   | -                     | 0.0031 | -   |

1. Values in inches are converted from mm and rounded to 4 decimal digits.
2. TFBGA stands for thin profile fine pitch ball grid array. The total profile height (dim A) is measured from the seating plane to the top of the component.
3. Initial ball equal 0.300 mm.
4. The tolerance of position that controls the location of the pattern of balls with respect to datums A and B. For each ball there is a cylindrical tolerance zone eee perpendicular to datum C and located on true position with respect to datums A and B as defined by e. The axis perpendicular to datum C of each ball must lie within this tolerance zone.
5. The tolerance of position that controls the location of the balls within the matrix with respect to each other. For each ball there is a cylindrical tolerance zone fff perpendicular to datum C and located on true position as defined by e. The axis perpendicular to datum C of each ball must lie within this tolerance zone. Each tolerance zone fff in the array is contained entirely in the respective zone eee above. The axis of each ball must lie simultaneously in both tolerance zones

Figure 60. TFBGA320 - Recommended footprint

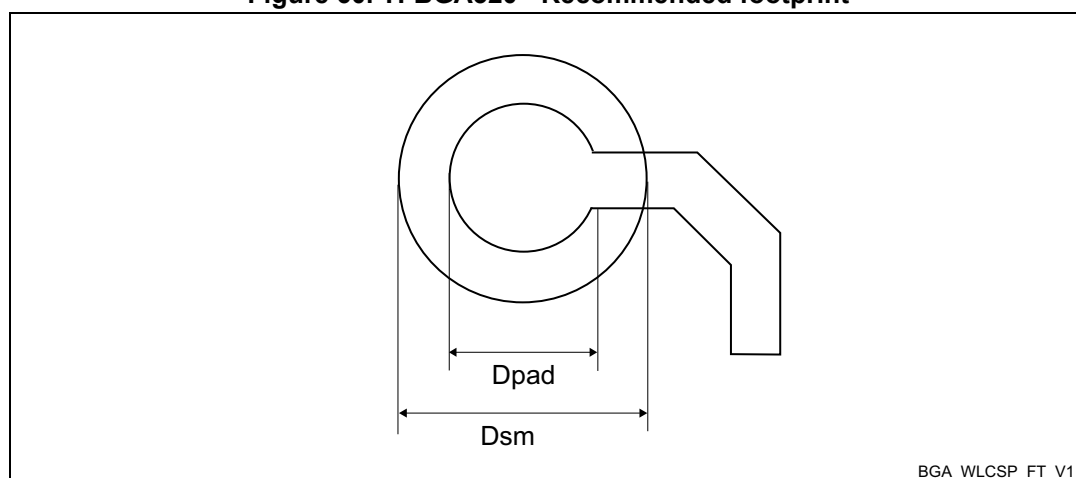


Table 115. TFBGA320 - Recommended PCB design rules

| Dimension         | Recommended values   |
|-------------------|----------------------|
| Pitch             | 0.5 mm               |
| Dpad              | 0.230 mm             |
| Dsm               | 0.330 mm typ.        |
| Stencil opening   | 0.230 mm             |
| Stencil thickness | 0.125 mm to 0.100 mm |

## 7.4 Thermal characteristics

Package thermal characteristics in [Table 116](#) are specified with conditions as per JEDEC JESD51-6, JESD51-8, JESD51-9, and JESD51-12. These typical values will vary in function of board thermal characteristics and other components on the board.

$\Theta_{JA}$ : Thermal resistance junction-ambient.  
 $\Theta_{JB}$ : Thermal resistance junction-board.  
 $\Theta_{JC}$ : Thermal resistance junction-top-case.  
 $\Psi_{jb}$ : Thermal parameter junction-board.  
 $\Psi_{jt}$ : Thermal parameter junction-top-case.  
 Motherboard type: four layers, JEDEC 2S2P

**Table 116. Thermal characteristics**

| Symbol              | Parameter                                  | Value              |                  | Unit |
|---------------------|--------------------------------------------|--------------------|------------------|------|
|                     |                                            | Natural convection | 1m/s (200 ft/mn) |      |
| $\Theta_{JA}^{(1)}$ | LFBGA289 - 289-ball 14x14 mm 0.80 mm pitch | 31.7               | 29.2             | °C/W |
|                     | TFBGA289 - 289-ball 9x9 mm 0.50 mm pitch   | 29.3               | 27               |      |
|                     | TFBGA320 - 320-ball 11x11 mm 0.50 mm pitch | 29                 | 26.6             |      |
| $\Theta_{JB}^{(2)}$ | LFBGA289 - 289-ball 14x14 mm 0.80 mm pitch | 21.2               |                  | °C/W |
|                     | TFBGA289 - 289-ball 9x9 mm 0.50 mm pitch   | 15.9               |                  |      |
|                     | TFBGA320 - 320-ball 11x11 mm 0.50 mm pitch | 16.9               |                  |      |
| $\Theta_{JC}^{(3)}$ | LFBGA289 - 289-ball 14x14 mm 0.80 mm pitch | 8.9                |                  | °C/W |
|                     | TFBGA289 - 289-ball 9x9 mm 0.50 mm pitch   | 8.6                |                  |      |
|                     | TFBGA320 - 320-ball 11x11 mm 0.50 mm pitch | 8.5                |                  |      |
| $\Psi_{jb}^{(4)}$   | LFBGA289 - 289-ball 14x14 mm 0.80 mm pitch | 21.1               | 20.9             | °C/W |
|                     | TFBGA289 - 289-ball 9x9 mm 0.50 mm pitch   | 15.9               | 15.8             |      |
|                     | TFBGA320 - 320-ball 11x11 mm 0.50 mm pitch | 16.9               | 16.8             |      |
| $\Psi_{jt}^{(5)}$   | LFBGA289 - 289-ball 14x14 mm 0.80 mm pitch | 0.21               | 0.29             | °C/W |
|                     | TFBGA289 - 289-ball 9x9 mm 0.50 mm pitch   | 0.18               | 0.26             |      |
|                     | TFBGA320 - 320-ball 11x11 mm 0.50 mm pitch | 0.18               | 0.26             |      |

1. Per JEDEC JESD51-9
2. Per JEDEC JESD51-8
3. Per JEDEC JESD51-12 best practice guidelines
4. Per JEDEC JESD51-12.
5. Per JEDEC JESD51-12.

### 7.4.1 Reference documents

JESD51-6 Integrated Circuit Thermal Test Method Environmental Conditions - Forced Convection (Moving Air). Available from [www.jedec.org](http://www.jedec.org).

JESD51-8 Integrated Circuit Thermal Test Method Environmental Conditions —Junction-to-Board. Available from [www.jedec.org](http://www.jedec.org).

JESD51-9 Test Boards for Area Array Surface. Mount Package Thermal. Measurements.

Available from [www.jedec.org](http://www.jedec.org).

JESD51-12 Guidelines for Reporting and Using Electronic Package Thermal Information.

Available from [www.jedec.org](http://www.jedec.org).

## 7.5 Device marking

Refer to technical note “Reference device marking schematics for STM32 microcontrollers and microprocessors” (TN1433) available on [www.st.com](http://www.st.com), for the location of ball A1 as well as the location and orientation of the marking areas versus ball A1.

Parts marked as “ES”, “E” or accompanied by an engineering sample notification letter, are not yet qualified and therefore not approved for use in production. ST is not responsible for any consequences resulting from such use. In no event will ST be liable for the customer using any of these engineering samples in production. ST’s Quality department must be contacted prior to any decision to use these engineering samples to run a qualification activity.

## 8 Ordering information

**Table 117. STM32MP133C/F ordering information scheme**

| Example:                                                                                                                                                        | STM32 | MP | 133 | C | AE | 3 | T |
|-----------------------------------------------------------------------------------------------------------------------------------------------------------------|-------|----|-----|---|----|---|---|
| Device family                                                                                                                                                   |       |    |     |   |    |   |   |
| STM32 = Arm-based 32-bit processor                                                                                                                              |       |    |     |   |    |   |   |
| Product type                                                                                                                                                    |       |    |     |   |    |   |   |
| MP = MPU product                                                                                                                                                |       |    |     |   |    |   |   |
| Device subfamily                                                                                                                                                |       |    |     |   |    |   |   |
| 133 = STM32MP133 line                                                                                                                                           |       |    |     |   |    |   |   |
| Security option                                                                                                                                                 |       |    |     |   |    |   |   |
| C = Secure boot, security features, cryptography hardware, 650 MHz<br>F = Secure boot, security features, cryptography hardware, 1000 MHz                       |       |    |     |   |    |   |   |
| Package and pin count                                                                                                                                           |       |    |     |   |    |   |   |
| AE = LFBGA289 14x14, 289 balls pitch 0.8 mm<br>AF = TFBGA320 11x11, 320 balls pitch 0.5 mm<br>AG = TFBGA289 9x9, 289 balls pitch 0.5 mm                         |       |    |     |   |    |   |   |
| Junction temperature range                                                                                                                                      |       |    |     |   |    |   |   |
| 3 = -40 °C < T <sub>J</sub> < +125 °C up to 650 MHz Cortex®-A7 <sup>(1)</sup><br>7 = -40 °C < T <sub>J</sub> < +105 °C up to 1000 MHz Cortex®-A7 <sup>(1)</sup> |       |    |     |   |    |   |   |
| Options                                                                                                                                                         |       |    |     |   |    |   |   |
| Blank = no options                                                                                                                                              |       |    |     |   |    |   |   |
| Packing                                                                                                                                                         |       |    |     |   |    |   |   |
| T = tape and reel<br>No character = tray or tube                                                                                                                |       |    |     |   |    |   |   |

1. Refer also to the application note AN5438 "STM32MP1 Series lifetime estimates" available from the ST website [www.st.com](http://www.st.com).

For a list of available options (speed, package, etc.) or for further information on any aspect of this device, please contact your nearest ST sales office.

## 9 Important security notice

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## 10 Revision history

Table 118. Document revision history

| Date        | Revision | Changes          |
|-------------|----------|------------------|
| 16-Feb-2023 | 1        | Initial release. |

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